32-bit Arm® Cortex®-M4F microcontroller TRAVEO™ T2G family

General description

CYT2B9 is a family of TRAVEO™ T2G microcontrollers targeted at automotive systems such as body control units. CYT2B9 has an Arm® Cortex®-M4 CPU for primary processing, and an Arm® Cortex®-M0+ CPU for peripheral and security processing. These devices contain embedded peripherals supporting Controller Area Network with Flexible Data rate (CAN FD), Local Interconnect Network (LIN), and Clock Extension Peripheral Interface (CXPI). TRAVEO™ T2G devices are manufactured on an advanced 40-nm process. CYT2B9 incorporates Cypress' low-power flash memory, multiple high-performance analog and digital peripherals, and enables the creation of a secure computing platform.

Features

- **Dual CPU subsystem**
  - 160-MHz (max) 32-bit Arm® Cortex®-M4F CPU with
    - Single-cycle multiply
    - Single-precision floating point unit (FPU)
    - Memory protection unit (MPU)
  - 100-MHz (max) 32-bit Arm® Cortex® M0+ CPU with
    - Single-cycle multiply
    - Memory protection unit
  - Inter-processor communication in hardware
  - Three DMA controllers
    - Peripheral DMA controller #0 (P-DMA0) with 92 channels
    - Peripheral DMA controller #1 (P-DMA1) with 44 channels
    - Memory DMA controller #0 (M-DMA0) with 4 channels
- **Integrated memories**
  - 2112-KB of code-flash with an additional 128-KB of work-flash
    - Read-While-Write (RWW) allows updating the code-flash/work-flash while executing code from it
    - Single- and dual-bank modes (specifically for Firmware update Over The Air [FOTA])
    - Flash programming through SWD/JTAG interface
  - 256-KB of SRAM with selectable retention granularity
- **Crypto engine**[1]
  - Supports Enhanced Secure Hardware Extension (eSHE) and Hardware Security Module (HSM)
  - Secure boot and authentication
    - Using digital signature verification
    - Using fast secure boot
  - AES: 128-bit blocks, 128-/192-/256-bit keys
  - 3DES[2]: 64-bit blocks, 64-bit key
  - Vector unit[2] supporting asymmetric key cryptography such as Rivest-Shamir-Adleman (RSA) and Elliptic Curve (ECC)
  - SHA-1/2/3[2]: SHA-512, SHA-256, SHA-160 with variable length input data
  - CRC[2]: supports CCITT CRC16 and IEEE-802.3 CRC32
  - True random number generator (TRNG) and pseudo random number generator (PRNG)
  - Galois/Counter Mode (GCM)
- **Functional safety for ASIL-B**
  - Memory Protection Unit (MPU)
  - Shared Memory Protection Unit (SMPU)

Notes
1. Crypto engine features are available on select MPNs.
2. This feature is not available in “eSHE only” parts. For more information, see **Ordering Information**.

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- Peripheral Protection Unit (PPU)
- Watchdog timer (WDT)
- Multi-counter watchdog timer (MCWDT)
- Low-voltage detector (LVD)
- Brown-out detector (BOD)
- Overvoltage detection (OVD)
- Clock supervisor (CSV)
- Hardware error correction (SECDED ECC) on all safety-critical memories (SRAM, flash)

- **Low-power 2.7-V to 5.5-V operation**
  - Low-power Active, Sleep, Low-power Sleep, DeepSleep, and Hibernate modes for fine-grained power management
  - Configurable options for robust BOD
    - Two threshold levels (2.7 V and 3.0 V) for BOD on V_{DDD} and V_{DDA}
    - One threshold level (1.1 V) for BOD on V_{CCD}
- **Wakeup support**
  - Up to two pins to wakeup from Hibernate mode
  - Up to 152 GPIO pins to wakeup from Sleep modes
  - Event Generator, SCB, Watchdog Timer, RTC alarms to wake from DeepSleep modes
- **Clock sources**
  - Internal Main Oscillator (IMO)
  - Internal Low-Speed Oscillator (ILO)
  - External Crystal Oscillator (ECO)
  - Watch Crystal Oscillator (WCO)
  - Phase-Locked Loop (PLL)
  - Frequency-Locked Loop (FLL)
- **Communication interfaces**
  - Up to eight CAN FD channels
    - Increased data rate (up to 8 Mbps) compared to classic CAN, limited by physical layer topology and transceivers
    - Compliant to ISO 11898-1:2015
    - Supports all the requirements of Bosch CAN FD Specification V1.0 for non-ISO CAN FD
    - ISO 16845:2015 certificate available
  - Up to eight runtime-reconfigurable SCB (serial communication block) channels, each configurable as I^2C, SPI, or UART
  - Up to 12 independent LIN channels
    - LIN protocol compliant with ISO 17987
  - Up to four CXPI channels with data rate up to 20 kbps
- **Timers**
  - Up to 75 16-bit and eight 32-bit timer/counter pulse-width modulator (TCPWM) blocks
    - Up to 12 16-bit counters for motor control
    - Up to 63 16-bit counters and eight 32-bit counters for regular operations
    - Supports timer, capture, quadrature decoding, pulse-width modulation (PWM), PWM with dead time (PWM_DT), pseudo-random PWM (PWM_PR), and shift-register (SR) modes
  - Up to 11 Event Generation (EVTGEN) timers supporting cyclic wakeup from DeepSleep
    - Events trigger a specific device operation (such as execution of an interrupt handler, a SAR ADC conversion, and so on)

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Features

- **Real time clock (RTC)**
  - Year/Month/Date, Day-of-week, Hour:Minute:Second fields
  - Supports both 12- and 24-hour formats
  - Automatic leap-year correction
- **I/O**
  - Up to 152 programmable I/Os
  - Two I/O types
    - GPIO Standard (GPIO_STD)
    - GPIO Enhanced (GPIO_ENH)
- **Regulators**
  - Generates 1.1-V nominal core supply from a 2.7-V to 5.5-V input supply
  - Two types of regulators
    - DeepSleep
    - Core internal
- **Programmable analog**
  - Three SAR A/D converters with up to 67 external channels (64 I/Os + 3 I/Os for motor control)
    - ADC0 supports 24 logical channels, with 24 + 1 physical connections
    - ADC1 supports 32 logical channels, with 32 + 1 physical connections
    - ADC2 supports 8 logical channels, with 8 + 1 physical connections
    - Any external channel can be connected to any logical channel in the respective SAR
  - Each ADC supports 12-bit resolution and sampling rates of up to 1 Msps
  - Each ADC also supports up to six internal analog inputs such as:
    - Bandgap reference to establish absolute voltage levels
    - Calibrated diode for junction temperature calculations
    - Two AMUXBUS inputs and two direct connections to monitor supply levels
  - Each ADC supports addressing of external multiplexers
  - Each ADC has a sequencer supporting autonomous scanning of configured channels
  - Synchronized sampling of all ADCs for motor-sense applications
- **Smart I/O**
  - Up to five Smart I/O blocks, which can perform Boolean operations on signals going to and from I/Os
  - Up to 36 I/Os (GPIO_STD) supported
- **Debug interface**
  - JTAG controller and interface compliant to IEEE-1149.1-2001
  - Arm® SWD (serial wire debug) port
  - Supports Arm® Embedded Trace Macrocell (ETM) Trace
    - Data trace using SWD
    - Instruction and data trace using JTAG
- **Compatible with industry-standard tools**
  - GHS/MULTI or IAR EWARM for code development and debugging
- **Packages**
  - 64-LQFP, 10 × 10 × 1.7 mm (max), 0.5-mm lead pitch
  - 80-LQFP, 12 × 12 × 1.7 mm (max). 0.5-mm lead pitch
  - 100-LQFP, 14 × 14 × 1.7 mm (max), 0.5-mm lead pitch
  - 144-LQFP, 20 × 20 × 1.7 mm (max), 0.5-mm lead pitch
  - 176-LQFP, 24 × 24 × 1.7 mm (max), 0.5-mm lead pitch

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1 Features list

Table 1-1 CYT2B9 feature list for all packages

Features	Package				
	64-LQFP	80-LQFP	100-LQFP	144-LQFP	176-LQFP
CPU					
Core	32-bit Arm® Cortex®-M4F CPU and 32-bit Arm® Cortex® M0+ CPU				
Functional safety	ASIL-B				
Operating voltage	2.7 V to 5.5 V				
Core voltage	1.05 V to 1.15 V				
Operating frequency	Arm® Cortex®-M4 160 MHz (max) and Arm® Cortex®-M0+ 100 MHz (max), related by integer frequency ratio (that is, 1:1, 1:2, 1:3, and so on)				
MPU, PPU	Supported				
FPU	Single precision (32-bit)				
DSP-MUL/DIV/MAC	Supported by Arm® Cortex®-M4F CPU				
Memory					
Code-flash	2112 KB (1984 KB + 128 KB)				
Work-flash	128 KB (96 KB + 32 KB)				
SRAM (configurable for retention)	256 KB				
ROM	32 KB				
Communication interfaces					
CAN0 (CAN FD: Up to 8 Mbps)	3 ch		4 ch		
CAN1 (CAN FD: Up to 8 Mbps)	2 ch	4 ch			
CAN RAM	32 KB per instance (4 ch), 64 KB in total				
Serial communication block (SCB/UART)	7 ch	8 ch			
Serial communication block (SCB/I^2C)	6 ch		8 ch		
Serial communication block (SCB/SPI)	3 ch	6 ch	8 ch		
LIN0	7 ch	9 ch		12 ch	
CXPI controller	2 ch	3 ch	4 ch		
Timers					
RTC	1 ch				
TCPWM (16-bit) (Motor Control)	12 ch				
TCPWM (16-bit)	63 ch				
TCPWM (32-bit)	8 ch				
External interrupts	49	63	78	122	152
Analog					
12-bit, 1 Msps SAR ADC	3 Units (SAR0/24, SAR1/32, SAR2/8 logical channels)				
	27 external channels (SAR0 11 ch, SAR1 9 ch, SAR2 7 ch)	34 external channels (SAR0 12 ch, SAR1 14 ch, SAR2 8 ch)	39 external channels (SAR0 14 ch, SAR1 17 ch, SAR2 8 ch)	54 external channels (SAR0 21 ch, SAR1 25 ch, SAR2 8 ch)	64 external channels (SAR0 24 ch, SAR1 32 ch, SAR2 8 ch)
	18 ch (6 per ADC) Internal sampling				

Note
3. Enhanced Secure Hardware Extension (eSHE) and Hardware Security Module (HSM) support are enabled by third-party firmware.

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Table 1-1 CYT2B9 feature list for all packages *(continued)*

Features	Package				
	64-LQFP	80-LQFP	100-LQFP	144-LQFP	176-LQFP
Motor control input	3 ch (synchronous sampling of one channel on each of the 3 ADCs)				
Security					
Flash Security (program/work read protection)	Supported				
Flash Chip erase enable	Configurable				
eSHE/HSM	By separate firmware[3]				
System					
DMA controller	P-DMA0 with 92 channels (16 general purpose), P-DMA1 with 44 channels (8 general purpose), and M-DMA0 with 4 channels				
Internal main oscillator	8 MHz				
Internal low-speed oscillator	32.768 kHz (nominal)				
PLL	Input frequency: 3.988 to 33.34 MHz, PLL output frequency: up to 160 MHz				
FLL	Input frequency: 0.25 to 80 MHz, FLL output frequency: up to 100 MHz				
Watchdog timer and multi-counter Watchdog timer	Supported				
Clock supervisor	Supported				
Cyclic wakeup	Supported				
GPIO_STD	45	59	74	118	148
GPIO_ENH	4				
Smart I/O (Blocks)	3 blocks, 9 I/Os	3 blocks, 14 I/Os	4 blocks, 20 I/Os	5 blocks, 29 I/Os	5 blocks, 36 I/Os
Low-voltage detect	Two, 26 selectable levels				
Maximum ambient temperature	105 °C for S-grade and 125 °C for E-grade				
Debug interface	SWD/JTAG				
Debug trace	Arm® Cortex®-M4 ETB size of 8 KB, Arm® Cortex® M0+ MTB size of 4 KB				

1.1 Communication peripheral instance list

The following table lists the instances supported under each package for communication peripherals, based on the minimum pins needed for the functionality.

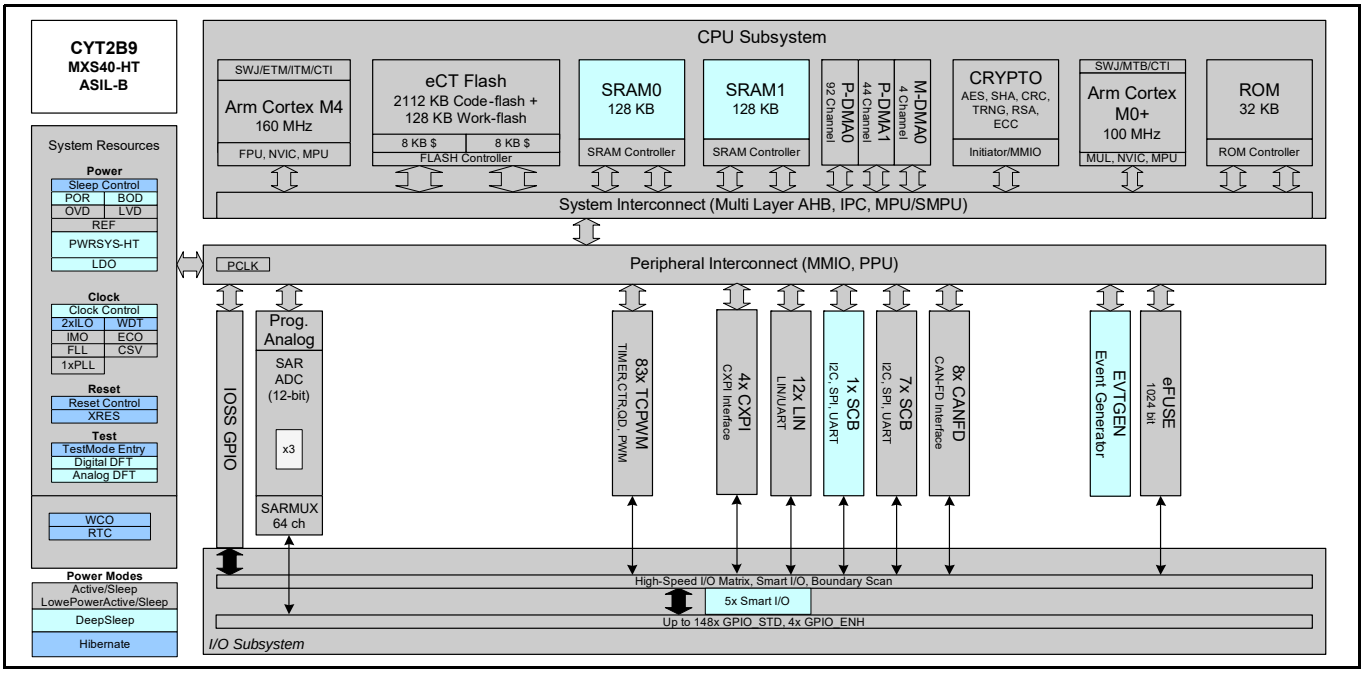
Table 1 Peripheral instance list

Module	64-LQFP	80-LQFP	100-LQFP	144-LQFP	176-LQFP	Minimum pin functions
CXPI	0/1	0/1/2	0/1/2/3	0/1/2/3	0/1/2/3	TX, RX
CAN0	0/1/2	0/1/2	0/1/2/3	0/1/2/3	0/1/2/3	TX, RX
CAN1	0/2	0/1/2/3	0/1/2/3	0/1/2/3	0/1/2/3	TX, RX
LIN0	0/1/2/3/4/7/9	0/1/2/3/4/6/7/8/9	0/1/2/3/4/6/7/8/9	0/1/2/3/4/5/6/7/8/9/10/11	0/1/2/3/4/5/6/7/8/9/10/11	TX, RX
SCB/UART	0/1/2/3/4/5/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	TX, RX
SCB/I^2C	0/2/3/4/5/7	0/1/3/4/5/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	SCL, SDA
SCB/SPI	0/3/4	0/1/3/4/5/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	0/1/2/3/4/5/6/7	MISO, MOSI, SCK, SELECT0

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2 Blocks and functionality

Block diagram



The **Block diagram** shows the CYT2B9 architecture, giving a simplified view of the interconnection between subsystems and blocks. CYT2B9 has four major subsystems: CPU, system resources, peripherals, and I/O[4, 5]. The color-coding shows the lowest power mode where the particular block is still functional.

CYT2B9 provides extensive support for programming, testing, debugging, and tracing of both hardware and firmware.

Debug-on-chip functionality enables in-system debugging using the production device. It does not require special interfaces, debugging pods, simulators, or emulators.

The JTAG interface is fully compatible with industry-standard third-party probes such as I-jet, J-Link, and GHS.

The debug circuits are enabled by default.

CYT2B9 provides a high level of security with robust flash protection and the ability to disable features such as debug.

Additionally, each device interface can be permanently disabled for applications concerned with phishing attacks from a maliciously reprogrammed device or attempts to defeat security by starting and interrupting flash programming sequences. All programming, debug, and test interfaces are disabled when maximum device security is enabled.

Notes
4. GPIO_STD supporting 2.7 V to 5.5 V V_{DDIO} range.
5. GPIO_ENH supporting 2.7 V to 5.5 V V_{DDIO} range with higher currents at lower voltages.

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3 Functional description

3.1 CPU subsystem

3.1.1 CPU

The CYT2B9 CPU subsystem contains a 32-bit Arm® Cortex®-M0+ CPU with MPU, and a 32-bit Arm® Cortex®-M4F CPU with MPU, and single-precision FPU. This subsystem also includes P-/M-DMA controllers, a cryptographic accelerator, 2112 KB of code-flash, 128 KB of work-flash, 256 KB of SRAM, and 32 KB of ROM.

The Cortex-M0+ CPU provides a secure, un-interruptible boot function. This guarantees that, following completion of the boot function, system integrity is valid and privileges are enforced. Shared resources (flash, SRAM, peripherals, and so on) can be accessed through bus arbitration, and exclusive accesses are supported by an inter-processor communication (IPC) mechanism using hardware semaphores.

3.1.2 DMA controllers

CYT2B9 has three DMA controllers: P-DMA0 with 16 general-purpose and 76 dedicated channels, P-DMA1 with 8 general-purpose and 36 dedicated channels, and M-DMA0 with four channels. P-DMA is used for peripheral-to-memory and memory-to-peripheral data transfers and provides low latency for a large number of channels. Each P-DMA controller uses a single data-transfer engine that is shared by the associated channels. General-purpose channels have a rich interconnect matrix including P-DMA cross-triggering, which enables demanding data-transfer scenarios. Dedicated channels have a single triggering input (such as an ADC channel) to handle common transfer needs. M-DMA is used for memory-to-memory data transfers and provides high memory bandwidth for a small number of channels. M-DMA uses a dedicated data-transfer engine for each channel. They support independent accesses to peripherals using the AHB multi-layer bus.

3.1.3 Flash

CYT2B9 has 2112 KB (1984 KB with a 32-KB sector size, and 128 KB with an 8-KB sector size) of code-flash with an additional work-flash of up to 128 KB (96 KB with 2-KB sector size, and 32 KB with 128-B sectors size). Work-flash is optimized for reprogramming many more times than code-flash. Code-flash supports Read-While-Write (RWW) operation allowing flash to be updated while the CPU is active. Both the code-flash and work-flash areas support dual-bank operation for over-the-air (OTA) programming.

3.1.4 SRAM

CYT2B9 has 256 KB of SRAM with two independent controllers. The first controller SRAM0 provides DeepSleep retention in 32-KB increments while SRAM1 is selectable between fully retained and not retained.

3.1.5 ROM

CYT2B9 has 32-KB ROM that contains boot and configuration routines. This ROM enables secure boot and authentication of user flash to guarantee a secure system.

3.1.6 Cryptography accelerator for security

The cryptography accelerator implements (3)DES block cipher, AES block cipher, SHA hash, cyclic redundancy check, pseudo random number generation, true random number generation, galois/counter mode, and a vector unit to support asymmetric key cryptography such as RSA and ECC.

Depending on the part number, this block is either completely or partially available or not available at all. See **Ordering Information** for more details.

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3.2 System resources

3.2.1 Power system

The power system ensures that the supply voltage levels meet the requirements of each power mode, and provides a full-system reset when these levels are not valid. Internal power-on reset (POR) guarantees full-chip reset during the initial power ramp.

Three BOD circuits monitor the external supply voltages (V_{DDD}, V_{DDA}, V_{CCD}). The BOD on V_{DDD} and V_{CCD} are initially enabled and cannot be disabled. The BOD on V_{DDA} is initially disabled and can be enabled by the user. For the external supplies V_{DDD} and V_{DDA}, BOD circuits are software configurable with two settings; a 2.7-V minimum voltage that is robust for all internal signaling and a 3.0-V minimum voltage, which is also robust for all I/O specifications (which are guaranteed at 2.7 V). The BOD on V_{CCD} is provided as a safety measure and is not a robust detector.

Three OVD circuits are provided for monitoring external supplies (V_{DDD}, V_{DDA}, V_{CCD}), and overcurrent detection circuits (OCD) for monitoring internal and external regulators. OVD thresholds on V_{DDD} and V_{DDA} are configurable with two settings; a 5.0-V and 5.5-V maximum voltage.

Two voltage detection circuits are provided to monitor the external supply voltage (V_{DDD}) for falling and rising levels, each configurable for one of the 26 selectable levels.

All BOD, OVD, and OCD circuits on V_{DDD} and V_{CCD} generate a reset, because these protect the CPUs and fault logic. The BOD and OVD circuits on V_{DDA} can be configured to generate either a reset, or a fault.

3.2.2 Regulators

CYT2B9 contains two regulators that provide power to the low-voltage core transistors: DeepSleep and core internal. These regulators accept a 2.7–5.5-V V_{DDD} supply and provide a low-noise 1.1-V supply to various parts of the device. These regulators are automatically enabled and disabled by hardware and firmware when switching between power modes. The core internal regulators operate in Active mode, and provide power to the CPU subsystem and associated peripherals.

3.2.2.1 DeepSleep

The DeepSleep regulator is used to maintain power to a small number of blocks when in DeepSleep mode. These blocks include the ILO and WDT timers, BOD detector, SCB0, SRAM memories, Smart I/O, and other configuration memories. The DeepSleep regulator is enabled when in DeepSleep mode, and the core internal regulator is disabled. It is disabled when XRES_L is asserted (LOW) and when the core internal regulator is disabled.

3.2.2.2 Core internal

The core internal regulator supports load currents up to 150 mA, and is operational during device startup (boot process), and in Active/Sleep modes.

3.2.3 Clock system

The CYT2B9 clock system provides clocks to all subsystems that require them, and glitch-free switching between different clock sources. In addition, the clock system ensures that no metastable conditions occur.

The clock system for CYT2B9 consists of the 8-MHz IMO, two ILOs, three watchdog timers, a PLL, an FLL, five clock supervisors (CSV), a 3.988- to 33.34-MHz ECO, and a 32.768-kHz WCO.

The clock system supports two main clock domains: CLK_HF and CLK_LF.

- CLK_HFx are the active domain clocks. Each can use any of the high-frequency clock sources including IMO, EXT_CLK, ECO, FLL, or PLL.
- CLK_LF is a DeepSleep domain clock and provides source for MCWDT or RTC modules. The reference clock for the CLK_LF domain is selectable from ILO0, ILO1, WCO, or disabled.

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Table 3-1 CLK_HF destinations

Name	Description
CLK_HF0	CPUSS clocks, PERI, and AHB infrastructure
CLK_HF1	Event Generator, also available in HSIOM as an output

3.2.3.1 IMO clock source

The IMO is the frequency reference in CYT2B9 when no external reference is available or enabled. The IMO operates at a frequency of around 8 MHz.

3.2.3.2 ILO clock source

An ILO is a low-power oscillator, nominally 32.768 kHz, which generates clocks for a watchdog timer when in DeepSleep mode. There are two ILOs to ensure CSV (clock supervisor) capability in DeepSleep mode. ILO-driven counters can be calibrated to the IMO, WCO, or ECO to improve their accuracy. ILO1 is also used for clock supervision.

3.2.3.3 PLL and FLL

A PLL or FLL may be used to generate high-speed clocks from the IMO, the ECO, or EXT_CLK. The FLL provides a much faster lock than the PLL (5 µs instead of 35 µs) in exchange for a small amount (±2%) of frequency error[6].

3.2.3.4 Clock supervisor

Each clock supervisor (CSV) allows one clock (reference) to supervise the behavior of another clock (monitored). Each CSV has counters for both the monitored and reference clocks. Parameters for each counter determine the frequency of the reference clock as well as the upper and lower frequency limits of the monitored clock. If the frequency range comparator detects a stopped clock or a clock outside the specified frequency range, an abnormal state is signaled and either a reset or an interrupt is generated.

3.2.3.5 EXT_CLK

One of two GPIO_STD I/Os can be used to provide an external clock input of up to 80 MHz. This clock can be used as the source clock for either the PLL or FLL, or can be used directly by the CLK_HF domain.

3.2.3.6 ECO

The ECO provides high-frequency clocking using an external crystal connected to the ECO_IN and ECO_OUT pins. It supports fundamental mode (non-overtone) quartz crystals, in the range of 3.988 to 33.34 MHz. When used in conjunction with the PLL, it generates CPU and peripheral clocks up to device's maximum frequency. ECO accuracy depends on the selected crystal. If the ECO is disabled, the associated pins can be used for any of the available I/O functions.

3.2.3.7 WCO

The WCO is a low-power, watch-crystal oscillator intended for real-time-clock applications. It requires an external 32.768-kHz crystal connected to the WCO_IN and WCO_OUT pins. The WCO can also be configured as a clock reference for CLK_LF, which is the clock source for the MCWDT and RTC.

Note
6. Operation of reference-timed peripherals (like a UART) with an FLL-based reference is not recommended due the allowed frequency error.

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3.2.4 Reset

CYT2B9 can be reset from a variety of sources, including software. Reset events are asynchronous and guarantee reversion to a known state. The reset cause (POR, BOD, OVD, overcurrent, XRES_L, WDT, MCWDT, software reset, fault, CSV, Hibernate wakeup, debug) is recorded in a register, which is sticky through reset and allows software to determine the cause of the reset. An XRES_L pin is available for external reset.

3.2.5 Watchdog timers

CYT2B9 has one watchdog timer (WDT) and two multi-counter watchdog timers (MCWDT).

The WDT is a free-running counter clocked only by ILO0, which allows it to be used as a wakeup source from Hibernate. This allows watchdog operation during all power modes and needs to be serviced during a configured window, otherwise generates a watchdog reset, if not serviced before the timeout occurs. A watchdog reset is recorded in the Reset Cause register.

An MCWDT is available for each of the CPU cores. These timers provide more capabilities than the WDT, and are only available in the Active, Sleep, and DeepSleep modes. These timers have multiple counters that can be used separately or cascaded to trigger interrupts and/or resets. They are clocked from ILO0 or the WCO.

3.2.6 Power modes

CYT2B9 has six different power modes:

- Active – All peripherals are available
- Low-Power Active (LPACTIVE) – Low-power profile of Active mode where all peripherals and the CPUs are available, but with limited capability
- Sleep – All peripherals except the CPUs are available
- Low-Power Sleep (LPSLEEP) – Low-power profile of Sleep mode where all peripherals except the CPUs are available, but with limited capability
- DeepSleep – Only peripherals which work with CLK_LF are available
- Hibernate – the device and I/O states are frozen, the device resets on wakeup

3.3 Peripherals

3.3.1 Peripheral clock dividers

Integer and fractional clock dividers are provided for peripheral and timing purposes.

Table 3-1 Clock dividers

Divider	Count	Description
div_8	32	Integer divider, 8 bits
div_16	16	Integer divider, 16 bits
div_24_5	8	Fractional divider, 24.5 bits (24 integer bits, 5 fractional bits)

3.3.2 Peripheral protection unit

The Peripheral Protection Unit (PPU) controls and monitors unauthorized access from all masters (CPU, P-/M-DMA, Crypto, and any enabled debug interface) to the peripherals. It allows or restricts data transfers on the bus infrastructure. The access rules are enforced based on specific properties of a transfer, such as an address range for the transfer and access attributes (such as read/write, user/privilege, and secure/non-secure).

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3.3.3 12-bit SAR ADC

CYT2B9 contains three 1-Msps SAR ADCs. These ADCs can be clocked at up to 26.67 MHz and provide a 12-bit result in 26 clock cycles.

The references for all three SAR ADCs comes from a dedicated pair of inputs: VREFH and VREFL[7].

CYT2B9 devices support up to 85 logical ADC channels, and external inputs from up to 67 I/Os. Each ADC also supports six internal connections for diagnostic and monitoring purposes. The number of ADC channels (per ADC and package type) are listed in **Table 1-1**.

Each ADC has a sequencer, which autonomously cycles through the configured channels (sequencer scan) with zero-switching overhead (that is, the aggregate sampling bandwidth, when clocked at 26.67 MHz, is equal to 1 Msps whether it is for a single channel or distributed over several channels). The sequencer switching is controlled through a state machine or firmware. The sequencer prioritizes trigger requests, enables the appropriate analog channel, controls ADC sampling, initiates ADC data conversion, manages results, and initiates subsequent conversions for repetitive or group conversions without CPU intervention.

Each SAR ADC has an analog multiplexer used to connect the signals to be measured to the ADC. It has 32 GPIO_STD inputs, one special GPIO_STD input for motor-sense, and six additional inputs to measure internal signals such as a band-gap reference, a temperature sensor, and power supplies. The device supports synchronous sampling of one motor-sense channel on each of the three ADCs.

CYT2B9 has one temperature sensor that is shared by all three ADCs. The temperature sensor must only be sampled by one ADC at a time. Software post processing is required to convert the temperature sensor reading into kelvin or Celsius values.

To accommodate signals with varying source impedances and frequencies, it is possible to have different sample times programmed for each channel. Each ADC also supports range comparison, which allows fast detection of out-of-range values without having to wait for a sequencer scan to complete and for the CPU firmware to evaluate the measurement for out-of-range values.

The ADCs are not usable in DeepSleep and Hibernate modes as they require a high-speed clock. The ADC input reference voltage VREFH range is 2.7 V to V_{DDA} and VREFL is V_{SSA}.

3.3.4 Timer/counter/PWM block (TCPWM)

The TCPWM block consists of 16-bit (75 channels) and 32-bit (eight channels) counters with user-programmable period. Twelve of the 16-bit counters include extra features to support motor control operations. Each TCPWM counter contains a capture register to record the count at the time of an event, a period register (used to either stop or auto-reload the counter when its count is equal to the period register), and compare registers to generate signals that are used as PWM duty-cycle outputs.

Each counter within the TCPWM block supports several functional modes such as timer, capture, quadrature, PWM, PWM with dead-time insertion (PWM_DT, 8-bit), pseudo-random PWM (PWM_PR), and shift-register.

In motor-control applications, the counter within the TCPWM block supports enhanced quadrature mode with features such as asymmetric PWM generation, dead-time insertion (16-bit), and association of different dead times for PWM output signals.

The TCPWM block also provides true and complement outputs, with programmable offset between them, to allow their use as deadband complementary PWM outputs. The TCPWM block also has a kill input (only for the PWM mode) to force outputs to a predetermined state; for example, this may be used in motor-drive systems when an overcurrent state is detected and the PWMs driving the FETs need to be shut off immediately (no time for software intervention).

Note
7. VREF_L prevents IR drops in the VSSIO and VSSA paths from impacting the measurements. VREF_L, when properly connected, reduces or removes the impact of IR drops in the VSSIO and VSSA paths from measurements.

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3.3.5 Serial communication blocks (SCB)

CYT2B9 contains eight serial communication blocks, each configurable to support I^2C, UART, or SPI.

- *I^2C interface*

  An SCB can be configured to implement a full I^2C master (capable of multi-master arbitration) or slave interface. Each SCB configured for I^2C can operate at speeds of up to 1 Mbps (Fast-mode Plus[8]) and has flexible buffering options to reduce the interrupt overhead and latency of the CPU. In addition, each SCB supports FIFO buffering for receive and transmit data, which, by increasing the time for the CPU to read the data, reduces the need for clock stretching. The I^2C interface is compatible with Standard, Fast-mode, and Fast-mode Plus devices as specified in the NXP I^2C-bus specification and user manual (UM10204). The I^2C-bus I/O is implemented with GPIO in open-drain modes[9, 10].

- *UART interface*

  When configured as a UART, each SCB provides a full-featured UART with maximum signaling rate determined by the configured peripheral-clock frequency and over-sampling rate. It supports infrared interface (IrDA) and SmartCard (ISO 7816) protocols, which are minor variants of the UART protocol. It also supports the 9-bit multiprocessor mode that allows the addressing of peripherals connected over common Rx and Tx lines. Common UART functions such as parity, number of stop bits, break detect, and frame error are supported. FIFO buffering of transmit and receive data allows greater CPU service latencies to be tolerated.

  The LIN protocol is supported by the UART. LIN is based on a single-master multi-slave topology. There is one master node and multiple slave nodes on the LIN bus. The SCB UART supports only LIN slave functionality. Compared to the dedicated LIN blocks, an SCB/UART used for LIN requires a higher level of software interaction and increased CPU load.

- SPI interface

  The SPI configuration supports full Motorola SPI, TI Synchronous Serial Protocol (SSP, essentially adds a start pulse that is used to synchronize SPI-based codecs), and National Microwire (a half-duplex form of SPI). The SPI interface can use the FIFO. The SPI interface operates with up to a 12.5-MHz SPI Clock. SCB also supports EZSPI[11] mode.

SCB0 supports the following additional features:

- Operable as a slave in DeepSleep mode
- I^2C slave EZ (EZI2C[12]) mode with up to 256-B data buffer for multi-byte communication without CPU intervention
- I^2C slave externally-clocked operations
- Command/response mode with a 512-B data buffer for multi-byte communication without CPU intervention

3.3.6 CAN FD

CYT2B9 supports two CAN FD controller blocks, each supporting four CAN FD channel. All CAN FD controllers are compliant with the ISO 11898-1:2015 standard; an ISO 16845:2015 certificate is available. It also implements the time-triggered CAN (TTCAN) protocol specified in ISO 11898-4 (TTCAN protocol levels 1 and 2) completely in hardware. All functions concerning the handling of messages are implemented by the Rx and Tx handlers. The Rx handler manages message acceptance filtering, transfer of received messages from the CAN core to a message RAM, and provides receive-message status. The Tx handler is responsible for the transfer of transmit messages from the message RAM, to the CAN core, and provides transmit-message status.

Notes

8. I/Os drive level does not support the full bus capacitance in Fast-mode Plus speeds.
9. This is not 100 percent compliant with the I^2C-bus specification; I/Os are not high-voltage compliant, do not support the 20-mA sink requirement of Fast-mode Plus, and violate the leakage specification when no power is applied.
10. Only Port 0 with the slow feature enabled meets the minimum fall time requirement.
11. The Easy SPI (EZSPI) protocol is based on the Motorola SPI operating in any mode (0, 1, 2, or 3). It allows communication between master and slave, and reduces the need for CPU intervention.
12. The Easy I^2C (EZI2C) protocol is a unique communication scheme built on top of the I^2C protocol by Cypress. It uses a meta protocol around the standard I^2C protocol to communicate to an I^2C slave using indexed memory transfers. This reduces the need for CPU intervention.

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3.3.7 Local interconnect network (LIN)

CYT2B9 contains up to 12 LIN channels. Each channel supports transmission/reception of data following the LIN protocol according to ISO standard 17987. Each LIN channel connects to an external transceiver through a 3-pin interface (including an enable function) and supports master and slave functionality. Each channel also supports classic and enhanced checksum, along with break detection during message reception and wake-up signaling. Break detection, sync field, checksum calculations, and error interrupts are handled in hardware.

3.3.8 Clock extension peripheral interface (CXPI)

CYT2B9 contains up to four CXPI channels compliant with JASO D015 and ISO standard 20794 including the controller specification.

Each channel supports:

- Master and slave functionality
- Polling and event trigger method for both normal and long frames
- Non-return to zero (NRZ) and PWM signaling modes
- Collision resolution and carries sense multiple access
- Wakeup pulse generation and detection
- CRC8 and CRC16 for both normal and long frames
- Error detection
- Dedicated FIFO (16 B) for transmit and receive

3.3.9 One-time-programmable (OTP) eFuse

CYT2B9 devices contain a 1024-bit OTP eFuse memory that can be used to store and access a unique and unalterable identifier or serial number for each device. eFuses are also used to control the device life-cycle (manufacturing, programming, normal operation, end-of-life, and so on) and the security state. Of the 1024 bits, 192 are available for user purposes.

3.3.10 Event generator

The event generator supports generation of interrupts and triggers in the Active mode and interrupts in the DeepSleep mode. The event generators are used to trigger a specific device function (execution of an interrupt handler, a SAR ADC conversion, and so on) and to provide a cyclic wakeup mechanism from the DeepSleep mode. They provide CPU-free triggers for device functions, and reduce CPU involvement in triggering device functions, thus reducing overall power consumption and processing overhead.

3.3.11 Trigger multiplexer

CYT2B9 supports connecting various peripherals using trigger signals. Triggers are used to inform a peripheral of the occurrence of an event or change of state. These triggers are used to affect or initiate some action in other peripherals. The trigger multiplexer is used to route triggers from a source peripheral to a destination. Triggers provide active logic functionality and are typically supported in the Active mode.

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3.4 I/Os

CYT2B9 has up to 152 programmable I/Os.

The I/Os are organized as logical entities called ports, which are a maximum of 8 bits wide. During power-on, and reset, the I/Os are forced to the High-Z state. During the Hibernate mode, I/Os are frozen.

Every I/O can generate an interrupt (if enabled) and each port has an interrupt request (IRQ) and interrupt service routine (ISR) associated with it.

The I/O port power source mapping is listed in **Table 3-2**. The associated supply determines the V_{OH}, V_{OL}, V_{IH}, and V_{IL} levels when configured for CMOS and Automotive thresholds.

Table 3-2 I/O port power source

Supply	Ports
VDDD	P0, P1, P2, P3, P4, P5, P16, P17, P18, P19, P20, P21, P22, P23
VDDIO_1	P6, P7, P8, P9[13]
VDDIO_2	P10, P11, P12, P13, P14, P15

3.4.1 Port nomenclature

Px.y describes a particular bit “y” available within an I/O port “x.”

For example, P4.2 reads “port 4, bit 2”.

Each I/O implements the following:

- Programmable drive mode
  - High impedance
  - Resistive pull-up
  - Resistive pull-down
  - Open drain with strong pull-down
  - Open drain with strong pull-up
  - Strong pull-up or pull-down
  - Weak pull-up or pull-down

CYT2B9 has two types of programmable I/Os: GPIO Standard and GPIO Enhanced.

3.4.2 GPIO Standard (GPIO_STD)

Supports standard automotive signaling across the 2.7-V to 5.5-V V_{DDIO} range. GPIO Standard I/Os have multiple configurable drive levels, drive modes, and selectable input levels.

3.4.3 GPIO Enhanced (GPIO_ENH)

Supports extended functionality automotive signaling across the 2.7-V to 5.5-V V_{DDIO} range with higher currents at lower voltages (full I^2C timing support, slew-rate control).

Both GPIO_STD and GPIO_ENH implement the following:

- Configurable input threshold (CMOS, TTL, or Automotive)
- Hold mode for latching previous state (used for retaining the I/O state in DeepSleep mode)
- Analog input mode (input and output buffers disabled)

Note
13.The I/Os in VDDIO_1 domain refer to the VDDD domain in 64-LQFP package.

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3.4.4 Smart I/O

Smart I/O allows Boolean operations on signals going to the I/O from the subsystems of the chip or on signals coming into the chip. CYT2B9 has five Smart I/O blocks. Operation can be synchronous or asynchronous and the blocks operate in all device power modes except for the Hibernate mode.

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4 CYT2B9 address map

The CYT2B9 microcontroller supports the memory spaces shown in **Figure 4-1**:

- 2112 KB (1984 KB + 128 KB) of code-flash, used in the single- or dual-bank mode based on the associated bit in the flash control register
  - Single-bank mode - 2112 KB
  - Dual-bank mode - 1056 KB per bank
- 128 KB (96 KB + 32 KB) of work-flash, used in the single- or dual-bank mode based on the associated bit in the flash control register
  - Single-bank mode - 128 KB
  - Dual-bank mode - 64 KB per bank
- 32 KB of secure ROM
- 256 KB of SRAM (First 2 KB is reserved for internal usage)

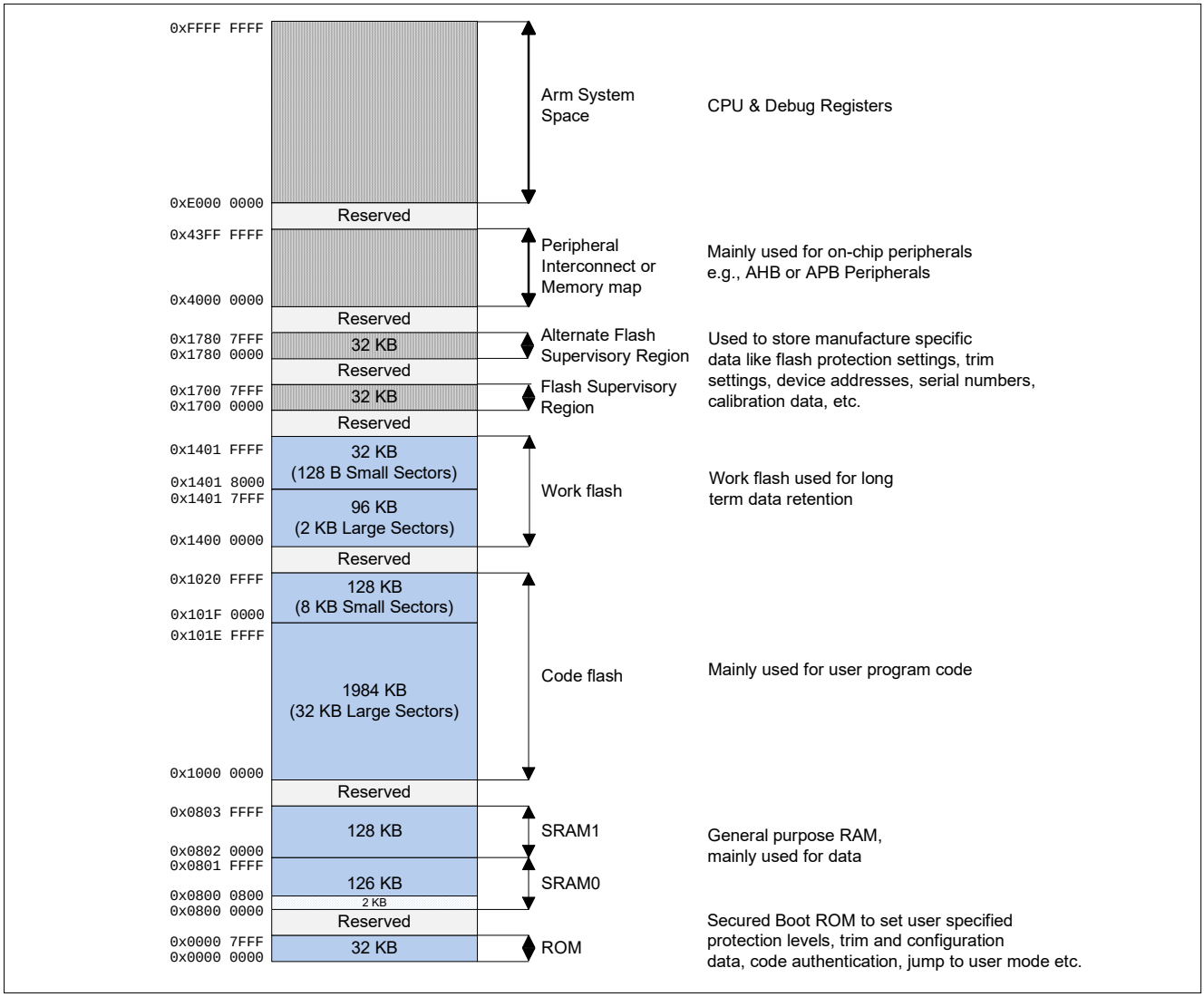


Figure 4-1 CYT2B9 address map[14, 15]

Notes
14. The size representation is not up to scale.
15. First 2KB of SRAM is reserved, not available for users. User must keep the power of first 32KB block of SRAM0 in enabled or retained in all Active, LP Active, Sleep, LP Sleep, DeepSleep modes.

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5 Flash base address map

Table 5-1 through Table 5-6 give information about the sector mapping of the code- and work-flash regions along with their respective base addresses.

Table 5-1 Code-flash Address Mapping in Single Bank Mode

Code-flash Size (KB)	Large Sectors (LS)	Small Sectors (SS)	Large Sector Base Address	Small Sector Base Address
2112	32 KB × 62	8 KB × 16	0x1000 0000	0x101F 0000

Table 5-2 Work-flash Address Mapping in Single Bank Mode

Work-flash Size (KB)	Large Sectors	Small Sectors	Large Sector Base Address	Small Sector Base Address
128	2 KB × 48	128 B × 256	0x1400 0000	0x1401 8000

Table 5-3 Code-flash Address Mapping in Dual Bank Mode (Mapping A)

Code-flash Size (KB)	First Half LS	First Half SS	Second Half LS	Second Half SS	First Half LS Base Address	First Half SS Base Address	Second Half LS Base Address	Second Half SS Base Address
2112	32 KB × 31	8KB × 8	32 KB × 31	8 KB × 8	0x1000 0000	0x100F 8000	0x1200 0000	0x120F 8000

Table 5-4 Code-flash Address Mapping in Dual Bank Mode (Mapping B)

Code-flash Size (KB)	First Half LS	First Half SS	Second Half LS	Second Half SS	First Half LS Base Address	First Half SS Base Address	Second Half LS Base Address	Second Half SS Base Address
2112	32 KB × 31	8 KB × 8	32 KB × 31	8 KB × 8	0x1200 0000	0x120F 8000	0x1000 0000	0x100F 8000

Table 5-5 Work-flash Address Mapping in Dual Bank Mode (Mapping A)

Work-flash Size (KB)	First Half LS	First Half SS	Second Half LS	Second Half SS	First Half LS Base Address	First Half SS Base Address	Second Half LS Base Address	Second Half SS Base Address
128	2 KB × 24	128 B × 128	2 KB × 24	128 B × 128	0x1400 0000	0x1400 C000	0x1500 0000	0x1500 C000

Table 5-6 Work-flash Address Mapping in Dual Bank Mode (Mapping B)

Work-flash Size (KB)	First Half LS	First Half SS	Second Half LS	Second Half SS	First Half LS Base Address	First Half SS Base Address	Second Half LS Base Address	Second Half SS Base Address
128	2 KB × 24	128 B × 128	2 KB × 24	128 B × 128	0x1500 0000	0x1500 C000	0x1400 0000	0x1400 C000

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6 Peripheral I/O map

Table 6-1 CYT2B9 Peripheral I/O Map

Section	Description	Base Address	Instances	Instance Size	Group	Slave
PERI	Peripheral interconnect	0x4000 0000			0	0
	Peripheral group (0, 1, 2, 3, 5, 6, 9)	0x4000 4000	7	0x20		
	Peripheral trigger group	0x4000 8000	11	0x400		
	Peripheral 1:1 trigger group	0x4000 C000	11	0x400		
PERI_MS	Peripheral interconnect, master interface	0x4001 0000			0	1
	PERI Programmable PPU	0x4001 0000	6[16]	0x40		
	PERI Fixed PPU	0x4001 0800	487	0x40		
Crypto	Cryptography component	0x4010 0000			1	0
CPUSS	CPU subsystem (CPUSS)	0x4020 0000			2	0
FAULT	Fault structure subsystem	0x4021 0000			2	1
	Fault structures	0x4021 0000	4	0x100		
IPC	Inter process communication	0x4022 0000			2	2
	IPC structures	0x4022 0000	8	0x20		
	IPC interrupt structures	0x4022 1000	8	0x20		
PROT	Protection	0x4023 0000			2	3
	Shared memory protection unit structures	0x4023 2000	16	0x40		
	Memory protection unit structures	0x4023 4000	16	0x400		
FLASHC	Flash controller	0x4024 0000			2	4
SRSS	System Resources Sub-System Core Registers	0x4026 0000			2	5
	Clock Supervision High Frequency	0x4026 1400	3	0x10		
	Clock Supervision Reference Frequency	0x4026 1710	1			
	Clock Supervision Low Frequency	0x4026 1720	1			
	Clock Supervision Internal Low Frequency	0x4026 1730	1			
	Multi Counter WDT	0x4026 8000	2	0x100		
	Free Running WDT	0x4026 C000	1			
BACKUP	SRSS Backup Domain/RTC	0x4027 0000			2	6
	Backup Register	0x4027 1000	4	0x04		
P-DMA	P-DMA0 Controller	0x4028 0000			2	7
	P-DMA0 channel structures	0x4028 8000	92	0x40		
	P-DMA1 Controller	0x4029 0000			2	8
	P-DMA1 channel structures	0x4029 8000	44	0x40		
M-DMA	M-DMA0 Controller	0x402A 0000			2	9
	M-DMA0 channels	0x402A 1000	4	0x100		
eFUSE	eFUSE Customer Data (192 bits)	0x402C 0868	6	0x04	2	10
HSIOM	High-Speed I/O Matrix (HSIOM)	0x4030 0000	24	0x10	3	0
GPIO	GPIO port control/configuration	0x4031 0000	24	0x80	3	1

Note
16. These six Programmable PPUs are configured by the Boot ROM and are available for the user based on the access rights. Refer to the device specific TRM to know more about the configuration of these programmable PPUs.

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Table 6-1 CYT2B9 Peripheral I/O Map *(continued)*

Section	Description	Base Address	Instances	Instance Size	Group	Slave
SMARTIO	Programmable I/O configuration	0x4032 0000			3	2
	SMART I/O port configuration	0x4032 0C00	5	0x100		
TCPWM	Timer/Counter/PWM 0 (TCPWM0)	0x4038 0000			3	3
	TCPWM0 Group #0 (16-bit)	0x4038 0000	63	0x80		
	TCPWM0 Group #1 (16-bit, Motor control)	0x4038 8000	12	0x80		
	TCPWM0 Group #2 (32-bit)	0x4039 0000	4	0x80		
EVTGEN	Event generator 0 (EVTGEN0)	0x403F 0000			3	4
	Event generator 0 comparator structures	0x403F 0800	11	0x20		
LIN	Local Interconnect Network 0 (LIN0)	0x4050 0000			5	0
	LIN0 Channels	0x4050 8000	12	0x100		
CXPI	Clock Extension Peripheral Interface 0 (CXPI0)	0x4051 0000			5	1
	CXPI0 Channels	0x4051 8000	4	0x100		
TTCANFD	CAN0 controller	0x4052 0000	4	0x200	5	2
	Message RAM CAN0	0x4053 0000		0x7FFF		
	CAN1 controller	0x4054 0000	4	0x200	5	3
	Message RAM CAN1	0x4055 0000		0x7FFF		
SCB	Serial Communications Block (SPI/UART/I^2C)	0x4060 0000	8	0x10000	6	0-7
SAR PASS	Programmable Analog Subsystem (PASS0)	0x4090 0000			9	0
	SAR0 channel controller	0x4090 0000				
	SAR1 channel controller	0x4090 1000				
	SAR2 channel controller	0x4090 2000				
	SAR0 channel structures	0x4090 0800	24	0x40		
	SAR1 channel structures	0x4090 1800	32	0x40		
	SAR2 channel structures	0x4090 2800	8	0x40		

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7 CYT2B9 clock diagram

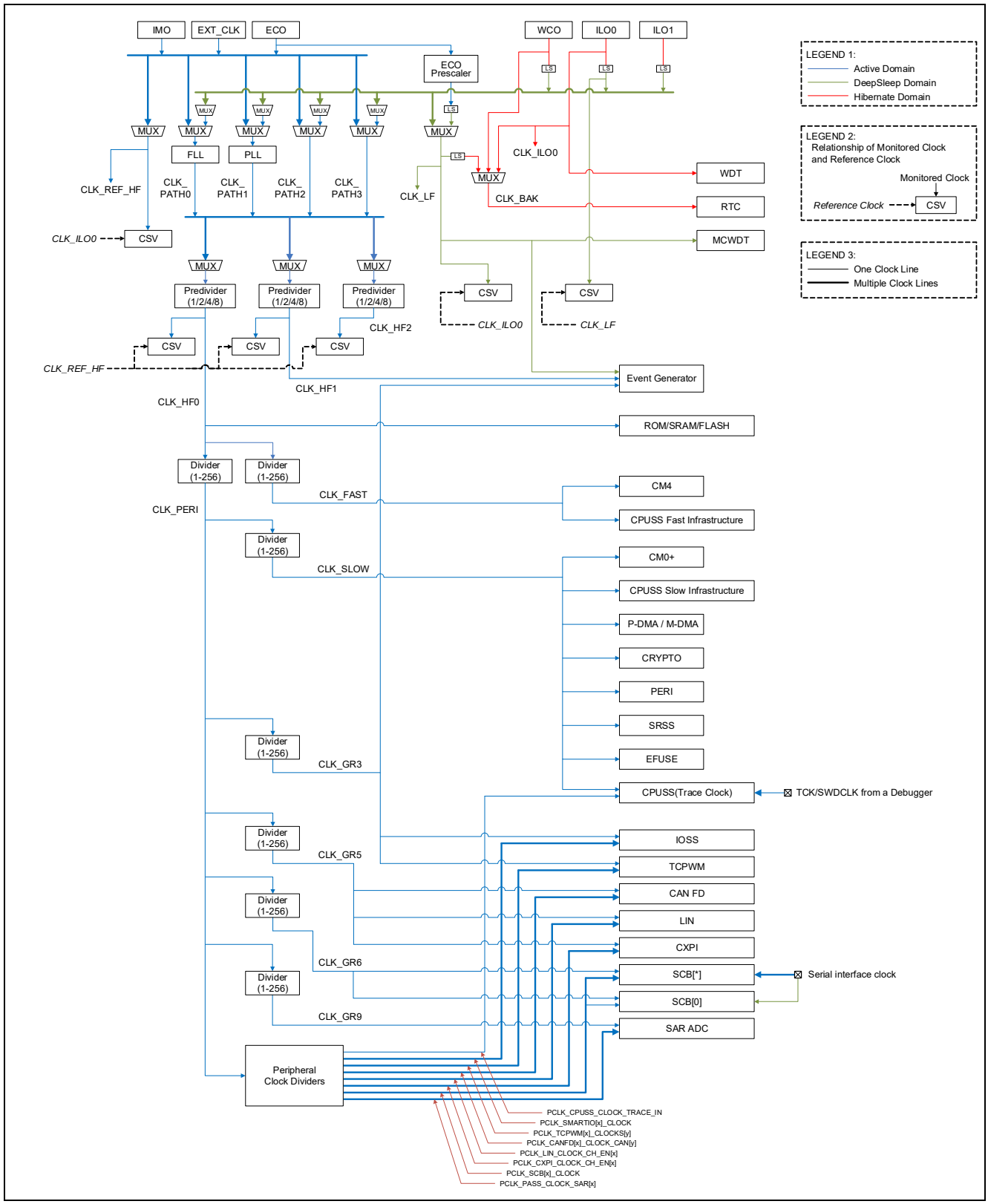


Figure 7-1 CYT2B9 clock diagram

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8 CYT2B9 CPU start-up sequence

The following steps describe the start-up sequence:

1. System Reset (@0x0000 0000)
2. CM0+ executes ROM boot (@0x0000 0004)
   i. Applies trims
   ii. Applies Debug Access port (DAP) access restrictions and system protection from eFuse and supervisory flash
   iii. Authenticates flash boot (only in SECURE life-cycle stage) and transfers control to it
3. CM0+ executes flash boot (from Supervisory flash @0x1700 2000)
   i. Debug pins are configured as per the SWD/JTAG spec[17]
   ii. Sets CM0+ vector offset register (CM0_VTOR part of the Arm® system space) to the beginning of flash (@0x1000 0000)
   iii. CM0+ branches to its Reset handler
4. CM0+ starts execution
   i. Moves CM0+ vector table to SRAM (updates CM0+ vector table base)
   ii. Sets CM4_VECTOR_TABLE_BASE (@0x0000 0200) to the location of CM4 vector table mentioned in flash (specified in CM4 linker definition file)
   iii. Releases CM4 from reset
   iv. Continues execution of CM0+ user application
5. CM4 executes directly from either code-flash or SRAM
   i. CM4 branches to its Reset handler
   ii. Continues execution of CM4 user application

Note
17. Port configuration of SWD/JTAG pins will be changed from the default GPIO mode to support debugging after the boot process, see **Table 11-1** for pin assignments.

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9 Pin assignment

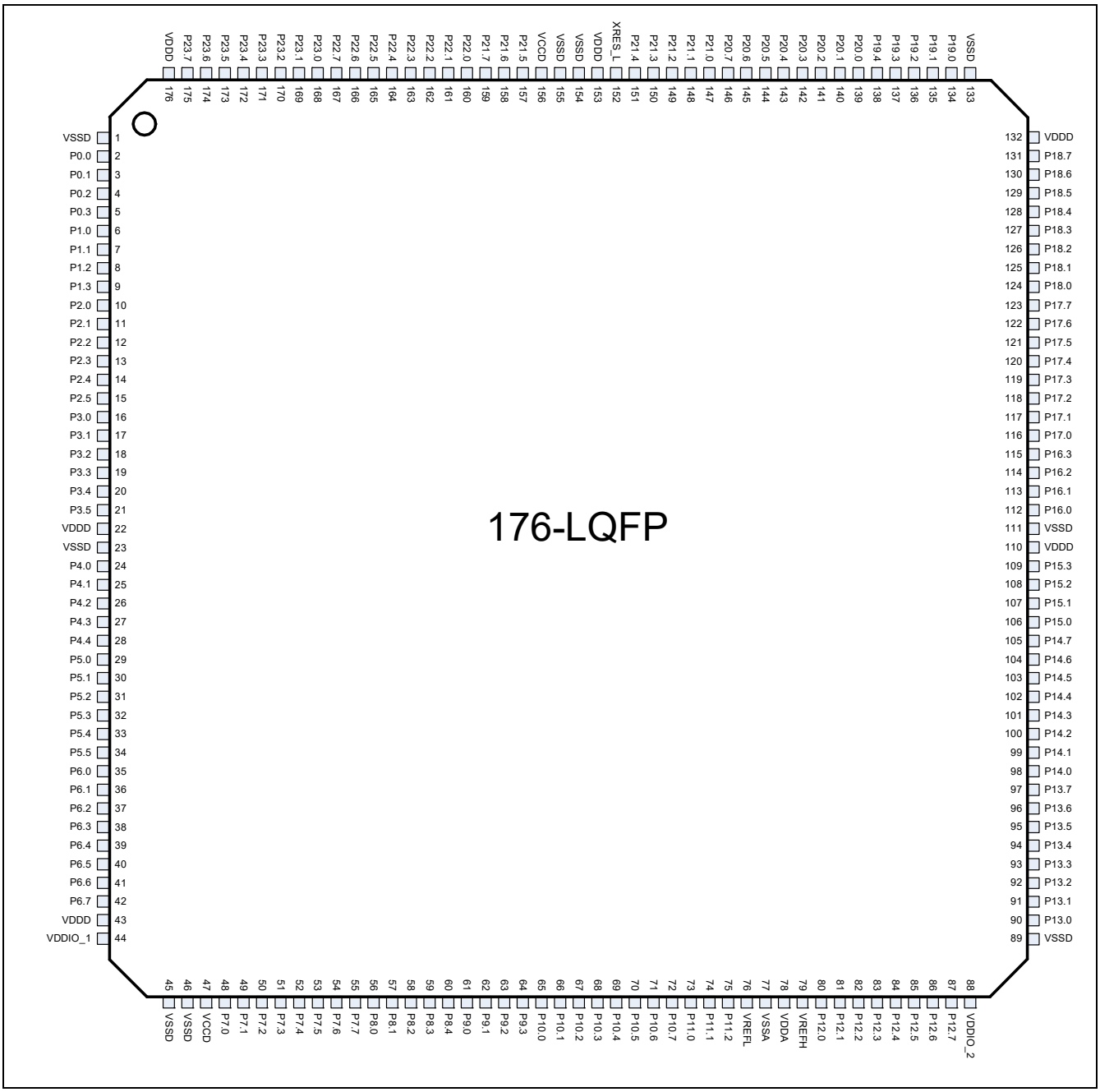


Figure 9-1 176-LQFP pin assignment

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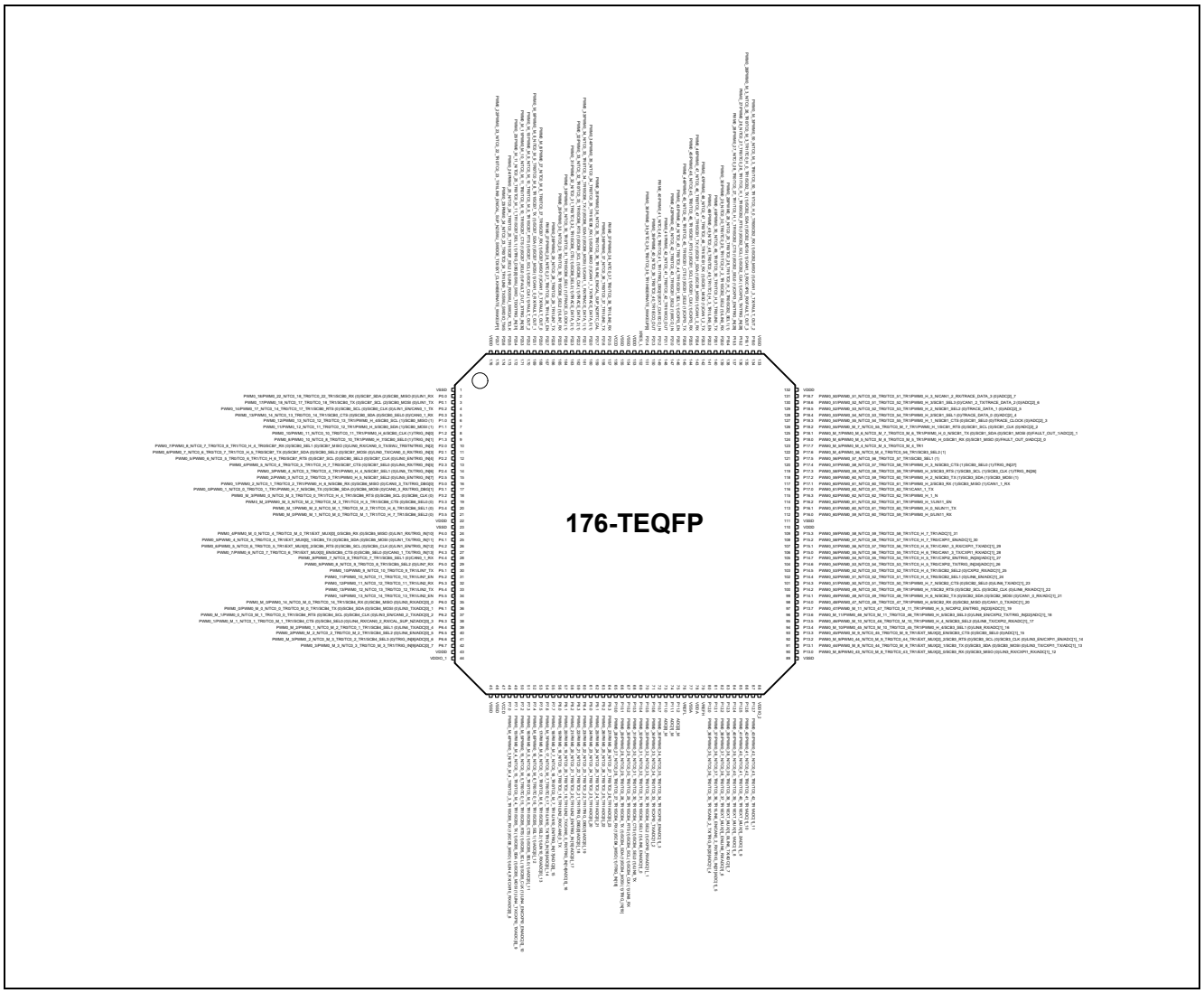


Figure 9-2 176-LQFP pin assignment with alternate functions

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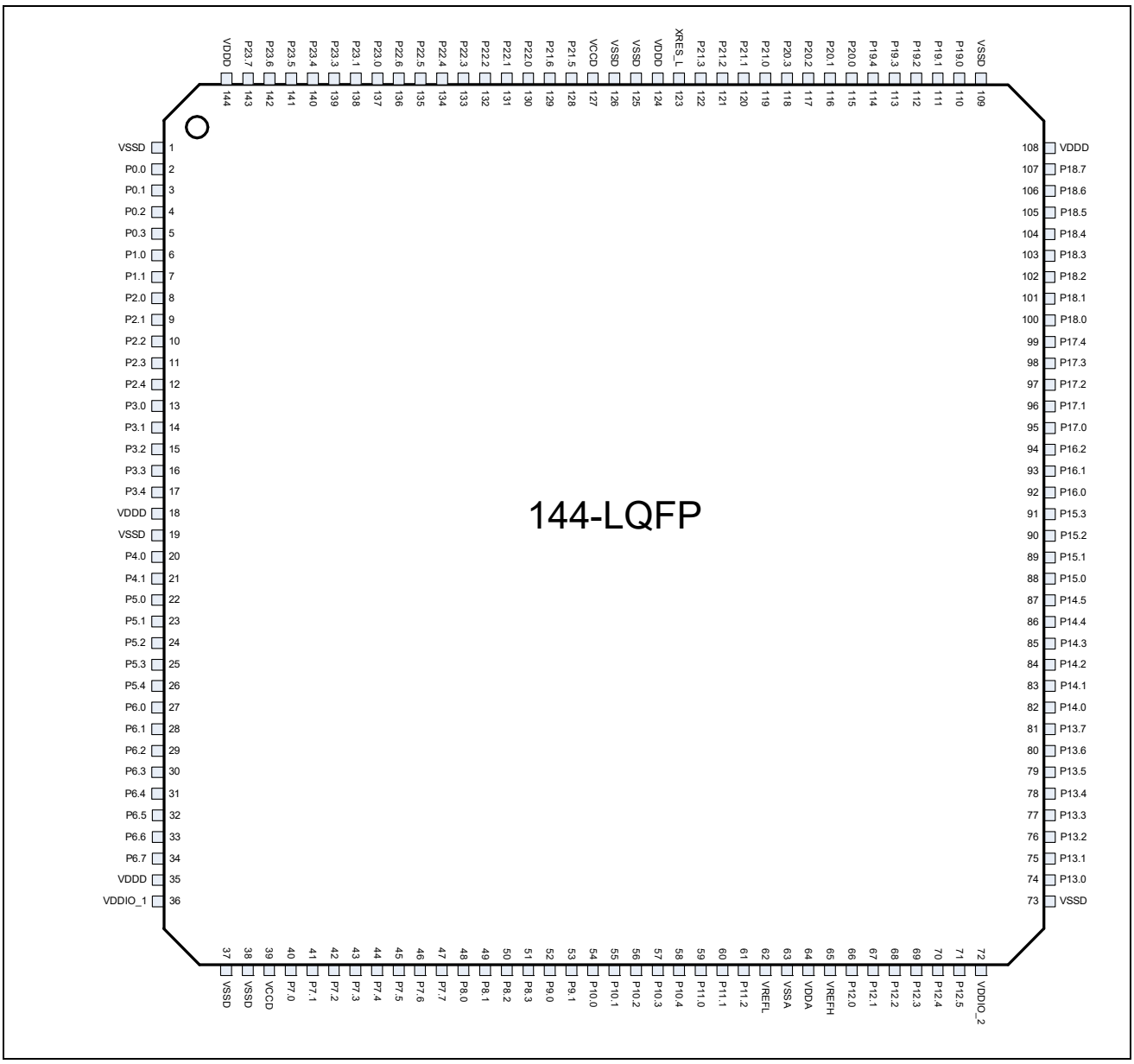


Figure 9-3 144-LQFP pin assignment

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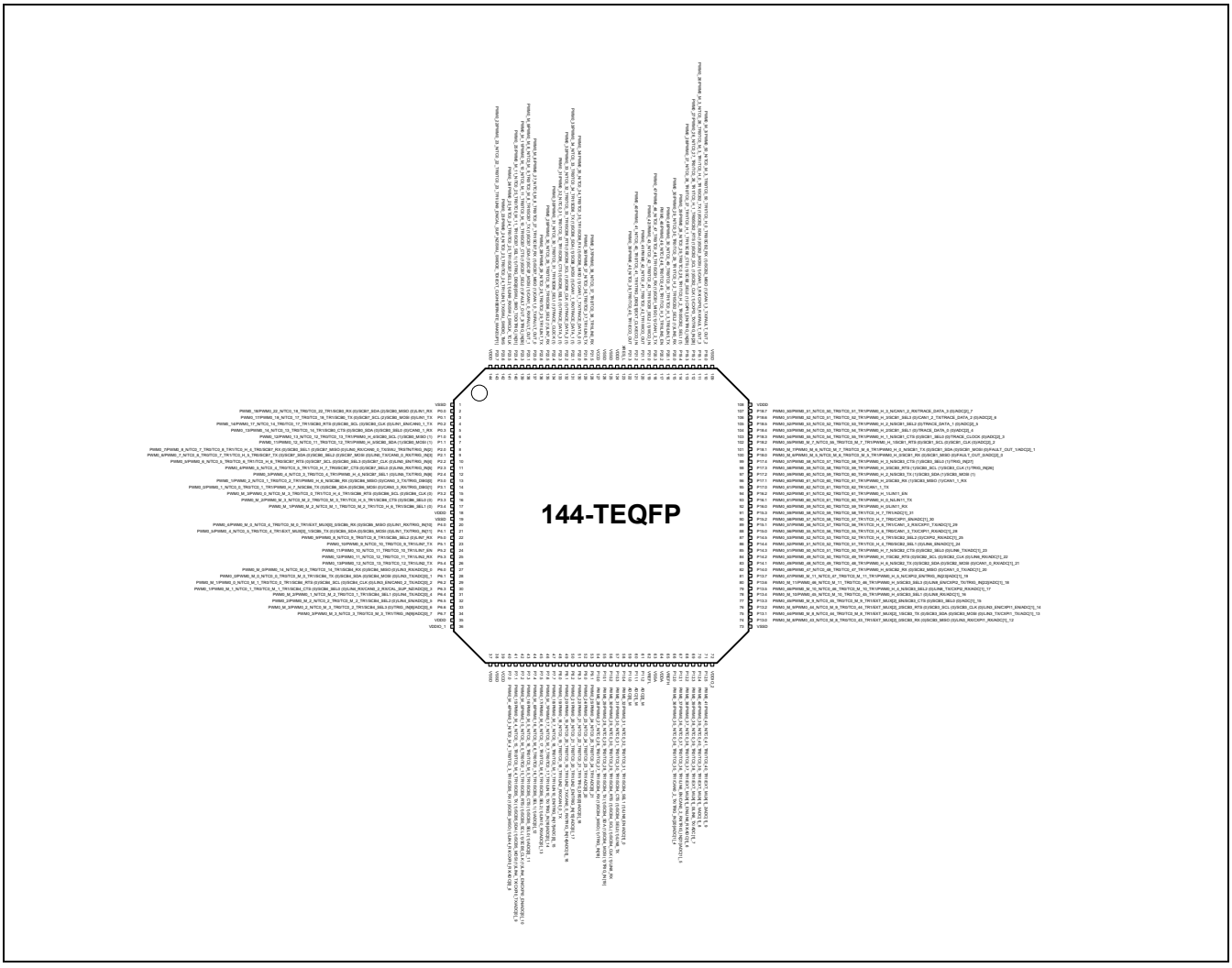


Figure 9-4 144-LQFP pin assignment with alternate functions

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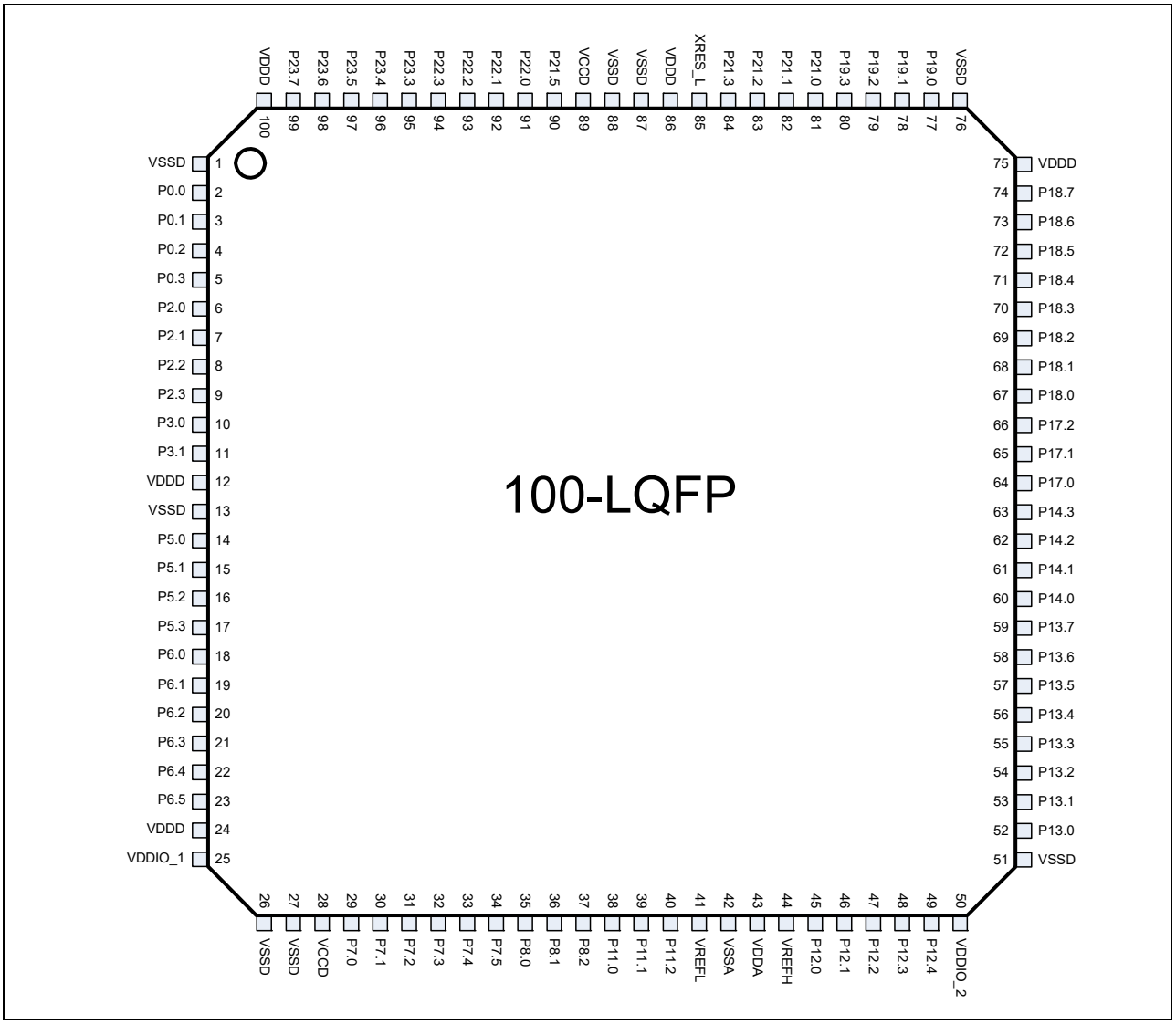


Figure 9-5 100-LQFP pin assignment

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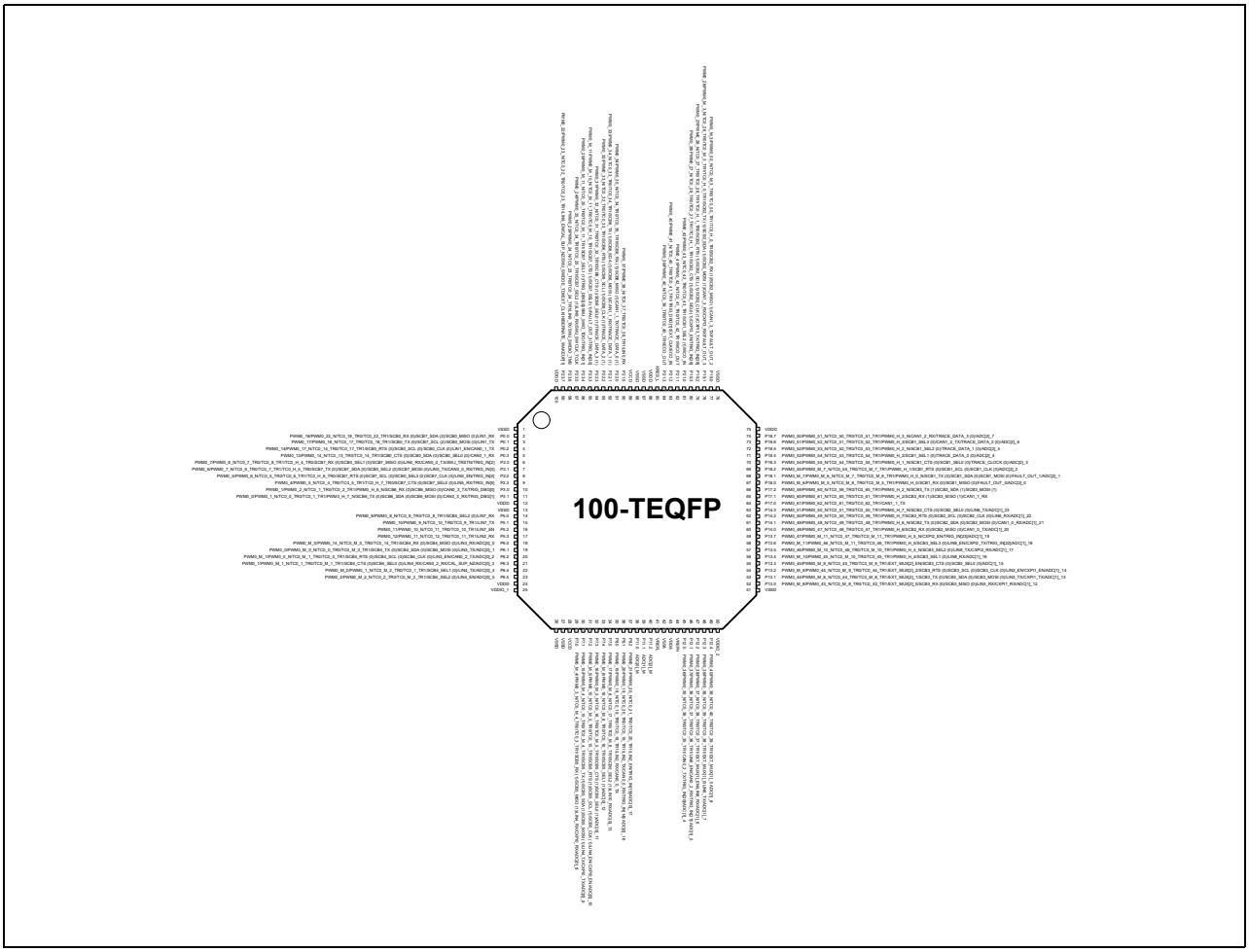


Figure 9-6 100-LQFP pin assignment with alternate functions

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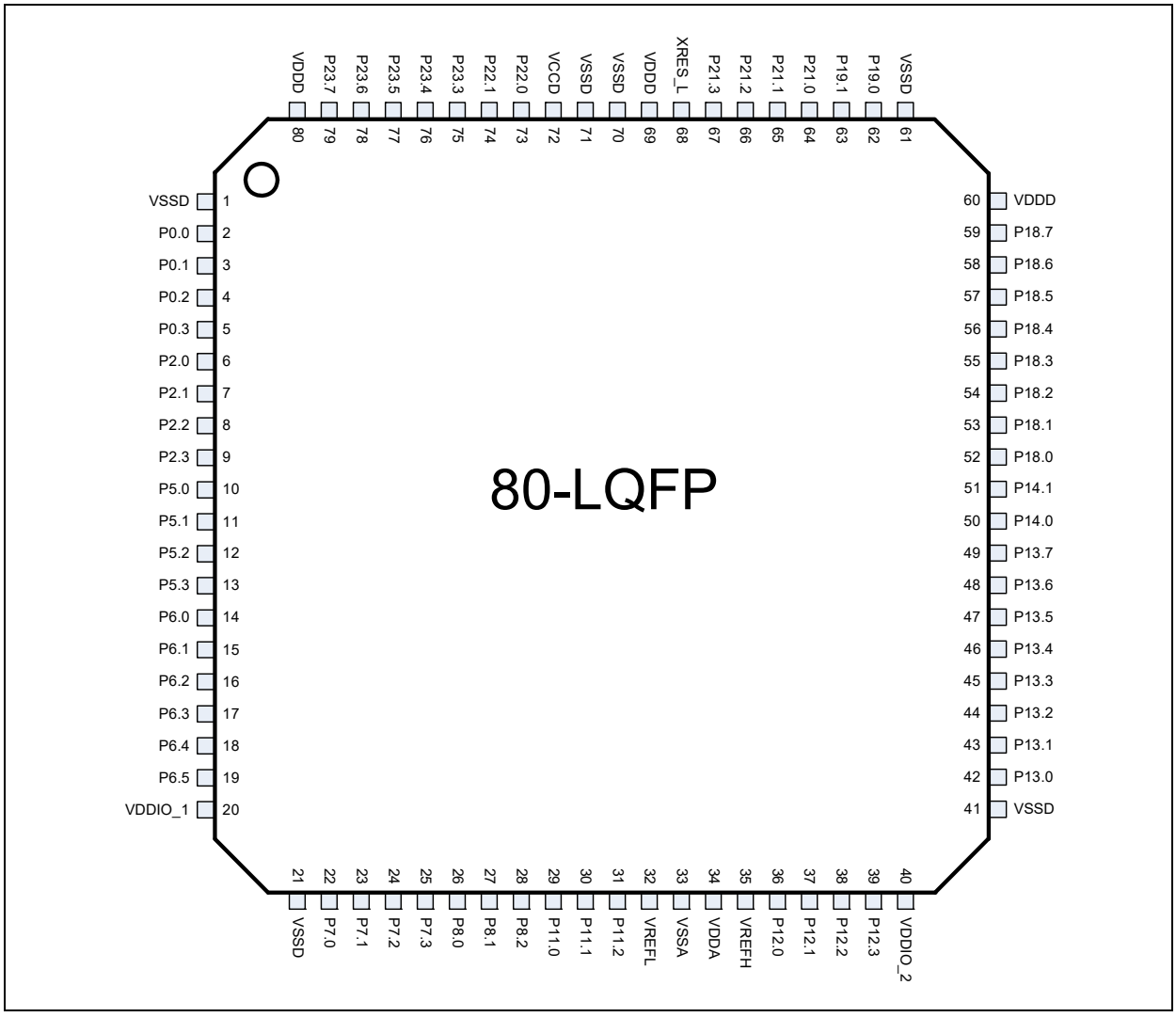


Figure 9-7 80-LQFP pin assignment

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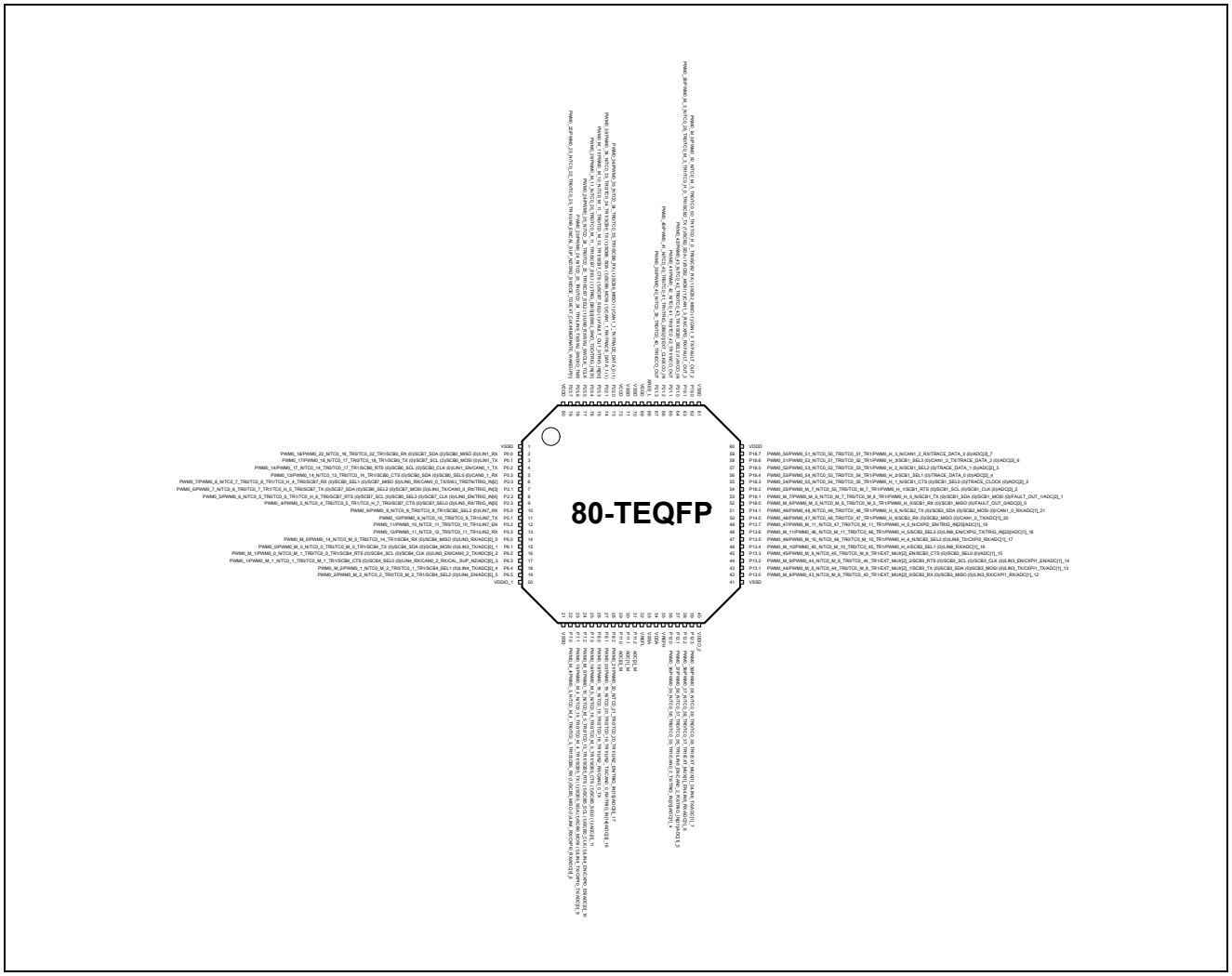


Figure 9-8 80-LQFP pin assignment with alternate functions

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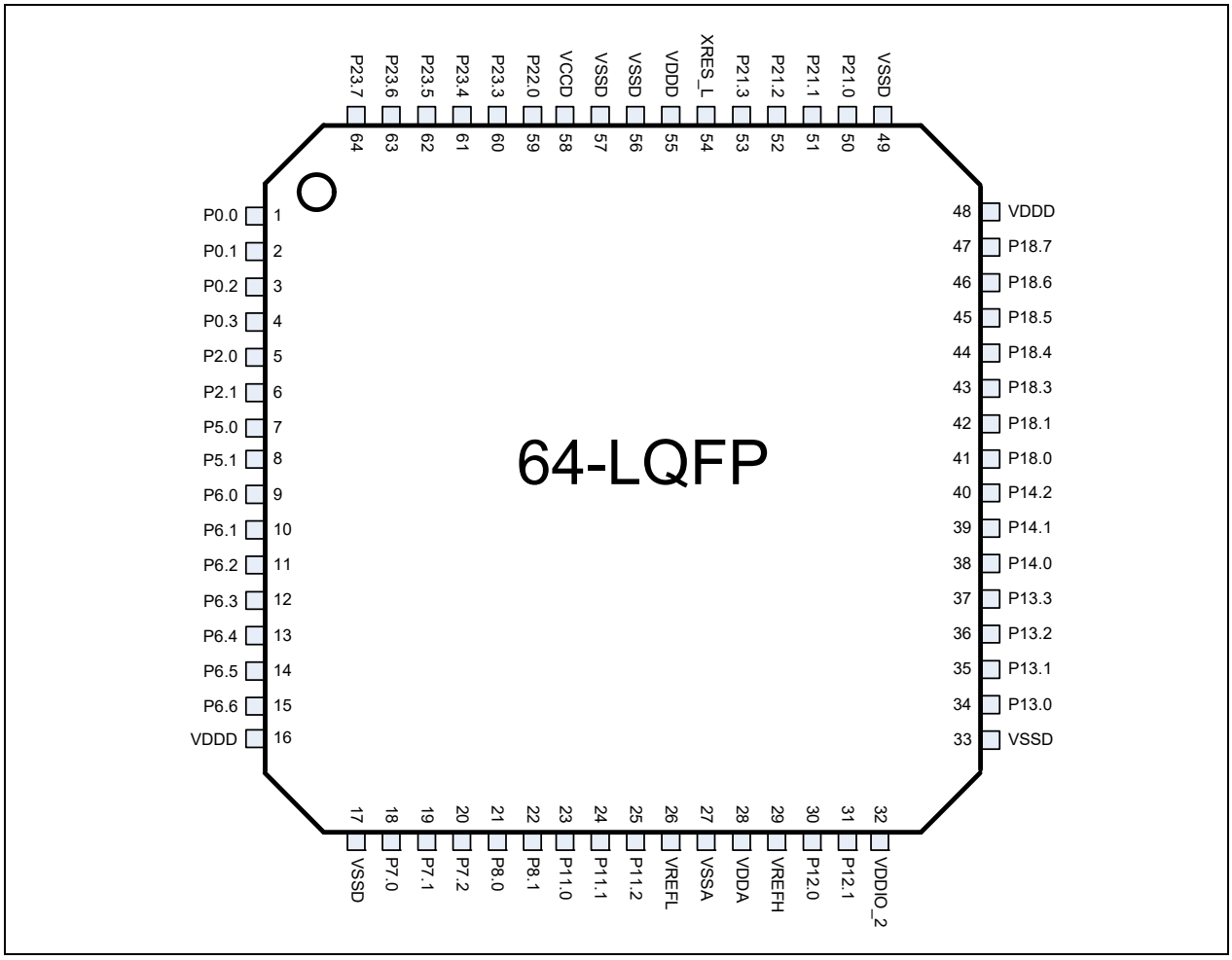


Figure 9-9 64-LQFP pin assignment

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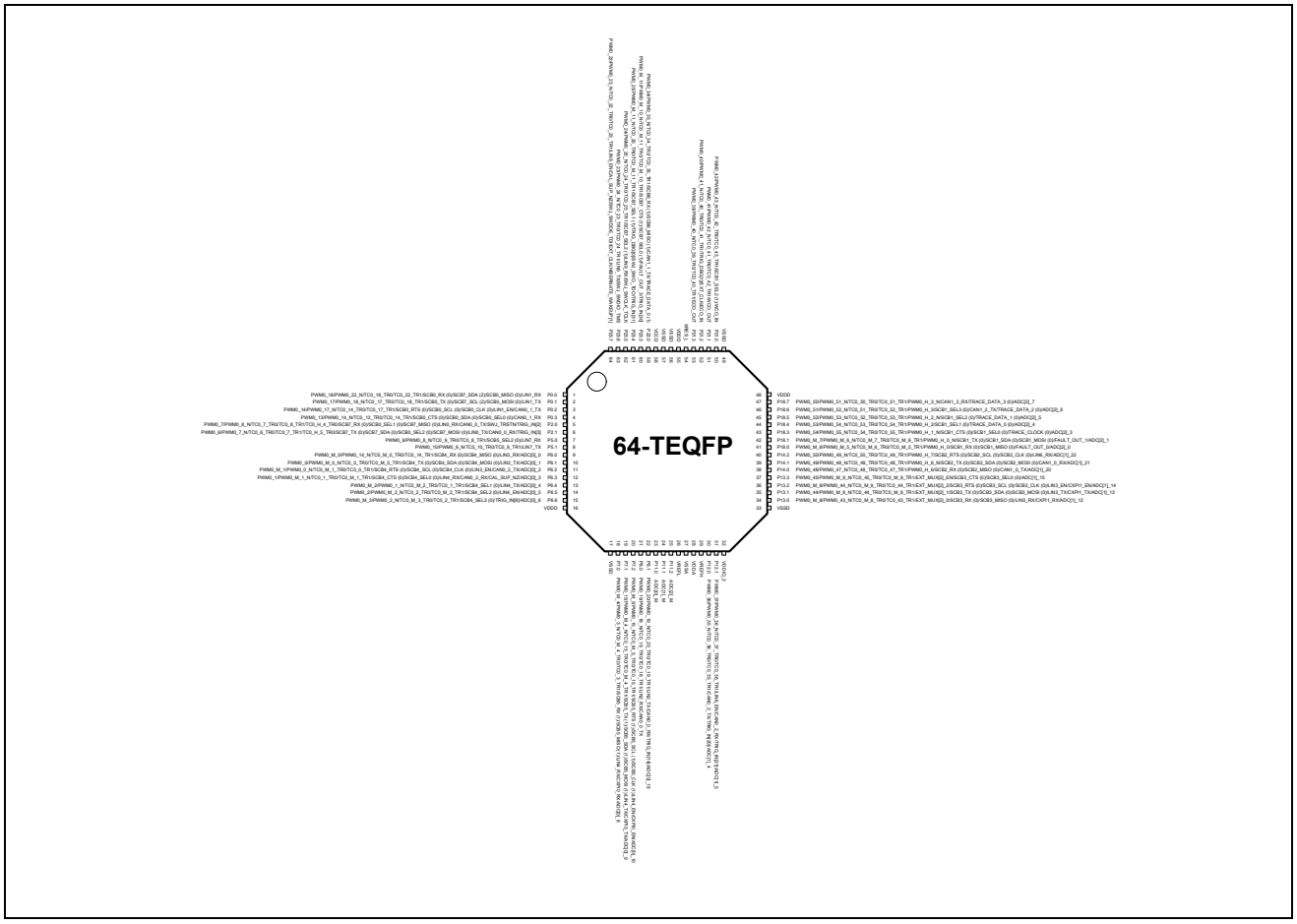


Figure 9-10 64-LQFP pin assignment with alternate functions

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10 High-Speed I/O matrix connections

Table 10-1 HSIOM connections reference

Name	Number	Description
HSIOM_SEL_GPIO	0	GPIO controls 'out'
HSIOM_SEL_GPIO_DSI	1	Reserved
HSIOM_SEL_DSI_DSI	2	
HSIOM_SEL_DSI_GPIO	3	
HSIOM_SEL_AMUXA	4	
HSIOM_SEL_AMUXB	5	
HSIOM_SEL_AMUXA_DSI	6	
HSIOM_SEL_AMUXB_DSI	7	
HSIOM_SEL_ACT_0	8	Active functionality 0
HSIOM_SEL_ACT_1	9	Active functionality 1
HSIOM_SEL_ACT_2	10	Active functionality 2
HSIOM_SEL_ACT_3	11	Active functionality 3
HSIOM_SEL_DS_0	12	DeepSleep functionality 0
HSIOM_SEL_DS_1	13	DeepSleep functionality 1
HSIOM_SEL_DS_2	14	DeepSleep functionality 2
HSIOM_SEL_DS_3	15	DeepSleep functionality 3
HSIOM_SEL_ACT_4	16	Active functionality 4
HSIOM_SEL_ACT_5	17	Active functionality 5
HSIOM_SEL_ACT_6	18	Active functionality 6
HSIOM_SEL_ACT_7	19	Active functionality 7
HSIOM_SEL_ACT_8	20	Active functionality 8
HSIOM_SEL_ACT_9	21	Active functionality 9
HSIOM_SEL_ACT_10	22	Active functionality 10
HSIOM_SEL_ACT_11	23	Active functionality 11
HSIOM_SEL_ACT_12	24	Active functionality 12
HSIOM_SEL_ACT_13	25	Active functionality 13
HSIOM_SEL_ACT_14	26	Active functionality 14
HSIOM_SEL_ACT_15	27	Active functionality 15
HSIOM_SEL_DS_4	28	DeepSleep functionality 4
HSIOM_SEL_DS_5	29	DeepSleep functionality 5
HSIOM_SEL_DS_6	30	DeepSleep functionality 6
HSIOM_SEL_DS_7	31	DeepSleep functionality 7

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11 Package pin list and alternate functions

Most pins have alternate functionality, as specified in **Table 11-1**.

Port 11 has the following additional features:

- Ability to pass full-level analog signals to the SAR without clipping to V_{DDD} in cases where $V_{DDD} < V_{DDA}$
- Ability to simultaneously capture all three ADC signals with highest priority (ADC[0:2]_M)
- Lower noise for the most sensitive sensors

Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22]

Name		Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
	HCon#0[18]	176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P0.0	GPIO_ENH	2	2	2	2	1			SCB0_MISO (0)		
P0.1	GPIO_ENH	3	3	3	3	2			SCB0_MOSI (0)		
P0.2	GPIO_ENH	4	4	4	4	3	SCB0_SCL (0)		SCB0_CLK (0)		
P0.3	GPIO_ENH	5	5	5	5	4	SCB0_SDA (0)		SCB0_SEL0 (0)		
P1.0	GPIO_STD	6	6	NA	NA	NA	SCB0_SCL (1)		SCB0_MISO (1)		
P1.1	GPIO_STD	7	7	NA	NA	NA	SCB0_SDA (1)		SCB0_MOSI (1)		
P1.2	GPIO_STD	8	NA	NA	NA	NA			SCB0_CLK (1)		
P1.3	GPIO_STD	9	NA	NA	NA	NA			SCB0_SEL0 (1)		
P2.0	GPIO_STD	10	8	6	6	5		SWJ_TRSTN	SCB0_SEL1 (0)		
P2.1	GPIO_STD	11	9	7	7	6			SCB0_SEL2 (0)		
P2.2	GPIO_STD	12	10	8	8	NA			SCB0_SEL3 (0)		
P2.3	GPIO_STD	13	11	9	9	NA					
P2.4	GPIO_STD	14	12	NA	NA	NA					
P2.5	GPIO_STD	15	NA	NA	NA	NA					
P3.0	GPIO_STD	16	13	10	NA	NA					
P3.1	GPIO_STD	17	14	11	NA	NA					
P3.2	GPIO_STD	18	15	NA	NA	NA					
P3.3	GPIO_STD	19	16	NA	NA	NA					
P3.4	GPIO_STD	20	17	NA	NA	NA					

Notes

18.High-Speed I/O matrix connection (HCon) reference as per **Table 10-1**.
19.DeepSleep ordering (DS#0, DS#1, DS#2) does not have any impact on choosing any alternate functions; the HSIOM module handles the individual alternate function assignment.
20.All port pin functions available in DeepSleep mode are also available in Active mode.
21.Refer to **Table 13-2** for more information on pin multiplexer abbreviations used.
22.For any function marked with an identifier (n), the AC timing is only guaranteed within the respective group "n".

Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22] *(continued)*

Name		Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
	HCon#0[18]	176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P3.5	GPIO_STD	21	NA	NA	NA	NA					
P4.0	GPIO_STD	24	20	NA	NA	NA					
P4.1	GPIO_STD	25	21	NA	NA	NA					
P4.2	GPIO_STD	26	NA	NA	NA	NA					
P4.3	GPIO_STD	27	NA	NA	NA	NA					
P4.4	GPIO_STD	28	NA	NA	NA	NA					
P5.0	GPIO_STD	29	22	14	10	7					
P5.1	GPIO_STD	30	23	15	11	8					
P5.2	GPIO_STD	31	24	16	12	NA					
P5.3	GPIO_STD	32	25	17	13	NA					
P5.4	GPIO_STD	33	26	NA	NA	NA					
P5.5	GPIO_STD	34	NA	NA	NA	NA					
P6.0	GPIO_STD	35	27	18	14	9				ADC[0]_0	
P6.1	GPIO_STD	36	28	19	15	10				ADC[0]_1	
P6.2	GPIO_STD	37	29	20	16	11				ADC[0]_2	
P6.3	GPIO_STD	38	30	21	17	12				ADC[0]_3	
P6.4	GPIO_STD	39	31	22	18	13				ADC[0]_4	
P6.5	GPIO_STD	40	32	23	19	14				ADC[0]_5	
P6.6	GPIO_STD	41	33	NA	NA	15				ADC[0]_6	
P6.7	GPIO_STD	42	34	NA	NA	NA				ADC[0]_7	
P7.0	GPIO_STD	48	40	29	22	18				ADC[0]_8	
P7.1	GPIO_STD	49	41	30	23	19				ADC[0]_9	
P7.2	GPIO_STD	50	42	31	24	20				ADC[0]_10	
P7.3	GPIO_STD	51	43	32	25	NA				ADC[0]_11	
P7.4	GPIO_STD	52	44	33	NA	NA				ADC[0]_12	
P7.5	GPIO_STD	53	45	34	NA	NA				ADC[0]_13	
P7.6	GPIO_STD	54	46	NA	NA	NA				ADC[0]_14	
P7.7	GPIO_STD	55	47	NA	NA	NA				ADC[0]_15	
P8.0	GPIO_STD	56	48	35	26	21					
P8.1	GPIO_STD	57	49	36	27	22				ADC[0]_16	
P8.2	GPIO_STD	58	50	37	28	NA				ADC[0]_17	

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Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22] *(continued)*

Name		Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
	HCon#0[18]	176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P8.3	GPIO_STD	59	51	NA	NA	NA				ADC[0]_18	
P8.4	GPIO_STD	60	NA	NA	NA	NA				ADC[0]_19	
P9.0	GPIO_STD	61	52	NA	NA	NA				ADC[0]_20	
P9.1	GPIO_STD	62	53	NA	NA	NA				ADC[0]_21	
P9.2	GPIO_STD	63	NA	NA	NA	NA				ADC[0]_22	
P9.3	GPIO_STD	64	NA	NA	NA	NA				ADC[0]_23	
P10.0	GPIO_STD	65	54	NA	NA	NA					
P10.1	GPIO_STD	66	55	NA	NA	NA					
P10.2	GPIO_STD	67	56	NA	NA	NA					
P10.3	GPIO_STD	68	57	NA	NA	NA					
P10.4	GPIO_STD	69	58	NA	NA	NA				ADC[1]_0	
P10.5	GPIO_STD	70	NA	NA	NA	NA				ADC[1]_1	
P10.6	GPIO_STD	71	NA	NA	NA	NA				ADC[1]_2	
P10.7	GPIO_STD	72	NA	NA	NA	NA				ADC[1]_3	
P11.0	GPIO_STD	73	59	38	29	23				ADC[0]_M	
P11.1	GPIO_STD	74	60	39	30	24				ADC[1]_M	
P11.2	GPIO_STD	75	61	40	31	25				ADC[2]_M	
P12.0	GPIO_STD	80	66	45	36	30				ADC[1]_4	SMARTIO12_0
P12.1	GPIO_STD	81	67	46	37	31				ADC[1]_5	SMARTIO12_1
P12.2	GPIO_STD	82	68	47	38	NA				ADC[1]_6	SMARTIO12_2
P12.3	GPIO_STD	83	69	48	39	NA				ADC[1]_7	SMARTIO12_3
P12.4	GPIO_STD	84	70	49	NA	NA				ADC[1]_8	SMARTIO12_4
P12.5	GPIO_STD	85	71	NA	NA	NA				ADC[1]_9	SMARTIO12_5
P12.6	GPIO_STD	86	NA	NA	NA	NA				ADC[1]_10	SMARTIO12_6
P12.7	GPIO_STD	87	NA	NA	NA	NA				ADC[1]_11	SMARTIO12_7
P13.0	GPIO_STD	90	74	52	42	34				ADC[1]_12	SMARTIO13_0
P13.1	GPIO_STD	91	75	53	43	35				ADC[1]_13	SMARTIO13_1
P13.2	GPIO_STD	92	76	54	44	36				ADC[1]_14	SMARTIO13_2
P13.3	GPIO_STD	93	77	55	45	37				ADC[1]_15	SMARTIO13_3
P13.4	GPIO_STD	94	78	56	46	NA				ADC[1]_16	SMARTIO13_4
P13.5	GPIO_STD	95	79	57	47	NA				ADC[1]_17	SMARTIO13_5

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Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22] *(continued)*

Name		Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
	HCon#0[18]	176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P13.6	GPIO_STD	96	80	58	48	NA				ADC[1]_18	SMARTIO13_6
P13.7	GPIO_STD	97	81	59	49	NA				ADC[1]_19	SMARTIO13_7
P14.0	GPIO_STD	98	82	60	50	38				ADC[1]_20	SMARTIO14_0
P14.1	GPIO_STD	99	83	61	51	39				ADC[1]_21	SMARTIO14_1
P14.2	GPIO_STD	100	84	62	NA	40				ADC[1]_22	SMARTIO14_2
P14.3	GPIO_STD	101	85	63	NA	NA				ADC[1]_23	SMARTIO14_3
P14.4	GPIO_STD	102	86	NA	NA	NA				ADC[1]_24	SMARTIO14_4
P14.5	GPIO_STD	103	87	NA	NA	NA				ADC[1]_25	SMARTIO14_5
P14.6	GPIO_STD	104	NA	NA	NA	NA				ADC[1]_26	SMARTIO14_6
P14.7	GPIO_STD	105	NA	NA	NA	NA				ADC[1]_27	SMARTIO14_7
P15.0	GPIO_STD	106	88	NA	NA	NA				ADC[1]_28	SMARTIO15_0
P15.1	GPIO_STD	107	89	NA	NA	NA				ADC[1]_29	SMARTIO15_1
P15.2	GPIO_STD	108	90	NA	NA	NA				ADC[1]_30	SMARTIO15_2
P15.3	GPIO_STD	109	91	NA	NA	NA				ADC[1]_31	SMARTIO15_3
P16.0	GPIO_STD	112	92	NA	NA	NA					
P16.1	GPIO_STD	113	93	NA	NA	NA					
P16.2	GPIO_STD	114	94	NA	NA	NA					
P16.3	GPIO_STD	115	NA	NA	NA	NA					
P17.0	GPIO_STD	116	95	64	NA	NA					SMARTIO17_0
P17.1	GPIO_STD	117	96	65	NA	NA					SMARTIO17_1
P17.2	GPIO_STD	118	97	66	NA	NA					SMARTIO17_2
P17.3	GPIO_STD	119	98	NA	NA	NA					SMARTIO17_3
P17.4	GPIO_STD	120	99	NA	NA	NA					SMARTIO17_4
P17.5	GPIO_STD	121	NA	NA	NA	NA					SMARTIO17_5
P17.6	GPIO_STD	122	NA	NA	NA	NA					SMARTIO17_6
P17.7	GPIO_STD	123	NA	NA	NA	NA					SMARTIO17_7
P18.0	GPIO_STD	124	100	67	52	41				ADC[2]_0	
P18.1	GPIO_STD	125	101	68	53	42				ADC[2]_1	
P18.2	GPIO_STD	126	102	69	54	NA				ADC[2]_2	
P18.3	GPIO_STD	127	103	70	55	43				ADC[2]_3	
P18.4	GPIO_STD	128	104	71	56	44				ADC[2]_4	

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Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22] *(continued)*

Name	HCon#0[18]	Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
		176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P18.5	GPIO_STD	129	105	72	57	45				ADC[2]_5	
P18.6	GPIO_STD	130	106	73	58	46				ADC[2]_6	
P18.7	GPIO_STD	131	107	74	59	47				ADC[2]_7	
P19.0	GPIO_STD	134	110	77	62	NA					
P19.1	GPIO_STD	135	111	78	63	NA					
P19.2	GPIO_STD	136	112	79	NA	NA					
P19.3	GPIO_STD	137	113	80	NA	NA					
P19.4	GPIO_STD	138	114	NA	NA	NA					
P20.0	GPIO_STD	139	115	NA	NA	NA					
P20.1	GPIO_STD	140	116	NA	NA	NA					
P20.2	GPIO_STD	141	117	NA	NA	NA					
P20.3	GPIO_STD	142	118	NA	NA	NA					
P20.4	GPIO_STD	143	NA	NA	NA	NA					
P20.5	GPIO_STD	144	NA	NA	NA	NA					
P20.6	GPIO_STD	145	NA	NA	NA	NA					
P20.7	GPIO_STD	146	NA	NA	NA	NA					
P21.0	GPIO_STD	147	119	81	64	50				WCO_IN[23]	
P21.1	GPIO_STD	148	120	82	65	51				WCO_OUT[23]	
P21.2	GPIO_STD	149	121	83	66	52				ECO_IN[23]	
P21.3	GPIO_STD	150	122	84	67	53				ECO_OUT[23]	
P21.4[24]	GPIO_STD	151	NA	NA	NA	NA				HIBERNATE_WAKEUP[0]	
P21.5	GPIO_STD	157	128	90	NA	NA					
P21.6	GPIO_STD	158	129	NA	NA	NA					
P21.7	GPIO_STD	159	NA	NA	NA	NA		RTC_CAL			
P22.0	GPIO_STD	160	130	91	73	59					
P22.1	GPIO_STD	161	131	92	74	NA					
P22.2	GPIO_STD	162	132	93	NA	NA					
P22.3	GPIO_STD	163	133	94	NA	NA					
P22.4	GPIO_STD	164	134	NA	NA	NA					
P22.5	GPIO_STD	165	135	NA	NA	NA					
P22.6	GPIO_STD	166	136	NA	NA	NA					
P22.7	GPIO_STD	167	NA	NA	NA	NA					

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Table 11-1 Pin selector and alternate pin functions in DeepSleep (DS) Mode, Analog, SMART I/O[21, 22] *(continued)*

Name		Package Pins					DeepSleep Mapping[20]			Analog	SMARTIO
	HCon#0[18]	176-LQFP	144-LQFP	100-LQFP	80-LQFP	64-LQFP	HCon#14	HCon#29	HCon#30		
	GPIO						DS #0[19]	DS #1	DS #2		
P23.0	GPIO_STD	168	137	NA	NA	NA					
P23.1	GPIO_STD	169	138	NA	NA	NA					
P23.2	GPIO_STD	170	NA	NA	NA	NA					
P23.3	GPIO_STD	171	139	95	75	60					
P23.4	GPIO_STD	172	140	96	76	61		SWJ_SWO_TDO			
P23.5	GPIO_STD	173	141	97	77	62		SWJ_SWCLK_TCLK			
P23.6	GPIO_STD	174	142	98	78	63		SWJ_SWDIO_TMS			
P23.7	GPIO_STD	175	143	99	79	64		SWJ_SWDOE_TDI		HIBERNATE_WAKEUP[1]	

Notes
23. GPIO pins that support an oscillator function (WCO or ECO) must be configured for high-impedance if the oscillator is enabled.
24. This I/O will have increased leakage to ground when VDDD is below the POR threshold.

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12 Power pin assignments

Table 12-1 Power pin assignments

Name	Package					Remarks
	64-LQFP	80-LQFP	100-LQFP	144-LQFP	176-LQFP	
VDDD	55, 48, 16	80, 69, 60	100, 86, 75, 24, 12	144, 124, 108, 35, 18	176, 153, 132, 110, 43, 22	Main digital supply
VSSD	57, 56, 49, 33, 17	71, 70, 61, 41, 21, 1	88, 87, 76, 51, 27, 26, 13, 1	126, 125, 109, 73, 38, 37, 19, 1	155, 154, 133, 111, 89, 46, 45, 23, 1	Main digital ground
VDDIO_1	NA	20	25	36	44	I/O supply for group 1
VDDIO_2	32	40	50	72	88	I/O supply for group 2
VCCD[25]	58	72	89, 28	127, 39	156, 47	Main regulated supply. Driven by LDO regulator
VREFH	29	35	44	65	79	High reference voltage for SAR
VREFL	26	32	41	62	76	Low reference voltage for SAR
VDDA	28	34	43	64	78	Main analog supply (for PASS SAR)
VSSA	27	33	42	63	77	Main analog ground
XRES_L	54	68	85	123	152	Active low external reset input

Note
25.The V_{CCD} pins must be connected together to ensure a low-impedance connection. (see the requirement in **Figure 26-2**)

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13 Alternate function pin assignments

Table 13-1 Alternate pin functions in active Mode[28, 29]

Name	Active Mapping												
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15
P0.0	PWM0_18	PWM0_22_N	TC0_18_TR0	TC0_22_TR1		SCB0_RX (0)	SCB7_SDA (2)		LIN1_RX				
P0.1	PWM0_17	PWM0_18_N	TC0_17_TR0	TC0_18_TR1		SCB0_TX (0)	SCB7_SCL (2)		LIN1_TX				
P0.2	PWM0_14	PWM0_17_N	TC0_14_TR0	TC0_17_TR1		SCB0_RTS (0)			LIN1_EN	CAN0_1_TX			
P0.3	PWM0_13	PWM0_14_N	TC0_13_TR0	TC0_14_TR1		SCB0_CTS (0)				CAN0_1_RX			
P1.0	PWM0_12	PWM0_13_N	TC0_12_TR0	TC0_13_TR1	PWM0_H_4								
P1.1	PWM0_11	PWM0_12_N	TC0_11_TR0	TC0_12_TR1	PWM0_H_5								
P1.2	PWM0_10	PWM0_11_N	TC0_10_TR0	TC0_11_TR1	PWM0_H_6							TRIG_IN[0]	
P1.3	PWM0_8	PWM0_10_N	TC0_8_TR0	TC0_10_TR1	PWM0_H_7							TRIG_IN[1]	
P2.0	PWM0_7	PWM0_8_N	TC0_7_TR0	TC0_8_TR1	TC0_H_4_TR0	SCB7_RX (0)		SCB7_MISO (0)	LIN0_RX	CAN0_0_TX		TRIG_IN[2]	
P2.1	PWM0_6	PWM0_7_N	TC0_6_TR0	TC0_7_TR1	TC0_H_5_TR0	SCB7_TX (0)	SCB7_SDA (0)	SCB7_MOSI (0)	LIN0_TX	CAN0_0_RX		TRIG_IN[3]	
P2.2	PWM0_5	PWM0_6_N	TC0_5_TR0	TC0_6_TR1	TC0_H_6_TR0	SCB7_RTS (0)	SCB7_SCL (0)	SCB7_CLK (0)	LIN0_EN			TRIG_IN[4]	
P2.3	PWM0_4	PWM0_5_N	TC0_4_TR0	TC0_5_TR1	TC0_H_7_TR0	SCB7_CTS (0)		SCB7_SEL0 (0)	LIN5_RX			TRIG_IN[5]	
P2.4	PWM0_3	PWM0_4_N	TC0_3_TR0	TC0_4_TR1	PWM0_H_4_N			SCB7_SEL1 (0)	LIN5_TX			TRIG_IN[6]	
P2.5	PWM0_2	PWM0_3_N	TC0_2_TR0	TC0_3_TR1	PWM0_H_5_N			SCB7_SEL2 (0)	LIN5_EN			TRIG_IN[7]	
P3.0	PWM0_1	PWM0_2_N	TC0_1_TR0	TC0_2_TR1	PWM0_H_6_N	SCB6_RX (0)		SCB6_MISO (0)		CAN0_3_TX			TRIG_DBG[0]
P3.1	PWM0_0	PWM0_1_N	TC0_0_TR0	TC0_1_TR1	PWM0_H_7_N	SCB6_TX (0)	SCB6_SDA (0)	SCB6_MOSI (0)		CAN0_3_RX			TRIG_DBG[1]
P3.2	PWM0_M_3	PWM0_0_N	TC0_M_3_TR0	TC0_0_TR1	TC0_H_4_TR1	SCB6_RTS (0)	SCB6_SCL (0)	SCB6_CLK (0)					
P3.3	PWM0_M_2	PWM0_M_3_N	TC0_M_2_TR0	TC0_M_3_TR1	TC0_H_5_TR1	SCB6_CTS (0)		SCB6_SEL0 (0)					
P3.4	PWM0_M_1	PWM0_M_2_N	TC0_M_1_TR0	TC0_M_2_TR1	TC0_H_6_TR1			SCB6_SEL1 (0)					
P3.5	PWM0_M_0	PWM0_M_1_N	TC0_M_0_TR0	TC0_M_1_TR1	TC0_H_7_TR1			SCB6_SEL2 (0)					
P4.0	PWM0_4	PWM0_M_0_N	TC0_4_TR0	TC0_M_0_TR1	EXT_MUX[0]_0	SCB5_RX (0)		SCB5_MISO (0)	LIN1_RX			TRIG_IN[10]	
P4.1	PWM0_5	PWM0_4_N	TC0_5_TR0	TC0_4_TR1	EXT_MUX[0]_1	SCB5_TX (0)	SCB5_SDA (0)	SCB5_MOSI (0)	LIN1_TX			TRIG_IN[11]	
P4.2	PWM0_6	PWM0_5_N	TC0_6_TR0	TC0_5_TR1	EXT_MUX[0]_2	SCB5_RTS (0)	SCB5_SCL (0)	SCB5_CLK (0)	LIN1_EN			TRIG_IN[12]	
P4.3	PWM0_7	PWM0_6_N	TC0_7_TR0	TC0_6_TR1	EXT_MUX[0]_EN	SCB5_CTS (0)		SCB5_SEL0 (0)		CAN0_1_TX		TRIG_IN[13]	
P4.4	PWM0_8	PWM0_7_N	TC0_8_TR0	TC0_7_TR1				SCB5_SEL1 (0)		CAN0_1_RX			

Notes
26. High-Speed I/O matrix connection (HCon) reference as per **Table 10-1**.
27. Active Mode ordering (ACT#0, ACT#1, and so on) does not have any impact on choosing any alternate functions; HSIOM module will handle the individual alternate function assignment.
28. Refer to **Table 13-2** for more information on pin multiplexer abbreviations used.
29. For any function marked with an identifier (n), the AC timing is only guaranteed within the respective group "n".

Table 13-1 Alternate pin functions in active Mode[28, 29] *(continued)*

Name	Active Mapping												
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15
P5.0	PWM0_9	PWM0_8_N	TC0_9_TR0	TC0_8_TR1				SCB5_SEL2 (0)	LIN7_RX				
P5.1	PWM0_10	PWM0_9_N	TC0_10_TR0	TC0_9_TR1					LIN7_TX				
P5.2	PWM0_11	PWM0_10_N	TC0_11_TR0	TC0_10_TR1					LIN7_EN				
P5.3	PWM0_12	PWM0_11_N	TC0_12_TR0	TC0_11_TR1					LIN2_RX				
P5.4	PWM0_13	PWM0_12_N	TC0_13_TR0	TC0_12_TR1					LIN2_TX				
P5.5	PWM0_14	PWM0_13_N	TC0_14_TR0	TC0_13_TR1					LIN2_EN				
P6.0	PWM0_M_0	PWM0_14_N	TC0_M_0_TR0	TC0_14_TR1		SCB4_RX (0)		SCB4_MISO (0)	LIN3_RX				
P6.1	PWM0_0	PWM0_M_0_N	TC0_0_TR0	TC0_M_0_TR1		SCB4_TX (0)	SCB4_SDA (0)	SCB4_MOSI (0)	LIN3_TX				
P6.2	PWM0_M_1	PWM0_0_N	TC0_M_1_TR0	TC0_0_TR1		SCB4_RTS (0)	SCB4_SCL (0)	SCB4_CLK (0)	LIN3_EN	CAN0_2_TX			
P6.3	PWM0_1	PWM0_M_1_N	TC0_1_TR0	TC0_M_1_TR1		SCB4_CTS (0)		SCB4_SEL0 (0)	LIN4_RX	CAN0_2_RX			CAL_SUP_NZ
P6.4	PWM0_M_2	PWM0_1_N	TC0_M_2_TR0	TC0_1_TR1				SCB4_SEL1 (0)	LIN4_TX				
P6.5	PWM0_2	PWM0_M_2_N	TC0_2_TR0	TC0_M_2_TR1				SCB4_SEL2 (0)	LIN4_EN				
P6.6	PWM0_M_3	PWM0_2_N	TC0_M_3_TR0	TC0_2_TR1				SCB4_SEL3 (0)				TRIG_IN[8]	
P6.7	PWM0_3	PWM0_M_3_N	TC0_3_TR0	TC0_M_3_TR1								TRIG_IN[9]	
P7.0	PWM0_M_4	PWM0_3_N	TC0_M_4_TR0	TC0_3_TR1		SCB5_RX (1)		SCB5_MISO (1)	LIN4_RX		CXPI0_RX		
P7.1	PWM0_15	PWM0_M_4_N	TC0_15_TR0	TC0_M_4_TR1		SCB5_TX (1)	SCB5_SDA (1)	SCB5_MOSI (1)	LIN4_TX		CXPI0_TX		
P7.2	PWM0_M_5	PWM0_15_N	TC0_M_5_TR0	TC0_15_TR1		SCB5_RTS (1)	SCB5_SCL (1)	SCB5_CLK (1)	LIN4_EN		CXPI0_EN		
P7.3	PWM0_16	PWM0_M_5_N	TC0_16_TR0	TC0_M_5_TR1		SCB5_CTS (1)		SCB5_SEL0 (1)					
P7.4	PWM0_M_6	PWM0_16_N	TC0_M_6_TR0	TC0_16_TR1				SCB5_SEL1 (1)					
P7.5	PWM0_17	PWM0_M_6_N	TC0_17_TR0	TC0_M_6_TR1				SCB5_SEL2 (1)	LIN10_RX				
P7.6	PWM0_M_7	PWM0_17_N	TC0_M_7_TR0	TC0_17_TR1					LIN10_TX			TRIG_IN[16]	
P7.7	PWM0_18	PWM0_M_7_N	TC0_18_TR0	TC0_M_7_TR1					LIN10_EN			TRIG_IN[17]	
P8.0	PWM0_19	PWM0_18_N	TC0_19_TR0	TC0_18_TR1					LIN2_RX	CAN0_0_TX			
P8.1	PWM0_20	PWM0_19_N	TC0_20_TR0	TC0_19_TR1					LIN2_TX	CAN0_0_RX		TRIG_IN[14]	
P8.2	PWM0_21	PWM0_20_N	TC0_21_TR0	TC0_20_TR1					LIN2_EN			TRIG_IN[15]	
P8.3	PWM0_22	PWM0_21_N	TC0_22_TR0	TC0_21_TR1									TRIG_DBG[0]
P8.4	PWM0_23	PWM0_22_N	TC0_23_TR0	TC0_22_TR1									TRIG_DBG[1]
P9.0	PWM0_24	PWM0_23_N	TC0_24_TR0	TC0_23_TR1									
P9.1	PWM0_25	PWM0_24_N	TC0_25_TR0	TC0_24_TR1									
P9.2	PWM0_26	PWM0_25_N	TC0_26_TR0	TC0_25_TR1									
P9.3	PWM0_27	PWM0_26_N	TC0_27_TR0	TC0_26_TR1									

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Table 13-1 Alternate pin functions in active Mode[28, 29] *(continued)*

Name	Active Mapping												
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15
P10.0	PWM0_28	PWM0_27_N	TC0_28_TR0	TC0_27_TR1		SCB4_RX (1)		SCB4_MISO (1)				TRIG_IN[18]	
P10.1	PWM0_29	PWM0_28_N	TC0_29_TR0	TC0_28_TR1		SCB4_TX (1)	SCB4_SDA (1)	SCB4_MOSI (1)				TRIG_IN[19]	
P10.2	PWM0_30	PWM0_29_N	TC0_30_TR0	TC0_29_TR1		SCB4_RTS (1)	SCB4_SCL (1)	SCB4_CLK (1)	LIN8_RX				
P10.3	PWM0_31	PWM0_30_N	TC0_31_TR0	TC0_30_TR1		SCB4_CTS (1)		SCB4_SEL0 (1)	LIN8_TX				
P10.4	PWM0_32	PWM0_31_N	TC0_32_TR0	TC0_31_TR1				SCB4_SEL1 (1)	LIN8_EN				
P10.5	PWM0_33	PWM0_32_N	TC0_33_TR0	TC0_32_TR1				SCB4_SEL2 (1)			CXPI0_RX		
P10.6	PWM0_34	PWM0_33_N	TC0_34_TR0	TC0_33_TR1							CXPI0_TX		
P10.7	PWM0_35	PWM0_34_N	TC0_35_TR0	TC0_34_TR1							CXPI0_EN		
P11.0													
P11.1													
P11.2													
P12.0	PWM0_36	PWM0_35_N	TC0_36_TR0	TC0_35_TR1						CAN0_2_TX		TRIG_IN[20]	
P12.1	PWM0_37	PWM0_36_N	TC0_37_TR0	TC0_36_TR1					LIN6_EN	CAN0_2_RX		TRIG_IN[21]	
P12.2	PWM0_38	PWM0_37_N	TC0_38_TR0	TC0_37_TR1	EXT_MUX[1]_EN				LIN6_RX				
P12.3	PWM0_39	PWM0_38_N	TC0_39_TR0	TC0_38_TR1	EXT_MUX[1]_0				LIN6_TX				
P12.4	PWM0_40	PWM0_39_N	TC0_40_TR0	TC0_39_TR1	EXT_MUX[1]_1								
P12.5	PWM0_41	PWM0_40_N	TC0_41_TR0	TC0_40_TR1	EXT_MUX[1]_2								
P12.6	PWM0_42	PWM0_41_N	TC0_42_TR0	TC0_41_TR1									
P12.7	PWM0_43	PWM0_42_N	TC0_43_TR0	TC0_42_TR1									
P13.0	PWM0_M_8	PWM0_43_N	TC0_M_8_TR0	TC0_43_TR1	EXT_MUX[2]_0	SCB3_RX (0)		SCB3_MISO (0)	LIN3_RX		CXPI1_RX		
P13.1	PWM0_44	PWM0_M_8_N	TC0_44_TR0	TC0_M_8_TR1	EXT_MUX[2]_1	SCB3_TX (0)	SCB3_SDA (0)	SCB3_MOSI (0)	LIN3_TX		CXPI1_TX		
P13.2	PWM0_M_9	PWM0_44_N	TC0_M_9_TR0	TC0_44_TR1	EXT_MUX[2]_2	SCB3_RTS (0)	SCB3_SCL (0)	SCB3_CLK (0)	LIN3_EN		CXPI1_EN		
P13.3	PWM0_45	PWM0_M_9_N	TC0_45_TR0	TC0_M_9_TR1	EXT_MUX[2]_EN	SCB3_CTS (0)		SCB3_SEL0 (0)					
P13.4	PWM0_M_10	PWM0_45_N	TC0_M_10_TR0	TC0_45_TR1	PWM0_H_4			SCB3_SEL1 (0)	LIN8_RX				
P13.5	PWM0_46	PWM0_M_10_N	TC0_46_TR0	TC0_M_10_TR1	PWM0_H_4_N			SCB3_SEL2 (0)	LIN8_TX		CXPI2_RX		
P13.6	PWM0_M_11	PWM0_46_N	TC0_M_11_TR0	TC0_46_TR1	PWM0_H_5			SCB3_SEL3 (0)	LIN8_EN		CXPI2_TX	TRIG_IN[22]	
P13.7	PWM0_47	PWM0_M_11_N	TC0_47_TR0	TC0_M_11_TR1	PWM0_H_5_N						CXPI2_EN	TRIG_IN[23]	
P14.0	PWM0_48	PWM0_47_N	TC0_48_TR0	TC0_47_TR1	PWM0_H_6	SCB2_RX (0)		SCB2_MISO (0)		CAN1_0_TX			
P14.1	PWM0_49	PWM0_48_N	TC0_49_TR0	TC0_48_TR1	PWM0_H_6_N	SCB2_TX (0)	SCB2_SDA (0)	SCB2_MOSI (0)		CAN1_0_RX			
P14.2	PWM0_50	PWM0_49_N	TC0_50_TR0	TC0_49_TR1	PWM0_H_7	SCB2_RTS (0)	SCB2_SCL (0)	SCB2_CLK (0)	LIN6_RX				
P14.3	PWM0_51	PWM0_50_N	TC0_51_TR0	TC0_50_TR1	PWM0_H_7_N	SCB2_CTS (0)		SCB2_SEL0 (0)	LIN6_TX				

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Table 13-1 Alternate pin functions in active Mode[28, 29] *(continued)*

Name	Active Mapping												
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15
P14.4	PWM0_52	PWM0_51_N	TC0_52_TR0	TC0_51_TR1	TC0_H_4_TR0			SCB2_SEL1 (0)	LIN6_EN				
P14.5	PWM0_53	PWM0_52_N	TC0_53_TR0	TC0_52_TR1	TC0_H_4_TR1			SCB2_SEL2 (0)			CXPI2_RX		
P14.6	PWM0_54	PWM0_53_N	TC0_54_TR0	TC0_53_TR1	TC0_H_5_TR0						CXPI2_TX	TRIG_IN[24]	
P14.7	PWM0_55	PWM0_54_N	TC0_55_TR0	TC0_54_TR1	TC0_H_5_TR1						CXPI2_EN	TRIG_IN[25]	
P15.0	PWM0_56	PWM0_55_N	TC0_56_TR0	TC0_55_TR1	TC0_H_6_TR0					CAN1_3_TX	CXPI1_RX		
P15.1	PWM0_57	PWM0_56_N	TC0_57_TR0	TC0_56_TR1	TC0_H_6_TR1					CAN1_3_RX	CXPI1_TX		
P15.2	PWM0_58	PWM0_57_N	TC0_58_TR0	TC0_57_TR1	TC0_H_7_TR0						CXPI1_EN		
P15.3	PWM0_59	PWM0_58_N	TC0_59_TR0	TC0_58_TR1	TC0_H_7_TR1								
P16.0	PWM0_60	PWM0_59_N	TC0_60_TR0	TC0_59_TR1	PWM0_H_0				LIN11_RX				
P16.1	PWM0_61	PWM0_60_N	TC0_61_TR0	TC0_60_TR1	PWM0_H_0_N				LIN11_TX				
P16.2	PWM0_62	PWM0_61_N	TC0_62_TR0	TC0_61_TR1	PWM0_H_1				LIN11_EN				
P16.3	PWM0_62	PWM0_62_N	TC0_62_TR0	TC0_62_TR1	PWM0_H_1_N								
P17.0	PWM0_61	PWM0_62_N	TC0_61_TR0	TC0_62_TR1						CAN1_1_TX			
P17.1	PWM0_60	PWM0_61_N	TC0_60_TR0	TC0_61_TR1	PWM0_H_2	SCB3_RX (1)		SCB3_MISO (1)		CAN1_1_RX			
P17.2	PWM0_59	PWM0_60_N	TC0_59_TR0	TC0_60_TR1	PWM0_H_2_N	SCB3_TX (1)	SCB3_SDA (1)	SCB3_MOSI (1)					
P17.3	PWM0_58	PWM0_59_N	TC0_58_TR0	TC0_59_TR1	PWM0_H_3	SCB3_RTS (1)	SCB3_SCL (1)	SCB3_CLK (1)				TRIG_IN[26]	
P17.4	PWM0_57	PWM0_58_N	TC0_57_TR0	TC0_58_TR1	PWM0_H_3_N	SCB3_CTS (1)		SCB3_SEL0 (1)				TRIG_IN[27]	
P17.5	PWM0_56	PWM0_57_N	TC0_56_TR0	TC0_57_TR1				SCB3_SEL1 (1)					
P17.6	PWM0_M_4	PWM0_56_N	TC0_M_4_TR0	TC0_56_TR1				SCB3_SEL2 (1)					
P17.7	PWM0_M_5	PWM0_M_4_N	TC0_M_5_TR0	TC0_M_4_TR1									
P18.0	PWM0_M_6	PWM0_M_5_N	TC0_M_6_TR0	TC0_M_5_TR1	PWM0_H_0	SCB1_RX (0)		SCB1_MISO (0)					FAULT_OUT_0
P18.1	PWM0_M_7	PWM0_M_6_N	TC0_M_7_TR0	TC0_M_6_TR1	PWM0_H_0_N	SCB1_TX (0)	SCB1_SDA (0)	SCB1_MOSI (0)					FAULT_OUT_1
P18.2	PWM0_55	PWM0_M_7_N	TC0_55_TR0	TC0_M_7_TR1	PWM0_H_1	SCB1_RTS (0)	SCB1_SCL (0)	SCB1_CLK (0)					
P18.3	PWM0_54	PWM0_55_N	TC0_54_TR0	TC0_55_TR1	PWM0_H_1_N	SCB1_CTS (0)		SCB1_SEL0 (0)					TRACE_CLOCK (0)
P18.4	PWM0_53	PWM0_54_N	TC0_53_TR0	TC0_54_TR1	PWM0_H_2			SCB1_SEL1 (0)					TRACE_DATA_0 (0)
P18.5	PWM0_52	PWM0_53_N	TC0_52_TR0	TC0_53_TR1	PWM0_H_2_N			SCB1_SEL2 (0)					TRACE_DATA_1 (0)
P18.6	PWM0_51	PWM0_52_N	TC0_51_TR0	TC0_52_TR1	PWM0_H_3			SCB1_SEL3 (0)		CAN1_2_TX			TRACE_DATA_2 (0)
P18.7	PWM0_50	PWM0_51_N	TC0_50_TR0	TC0_51_TR1	PWM0_H_3_N					CAN1_2_RX			TRACE_DATA_3 (0)
P19.0	PWM0_M_3	PWM0_50_N	TC0_M_3_TR0	TC0_50_TR1	TC0_H_0_TR0	SCB2_RX (1)		SCB2_MISO (1)		CAN1_3_TX			FAULT_OUT_2
P19.1	PWM0_26	PWM0_M_3_N	TC0_26_TR0	TC0_M_3_TR1	TC0_H_0_TR1	SCB2_TX (1)	SCB2_SDA (1)	SCB2_MOSI (1)		CAN1_3_RX	CXPI3_RX		FAULT_OUT_3
P19.2	PWM0_27	PWM0_26_N	TC0_27_TR0	TC0_26_TR1	TC0_H_1_TR0	SCB2_RTS (1)	SCB2_SCL (1)	SCB2_CLK (1)			CXPI3_TX	TRIG_IN[28]	

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Table 13-1 Alternate pin functions in active Mode[28, 29] *(continued)*

Name	Active Mapping												
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15
P19.3	PWM0_28	PWM0_27_N	TC0_28_TR0	TC0_27_TR1	TC0_H_1_TR1	SCB2_CTS (1)		SCB2_SEL0 (1)			CXPI3_EN	TRIG_IN[29]	
P19.4	PWM0_29	PWM0_28_N	TC0_29_TR0	TC0_28_TR1	TC0_H_2_TR0			SCB2_SEL1 (1)					
P20.0	PWM0_30	PWM0_29_N	TC0_30_TR0	TC0_29_TR1	TC0_H_2_TR1			SCB2_SEL2 (1)	LIN5_RX				
P20.1	PWM0_49	PWM0_30_N	TC0_49_TR0	TC0_30_TR1	TC0_H_3_TR0				LIN5_TX				
P20.2	PWM0_48	PWM0_49_N	TC0_48_TR0	TC0_49_TR1	TC0_H_3_TR1				LIN5_EN				
P20.3	PWM0_47	PWM0_48_N	TC0_47_TR0	TC0_48_TR1		SCB1_RX (1)		SCB1_MISO (1)		CAN1_2_TX			
P20.4	PWM0_46	PWM0_47_N	TC0_46_TR0	TC0_47_TR1		SCB1_TX (1)	SCB1_SDA (1)	SCB1_MOSI (1)		CAN1_2_RX			
P20.5	PWM0_45	PWM0_46_N	TC0_45_TR0	TC0_46_TR1		SCB1_RTS (1)	SCB1_SCL (1)	SCB1_CLK (1)			CXPI3_RX		
P20.6	PWM0_44	PWM0_45_N	TC0_44_TR0	TC0_45_TR1		SCB1_CTS (1)		SCB1_SEL0 (1)			CXPI3_TX		
P20.7	PWM0_43	PWM0_44_N	TC0_43_TR0	TC0_44_TR1				SCB1_SEL1 (1)			CXPI3_EN		
P21.0	PWM0_42	PWM0_43_N	TC0_42_TR0	TC0_43_TR1				SCB1_SEL2 (1)					
P21.1	PWM0_41	PWM0_42_N	TC0_41_TR0	TC0_42_TR1									
P21.2	PWM0_40	PWM0_41_N	TC0_40_TR0	TC0_41_TR1								EXT_CLK	TRIG_DBG[1]
P21.3	PWM0_39	PWM0_40_N	TC0_39_TR0	TC0_40_TR1									
P21.4	PWM0_38	PWM0_39_N	TC0_38_TR0	TC0_39_TR1									
P21.5	PWM0_37	PWM0_38_N	TC0_37_TR0	TC0_38_TR1					LIN0_RX				
P21.6	PWM0_36	PWM0_37_N	TC0_36_TR0	TC0_37_TR1					LIN0_TX				
P21.7	PWM0_35	PWM0_36_N	TC0_35_TR0	TC0_36_TR1					LIN0_EN				CAL_SUP_NZ
P22.0	PWM0_34	PWM0_35_N	TC0_34_TR0	TC0_35_TR1		SCB6_RX (1)		SCB6_MISO (1)		CAN1_1_TX			TRACE_DATA_0 (1)
P22.1	PWM0_33	PWM0_34_N	TC0_33_TR0	TC0_34_TR1		SCB6_TX (1)	SCB6_SDA (1)	SCB6_MOSI (1)		CAN1_1_RX			TRACE_DATA_1 (1)
P22.2	PWM0_32	PWM0_33_N	TC0_32_TR0	TC0_33_TR1		SCB6_RTS (1)	SCB6_SCL (1)	SCB6_CLK (1)					TRACE_DATA_2 (1)
P22.3	PWM0_31	PWM0_32_N	TC0_31_TR0	TC0_32_TR1		SCB6_CTS (1)		SCB6_SEL0 (1)					TRACE_DATA_3 (1)
P22.4	PWM0_30	PWM0_31_N	TC0_30_TR0	TC0_31_TR1				SCB6_SEL1 (1)					TRACE_CLOCK (1)
P22.5	PWM0_29	PWM0_30_N	TC0_29_TR0	TC0_30_TR1				SCB6_SEL2 (1)	LIN7_RX				
P22.6	PWM0_28	PWM0_29_N	TC0_28_TR0	TC0_29_TR1					LIN7_TX				
P22.7	PWM0_27	PWM0_28_N	TC0_27_TR0	TC0_28_TR1					LIN7_EN				
P23.0	PWM0_M_8	PWM0_27_N	TC0_M_8_TR0	TC0_27_TR1		SCB7_RX (1)		SCB7_MISO (1)		CAN1_0_TX			FAULT_OUT_0
P23.1	PWM0_M_9	PWM0_M_8_N	TC0_M_9_TR0	TC0_M_8_TR1		SCB7_TX (1)	SCB7_SDA (1)	SCB7_MOSI (1)		CAN1_0_RX			FAULT_OUT_1
P23.2	PWM0_M_10	PWM0_M_9_N	TC0_M_10_TR0	TC0_M_9_TR1		SCB7_RTS (1)	SCB7_SCL (1)	SCB7_CLK (1)					FAULT_OUT_2
P23.3	PWM0_M_11	PWM0_M_10_N	TC0_M_11_TR0	TC0_M_10_TR1		SCB7_CTS (1)		SCB7_SEL0 (1)				TRIG_IN[30]	FAULT_OUT_3
P23.4	PWM0_25	PWM0_M_11_N	TC0_25_TR0	TC0_M_11_TR1				SCB7_SEL1 (1)				TRIG_IN[31]	TRIG_DBG[0]

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Table 13-1 Alternate pin functions in active Mode[28, 29] *(continued)*

Name	Active Mapping																			
	HCon#8[26]	HCon#9	HCon#10	HCon#11	HCon#16	HCon#17	HCon#18	HCon#19	HCon#20	HCon#21	HCon#22	HCon#26	HCon#27							
	ACT#0[27]	ACT#1	ACT#2	ACT#3	ACT#4	ACT#5	ACT#6	ACT#7	ACT#8	ACT#9	ACT#10	ACT#14	ACT#15							
P23.5	PWM0_24	PWM0_25_N	TCO_24_TR0	TCO_25_TR1				SCB7_SEL2 (1)	LIN9_RX											
P23.6	PWM0_23	PWM0_24_N	TCO_23_TR0	TCO_24_TR1					LIN9_TX											
P23.7	PWM0_22	PWM0_23_N	TCO_22_TR0	TCO_23_TR1					LIN9_EN			EXT_CLK	CAL_SUP_NZ							

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Table 13-2 Pin Mux Descriptions

Sl. No.	Pin	Module	Description
1	PWMx_y	TCPWM	TCPWM 16-bit PWM (no motor control), PWM_DT and PWM_PR line out, x-TCPWM block, y-counter number
2	PWMx_y_N	TCPWM	TCPWM 16-bit PWM (no motor control), PWM_DT and PWM_PR complementary line out (N), x-TCPWM block, y-counter number
3	PWMx_M_y	TCPWM	TCPWM 16-bit PWM with motor control line out, x-TCPWM block, y-counter number
4	PWMx_M_y_N	TCPWM	TCPWM 16-bit PWM with motor control complementary line out (N), x-TCPWM block, y-counter number
5	PWMx_H_y	TCPWM	TCPWM 32-bit PWM, PWM_DT and PWM_PR line out, x-TCPWM block, y-counter number
6	PWMx_H_y_N	TCPWM	TCPWM 32-bit PWM, PWM_DT and PWM_PR complementary line out (N), x-TCPWM block, y-counter number
7	TCx_y_TRz	TCPWM	TCPWM 16-bit dedicated counter input triggers, x-TCPWM block, y-counter number, z-trigger number
8	TCx_M_y_TRz	TCPWM	TCPWM 16-bit dedicated counter input triggers with motor control, x-TCPWM block, y-counter number, z-trigger number
9	TCx_H_y_TRz	TCPWM	TCPWM 32-bit dedicated counter input triggers, x-TCPWM block, y-counter number, z-trigger number
10	SCBx_RX	SCB	UART Receive, x-SCB block
11	SCBx_TX	SCB	UART Transmit, x-SCB block
12	SCBx_RTS	SCB	UART Request to Send (Handshake), x-SCB block
13	SCBx_CTS	SCB	UART Clear to Send (Handshake), x-SCB block
14	SCBx_SDA	SCB	I2C Data line, x-SCB block
15	SCBx_SCL	SCB	I2C Clock line, x-SCB block
16	SCBx_MISO	SCB	SPI Master Input Slave Output, x-SCB block
17	SCBx_MOSI	SCB	SPI Master Output Slave Input, x-SCB block
18	SCBx_CLK	SCB	SPI Serial Clock, x-SCB block
19	SCBx_SELy	SCB	SPI Slave Select, x-SCB block, y-select line
20	LINx_RX	LIN	LIN Receive line, x-LIN block
21	LINx_TX	LIN	LIN Transmit line, x-LIN block
22	LINx_EN	LIN	LIN Enable line, x-LIN block
23	CXPI0_RX	CXPI	CXPI Receive line, x-CXPI block
24	CXPI0_TX	CXPI	CXPI Transmit line, x-CXPI block
25	CXPI0_EN	CXPI	CXPI Enable line, x-CXPI block
26	CANx_y_TX	CAN FD	CAN Transmit line, x-CAN block, y-channel number
27	CANx_y_RX	CAN FD	CAN Receive line, x-CAN block, y-channel number
28	CAL_SUP_NZ	CPUSS	ETAS Calibration support line
29	FAULT_OUT_x	SRSS	Fault output line x-0 to 3
30	TRACE_DATA_x	SRSS	Trace data out line x-0 to 3
31	TRACE_CLOCK	SRSS	Trace clock line
32	RTC_CAL	SRSS RTC	RTC calibration clock input
33	SWJ_TRSTN	SRSS	JTAG Test reset line (Active low)

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Table 13-2 Pin Mux Descriptions *(continued)*

Sl. No.	Pin	Module	Description
34	SWJ_SWO_TDO	SRSS	JTAG Test data output/SWO (Serial Wire Output)
35	SWJ_SWCLK_TCLK	SRSS	JTAG Test clock/SWD clock (Serial Wire Clock)
36	SWJ_SWDIO_TMS	SRSS	JTAG Test mode select/SWD data (Serial Wire Data Input/Output)
37	SWJ_SWDOE_TDI	SRSS	JTAG Test data input
38	HIBERNATE_WAKEUP[x]	SRSS	Hibernate wakeup line x-0 to 1
39	ADC[x]_y	PASS SAR	SAR, channel, x-SAR number, y-channel number
40	ADC[x]_M	PASS SAR	SAR motor control input, x-SAR number
41	EXT_MUX[x]_y	PASS SAR	External SAR MUX inputs, x-MUX number, y-MUX input 0 to 2
42	EXT_MUX[x]_EN	PASS SAR	External SAR MUX enable line

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14 Interrupts and wake-up assignments

Table 14-1 Peripheral interrupt assignments and wake-up sources

Interrupt	Source	Power Mode	Description
0	cpuss_interrupts_ipc_0_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #0
1	cpuss_interrupts_ipc_1_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #1
2	cpuss_interrupts_ipc_2_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #2
3	cpuss_interrupts_ipc_3_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #3
4	cpuss_interrupts_ipc_4_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #4
5	cpuss_interrupts_ipc_5_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #5
6	cpuss_interrupts_ipc_6_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #6
7	cpuss_interrupts_ipc_7_IRQn	DeepSleep	CPUSS Inter Process Communication Interrupt #7
8	cpuss_interrupts_fault_0_IRQn	DeepSleep	CPUSS Fault Structure #0 Interrupt
9	cpuss_interrupts_fault_1_IRQn	DeepSleep	CPUSS Fault Structure #1 Interrupt
10	cpuss_interrupts_fault_2_IRQn	DeepSleep	CPUSS Fault Structure #2 Interrupt
11	cpuss_interrupts_fault_3_IRQn	DeepSleep	CPUSS Fault Structure #3 Interrupt
12	srss_interrupt_backup_IRQn	DeepSleep	BACKUP domain Interrupt
13	srss_interrupt_mcwdt_0_IRQn	DeepSleep	Multi Counter Watchdog Timer #0 interrupt
14	srss_interrupt_mcwdt_1_IRQn	DeepSleep	Multi Counter Watchdog Timer #1 interrupt
15	srss_interrupt_wdt_IRQn	DeepSleep	Hardware Watchdog Timer interrupt
16	srss_interrupt_IRQn	DeepSleep	Other combined Interrupts for SRSS (LVD, CLK_CAL)
17	scb_0_interrupt_IRQn	DeepSleep	Serial Communication Block #0 (DeepSleep capable)
18	evtgen_0_interrupt_dpslp_IRQn	DeepSleep	Event gen DeepSleep domain interrupt
19	ioss_interrupt_vdd_IRQn	DeepSleep	I/O Supply (V_{DDIO}, V_{DDA}, V_{DDD}) state change Interrupt
20	ioss_interrupt_gpio_IRQn	DeepSleep	Consolidated Interrupt for GPIO_STD and GPIO_ENH, All Ports
21	ioss_interrupts_gpio_0_IRQn	DeepSleep	GPIO_ENH Port #0 Interrupt
22	ioss_interrupts_gpio_1_IRQn	DeepSleep	GPIO_STD Port #1 Interrupt
23	ioss_interrupts_gpio_2_IRQn	DeepSleep	GPIO_STD Port #2 Interrupt
24	ioss_interrupts_gpio_3_IRQn	DeepSleep	GPIO_STD Port #3 Interrupt
25	ioss_interrupts_gpio_4_IRQn	DeepSleep	GPIO_STD Port #4 Interrupt
26	ioss_interrupts_gpio_5_IRQn	DeepSleep	GPIO_STD Port #5 Interrupt
27	ioss_interrupts_gpio_6_IRQn	DeepSleep	GPIO_STD Port #6 Interrupt
28	ioss_interrupts_gpio_7_IRQn	DeepSleep	GPIO_STD Port #7 Interrupt
29	ioss_interrupts_gpio_8_IRQn	DeepSleep	GPIO_STD Port #8 Interrupt
30	ioss_interrupts_gpio_9_IRQn	DeepSleep	GPIO_STD Port #9 Interrupt
31	ioss_interrupts_gpio_10_IRQn	DeepSleep	GPIO_STD Port #10 Interrupt
32	ioss_interrupts_gpio_11_IRQn	DeepSleep	GPIO_STD Port #11 Interrupt
33	ioss_interrupts_gpio_12_IRQn	DeepSleep	GPIO_STD Port #12 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
34	ioss_interrupts_gpio_13_IRQn	DeepSleep	GPIO_STD Port #13 Interrupt
35	ioss_interrupts_gpio_14_IRQn	DeepSleep	GPIO_STD Port #14 Interrupt
36	ioss_interrupts_gpio_15_IRQn	DeepSleep	GPIO_STD Port #15 Interrupt
37	ioss_interrupts_gpio_16_IRQn	DeepSleep	GPIO_STD Port #16 Interrupt
38	ioss_interrupts_gpio_17_IRQn	DeepSleep	GPIO_STD Port #17 Interrupt
39	ioss_interrupts_gpio_18_IRQn	DeepSleep	GPIO_STD Port #18 Interrupt
40	ioss_interrupts_gpio_19_IRQn	DeepSleep	GPIO_STD Port #19 Interrupt
41	ioss_interrupts_gpio_20_IRQn	DeepSleep	GPIO_STD Port #20 Interrupt
42	ioss_interrupts_gpio_21_IRQn	DeepSleep	GPIO_STD Port #21 Interrupt
43	ioss_interrupts_gpio_22_IRQn	DeepSleep	GPIO_STD Port #22 Interrupt
44	ioss_interrupts_gpio_23_IRQn	DeepSleep	GPIO_STD Port #23 Interrupt
45	cpuss_interrupt_crypto_IRQn	Active	Crypto Accelerator Interrupt
46	cpuss_interrupt_fm_IRQn	Active	FLASH Macro Interrupt
47	cpuss_interrupts_cm4_fp_IRQn	Active	CM4 Floating Point operation fault
48	cpuss_interrupts_cm0_cti_0_IRQn	Active	CM0+ CTI (Cross Trigger Interface) #0
49	cpuss_interrupts_cm0_cti_1_IRQn	Active	CM0+ CTI #1
50	cpuss_interrupts_cm4_cti_0_IRQn	Active	CM4 CTI #0
51	cpuss_interrupts_cm4_cti_1_IRQn	Active	CM4 CTI #1
52	evtgen_0_interrupt_IRQn	Active	Event Generator Active domain interrupt
53	canfd_0_interrupt0_IRQn	Active	CAN0, Consolidated Interrupt #0 for all three channels
54	canfd_0_interrupt1_IRQn	Active	CAN0, Consolidated Interrupt #1 for all three channels
55	canfd_1_interrupt0_IRQn	Active	CAN1, Consolidated Interrupt #0 for all three channels
56	canfd_1_interrupt1_IRQn	Active	CAN1, Consolidated Interrupt #1 for all three channels
57	canfd_0_interrupts0_0_IRQn	Active	CAN0, Interrupt #0, Channel #0
58	canfd_0_interrupts0_1_IRQn	Active	CAN0, Interrupt #0, Channel #1
59	canfd_0_interrupts0_2_IRQn	Active	CAN0, Interrupt #0, Channel #2
60	canfd_0_interrupts0_3_IRQn	Active	CAN0, Interrupt #0, Channel #3
61	canfd_0_interrupts1_0_IRQn	Active	CAN0, Interrupt #1, Channel #0
62	canfd_0_interrupts1_1_IRQn	Active	CAN0, Interrupt #1, Channel #1
63	canfd_0_interrupts1_2_IRQn	Active	CAN0, Interrupt #1, Channel #2
64	canfd_0_interrupts1_3_IRQn	Active	CAN0, Interrupt #1, Channel #3
65	canfd_1_interrupts0_0_IRQn	Active	CAN1, Interrupt #0, Channel #0
66	canfd_1_interrupts0_1_IRQn	Active	CAN1, Interrupt #0, Channel #1
67	canfd_1_interrupts0_2_IRQn	Active	CAN1, Interrupt #0, Channel #2
68	canfd_1_interrupts0_3_IRQn	Active	CAN1, Interrupt #0, Channel #3
69	canfd_1_interrupts1_0_IRQn	Active	CAN1, Interrupt #1, Channel #0
70	canfd_1_interrupts1_1_IRQn	Active	CAN1, Interrupt #1, Channel #1
71	canfd_1_interrupts1_2_IRQn	Active	CAN1, Interrupt #1, Channel #2

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
72	canfd_1_interrupts1_3_IRQn	Active	CAN1, Interrupt #1, Channel #3
73	lin_0_interrupts_0_IRQn	Active	LIN0, Channel #0 Interrupt
74	lin_0_interrupts_1_IRQn	Active	LIN0, Channel #1 Interrupt
75	lin_0_interrupts_2_IRQn	Active	LIN0, Channel #2 Interrupt
76	lin_0_interrupts_3_IRQn	Active	LIN0, Channel #3 Interrupt
77	lin_0_interrupts_4_IRQn	Active	LIN0, Channel #4 Interrupt
78	lin_0_interrupts_5_IRQn	Active	LIN0, Channel #5 Interrupt
79	lin_0_interrupts_6_IRQn	Active	LIN0, Channel #6 Interrupt
80	lin_0_interrupts_7_IRQn	Active	LIN0, Channel #7 Interrupt
81	lin_0_interrupts_8_IRQn	Active	LIN0, Channel #8 Interrupt
82	lin_0_interrupts_9_IRQn	Active	LIN0, Channel #9 Interrupt
83	lin_0_interrupts_10_IRQn	Active	LIN0, Channel #10 Interrupt
84	lin_0_interrupts_11_IRQn	Active	LIN0, Channel #11 Interrupt
85	cxpi_0_interrupts_0_IRQn	Active	CXPI0 Channel #0 Interrupt
86	cxpi_0_interrupts_1_IRQn	Active	CXPI0 Channel #1 Interrupt
87	cxpi_0_interrupts_2_IRQn	Active	CXPI0 Channel #2 Interrupt
88	cxpi_0_interrupts_3_IRQn	Active	CXPI0 Channel #3 Interrupt
89	scb_1_interrupt_IRQn	Active	SCB1 Interrupt
90	scb_2_interrupt_IRQn	Active	SCB2 Interrupt
91	scb_3_interrupt_IRQn	Active	SCB3 Interrupt
92	scb_4_interrupt_IRQn	Active	SCB4 Interrupt
93	scb_5_interrupt_IRQn	Active	SCB5 Interrupt
94	scb_6_interrupt_IRQn	Active	SCB6 Interrupt
95	scb_7_interrupt_IRQn	Active	SCB7 Interrupt
96	pass_0_interrupts_sar_0_IRQn	Active	SAR0, Logical Channel #0 Interrupt
97	pass_0_interrupts_sar_1_IRQn	Active	SAR0, Logical Channel #1 Interrupt
98	pass_0_interrupts_sar_2_IRQn	Active	SAR0, Logical Channel #2 Interrupt
99	pass_0_interrupts_sar_3_IRQn	Active	SAR0, Logical Channel #3 Interrupt
100	pass_0_interrupts_sar_4_IRQn	Active	SAR0, Logical Channel #4 Interrupt
101	pass_0_interrupts_sar_5_IRQn	Active	SAR0, Logical Channel #5 Interrupt
102	pass_0_interrupts_sar_6_IRQn	Active	SAR0, Logical Channel #6 Interrupt
103	pass_0_interrupts_sar_7_IRQn	Active	SAR0, Logical Channel #7 Interrupt
104	pass_0_interrupts_sar_8_IRQn	Active	SAR0, Logical Channel #8 Interrupt
105	pass_0_interrupts_sar_9_IRQn	Active	SAR0, Logical Channel #9 Interrupt
106	pass_0_interrupts_sar_10_IRQn	Active	SAR0, Logical Channel #10 Interrupt
107	pass_0_interrupts_sar_11_IRQn	Active	SAR0, Logical Channel #11 Interrupt
108	pass_0_interrupts_sar_12_IRQn	Active	SAR0, Logical Channel #12 Interrupt
109	pass_0_interrupts_sar_13_IRQn	Active	SAR0, Logical Channel #13 Interrupt
110	pass_0_interrupts_sar_14_IRQn	Active	SAR0, Logical Channel #14 Interrupt
111	pass_0_interrupts_sar_15_IRQn	Active	SAR0, Logical Channel #15 Interrupt
112	pass_0_interrupts_sar_16_IRQn	Active	SAR0, Logical Channel #16 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
113	pass_0_interrupts_sar_17_IRQn	Active	SAR0, Logical Channel #17 Interrupt
114	pass_0_interrupts_sar_18_IRQn	Active	SAR0, Logical Channel #18 Interrupt
115	pass_0_interrupts_sar_19_IRQn	Active	SAR0, Logical Channel #19 Interrupt
116	pass_0_interrupts_sar_20_IRQn	Active	SAR0, Logical Channel #20 Interrupt
117	pass_0_interrupts_sar_21_IRQn	Active	SAR0, Logical Channel #21 Interrupt
118	pass_0_interrupts_sar_22_IRQn	Active	SAR0, Logical Channel #22 Interrupt
119	pass_0_interrupts_sar_23_IRQn	Active	SAR0, Logical Channel #23 Interrupt
120	pass_0_interrupts_sar_32_IRQn	Active	SAR1, Logical Channel #0 Interrupt
121	pass_0_interrupts_sar_33_IRQn	Active	SAR1, Logical Channel #1 Interrupt
122	pass_0_interrupts_sar_34_IRQn	Active	SAR1, Logical Channel #2 Interrupt
123	pass_0_interrupts_sar_35_IRQn	Active	SAR1, Logical Channel #3 Interrupt
124	pass_0_interrupts_sar_36_IRQn	Active	SAR1, Logical Channel #4 Interrupt
125	pass_0_interrupts_sar_37_IRQn	Active	SAR1, Logical Channel #5 Interrupt
126	pass_0_interrupts_sar_38_IRQn	Active	SAR1, Logical Channel #6 Interrupt
127	pass_0_interrupts_sar_39_IRQn	Active	SAR1, Logical Channel #7 Interrupt
128	pass_0_interrupts_sar_40_IRQn	Active	SAR1, Logical Channel #8 Interrupt
129	pass_0_interrupts_sar_41_IRQn	Active	SAR1, Logical Channel #9 Interrupt
130	pass_0_interrupts_sar_42_IRQn	Active	SAR1, Logical Channel #10 Interrupt
131	pass_0_interrupts_sar_43_IRQn	Active	SAR1, Logical Channel #11 Interrupt
132	pass_0_interrupts_sar_44_IRQn	Active	SAR1, Logical Channel #12 Interrupt
133	pass_0_interrupts_sar_45_IRQn	Active	SAR1, Logical Channel #13 Interrupt
134	pass_0_interrupts_sar_46_IRQn	Active	SAR1, Logical Channel #14 Interrupt
135	pass_0_interrupts_sar_47_IRQn	Active	SAR1, Logical Channel #15 Interrupt
136	pass_0_interrupts_sar_48_IRQn	Active	SAR1, Logical Channel #16 Interrupt
137	pass_0_interrupts_sar_49_IRQn	Active	SAR1, Logical Channel #17 Interrupt
138	pass_0_interrupts_sar_50_IRQn	Active	SAR1, Logical Channel #18 Interrupt
139	pass_0_interrupts_sar_51_IRQn	Active	SAR1, Logical Channel #19 Interrupt
140	pass_0_interrupts_sar_52_IRQn	Active	SAR1, Logical Channel #20 Interrupt
141	pass_0_interrupts_sar_53_IRQn	Active	SAR1, Logical Channel #21 Interrupt
142	pass_0_interrupts_sar_54_IRQn	Active	SAR1, Logical Channel #22 Interrupt
143	pass_0_interrupts_sar_55_IRQn	Active	SAR1, Logical Channel #23 Interrupt
144	pass_0_interrupts_sar_56_IRQn	Active	SAR1, Logical Channel #24 Interrupt
145	pass_0_interrupts_sar_57_IRQn	Active	SAR1, Logical Channel #25 Interrupt
146	pass_0_interrupts_sar_58_IRQn	Active	SAR1, Logical Channel #26 Interrupt
147	pass_0_interrupts_sar_59_IRQn	Active	SAR1, Logical Channel #27 Interrupt
148	pass_0_interrupts_sar_60_IRQn	Active	SAR1, Logical Channel #28 Interrupt
149	pass_0_interrupts_sar_61_IRQn	Active	SAR1, Logical Channel #29 Interrupt
150	pass_0_interrupts_sar_62_IRQn	Active	SAR1, Logical Channel #30 Interrupt
151	pass_0_interrupts_sar_63_IRQn	Active	SAR1, Logical Channel #31 Interrupt
152	pass_0_interrupts_sar_64_IRQn	Active	SAR2, Logical Channel #0 Interrupt
153	pass_0_interrupts_sar_65_IRQn	Active	SAR2, Logical Channel #1 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
154	pass_0_interrupts_sar_66_IRQn	Active	SAR2, Logical Channel #2 Interrupt
155	pass_0_interrupts_sar_67_IRQn	Active	SAR2, Logical Channel #3 Interrupt
156	pass_0_interrupts_sar_68_IRQn	Active	SAR2, Logical Channel #4 Interrupt
157	pass_0_interrupts_sar_69_IRQn	Active	SAR2, Logical Channel #5 Interrupt
158	pass_0_interrupts_sar_70_IRQn	Active	SAR2, Logical Channel #6 Interrupt
159	pass_0_interrupts_sar_71_IRQn	Active	SAR2, Logical Channel #7 Interrupt
160	cpuss_interrupts_dmac_0_IRQn	Active	CPUSS M-DMA0, Channel #0 Interrupt
161	cpuss_interrupts_dmac_1_IRQn	Active	CPUSS M-DMA0, Channel #1 Interrupt
162	cpuss_interrupts_dmac_2_IRQn	Active	CPUSS M-DMA0, Channel #2 Interrupt
163	cpuss_interrupts_dmac_3_IRQn	Active	CPUSS M-DMA0, Channel #3 Interrupt
164	cpuss_interrupts_dw0_0_IRQn	Active	CPUSS P-DMA0, Channel #0 Interrupt
165	cpuss_interrupts_dw0_1_IRQn	Active	CPUSS P-DMA0, Channel #1 Interrupt
166	cpuss_interrupts_dw0_2_IRQn	Active	CPUSS P-DMA0, Channel #2 Interrupt
167	cpuss_interrupts_dw0_3_IRQn	Active	CPUSS P-DMA0, Channel #3 Interrupt
168	cpuss_interrupts_dw0_4_IRQn	Active	CPUSS P-DMA0, Channel #4 Interrupt
169	cpuss_interrupts_dw0_5_IRQn	Active	CPUSS P-DMA0, Channel #5 Interrupt
170	cpuss_interrupts_dw0_6_IRQn	Active	CPUSS P-DMA0, Channel #6 Interrupt
171	cpuss_interrupts_dw0_7_IRQn	Active	CPUSS P-DMA0, Channel #7 Interrupt
172	cpuss_interrupts_dw0_8_IRQn	Active	CPUSS P-DMA0, Channel #8 Interrupt
173	cpuss_interrupts_dw0_9_IRQn	Active	CPUSS P-DMA0, Channel #9 Interrupt
174	cpuss_interrupts_dw0_10_IRQn	Active	CPUSS P-DMA0, Channel #10 Interrupt
175	cpuss_interrupts_dw0_11_IRQn	Active	CPUSS P-DMA0, Channel #11 Interrupt
176	cpuss_interrupts_dw0_12_IRQn	Active	CPUSS P-DMA0, Channel #12 Interrupt
177	cpuss_interrupts_dw0_13_IRQn	Active	CPUSS P-DMA0, Channel #13 Interrupt
178	cpuss_interrupts_dw0_14_IRQn	Active	CPUSS P-DMA0, Channel #14 Interrupt
179	cpuss_interrupts_dw0_15_IRQn	Active	CPUSS P-DMA0, Channel #15 Interrupt
180	cpuss_interrupts_dw0_16_IRQn	Active	CPUSS P-DMA0, Channel #16 Interrupt
181	cpuss_interrupts_dw0_17_IRQn	Active	CPUSS P-DMA0, Channel #17 Interrupt
182	cpuss_interrupts_dw0_18_IRQn	Active	CPUSS P-DMA0, Channel #18 Interrupt
183	cpuss_interrupts_dw0_19_IRQn	Active	CPUSS P-DMA0, Channel #19 Interrupt
184	cpuss_interrupts_dw0_20_IRQn	Active	CPUSS P-DMA0, Channel #20 Interrupt
185	cpuss_interrupts_dw0_21_IRQn	Active	CPUSS P-DMA0, Channel #21 Interrupt
186	cpuss_interrupts_dw0_22_IRQn	Active	CPUSS P-DMA0, Channel #22 Interrupt
187	cpuss_interrupts_dw0_23_IRQn	Active	CPUSS P-DMA0, Channel #23 Interrupt
188	cpuss_interrupts_dw0_24_IRQn	Active	CPUSS P-DMA0, Channel #24 Interrupt
189	cpuss_interrupts_dw0_25_IRQn	Active	CPUSS P-DMA0, Channel #25 Interrupt
190	cpuss_interrupts_dw0_26_IRQn	Active	CPUSS P-DMA0, Channel #26 Interrupt
191	cpuss_interrupts_dw0_27_IRQn	Active	CPUSS P-DMA0, Channel #27 Interrupt
192	cpuss_interrupts_dw0_28_IRQn	Active	CPUSS P-DMA0, Channel #28 Interrupt
193	cpuss_interrupts_dw0_29_IRQn	Active	CPUSS P-DMA0, Channel #29 Interrupt
194	cpuss_interrupts_dw0_30_IRQn	Active	CPUSS P-DMA0, Channel #30 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
195	cpuss_interrupts_dw0_31_IRQn	Active	CPUSS P-DMA0, Channel #31 Interrupt
196	cpuss_interrupts_dw0_32_IRQn	Active	CPUSS P-DMA0, Channel #32 Interrupt
197	cpuss_interrupts_dw0_33_IRQn	Active	CPUSS P-DMA0, Channel #33 Interrupt
198	cpuss_interrupts_dw0_34_IRQn	Active	CPUSS P-DMA0, Channel #34 Interrupt
199	cpuss_interrupts_dw0_35_IRQn	Active	CPUSS P-DMA0, Channel #35 Interrupt
200	cpuss_interrupts_dw0_36_IRQn	Active	CPUSS P-DMA0, Channel #36 Interrupt
201	cpuss_interrupts_dw0_37_IRQn	Active	CPUSS P-DMA0, Channel #37 Interrupt
202	cpuss_interrupts_dw0_38_IRQn	Active	CPUSS P-DMA0, Channel #38 Interrupt
203	cpuss_interrupts_dw0_39_IRQn	Active	CPUSS P-DMA0, Channel #39 Interrupt
204	cpuss_interrupts_dw0_40_IRQn	Active	CPUSS P-DMA0, Channel #40 Interrupt
205	cpuss_interrupts_dw0_41_IRQn	Active	CPUSS P-DMA0, Channel #41 Interrupt
206	cpuss_interrupts_dw0_42_IRQn	Active	CPUSS P-DMA0, Channel #42 Interrupt
207	cpuss_interrupts_dw0_43_IRQn	Active	CPUSS P-DMA0, Channel #43 Interrupt
208	cpuss_interrupts_dw0_44_IRQn	Active	CPUSS P-DMA0, Channel #44 Interrupt
209	cpuss_interrupts_dw0_45_IRQn	Active	CPUSS P-DMA0, Channel #45 Interrupt
210	cpuss_interrupts_dw0_46_IRQn	Active	CPUSS P-DMA0, Channel #46 Interrupt
211	cpuss_interrupts_dw0_47_IRQn	Active	CPUSS P-DMA0, Channel #47 Interrupt
212	cpuss_interrupts_dw0_48_IRQn	Active	CPUSS P-DMA0, Channel #48 Interrupt
213	cpuss_interrupts_dw0_49_IRQn	Active	CPUSS P-DMA0, Channel #49 Interrupt
214	cpuss_interrupts_dw0_50_IRQn	Active	CPUSS P-DMA0, Channel #50 Interrupt
215	cpuss_interrupts_dw0_51_IRQn	Active	CPUSS P-DMA0, Channel #51 Interrupt
216	cpuss_interrupts_dw0_52_IRQn	Active	CPUSS P-DMA0, Channel #52 Interrupt
217	cpuss_interrupts_dw0_53_IRQn	Active	CPUSS P-DMA0, Channel #53 Interrupt
218	cpuss_interrupts_dw0_54_IRQn	Active	CPUSS P-DMA0, Channel #54 Interrupt
219	cpuss_interrupts_dw0_55_IRQn	Active	CPUSS P-DMA0, Channel #55 Interrupt
220	cpuss_interrupts_dw0_56_IRQn	Active	CPUSS P-DMA0, Channel #56 Interrupt
221	cpuss_interrupts_dw0_57_IRQn	Active	CPUSS P-DMA0, Channel #57 Interrupt
222	cpuss_interrupts_dw0_58_IRQn	Active	CPUSS P-DMA0, Channel #58 Interrupt
223	cpuss_interrupts_dw0_59_IRQn	Active	CPUSS P-DMA0, Channel #59 Interrupt
224	cpuss_interrupts_dw0_60_IRQn	Active	CPUSS P-DMA0, Channel #60 Interrupt
225	cpuss_interrupts_dw0_61_IRQn	Active	CPUSS P-DMA0, Channel #61 Interrupt
226	cpuss_interrupts_dw0_62_IRQn	Active	CPUSS P-DMA0, Channel #62 Interrupt
227	cpuss_interrupts_dw0_63_IRQn	Active	CPUSS P-DMA0, Channel #63 Interrupt
228	cpuss_interrupts_dw0_64_IRQn	Active	CPUSS P-DMA0, Channel #64 Interrupt
229	cpuss_interrupts_dw0_65_IRQn	Active	CPUSS P-DMA0, Channel #65 Interrupt
230	cpuss_interrupts_dw0_66_IRQn	Active	CPUSS P-DMA0, Channel #66 Interrupt
231	cpuss_interrupts_dw0_67_IRQn	Active	CPUSS P-DMA0, Channel #67 Interrupt
232	cpuss_interrupts_dw0_68_IRQn	Active	CPUSS P-DMA0, Channel #68 Interrupt
233	cpuss_interrupts_dw0_69_IRQn	Active	CPUSS P-DMA0, Channel #69 Interrupt
234	cpuss_interrupts_dw0_70_IRQn	Active	CPUSS P-DMA0, Channel #70 Interrupt
235	cpuss_interrupts_dw0_71_IRQn	Active	CPUSS P-DMA0, Channel #71 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
236	cpuss_interrupts_dw0_72_IRQn	Active	CPUSS P-DMA0, Channel #72 Interrupt
237	cpuss_interrupts_dw0_73_IRQn	Active	CPUSS P-DMA0, Channel #73 Interrupt
238	cpuss_interrupts_dw0_74_IRQn	Active	CPUSS P-DMA0, Channel #74 Interrupt
239	cpuss_interrupts_dw0_75_IRQn	Active	CPUSS P-DMA0, Channel #75 Interrupt
240	cpuss_interrupts_dw0_76_IRQn	Active	CPUSS P-DMA0, Channel #76 Interrupt
241	cpuss_interrupts_dw0_77_IRQn	Active	CPUSS P-DMA0, Channel #77 Interrupt
242	cpuss_interrupts_dw0_78_IRQn	Active	CPUSS P-DMA0, Channel #78 Interrupt
243	cpuss_interrupts_dw0_79_IRQn	Active	CPUSS P-DMA0, Channel #79 Interrupt
244	cpuss_interrupts_dw0_80_IRQn	Active	CPUSS P-DMA0, Channel #80 Interrupt
245	cpuss_interrupts_dw0_81_IRQn	Active	CPUSS P-DMA0, Channel #81 Interrupt
246	cpuss_interrupts_dw0_82_IRQn	Active	CPUSS P-DMA0, Channel #82 Interrupt
247	cpuss_interrupts_dw0_83_IRQn	Active	CPUSS P-DMA0, Channel #83 Interrupt
248	cpuss_interrupts_dw0_84_IRQn	Active	CPUSS P-DMA0, Channel #84 Interrupt
249	cpuss_interrupts_dw0_85_IRQn	Active	CPUSS P-DMA0, Channel #85 Interrupt
250	cpuss_interrupts_dw0_86_IRQn	Active	CPUSS P-DMA0, Channel #86 Interrupt
251	cpuss_interrupts_dw0_87_IRQn	Active	CPUSS P-DMA0, Channel #87 Interrupt
252	cpuss_interrupts_dw0_88_IRQn	Active	CPUSS P-DMA0, Channel #88 Interrupt
253	cpuss_interrupts_dw0_89_IRQn	Active	CPUSS P-DMA0, Channel #89 Interrupt
254	cpuss_interrupts_dw0_90_IRQn	Active	CPUSS P-DMA0, Channel #90 Interrupt
255	cpuss_interrupts_dw0_91_IRQn	Active	CPUSS P-DMA0, Channel #91 Interrupt
256	cpuss_interrupts_dw1_0_IRQn	Active	CPUSS P-DMA1, Channel #0 Interrupt
257	cpuss_interrupts_dw1_1_IRQn	Active	CPUSS P-DMA1, Channel #1 Interrupt
258	cpuss_interrupts_dw1_2_IRQn	Active	CPUSS P-DMA1, Channel #2 Interrupt
259	cpuss_interrupts_dw1_3_IRQn	Active	CPUSS P-DMA1, Channel #3 Interrupt
260	cpuss_interrupts_dw1_4_IRQn	Active	CPUSS P-DMA1, Channel #4 Interrupt
261	cpuss_interrupts_dw1_5_IRQn	Active	CPUSS P-DMA1, Channel #5 Interrupt
262	cpuss_interrupts_dw1_6_IRQn	Active	CPUSS P-DMA1, Channel #6 Interrupt
263	cpuss_interrupts_dw1_7_IRQn	Active	CPUSS P-DMA1, Channel #7 Interrupt
264	cpuss_interrupts_dw1_8_IRQn	Active	CPUSS P-DMA1, Channel #8 Interrupt
265	cpuss_interrupts_dw1_9_IRQn	Active	CPUSS P-DMA1, Channel #9 Interrupt
266	cpuss_interrupts_dw1_10_IRQn	Active	CPUSS P-DMA1, Channel #10 Interrupt
267	cpuss_interrupts_dw1_11_IRQn	Active	CPUSS P-DMA1, Channel #11 Interrupt
268	cpuss_interrupts_dw1_12_IRQn	Active	CPUSS P-DMA1, Channel #12 Interrupt
269	cpuss_interrupts_dw1_13_IRQn	Active	CPUSS P-DMA1, Channel #13 Interrupt
270	cpuss_interrupts_dw1_14_IRQn	Active	CPUSS P-DMA1, Channel #14 Interrupt
271	cpuss_interrupts_dw1_15_IRQn	Active	CPUSS P-DMA1, Channel #15 Interrupt
272	cpuss_interrupts_dw1_16_IRQn	Active	CPUSS P-DMA1, Channel #16 Interrupt
273	cpuss_interrupts_dw1_17_IRQn	Active	CPUSS P-DMA1, Channel #17 Interrupt
274	cpuss_interrupts_dw1_18_IRQn	Active	CPUSS P-DMA1, Channel #18 Interrupt
275	cpuss_interrupts_dw1_19_IRQn	Active	CPUSS P-DMA1, Channel #19 Interrupt
276	cpuss_interrupts_dw1_20_IRQn	Active	CPUSS P-DMA1, Channel #20 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
277	cpuss_interrupts_dw1_21_IRQn	Active	CPUSS P-DMA1, Channel #21 Interrupt
278	cpuss_interrupts_dw1_22_IRQn	Active	CPUSS P-DMA1, Channel #22 Interrupt
279	cpuss_interrupts_dw1_23_IRQn	Active	CPUSS P-DMA1, Channel #23 Interrupt
280	cpuss_interrupts_dw1_24_IRQn	Active	CPUSS P-DMA1, Channel #24 Interrupt
281	cpuss_interrupts_dw1_25_IRQn	Active	CPUSS P-DMA1, Channel #25 Interrupt
282	cpuss_interrupts_dw1_26_IRQn	Active	CPUSS P-DMA1, Channel #26 Interrupt
283	cpuss_interrupts_dw1_27_IRQn	Active	CPUSS P-DMA1, Channel #27 Interrupt
284	cpuss_interrupts_dw1_28_IRQn	Active	CPUSS P-DMA1, Channel #28 Interrupt
285	cpuss_interrupts_dw1_29_IRQn	Active	CPUSS P-DMA1, Channel #29 Interrupt
286	cpuss_interrupts_dw1_30_IRQn	Active	CPUSS P-DMA1, Channel #30 Interrupt
287	cpuss_interrupts_dw1_31_IRQn	Active	CPUSS P-DMA1, Channel #31 Interrupt
288	cpuss_interrupts_dw1_32_IRQn	Active	CPUSS P-DMA1, Channel #32 Interrupt
289	cpuss_interrupts_dw1_33_IRQn	Active	CPUSS P-DMA1, Channel #33 Interrupt
290	cpuss_interrupts_dw1_34_IRQn	Active	CPUSS P-DMA1, Channel #34 Interrupt
291	cpuss_interrupts_dw1_35_IRQn	Active	CPUSS P-DMA1, Channel #35 Interrupt
292	cpuss_interrupts_dw1_36_IRQn	Active	CPUSS P-DMA1, Channel #36 Interrupt
293	cpuss_interrupts_dw1_37_IRQn	Active	CPUSS P-DMA1, Channel #37 Interrupt
294	cpuss_interrupts_dw1_38_IRQn	Active	CPUSS P-DMA1, Channel #38 Interrupt
295	cpuss_interrupts_dw1_39_IRQn	Active	CPUSS P-DMA1, Channel #39 Interrupt
296	cpuss_interrupts_dw1_40_IRQn	Active	CPUSS P-DMA1, Channel #40 Interrupt
297	cpuss_interrupts_dw1_41_IRQn	Active	CPUSS P-DMA1, Channel #41 Interrupt
298	cpuss_interrupts_dw1_42_IRQn	Active	CPUSS P-DMA1, Channel #42 Interrupt
299	cpuss_interrupts_dw1_43_IRQn	Active	CPUSS P-DMA1, Channel #43 Interrupt
300	tcpwm_0_interrupts_0_IRQn	Active	TCPWM0 Group #0, Counter #0 Interrupt
301	tcpwm_0_interrupts_1_IRQn	Active	TCPWM0 Group #0, Counter #1 Interrupt
302	tcpwm_0_interrupts_2_IRQn	Active	TCPWM0 Group #0, Counter #2 Interrupt
303	tcpwm_0_interrupts_3_IRQn	Active	TCPWM0 Group #0, Counter #3 Interrupt
304	tcpwm_0_interrupts_4_IRQn	Active	TCPWM0 Group #0, Counter #4 Interrupt
305	tcpwm_0_interrupts_5_IRQn	Active	TCPWM0 Group #0, Counter #5 Interrupt
306	tcpwm_0_interrupts_6_IRQn	Active	TCPWM0 Group #0, Counter #6 Interrupt
307	tcpwm_0_interrupts_7_IRQn	Active	TCPWM0 Group #0, Counter #7 Interrupt
308	tcpwm_0_interrupts_8_IRQn	Active	TCPWM0 Group #0, Counter #8 Interrupt
309	tcpwm_0_interrupts_9_IRQn	Active	TCPWM0 Group #0, Counter #9 Interrupt
310	tcpwm_0_interrupts_10_IRQn	Active	TCPWM0 Group #0, Counter #10 Interrupt
311	tcpwm_0_interrupts_11_IRQn	Active	TCPWM0 Group #0, Counter #11 Interrupt
312	tcpwm_0_interrupts_12_IRQn	Active	TCPWM0 Group #0, Counter #12 Interrupt
313	tcpwm_0_interrupts_13_IRQn	Active	TCPWM0 Group #0, Counter #13 Interrupt
314	tcpwm_0_interrupts_14_IRQn	Active	TCPWM0 Group #0, Counter #14 Interrupt
315	tcpwm_0_interrupts_15_IRQn	Active	TCPWM0 Group #0, Counter #15 Interrupt
316	tcpwm_0_interrupts_16_IRQn	Active	TCPWM0 Group #0, Counter #16 Interrupt
317	tcpwm_0_interrupts_17_IRQn	Active	TCPWM0 Group #0, Counter #17 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
318	tcpwm_0_interrupts_18_IRQn	Active	TCPWM0 Group #0, Counter #18 Interrupt
319	tcpwm_0_interrupts_19_IRQn	Active	TCPWM0 Group #0, Counter #19 Interrupt
320	tcpwm_0_interrupts_20_IRQn	Active	TCPWM0 Group #0, Counter #20 Interrupt
321	tcpwm_0_interrupts_21_IRQn	Active	TCPWM0 Group #0, Counter #21 Interrupt
322	tcpwm_0_interrupts_22_IRQn	Active	TCPWM0 Group #0, Counter #22 Interrupt
323	tcpwm_0_interrupts_23_IRQn	Active	TCPWM0 Group #0, Counter #23 Interrupt
324	tcpwm_0_interrupts_24_IRQn	Active	TCPWM0 Group #0, Counter #24 Interrupt
325	tcpwm_0_interrupts_25_IRQn	Active	TCPWM0 Group #0, Counter #25 Interrupt
326	tcpwm_0_interrupts_26_IRQn	Active	TCPWM0 Group #0, Counter #26 Interrupt
327	tcpwm_0_interrupts_27_IRQn	Active	TCPWM0 Group #0, Counter #27 Interrupt
328	tcpwm_0_interrupts_28_IRQn	Active	TCPWM0 Group #0, Counter #28 Interrupt
329	tcpwm_0_interrupts_29_IRQn	Active	TCPWM0 Group #0, Counter #29 Interrupt
330	tcpwm_0_interrupts_30_IRQn	Active	TCPWM0 Group #0, Counter #30 Interrupt
331	tcpwm_0_interrupts_31_IRQn	Active	TCPWM0 Group #0, Counter #31 Interrupt
332	tcpwm_0_interrupts_32_IRQn	Active	TCPWM0 Group #0, Counter #32 Interrupt
333	tcpwm_0_interrupts_33_IRQn	Active	TCPWM0 Group #0, Counter #33 Interrupt
334	tcpwm_0_interrupts_34_IRQn	Active	TCPWM0 Group #0, Counter #34 Interrupt
335	tcpwm_0_interrupts_35_IRQn	Active	TCPWM0 Group #0, Counter #35 Interrupt
336	tcpwm_0_interrupts_36_IRQn	Active	TCPWM0 Group #0, Counter #36 Interrupt
337	tcpwm_0_interrupts_37_IRQn	Active	TCPWM0 Group #0, Counter #37 Interrupt
338	tcpwm_0_interrupts_38_IRQn	Active	TCPWM0 Group #0, Counter #38 Interrupt
339	tcpwm_0_interrupts_39_IRQn	Active	TCPWM0 Group #0, Counter #39 Interrupt
340	tcpwm_0_interrupts_40_IRQn	Active	TCPWM0 Group #0, Counter #40 Interrupt
341	tcpwm_0_interrupts_41_IRQn	Active	TCPWM0 Group #0, Counter #41 Interrupt
342	tcpwm_0_interrupts_42_IRQn	Active	TCPWM0 Group #0, Counter #42 Interrupt
343	tcpwm_0_interrupts_43_IRQn	Active	TCPWM0 Group #0, Counter #43 Interrupt
344	tcpwm_0_interrupts_44_IRQn	Active	TCPWM0 Group #0, Counter #44 Interrupt
345	tcpwm_0_interrupts_45_IRQn	Active	TCPWM0 Group #0, Counter #45 Interrupt
346	tcpwm_0_interrupts_46_IRQn	Active	TCPWM0 Group #0, Counter #46 Interrupt
347	tcpwm_0_interrupts_47_IRQn	Active	TCPWM0 Group #0, Counter #47 Interrupt
348	tcpwm_0_interrupts_48_IRQn	Active	TCPWM0 Group #0, Counter #48 Interrupt
349	tcpwm_0_interrupts_49_IRQn	Active	TCPWM0 Group #0, Counter #49 Interrupt
350	tcpwm_0_interrupts_50_IRQn	Active	TCPWM0 Group #0, Counter #50 Interrupt
351	tcpwm_0_interrupts_51_IRQn	Active	TCPWM0 Group #0, Counter #51 Interrupt
352	tcpwm_0_interrupts_52_IRQn	Active	TCPWM0 Group #0, Counter #52 Interrupt
353	tcpwm_0_interrupts_53_IRQn	Active	TCPWM0 Group #0, Counter #53 Interrupt
354	tcpwm_0_interrupts_54_IRQn	Active	TCPWM0 Group #0, Counter #54 Interrupt
355	tcpwm_0_interrupts_55_IRQn	Active	TCPWM0 Group #0, Counter #55 Interrupt
356	tcpwm_0_interrupts_56_IRQn	Active	TCPWM0 Group #0, Counter #56 Interrupt
357	tcpwm_0_interrupts_57_IRQn	Active	TCPWM0 Group #0, Counter #57 Interrupt
358	tcpwm_0_interrupts_58_IRQn	Active	TCPWM0 Group #0, Counter #58 Interrupt

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Table 14-1 Peripheral interrupt assignments and wake-up sources *(continued)*

Interrupt	Source	Power Mode	Description
359	tcpwm_0_interrupts_59_IRQn	Active	TCPWM0 Group #0, Counter #59 Interrupt
360	tcpwm_0_interrupts_60_IRQn	Active	TCPWM0 Group #0, Counter #60 Interrupt
361	tcpwm_0_interrupts_61_IRQn	Active	TCPWM0 Group #0, Counter #61 Interrupt
362	tcpwm_0_interrupts_62_IRQn	Active	TCPWM0 Group #0, Counter #62 Interrupt
363	tcpwm_0_interrupts_256_IRQn	Active	TCPWM0 Group #1, Counter #0 Interrupt
364	tcpwm_0_interrupts_257_IRQn	Active	TCPWM0 Group #1, Counter #1 Interrupt
365	tcpwm_0_interrupts_258_IRQn	Active	TCPWM0 Group #1, Counter #2 Interrupt
366	tcpwm_0_interrupts_259_IRQn	Active	TCPWM0 Group #1, Counter #3 Interrupt
367	tcpwm_0_interrupts_260_IRQn	Active	TCPWM0 Group #1, Counter #4 Interrupt
368	tcpwm_0_interrupts_261_IRQn	Active	TCPWM0 Group #1, Counter #5 Interrupt
369	tcpwm_0_interrupts_262_IRQn	Active	TCPWM0 Group #1, Counter #6 Interrupt
370	tcpwm_0_interrupts_263_IRQn	Active	TCPWM0 Group #1, Counter #7 Interrupt
371	tcpwm_0_interrupts_264_IRQn	Active	TCPWM0 Group #1, Counter #8 Interrupt
372	tcpwm_0_interrupts_265_IRQn	Active	TCPWM0 Group #1, Counter #9 Interrupt
372	tcpwm_0_interrupts_266_IRQn	Active	TCPWM0 Group #1, Counter #10 Interrupt
374	tcpwm_0_interrupts_267_IRQn	Active	TCPWM0 Group #1, Counter #11 Interrupt
375	tcpwm_0_interrupts_512_IRQn	Active	TCPWM0 Group #2, Counter #0 Interrupt
376	tcpwm_0_interrupts_513_IRQn	Active	TCPWM0 Group #2, Counter #1 Interrupt
377	tcpwm_0_interrupts_514_IRQn	Active	TCPWM0 Group #2, Counter #2 Interrupt
378	tcpwm_0_interrupts_515_IRQn	Active	TCPWM0 Group #2, Counter #3 Interrupt
379	tcpwm_0_interrupts_516_IRQn	Active	TCPWM0 Group #2, Counter #4 Interrupt
380	tcpwm_0_interrupts_517_IRQn	Active	TCPWM0 Group #2, Counter #5 Interrupt
381	tcpwm_0_interrupts_518_IRQn	Active	TCPWM0 Group #2, Counter #6 Interrupt
382	tcpwm_0_interrupts_519_IRQn	Active	TCPWM0 Group #2, Counter #7 Interrupt

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15 Core interrupt types

Table 15-1 Core interrupt types

Interrupt	Source	Power mode	Description
0	CPUIntIdx0_IRQn[30]	DeepSleep	CPU User Interrupt #0
1	CPUIntIdx1_IRQn[30]	DeepSleep	CPU User Interrupt #1
2	CPUIntIdx2_IRQn	DeepSleep	CPU User Interrupt #2
3	CPUIntIdx3_IRQn	DeepSleep	CPU User Interrupt #3
4	CPUIntIdx4_IRQn	DeepSleep	CPU User Interrupt #4
5	CPUIntIdx5_IRQn	DeepSleep	CPU User Interrupt #5
6	CPUIntIdx6_IRQn	DeepSleep	CPU User Interrupt #6
7	CPUIntIdx7_IRQn	DeepSleep	CPU User Interrupt #7
8	Internal0_IRQn	Active	Internal Software Interrupt #0
9	Internal1_IRQn	Active	Internal Software Interrupt #1
10	Internal2_IRQn	Active	Internal Software Interrupt #2
11	Internal3_IRQn	Active	Internal Software Interrupt #3
12	Internal4_IRQn	Active	Internal Software Interrupt #4
13	Internal5_IRQn	Active	Internal Software Interrupt #5
14	Internal6_IRQn	Active	Internal Software Interrupt #6
15	Internal7_IRQn	Active	Internal Software Interrupt #7

Note
30.User interrupt cannot be used for CM0+ application, as it is used internally by system calls. Note, this does not impact CM4 application.

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16 Trigger multiplexer

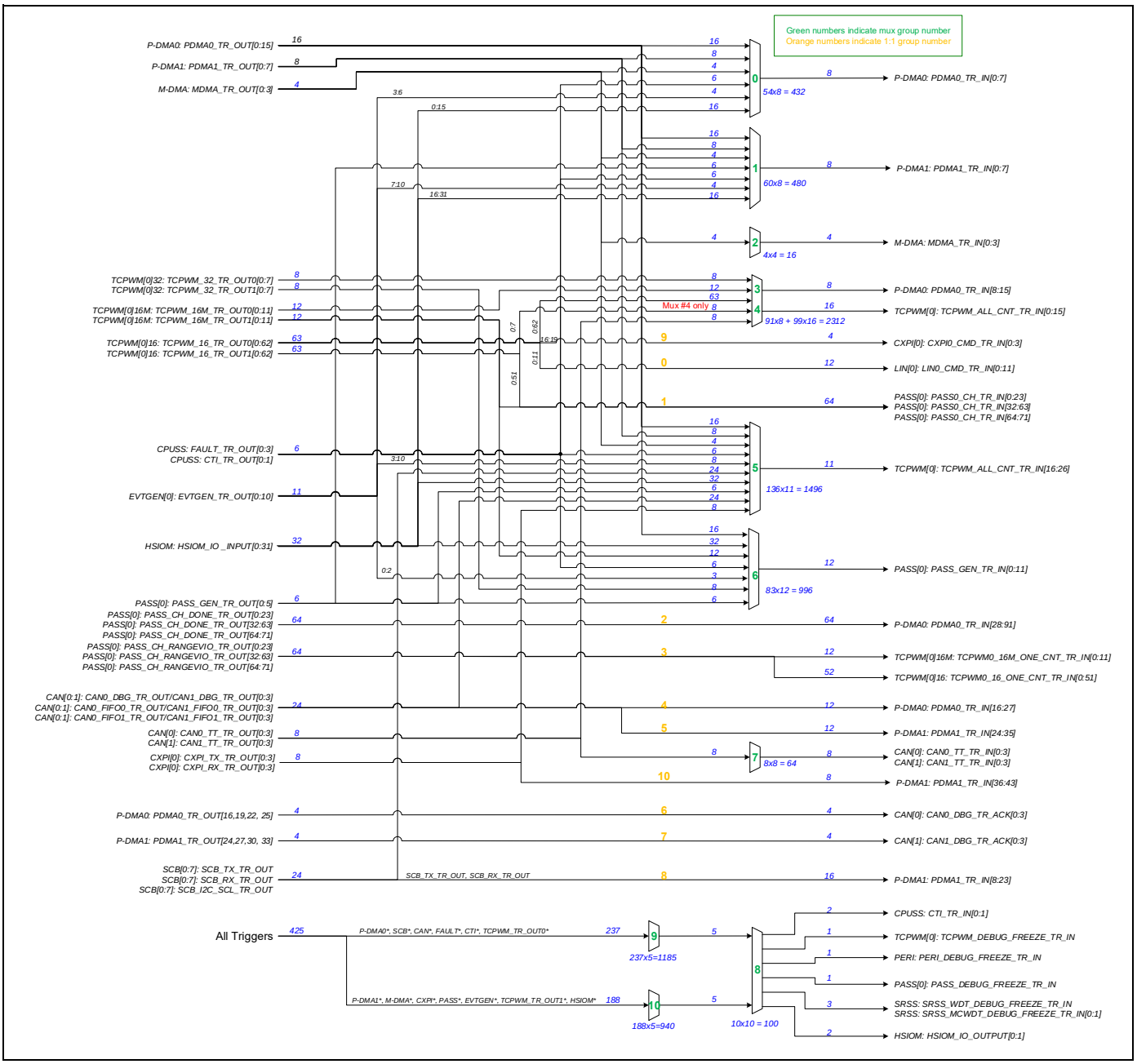


Figure 16-1 Trigger multiplexer[31]

Note
31. The diagram shows only the TRIG_LABEL, final trigger formation based on the formula TRIG_{PREFIX(IN/OUT)}_{MUX_x}_{TRIG_LABEL} / TRIG_{PREFIX(IN_1TO1/OUT_1TO1)}_{x}_{TRIG_LABEL} (see **Table 17-1**, **Table 18-1**, and **Table 19-1**.)

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17 Triggers group inputs

Table 17-1 Trigger inputs

Input	Trigger	Description
MUX Group 0: PDMA0_TR (P-DMA0 trigger multiplexer)		
1:16[32]	PDMA0_TR_OUT[0:15]	Allow P-DMA0 to chain to itself, useful for triggering once per row for 2D transfer
17:24	PDMA1_TR_OUT[0:7]	Cross connections from P-DMA1 to P-DMA0, Channels 0-7 are used
25:28	MDMA_TR_OUT[0:3]	Cross connections from M-DMA0 to P-DMA0
29:32	FAULT_TR_OUT[0:3]	Allow faults to initiate data transfer for debug purposes
33:34	CTI_TR_OUT[0:1]	Trace events
35:38	EVTGEN_TR_OUT[3:6]	EVTGEN triggers
39:54	HSIOM_IO_INPUT[0:15]	I/O inputs
MUX Group 1: PDMA1_TR (P-DMA1 trigger multiplexer)		
1:16	PDMA0_TR_OUT[0:15]	Allow P-DMA0 to trigger P-DMA1
17:24	PDMA1_TR_OUT[0:7]	Allow P-DMA1 to chain to itself, useful for triggering once per row for 2D transfer
25:28	MDMA_TR_OUT[0:3]	Allow M-DMA0 to trigger P-DMA0
29:32	FAULT_TR_OUT[0:3]	Allow faults to initiate data transfer for debug purposes
33:34	CTI_TR_OUT[0:1]	Trace events
35:38	EVTGEN_TR_OUT[7:10]	EVTGEN triggers
39:54	HSIOM_IO_INPUT[16:31]	I/O inputs
55:60	PASS_GEN_TR_OUT[0:5]	PASS SAR events
MUX Group 2: MDMA (M-DMA0 trigger multiplexer)		
1:4	MDMA_TR_OUT[0:3]	Allow M-DMA0 to trigger itself
MUX Group 3: TCPWM_TO_PDMA0 (TCPWM0 to P-DMA0 trigger multiplexer)		
1:8	TCPWM_32_TR_OUT0[0:7]	32-bit TCPWM0 counters
9:20	TCPWM_16M_TR_OUT0[0:11]	16-bit Motor enhanced TCPWM0 counters
21:83	TCPWM_16_TR_OUT0[0:62]	16-bit TCPWM0 counters
84:87	CAN0_TT_TR_OUT[0:3]	CAN0 TT Sync Outputs
88:91	CAN1_TT_TR_OUT[0:3]	CAN1 TT Sync Outputs
MUX Group 4: TCPWM_OUT (TCPWM0 loop back multiplexer)		
1:8	TCPWM_32_TR_OUT0[0:7]	32-bit TCPWM0 counters
9:20	TCPWM_16M_TR_OUT0[0:11]	16-bit Motor enhanced TCPWM0 counters
21:83	TCPWM_16_TR_OUT0[0:62]	16-bit TCPWM0 counters
84:91	TCPWM_16_TR_OUT1[0:7]	Allows feedback of two signals from same counters
92:95	CAN0_TT_TR_OUT[0:3]	CAN0 TT Sync Outputs
96:99	CAN1_TT_TR_OUT[0:3]	CAN1 TT Sync Outputs
MUX Group 5: TCPWM_IN (TCPWM0 Trigger Multiplexer)		
1:16	PDMA0_TR_OUT[0:15]	General-purpose P-DMA0 triggers
17:24	PDMA1_TR_OUT[0:7]	General-purpose P-DMA1 triggers

Note
32. "x:y" depicts a range starting from 'x' through 'y'.

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Table 17-1 Trigger inputs *(continued)*

Input	Trigger	Description
25:28	MDMA_TR_OUT[0:3]	M-DMA0 triggers
29:30	CTI_TR_OUT[0:1]	Trace events
31:34	FAULT_TR_OUT[0:3]	Fault events
35:40	PASS_GEN_TR_OUT[0:5]	PASS SAR events
41:72	HSIOM_IO_INPUT[0:31]	I/O inputs
73	SCB_TX_TR_OUT[0]	SCB0 TX trigger
74	SCB_RX_TR_OUT[0]	SCB0 RX trigger
75	SCB_I2C_SCL_TR_OUT[0]	SCB0 I^2C trigger
76	SCB_TX_TR_OUT[1]	SCB1 TX trigger
77	SCB_RX_TR_OUT[1]	SCB1 RX trigger
78	SCB_I2C_SCL_TR_OUT[1]	SCB1 I^2C trigger
79	SCB_TX_TR_OUT[2]	SCB2 TX trigger
80	SCB_RX_TR_OUT[2]	SCB2 RX trigger
81	SCB_I2C_SCL_TR_OUT[2]	SCB2 I^2C trigger
82	SCB_TX_TR_OUT[3]	SCB3 TX trigger
83	SCB_RX_TR_OUT[3]	SCB3 RX trigger
84	SCB_I2C_SCL_TR_OUT[3]	SCB3 I^2C trigger
85	SCB_TX_TR_OUT[4]	SCB4 TX trigger
86	SCB_RX_TR_OUT[4]	SCB4 RX trigger
87	SCB_I2C_SCL_TR_OUT[4]	SCB4 I^2C trigger
88	SCB_TX_TR_OUT[5]	SCB5 TX trigger
89	SCB_RX_TR_OUT[5]	SCB5 RX trigger
90	SCB_I2C_SCL_TR_OUT[5]	SCB5 I^2C trigger
91	SCB_TX_TR_OUT[6]	SCB6 TX trigger
92	SCB_RX_TR_OUT[6]	SCB6 RX trigger
93	SCB_I2C_SCL_TR_OUT[6]	SCB6 I^2C trigger
94	SCB_TX_TR_OUT[7]	SCB7 TX trigger
95	SCB_RX_TR_OUT[7]	SCB7 RX trigger
96	SCB_I2C_SCL_TR_OUT[7]	SCB7 I^2C trigger
97:100	CAN0_DBG_TR_OUT[0:3]	CAN0 M-DMA0 events
101:104	CAN0_FIFO0_TR_OUT[0:3]	CAN0 FIFO0 events
105:108	CAN0_FIFO1_TR_OUT[0:3]	CAN0 FIFO1 events
109:112	CAN1_DBG_TR_OUT[0:3]	CAN1 M-DMA0 events
113:116	CAN1_FIFO0_TR_OUT[0:3]	CAN1 FIFO0 events
117:120	CAN1_FIFO1_TR_OUT[0:3]	CAN1 FIFO1 events
121:124	CXPI_TX_TR_OUT[0:3]	CXPI transmit events
125:128	CXPI_RX_TR_OUT[0:3]	CXPI receive events
129:136	EVTGEN_TR_OUT[3:10]	EVTGEN triggers
MUX Group 6: PASS (PASS SAR trigger multiplexer)		
1:16	PDMA0_TR_OUT[0:15]	General purpose P-DMA0 triggers
17:18	CTI_TR_OUT[0:1]	Trace events

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Table 17-1 Trigger inputs *(continued)*

Input	Trigger	Description
19:22	FAULT_TR_OUT[0:3]	Fault events
23:25	EVTGEN_TR_OUT[0:2]	EVTGEN triggers
26:31	PASS_GEN_TR_OUT[0:5]	PASS SAR done signals
32:63	HSIOM_IO_INPUT[0:31]	I/O inputs
64:71	TCPWM_32_TR_OUT1[0:7]	32-bit TCPWM0 counters
72:83	TCPWM_16M_TR_OUT1[0:11]	16-bit Motor enhanced TCPWM0 counters
MUX Group 7: CAN TT sync triggers		
1:4	CAN0_TT_TR_OUT[0:3]	CAN0 TT Sync Outputs
5:8	CAN1_TT_TR_OUT[0:3]	CAN1 TT Sync Outputs
MUX Group 8: DebugMain (Debug Multiplexer)		
1:5	TR_GROUP9_OUTPUT[0:4]	Output from debug reduction multiplexer #1
6:10	TR_GROUP10_OUTPUT[0:4]	Output from debug reduction multiplexer #2
MUX Group 9: DebugReduction1 (Debug Reduction #1)		
1:92	PDMA0_TR_OUT[0:91]	P-DMA0 triggers
93:100	SCB_TX_TR_OUT[0:7]	SCB TTCAN tx Triggers
101:108	SCB_RX_TR_OUT[0:7]	SCB TTCAN rx Triggers
109:116	SCB_I2C_SCL_TR_OUT[0:7]	SCB I^2C triggers
117:120	CAN0_DBG_TR_OUT[0:3]	CAN0 P-DMA
121:124	CAN0_FIFO0_TR_OUT[0:3]	CAN0 FIFO0
125:128	CAN0_FIFO1_TR_OUT[0:3]	CAN0 FIFO1
129:132	CAN0_TT_TR_OUT[0:3]	CAN TT Sync Outputs
133:136	CAN1_DBG_TR_OUT[0:3]	CAN1 P-DMA
137:140	CAN1_FIFO0_TR_OUT[0:3]	CAN1 FIFO0
141:144	CAN1_FIFO1_TR_OUT[0:3]	CAN1 FIFO1
145:148	CAN1_TT_TR_OUT[0:3]	CAN TT Sync Outputs
149:150	CTI_TR_OUT[0:1]	Trace events
151:154	FAULT_TR_OUT[0:3]	Fault events
155:162	TCPWM_32_TR_OUT0[0:7]	32-bit TCPWM0 counters
163:174	TCPWM_16M_TR_OUT0[0:11]	16-bit Motor enhanced TCPWM0 counters
175:237	TCPWM_16_TR_OUT0[0:62]	16-bit TCPWM0 counters
MUX Group 10: DebugReduction2 (Debug Reduction #2)		
1:44	PDMA1_TR_OUT[0:43]	16-bit Motor enhanced TCPWM0 counters
45:48	MDMA_TR_OUT[0:3]	16-bit TCPWM0 counters
49:56	TCPWM_32_TR_OUT1[0:7]	32-bit TCPWM0 counters
57:68	TCPWM_16M_TR_OUT1[0:11]	16-bit Motor enhanced TCPWM0 counters
69:131	TCPWM_16_TR_OUT1[0:62]	16-bit TCPWM0 counters
132:137	PASS_GEN_TR_OUT[0:5]	PASS SAR conversion complete events
138:148	EVTGEN_TR_OUT[0:10]	EVTGEN Triggers
149:152	CXPI_TX_TR_OUT[0:3]	CXPI transmit events
153:156	CXPI_RX_TR_OUT[0:3]	CXPI receive events
157:188	HSIOM_IO_INPUT[0:31]	I/O inputs

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18 Triggers group outputs

Table 18-1 Trigger outputs

Output	Trigger	Description
MUX Group 0: PDMA0_TR (P-DMA0 trigger multiplexer)		
0:7	PDMA0_TR_IN[0:7]	Triggers to P-DMA0[0:7]
MUX Group 1: PDMA1_TR (P-DMA1 trigger multiplexer)		
0:7	PDMA1_TR_IN[0:7]	Triggers to P-DMA1[0:7]
MUX Group 2: MDMA (M-DMA0 trigger multiplexer)		
0:3	MDMA_TR_IN[0:3]	Triggers to M-DMA0
MUX Group 3: TCPWM_TO_PDMA0 (TCPWM0 to P-DMA0 trigger multiplexer)		
0:7	PDMA0_TR_IN[8:15]	Triggers to P-DMA0[8:15]
MUX Group 4: TCPWM_OUT (TCPWM0 loop back multiplexer)		
0:15	TCPWM_ALL_CNT_TR_IN[0:15]	All counters trigger input
MUX Group 5: TCPWM_IN (TCPWM0 Trigger Multiplexer)		
0:10	TCPWM_ALL_CNT_TR_IN[16:26]	Triggers to TCPWM0
MUX Group 6: PASS (PASS SAR trigger multiplexer)		
0:11	PASS_GEN_TR_IN[0:11]	Triggers to SAR ADCs
MUX Group 7: CAN TT sync triggers		
0:3	CAN0_TT_TR_IN[0:3]	CAN0 TT Sync Inputs
4:7	CAN1_TT_TR_IN[0:3]	CAN1 TT Sync Inputs
MUX Group 8: DebugMain (Debug Multiplexer)		
0:1	HSIOM_IO_OUTPUT[0:1]	To HSIOM as an output
2:3	CTI_TR_IN[0:1]	To CPU Cross Trigger system
4	PERI_DEBUG_FREEZE_TR_IN	Signal to Freeze PERI operation
5	PASS_DEBUG_FREEZE_TR_IN	Signal to Freeze SAR ADC operation
6	SRSS_WDT_DEBUG_FREEZE_TR_IN	Signal to Freeze WDT operation
7:8	SRSS_MCWDT_DEBUG_FREEZE_TR_IN[0:1]	Signal to Freeze MCWDT operation
9	TCPWM_DEBUG_FREEZE_TR_IN	Signal to Freeze TCPWM0 operation
MUX Group 9: DebugReduction1 (Debug Reduction #1)		
0:4	TR_GROUP8_INPUT[1:5]	To main debug multiplexer
MUX Group 10: DebugReduction2 (Debug Reduction #2)		
0:4	TR_GROUP8_INPUT[6:10]	To main debug multiplexer

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19 Triggers one-to-one

Table 19-1 Triggers 1:1

Input	Trigger In	Trigger Out	Description
MUX Group 0: TCPWM0 to LIN0 Triggers			
0:11	TCPWM0_16_TR_OUT0[0:11]	LIN0_CMD_TR_IN[0:11]	TCPWM0 (Group #0 Counter #00 to #07) to LIN0
MUX Group 1: TCPWM0 to PASS SARx direct connect			
0	TCPWM0_16M_TR_OUT1[0]	PASS0_CH_TR_IN[0]	TCPWM0 Group #1 Counter #00 (PWM0_M_0) to SAR0 ch#0
1	TCPWM0_16M_TR_OUT1[1]	PASS0_CH_TR_IN[1]	TCPWM0 Group #1 Counter #03 (PWM0_M_3) to SAR0 ch#1
2	TCPWM0_16M_TR_OUT1[2]	PASS0_CH_TR_IN[2]	TCPWM0 Group #1 Counter #06 (PWM0_M_6) to SAR0 ch#2
3	TCPWM0_16M_TR_OUT1[3]	PASS0_CH_TR_IN[3]	TCPWM0 Group #1 Counter #09 (PWM0_M_9) to SAR0 ch#3
4:23	TCPWM0_16_TR_OUT1[0:19]	PASS0_CH_TR_IN[4:23]	TCPWM0 Group #0 Counter #00 through 19 (PWM0_0 to PWM0_19) to SAR0 ch#4 through SAR0 ch#23
24	TCPWM0_16M_TR_OUT1[4]	PASS0_CH_TR_IN[32]	TCPWM0 Group #1 Counter #01 (PWM0_M_1) to SAR1 ch#0
25	TCPWM0_16M_TR_OUT1[5]	PASS0_CH_TR_IN[33]	TCPWM0 Group #1 Counter #04 (PWM0_M_4) to SAR1 ch#1
26	TCPWM0_16M_TR_OUT1[6]	PASS0_CH_TR_IN[34]	TCPWM0 Group #1 Counter #07 (PWM0_M_7) to SAR1 ch#2
27	TCPWM0_16M_TR_OUT1[7]	PASS0_CH_TR_IN[35]	TCPWM0 Group #1 Counter #10 (PWM0_M_10) to SAR1 ch#3
28:55	TCPWM0_16_TR_OUT1[20:47]	PASS0_CH_TR_IN[36:63]	TCPWM0 Group #0 Counter #20 through 47 (PWM0_20 to PWM0_47) to SAR1 ch#4 through SAR1 ch#31
56	TCPWM0_16M_TR_OUT1[8]	PASS0_CH_TR_IN[64]	TCPWM0 Group #1 Counter #02 (PWM0_M_2) to SAR2 ch#0
57	TCPWM0_16M_TR_OUT1[9]	PASS0_CH_TR_IN[65]	TCPWM0 Group #1 Counter #05 (PWM0_M_5) to SAR2 ch#1
58	TCPWM0_16M_TR_OUT1[10]	PASS0_CH_TR_IN[66]	TCPWM0 Group #1 Counter #08 (PWM0_M_8) to SAR2 ch#2
59	TCPWM0_16M_TR_OUT1[11]	PASS0_CH_TR_IN[67]	TCPWM0 Group #1 Counter #11 (PWM0_M_11) to SAR2 ch#3
60:63	TCPWM0_16_TR_OUT1[48:51]	PASS0_CH_TR_IN[68:71]	TCPWM0 Group #0 Counter #48 through 51 (PWM0_48 to PWM0_51) to SAR2 ch#4 through SAR2 ch#7
MUX Group 2: PASS SARx to P-DMA0 direct connect			
0:23	PASS0_CH_DONE_TR_OUT[0:23]	PDMA0_TR_IN[28:51]	PASS SAR0 [0:23] to P-DMA0 direct connect
24:55	PASS0_CH_DONE_TR_OUT[32:63]	PDMA0_TR_IN[52:83]	PASS SAR1 [0:31] to P-DMA0 direct connect
56:63	PASS0_CH_DONE_TR_OUT[64:71]	PDMA0_TR_IN[84:91]	PASS SAR2 [0:8] to P-DMA0 direct connect
MUX Group 3: PASS SARx to TCPWM0 direct connect			
0	PASS0_CH_RANGEVIO_TR_OUT[0]	TCPWM0_16M_ONE_CNT_TR_IN[0]	SAR0 ch#0[33], range violation to TCPWM0 Group #1 Counter #00 trig=2
1	PASS0_CH_RANGEVIO_TR_OUT[1]	TCPWM0_16M_ONE_CNT_TR_IN[3]	SAR0 ch#1, range violation to TCPWM0 Group #1 Counter #03 trig=2
2	PASS0_CH_RANGEVIO_TR_OUT[2]	TCPWM0_16M_ONE_CNT_TR_IN[6]	SAR0 ch#2, range violation to TCPWM0 Group #1 Counter #06 trig=2
3	PASS0_CH_RANGEVIO_TR_OUT[3]	TCPWM0_16M_ONE_CNT_TR_IN[9]	SAR0 ch#3, range violation to TCPWM0 Group #1 Counter #09 trig=2
4	PASS0_CH_RANGEVIO_TR_OUT[4]	TCPWM0_16_ONE_CNT_TR_IN[0]	SAR0 ch#4, range violation to TCPWM0 Group #0 Counter #00 trig=2
5	PASS0_CH_RANGEVIO_TR_OUT[5]	TCPWM0_16_ONE_CNT_TR_IN[1]	SAR0 ch#5, range violation to TCPWM0 Group #0 Counter #01 trig=2
6	PASS0_CH_RANGEVIO_TR_OUT[6]	TCPWM0_16_ONE_CNT_TR_IN[2]	SAR0 ch#6, range violation to TCPWM0 Group #0 Counter #02 trig=2
7	PASS0_CH_RANGEVIO_TR_OUT[7]	TCPWM0_16_ONE_CNT_TR_IN[3]	SAR0 ch#7, range violation to TCPWM0 Group #0 Counter #03 trig=2
8	PASS0_CH_RANGEVIO_TR_OUT[8]	TCPWM0_16_ONE_CNT_TR_IN[4]	SAR0 ch#8, range violation to TCPWM0 Group #0 Counter #04 trig=2
9	PASS0_CH_RANGEVIO_TR_OUT[9]	TCPWM0_16_ONE_CNT_TR_IN[5]	SAR0 ch#9, range violation to TCPWM0 Group #0 Counter #05 trig=2
10	PASS0_CH_RANGEVIO_TR_OUT[10]	TCPWM0_16_ONE_CNT_TR_IN[6]	SAR0 ch#10, range violation to TCPWM0 Group #0 Counter #06 trig=2
11	PASS0_CH_RANGEVIO_TR_OUT[11]	TCPWM0_16_ONE_CNT_TR_IN[7]	SAR0 ch#11, range violation to TCPWM0 Group #0 Counter #07 trig=2
12	PASS0_CH_RANGEVIO_TR_OUT[12]	TCPWM0_16_ONE_CNT_TR_IN[8]	SAR0 ch#12, range violation to TCPWM0 Group #0 Counter #08 trig=2
13	PASS0_CH_RANGEVIO_TR_OUT[13]	TCPWM0_16_ONE_CNT_TR_IN[9]	SAR0 ch#13, range violation to TCPWM0 Group #0 Counter #09 trig=2
14	PASS0_CH_RANGEVIO_TR_OUT[14]	TCPWM0_16_ONE_CNT_TR_IN[10]	SAR0 ch#14, range violation to TCPWM0 Group #0 Counter #10 trig=2
15	PASS0_CH_RANGEVIO_TR_OUT[15]	TCPWM0_16_ONE_CNT_TR_IN[11]	SAR0 ch#15, range violation to TCPWM0 Group #0 Counter #11 trig=2
16	PASS0_CH_RANGEVIO_TR_OUT[16]	TCPWM0_16_ONE_CNT_TR_IN[12]	SAR0 ch#16, range violation to TCPWM0 Group #0 Counter #12 trig=2
17	PASS0_CH_RANGEVIO_TR_OUT[17]	TCPWM0_16_ONE_CNT_TR_IN[13]	SAR0 ch#17, range violation to TCPWM0 Group #0 Counter #13 trig=2

Note
33.Each logical channel of SAR ADC[x] can be connected to any of the SAR ADC[x]_y external pin. (x = 0, or 1, or, 2 and y=0 to max 31)

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Table 19-1 Triggers 1:1 *(continued)*

Input	Trigger In	Trigger Out	Description
18	PASS0_CH_RANGEVIO_TR_OUT[18]	TCPWM0_16_ONE_CNT_TR_IN[14]	SAR0 ch#18, range violation to TCPWM0 Group #0 Counter #14 trig=2
19	PASS0_CH_RANGEVIO_TR_OUT[19]	TCPWM0_16_ONE_CNT_TR_IN[15]	SAR0 ch#19, range violation to TCPWM0 Group #0 Counter #15 trig=2
20	PASS0_CH_RANGEVIO_TR_OUT[20]	TCPWM0_16_ONE_CNT_TR_IN[16]	SAR0 ch#20, range violation to TCPWM0 Group #0 Counter #16 trig=2
21	PASS0_CH_RANGEVIO_TR_OUT[21]	TCPWM0_16_ONE_CNT_TR_IN[17]	SAR0 ch#21, range violation to TCPWM0 Group #0 Counter #17 trig=2
22	PASS0_CH_RANGEVIO_TR_OUT[22]	TCPWM0_16_ONE_CNT_TR_IN[18]	SAR0 ch#22, range violation to TCPWM0 Group #0 Counter #18 trig=2
23	PASS0_CH_RANGEVIO_TR_OUT[23]	TCPWM0_16_ONE_CNT_TR_IN[19]	SAR0 ch#23, range violation to TCPWM0 Group #0 Counter #19 trig=2
24	PASS0_CH_RANGEVIO_TR_OUT[32]	TCPWM0_16M_ONE_CNT_TR_IN[1]	SAR1 ch#0, range violation to TCPWM0 Group #1 Counter #01 trig=2
25	PASS0_CH_RANGEVIO_TR_OUT[33]	TCPWM0_16M_ONE_CNT_TR_IN[4]	SAR1 ch#1, range violation to TCPWM0 Group #1 Counter #04 trig=2
26	PASS0_CH_RANGEVIO_TR_OUT[34]	TCPWM0_16M_ONE_CNT_TR_IN[7]	SAR1 ch#2, range violation to TCPWM0 Group #1 Counter #07 trig=2
27	PASS0_CH_RANGEVIO_TR_OUT[35]	TCPWM0_16M_ONE_CNT_TR_IN[10]	SAR1 ch#3, range violation to TCPWM0 Group #1 Counter #10 trig=2
28	PASS0_CH_RANGEVIO_TR_OUT[36]	TCPWM0_16_ONE_CNT_TR_IN[20]	SAR1 ch#4, range violation to TCPWM0 Group #0 Counter #20 trig=2
29	PASS0_CH_RANGEVIO_TR_OUT[37]	TCPWM0_16_ONE_CNT_TR_IN[21]	SAR1 ch#5, range violation to TCPWM0 Group #0 Counter #21 trig=2
30	PASS0_CH_RANGEVIO_TR_OUT[38]	TCPWM0_16_ONE_CNT_TR_IN[22]	SAR1 ch#6, range violation to TCPWM0 Group #0 Counter #22 trig=2
31	PASS0_CH_RANGEVIO_TR_OUT[39]	TCPWM0_16_ONE_CNT_TR_IN[23]	SAR1 ch#7, range violation to TCPWM0 Group #0 Counter #23 trig=2
32	PASS0_CH_RANGEVIO_TR_OUT[40]	TCPWM0_16_ONE_CNT_TR_IN[24]	SAR1 ch#8, range violation to TCPWM0 Group #0 Counter #24 trig=2
33	PASS0_CH_RANGEVIO_TR_OUT[41]	TCPWM0_16_ONE_CNT_TR_IN[25]	SAR1 ch#9, range violation to TCPWM0 Group #0 Counter #25 trig=2
34	PASS0_CH_RANGEVIO_TR_OUT[42]	TCPWM0_16_ONE_CNT_TR_IN[26]	SAR1 ch#10, range violation to TCPWM0 Group #0 Counter #26 trig=2
35	PASS0_CH_RANGEVIO_TR_OUT[43]	TCPWM0_16_ONE_CNT_TR_IN[27]	SAR1 ch#11, range violation to TCPWM0 Group #0 Counter #27 trig=2
36	PASS0_CH_RANGEVIO_TR_OUT[44]	TCPWM0_16_ONE_CNT_TR_IN[28]	SAR1 ch#12, range violation to TCPWM0 Group #0 Counter #28 trig=2
37	PASS0_CH_RANGEVIO_TR_OUT[45]	TCPWM0_16_ONE_CNT_TR_IN[29]	SAR1 ch#13, range violation to TCPWM0 Group #0 Counter #29 trig=2
38	PASS0_CH_RANGEVIO_TR_OUT[46]	TCPWM0_16_ONE_CNT_TR_IN[30]	SAR1 ch#14, range violation to TCPWM0 Group #0 Counter #30 trig=2
39	PASS0_CH_RANGEVIO_TR_OUT[47]	TCPWM0_16_ONE_CNT_TR_IN[31]	SAR1 ch#15, range violation to TCPWM0 Group #0 Counter #31 trig=2
40	PASS0_CH_RANGEVIO_TR_OUT[48]	TCPWM0_16_ONE_CNT_TR_IN[32]	SAR1 ch#16, range violation to TCPWM0 Group #0 Counter #32 trig=2
41	PASS0_CH_RANGEVIO_TR_OUT[49]	TCPWM0_16_ONE_CNT_TR_IN[33]	SAR1 ch#17, range violation to TCPWM0 Group #0 Counter #33 trig=2
42	PASS0_CH_RANGEVIO_TR_OUT[50]	TCPWM0_16_ONE_CNT_TR_IN[34]	SAR1 ch#18, range violation to TCPWM0 Group #0 Counter #34 trig=2
43	PASS0_CH_RANGEVIO_TR_OUT[51]	TCPWM0_16_ONE_CNT_TR_IN[35]	SAR1 ch#19, range violation to TCPWM0 Group #0 Counter #35 trig=2
44	PASS0_CH_RANGEVIO_TR_OUT[52]	TCPWM0_16_ONE_CNT_TR_IN[36]	SAR1 ch#20, range violation to TCPWM0 Group #0 Counter #36 trig=2
45	PASS0_CH_RANGEVIO_TR_OUT[53]	TCPWM0_16_ONE_CNT_TR_IN[37]	SAR1 ch#21, range violation to TCPWM0 Group #0 Counter #37 trig=2
46	PASS0_CH_RANGEVIO_TR_OUT[54]	TCPWM0_16_ONE_CNT_TR_IN[38]	SAR1 ch#22, range violation to TCPWM0 Group #0 Counter #38 trig=2
47	PASS0_CH_RANGEVIO_TR_OUT[55]	TCPWM0_16_ONE_CNT_TR_IN[39]	SAR1 ch#23, range violation to TCPWM0 Group #0 Counter #39 trig=2
48	PASS0_CH_RANGEVIO_TR_OUT[56]	TCPWM0_16_ONE_CNT_TR_IN[40]	SAR1 ch#24, range violation to TCPWM0 Group #0 Counter #40 trig=2
49	PASS0_CH_RANGEVIO_TR_OUT[57]	TCPWM0_16_ONE_CNT_TR_IN[41]	SAR1 ch#25, range violation to TCPWM0 Group #0 Counter #41 trig=2
50	PASS0_CH_RANGEVIO_TR_OUT[58]	TCPWM0_16_ONE_CNT_TR_IN[42]	SAR1 ch#26, range violation to TCPWM0 Group #0 Counter #42 trig=2
51	PASS0_CH_RANGEVIO_TR_OUT[59]	TCPWM0_16_ONE_CNT_TR_IN[43]	SAR1 ch#27, range violation to TCPWM0 Group #0 Counter #43 trig=2
52	PASS0_CH_RANGEVIO_TR_OUT[60]	TCPWM0_16_ONE_CNT_TR_IN[44]	SAR1 ch#28, range violation to TCPWM0 Group #0 Counter #44 trig=2
53	PASS0_CH_RANGEVIO_TR_OUT[61]	TCPWM0_16_ONE_CNT_TR_IN[45]	SAR1 ch#29, range violation to TCPWM0 Group #0 Counter #45 trig=2
54	PASS0_CH_RANGEVIO_TR_OUT[62]	TCPWM0_16_ONE_CNT_TR_IN[46]	SAR1 ch#30, range violation to TCPWM0 Group #0 Counter #46 trig=2
55	PASS0_CH_RANGEVIO_TR_OUT[63]	TCPWM0_16_ONE_CNT_TR_IN[47]	SAR1 ch#31, range violation to TCPWM0 Group #0 Counter #47 trig=2
56	PASS0_CH_RANGEVIO_TR_OUT[64]	TCPWM0_16M_ONE_CNT_TR_IN[2]	SAR2 ch#0, range violation to TCPWM0 Group #1 Counter #02 trig=2
57	PASS0_CH_RANGEVIO_TR_OUT[65]	TCPWM0_16M_ONE_CNT_TR_IN[5]	SAR2 ch#1, range violation to TCPWM0 Group #1 Counter #05 trig=2
58	PASS0_CH_RANGEVIO_TR_OUT[66]	TCPWM0_16M_ONE_CNT_TR_IN[8]	SAR2 ch#2, range violation to TCPWM0 Group #1 Counter #08 trig=2
59	PASS0_CH_RANGEVIO_TR_OUT[67]	TCPWM0_16M_ONE_CNT_TR_IN[11]	SAR2 ch#3, range violation to TCPWM0 Group #1 Counter #11 trig=2
60	PASS0_CH_RANGEVIO_TR_OUT[68]	TCPWM0_16_ONE_CNT_TR_IN[48]	SAR2 ch#4, range violation to TCPWM0 Group #0 Counter #48 trig=2
61	PASS0_CH_RANGEVIO_TR_OUT[69]	TCPWM0_16_ONE_CNT_TR_IN[49]	SAR2 ch#5, range violation to TCPWM0 Group #0 Counter #49 trig=2
62	PASS0_CH_RANGEVIO_TR_OUT[70]	TCPWM0_16_ONE_CNT_TR_IN[50]	SAR2 ch#6, range violation to TCPWM0 Group #0 Counter #50 trig=2

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Table 19-1 Triggers 1:1 *(continued)*

Input	Trigger In	Trigger Out	Description
63	PASS0_CH_RANGEVIO_TR_OUT[71]	TCPWM0_16_ONE_CNT_TR_IN[51]	SAR2 ch#7, range violation to TCPWM0 Group #0 Counter #51 trig=2
MUX Group 4: CAN0 to P-DMA0 Triggers			
0	CAN0_DBG_TR_OUT[0]	PDMA0_TR_IN[16]	CAN0, Channel #0 P-DMA0 trigger
1	CAN0_FIFO0_TR_OUT[0]	PDMA0_TR_IN[17]	CAN0, Channel #0 FIFO0 trigger
2	CAN0_FIFO1_TR_OUT[0]	PDMA0_TR_IN[18]	CAN0, Channel #0 FIFO1 trigger
3	CAN0_DBG_TR_OUT[1]	PDMA0_TR_IN[19]	CAN0, Channel #1 P-DMA0 trigger
4	CAN0_FIFO0_TR_OUT[1]	PDMA0_TR_IN[20]	CAN0, Channel #1 FIFO0 trigger
5	CAN0_FIFO1_TR_OUT[1]	PDMA0_TR_IN[21]	CAN0, Channel #1 FIFO1 trigger
6	CAN0_DBG_TR_OUT[2]	PDMA0_TR_IN[22]	CAN0, Channel #2 P-DMA0 trigger
7	CAN0_FIFO0_TR_OUT[2]	PDMA0_TR_IN[23]	CAN0, Channel #2 FIFO0 trigger
8	CAN0_FIFO1_TR_OUT[2]	PDMA0_TR_IN[24]	CAN0, Channel #2 FIFO1 trigger
9	CAN0_DBG_TR_OUT[3]	PDMA0_TR_IN[25]	CAN0, Channel #3 P-DMA0 trigger
10	CAN0_FIFO0_TR_OUT[3]	PDMA0_TR_IN[26]	CAN0, Channel #3 FIFO0 trigger
11	CAN0_FIFO1_TR_OUT[3]	PDMA0_TR_IN[27]	CAN0, Channel #3 FIFO1 trigger
MUX Group 5: CAN1 to P-DMA1 triggers			
0	CAN1_DBG_TR_OUT[0]	PDMA1_TR_IN[24]	CAN1, Channel #0 P-DMA01 trigger
1	CAN1_FIFO0_TR_OUT[0]	PDMA1_TR_IN[25]	CAN1, Channel #0 FIFO0 trigger
2	CAN1_FIFO1_TR_OUT[0]	PDMA1_TR_IN[26]	CAN1, Channel #0 FIFO1 trigger
3	CAN1_DBG_TR_OUT[1]	PDMA1_TR_IN[27]	CAN1, Channel #1 P-DMA1 trigger
4	CAN1_FIFO0_TR_OUT[1]	PDMA1_TR_IN[28]	CAN1, Channel #1 FIFO0 trigger
5	CAN1_FIFO1_TR_OUT[1]	PDMA1_TR_IN[29]	CAN1, Channel #1 FIFO1 trigger
6	CAN1_DBG_TR_OUT[2]	PDMA1_TR_IN[30]	CAN1, Channel #2 P-DMA1 trigger
7	CAN1_FIFO0_TR_OUT[2]	PDMA1_TR_IN[31]	CAN1, Channel #2 FIFO0 trigger
8	CAN1_FIFO1_TR_OUT[2]	PDMA1_TR_IN[32]	CAN1, Channel #2 FIFO1 trigger
9	CAN1_DBG_TR_OUT[3]	PDMA1_TR_IN[33]	CAN1, Channel #3 P-DMA1 trigger
10	CAN1_FIFO0_TR_OUT[3]	PDMA1_TR_IN[34]	CAN1, Channel #3 FIFO0 trigger
11	CAN1_FIFO1_TR_OUT[3]	PDMA1_TR_IN[35]	CAN1, Channel #3 FIFO1 trigger
MUX Group 6:Acknowledge triggers from P-DMA0 to CAN0			
0	PDMA0_TR_OUT[16]	CAN0_DBG_TR_ACK[0]	CAN0, Channel #0 P-DMA0 acknowledge
1	PDMA0_TR_OUT[19]	CAN0_DBG_TR_ACK[1]	CAN0, Channel #1 P-DMA0 acknowledge
2	PDMA0_TR_OUT[22]	CAN0_DBG_TR_ACK[2]	CAN0, Channel #2 P-DMA0 acknowledge
3	PDMA0_TR_OUT[25]	CAN0_DBG_TR_ACK[3]	CAN0, Channel #3 P-DMA0 acknowledge
MUX Group 7: Acknowledge triggers from P-DMA1 to CAN1			
0	PDMA1_TR_OUT[24]	CAN1_DBG_TR_ACK[0]	CAN1, Channel #0 P-DMA1 acknowledge
1	PDMA1_TR_OUT[27]	CAN1_DBG_TR_ACK[1]	CAN1, Channel #1 P-DMA1 acknowledge
2	PDMA1_TR_OUT[30]	CAN1_DBG_TR_ACK[2]	CAN1, Channel #2 P-DMA1 acknowledge
3	PDMA1_TR_OUT[33]	CAN1_DBG_TR_ACK[3]	CAN1, Channel #3 P-DMA1 acknowledge
MUX Group 8: SCBx to P-DMA1 Triggers			
0	SCB0_TX_TR_OUT	PDMA1_TR_IN[8]	SCB0 TX to P-DMA1 Trigger
1	SCB0_RX_TR_OUT	PDMA1_TR_IN[9]	SCB0 RX to P-DMA1 Trigger
2	SCB1_TX_TR_OUT	PDMA1_TR_IN[10]	SCB1 TX to P-DMA1 Trigger
3	SCB1_RX_TR_OUT	PDMA1_TR_IN[11]	SCB1 RX to P-DMA1 Trigger
4	SCB2_TX_TR_OUT	PDMA1_TR_IN[12]	SCB2 TX to P-DMA1 Trigger
5	SCB2_RX_TR_OUT	PDMA1_TR_IN[13]	SCB2 RX to P-DMA1 Trigger

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Table 19-1 Triggers 1:1 *(continued)*

Input	Trigger In	Trigger Out	Description
6	SCB3_TX_TR_OUT	PDMA1_TR_IN[14]	SCB3 TX to P-DMA1 Trigger
7	SCB3_RX_TR_OUT	PDMA1_TR_IN[15]	SCB3 RX to P-DMA1 Trigger
8	SCB4_TX_TR_OUT	PDMA1_TR_IN[16]	SCB4 TX to P-DMA1 Trigger
9	SCB4_RX_TR_OUT	PDMA1_TR_IN[17]	SCB4 RX to P-DMA1 Trigger
10	SCB5_TX_TR_OUT	PDMA1_TR_IN[18]	SCB5 TX to P-DMA1 Trigger
11	SCB5_RX_TR_OUT	PDMA1_TR_IN[19]	SCB5 RX to P-DMA1 Trigger
12	SCB6_TX_TR_OUT	PDMA1_TR_IN[20]	SCB6 TX to P-DMA1 Trigger
13	SCB6_RX_TR_OUT	PDMA1_TR_IN[21]	SCB6 RX to P-DMA1 Trigger
14	SCB7_TX_TR_OUT	PDMA1_TR_IN[22]	SCB7 TX to P-DMA1 Trigger
15	SCB7_RX_TR_OUT	PDMA1_TR_IN[23]	SCB7 RX to P-DMA1 Trigger
MUX Group 9: TCPWM0 to CXPI Triggers			
0:3	TCPWM0_16_TR_OUT0[16:19]	CXPI0_CMD_TR_IN[0:3]	TCPWM0 Group #0 (Counter #16 to #19) to CXPI0 Trigger
MUX Group 10: CXPI to P-DMA1 Triggers			
0:3	CXPI_TX_TR_OUT[0:3]	PDMA1_TR_IN[36:39]	CXPI0 TX to P-DMA1 Triggers
4:7	CXPI_RX_TR_OUT[0:3]	PDMA1_TR_IN[40:43]	CXPI0 RX to P-DMA1 Triggers

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20 Peripheral clocks

Table 20-1 Peripheral clock assignments

Output	Destination	Description
0	PCLK_CPUSS_CLOCK_TRACE_IN	Trace clock
1	PCLK_SMARTIO12_CLOCK	SMART I/O #12
2	PCLK_SMARTIO13_CLOCK	SMART I/O #13
3	PCLK_SMARTIO14_CLOCK	SMART I/O #14
4	PCLK_SMARTIO15_CLOCK	SMART I/O #15
5	PCLK_SMARTIO17_CLOCK	SMART I/O #17
6	PCLK_CANFD0_CLOCK_CAN0	CAN0, Channel #0
7	PCLK_CANFD0_CLOCK_CAN1	CAN0, Channel #1
8	PCLK_CANFD0_CLOCK_CAN2	CAN0, Channel #2
9	PCLK_CANFD0_CLOCK_CAN3	CAN0, Channel #3
10	PCLK_CANFD1_CLOCK_CAN0	CAN1, Channel #0
11	PCLK_CANFD1_CLOCK_CAN1	CAN1, Channel #1
12	PCLK_CANFD1_CLOCK_CAN2	CAN1, Channel #2
13	PCLK_CANFD1_CLOCK_CAN3	CAN1, Channel #3
14	PCLK_LIN0_CLOCK_CH_EN0	LIN0, Channel #0
15	PCLK_LIN0_CLOCK_CH_EN1	LIN0, Channel #1
16	PCLK_LIN0_CLOCK_CH_EN2	LIN0, Channel #2
17	PCLK_LIN0_CLOCK_CH_EN3	LIN0, Channel #3
18	PCLK_LIN0_CLOCK_CH_EN4	LIN0, Channel #4
19	PCLK_LIN0_CLOCK_CH_EN5	LIN0, Channel #5
20	PCLK_LIN0_CLOCK_CH_EN6	LIN0, Channel #6
21	PCLK_LIN0_CLOCK_CH_EN7	LIN0, Channel #7
22	PCLK_LIN0_CLOCK_CH_EN8	LIN0, Channel #8
23	PCLK_LIN0_CLOCK_CH_EN9	LIN0, Channel #9
24	PCLK_LIN0_CLOCK_CH_EN10	LIN0, Channel #10
25	PCLK_LIN0_CLOCK_CH_EN11	LIN0, Channel #11
26	PCLK_CXPI0_CLOCK_CH_EN0	CXPI0 Channel #0
27	PCLK_CXPI0_CLOCK_CH_EN1	CXPI0 Channel #1
28	PCLK_CXPI0_CLOCK_CH_EN2	CXPI0 Channel #2
29	PCLK_CXPI0_CLOCK_CH_EN3	CXPI0 Channel #3
30	PCLK_SCB0_CLOCK	SCB0
31	PCLK_SCB1_CLOCK	SCB1
32	PCLK_SCB2_CLOCK	SCB2
33	PCLK_SCB3_CLOCK	SCB3
34	PCLK_SCB4_CLOCK	SCB4
35	PCLK_SCB5_CLOCK	SCB5
36	PCLK_SCB6_CLOCK	SCB6
37	PCLK_SCB7_CLOCK	SCB7
38	PCLK_PASS0_CLOCK_SAR0	SAR0

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Table 20-1 Peripheral clock assignments *(continued)*

Output	Destination	Description
39	PCLK_PASS0_CLOCK_SAR1	SAR1
40	PCLK_PASS0_CLOCK_SAR2	SAR2
41	PCLK_TCPWM0_CLOCKS0	TCPWM0 Group #0, Counter #0
42	PCLK_TCPWM0_CLOCKS1	TCPWM0 Group #0, Counter #1
43	PCLK_TCPWM0_CLOCKS2	TCPWM0 Group #0, Counter #2
44	PCLK_TCPWM0_CLOCKS3	TCPWM0 Group #0, Counter #3
45	PCLK_TCPWM0_CLOCKS4	TCPWM0 Group #0, Counter #4
46	PCLK_TCPWM0_CLOCKS5	TCPWM0 Group #0, Counter #5
47	PCLK_TCPWM0_CLOCKS6	TCPWM0 Group #0, Counter #6
48	PCLK_TCPWM0_CLOCKS7	TCPWM0 Group #0, Counter #7
49	PCLK_TCPWM0_CLOCKS8	TCPWM0 Group #0, Counter #8
50	PCLK_TCPWM0_CLOCKS9	TCPWM0 Group #0, Counter #9
51	PCLK_TCPWM0_CLOCKS10	TCPWM0 Group #0, Counter #10
52	PCLK_TCPWM0_CLOCKS11	TCPWM0 Group #0, Counter #11
53	PCLK_TCPWM0_CLOCKS12	TCPWM0 Group #0, Counter #12
54	PCLK_TCPWM0_CLOCKS13	TCPWM0 Group #0, Counter #13
55	PCLK_TCPWM0_CLOCKS14	TCPWM0 Group #0, Counter #14
56	PCLK_TCPWM0_CLOCKS15	TCPWM0 Group #0, Counter #15
57	PCLK_TCPWM0_CLOCKS16	TCPWM0 Group #0, Counter #16
58	PCLK_TCPWM0_CLOCKS17	TCPWM0 Group #0, Counter #17
59	PCLK_TCPWM0_CLOCKS18	TCPWM0 Group #0, Counter #18
60	PCLK_TCPWM0_CLOCKS19	TCPWM0 Group #0, Counter #19
61	PCLK_TCPWM0_CLOCKS20	TCPWM0 Group #0, Counter #20
62	PCLK_TCPWM0_CLOCKS21	TCPWM0 Group #0, Counter #21
63	PCLK_TCPWM0_CLOCKS22	TCPWM0 Group #0, Counter #22
64	PCLK_TCPWM0_CLOCKS23	TCPWM0 Group #0, Counter #23
65	PCLK_TCPWM0_CLOCKS24	TCPWM0 Group #0, Counter #24
66	PCLK_TCPWM0_CLOCKS25	TCPWM0 Group #0, Counter #25
67	PCLK_TCPWM0_CLOCKS26	TCPWM0 Group #0, Counter #26
68	PCLK_TCPWM0_CLOCKS27	TCPWM0 Group #0, Counter #27
69	PCLK_TCPWM0_CLOCKS28	TCPWM0 Group #0, Counter #28
70	PCLK_TCPWM0_CLOCKS29	TCPWM0 Group #0, Counter #29
71	PCLK_TCPWM0_CLOCKS30	TCPWM0 Group #0, Counter #30
72	PCLK_TCPWM0_CLOCKS31	TCPWM0 Group #0, Counter #31
73	PCLK_TCPWM0_CLOCKS32	TCPWM0 Group #0, Counter #32
74	PCLK_TCPWM0_CLOCKS33	TCPWM0 Group #0, Counter #33
75	PCLK_TCPWM0_CLOCKS34	TCPWM0 Group #0, Counter #34
76	PCLK_TCPWM0_CLOCKS35	TCPWM0 Group #0, Counter #35
77	PCLK_TCPWM0_CLOCKS36	TCPWM0 Group #0, Counter #36
78	PCLK_TCPWM0_CLOCKS37	TCPWM0 Group #0, Counter #37
79	PCLK_TCPWM0_CLOCKS38	TCPWM0 Group #0, Counter #38

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Table 20-1 Peripheral clock assignments *(continued)*

Output	Destination	Description
80	PCLK_TCPWM0_CLOCKS39	TCPWM0 Group #0, Counter #39
81	PCLK_TCPWM0_CLOCKS40	TCPWM0 Group #0, Counter #40
82	PCLK_TCPWM0_CLOCKS41	TCPWM0 Group #0, Counter #41
83	PCLK_TCPWM0_CLOCKS42	TCPWM0 Group #0, Counter #42
84	PCLK_TCPWM0_CLOCKS43	TCPWM0 Group #0, Counter #43
85	PCLK_TCPWM0_CLOCKS44	TCPWM0 Group #0, Counter #44
86	PCLK_TCPWM0_CLOCKS45	TCPWM0 Group #0, Counter #45
87	PCLK_TCPWM0_CLOCKS46	TCPWM0 Group #0, Counter #46
88	PCLK_TCPWM0_CLOCKS47	TCPWM0 Group #0, Counter #47
89	PCLK_TCPWM0_CLOCKS48	TCPWM0 Group #0, Counter #48
90	PCLK_TCPWM0_CLOCKS49	TCPWM0 Group #0, Counter #49
91	PCLK_TCPWM0_CLOCKS50	TCPWM0 Group #0, Counter #50
92	PCLK_TCPWM0_CLOCKS51	TCPWM0 Group #0, Counter #51
93	PCLK_TCPWM0_CLOCKS52	TCPWM0 Group #0, Counter #52
94	PCLK_TCPWM0_CLOCKS53	TCPWM0 Group #0, Counter #53
95	PCLK_TCPWM0_CLOCKS54	TCPWM0 Group #0, Counter #54
96	PCLK_TCPWM0_CLOCKS55	TCPWM0 Group #0, Counter #55
97	PCLK_TCPWM0_CLOCKS56	TCPWM0 Group #0, Counter #56
98	PCLK_TCPWM0_CLOCKS57	TCPWM0 Group #0, Counter #57
99	PCLK_TCPWM0_CLOCKS58	TCPWM0 Group #0, Counter #58
100	PCLK_TCPWM0_CLOCKS59	TCPWM0 Group #0, Counter #59
101	PCLK_TCPWM0_CLOCKS60	TCPWM0 Group #0, Counter #60
102	PCLK_TCPWM0_CLOCKS61	TCPWM0 Group #0, Counter #61
103	PCLK_TCPWM0_CLOCKS62	TCPWM0 Group #0, Counter #62
104	PCLK_TCPWM0_CLOCKS256	TCPWM0 Group #1, Counter #0
105	PCLK_TCPWM0_CLOCKS257	TCPWM0 Group #1, Counter #1
106	PCLK_TCPWM0_CLOCKS258	TCPWM0 Group #1, Counter #2
107	PCLK_TCPWM0_CLOCKS259	TCPWM0 Group #1, Counter #3
108	PCLK_TCPWM0_CLOCKS260	TCPWM0 Group #1, Counter #4
109	PCLK_TCPWM0_CLOCKS261	TCPWM0 Group #1, Counter #5
110	PCLK_TCPWM0_CLOCKS262	TCPWM0 Group #1, Counter #6
111	PCLK_TCPWM0_CLOCKS263	TCPWM0 Group #1, Counter #7
112	PCLK_TCPWM0_CLOCKS264	TCPWM0 Group #1, Counter #8
113	PCLK_TCPWM0_CLOCKS265	TCPWM0 Group #1, Counter #9
114	PCLK_TCPWM0_CLOCKS266	TCPWM0 Group #1, Counter #10
115	PCLK_TCPWM0_CLOCKS267	TCPWM0 Group #1, Counter #11
116	PCLK_TCPWM0_CLOCKS512	TCPWM0 Group #2, Counter #0
117	PCLK_TCPWM0_CLOCKS513	TCPWM0 Group #2, Counter #1
118	PCLK_TCPWM0_CLOCKS514	TCPWM0 Group #2, Counter #2
119	PCLK_TCPWM0_CLOCKS515	TCPWM0 Group #2, Counter #3
120	PCLK_TCPWM0_CLOCKS516	TCPWM0 Group #2, Counter #4

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Table 20-1 Peripheral clock assignments *(continued)*

Output	Destination	Description
121	PCLK_TCPWM0_CLOCKS517	TCPWM0 Group #2, Counter #5
122	PCLK_TCPWM0_CLOCKS518	TCPWM0 Group #2, Counter #6
123	PCLK_TCPWM0_CLOCKS519	TCPWM0 Group #2, Counter #7

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21 Faults

Table 21-1 Fault Assignments

Fault	Source	Description
0	CPUSS_MPU_VIO_0	CM0+ SMPU violation DATA0[31:0]: Violating address. DATA1[0]: User read. DATA1[1]: User write. DATA1[2]: User execute. DATA1[3]: Privileged read. DATA1[4]: Privileged write. DATA1[5]: Privileged execute. DATA1[6]: Non-secure. DATA1[11:8]: Master identifier. DATA1[15:12]: Protection context identifier. DATA1[31]: '0' MPU violation; '1': SMPU violation.
1	CPUSS_MPU_VIO_1	CRYPTO SMPU violation. See CPUSS_MPU_VIO_0 description.
2	CPUSS_MPU_VIO_2	P-DMA0 MPU/SMPU violation. See CPUSS_MPU_VIO_0 description.
3	CPUSS_MPU_VIO_3	P-DMA1 MPU/SMPU violation. See CPUSS_MPU_VIO_0 description.
4	CPUSS_MPU_VIO_4	M-DMA0 MPU/SMPU violation. See CPUSS_MPU_VIO_0 description.
15	CPUSS_MPU_VIO_15	Test Controller MPU/SMPU violation. See CPUSS_MPU_VIO_0 description.
16	CPUSS_MPU_VIO_16	CM4 system bus AHB-Lite interface MPU violation. See CPUSS_MPU_VIO_0 description.
17	CPUSS_MPU_VIO_17	CM4 code bus AHB-Lite interface MPU violation for non flash controller accesses. See CPUSS_MPU_VIO_0 description.
18	CPUSS_MPU_VIO_18	CM4 code bus AHB-Lite interface MPU violation for flash controller accesses. See CPUSS_MPU_VIO_0 description.
26	PERI_PERI_C_ECC	Peripheral protection SRAM correctable ECC violation DATA0[10:0]: Violating address. DATA1[7:0]: Syndrome of SRAM word.
27	PERI_PERI_NC_ECC	Peripheral protection SRAM non-correctable ECC violation
28	PERI_MS_VIO_0	CM0+ Peripheral Master Interface PPU violation DATA0[31:0]: Violating address. DATA1[0]: User read. DATA1[1]: User write. DATA1[2]: User execute. DATA1[3]: Privileged read. DATA1[4]: Privileged write. DATA1[5]: Privileged execute. DATA1[6]: Non-secure. DATA1[11:8]: Master identifier. DATA1[15:12]: Protection context identifier. DATA1[31:28]: “0”: master interface, PPU violation, “1': timeout detected, “2”: bus error, other: undefined.
29	PERI_MS_VIO_1	CM4 Peripheral Master Interface PPU violation. See PERI_MS_VIO_0 description.
30	PERI_MS_VIO_2	P-DMA0 Peripheral Master Interface PPU violation. See PERI_MS_VIO_0 description.
31	PERI_MS_VIO_3	P-DMA1 Peripheral Master Interface PPU violation. See PERI_MS_VIO_0 description.
32	PERI_GROUP_VIO_0	Peripheral Group #0 violation. DATA0[31:0]: Violating address. DATA1[0]: User read. DATA1[1]: User write. DATA1[2]: User execute. DATA1[3]: Privileged read. DATA1[4]: Privileged write. DATA1[5]: Privileged execute. DATA1[6]: Non-secure. DATA1[11:8]: Master identifier. DATA1[15:12]: Protection context identifier. DATA1[31:28]: “0”: decoder or peripheral bus error, other: undefined.
33	PERI_GROUP_VIO_1	Peripheral Group #1 violation. See PERI_GROUP_VIO_0 description.
34	PERI_GROUP_VIO_2	Peripheral Group #2 violation. See PERI_GROUP_VIO_0 description.
35	PERI_GROUP_VIO_3	Peripheral Group #3 violation. See PERI_GROUP_VIO_0 description.
37	PERI_GROUP_VIO_5	Peripheral Group #5 violation. See PERI_GROUP_VIO_0 description.
38	PERI_GROUP_VIO_6	Peripheral Group #6 violation. See PERI_GROUP_VIO_0 description.
41	PERI_GROUP_VIO_9	Peripheral Group #9 violation. See PERI_GROUP_VIO_0 description.

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Table 21-1 Fault Assignments *(continued)*

Fault	Source	Description
48	CPUSS_FLASHC_MAIN_BUS_ERROR	Flash controller main flash bus error FAULT_DATA0[26:0]: Violating address. Append 5'b00010 as most significant bits to derive 32-bit system address. FAULT_DATA1[11:8]: Master identifier.
49	CPUSS_FLASHC_MAIN_C_ECC	Flash controller main flash correctable ECC violation DATA[26:0]: Violating address. Append 5'b00010 as most significant bits to derive 32-bit system address. DATA1[7:0]: Syndrome of 64-bit word (at address offset 0x00). DATA1[15:8]: Syndrome of 64-bit word (at address offset 0x08). DATA1[23:16]: Syndrome of 64-bit word (at address offset 0x10). DATA1[31:24]: Syndrome of 64-bit word (at address offset 0x18).
50	CPUSS_FLASHC_MAIN_NC_ECC	Flash controller main flash non-correctable ECC violation. See CPUSS_FLASHC_MAIN_C_ECC description.
51	CPUSS_FLASHC_WORK_BUS_ERROR	Flash controller work-flash bus error. See CPUSS_FLASHC_MAIN_BUS_ERR description.
52	CPUSS_FLASHC_WORK_C_ECC	Flash controller work flash correctable ECC violation. DATA0[26:0]: Violating address. Append 5'b00010 as most significant bits to derive 32-bit system address. DATA1[6:0]: Syndrome of 32-bit word.
53	CPUSS_FLASHC_WORK_NC_ECC	Flash controller work-flash non-correctable ECC violation. See CPUSS_FLASHC_WORK_C_ECC description.
54	CPUSS_FLASHC_CM0_CA_C_ECC	Flash controller CM0+ cache correctable ECC violation. DATA0[26:0]: Violating address. DATA1[6:0]: Syndrome of 32-bit SRAM word (at address offset 0x0). DATA1[14:8]: Syndrome of 32-bit SRAM word (at address offset 0x4). DATA1[22:16]: Syndrome of 32-bit SRAM word (at address offset 0x8). DATA1[30:24]: Syndrome of 32-bit SRAM word (at address offset 0xc).
55	CPUSS_FLASHC_CM0_CA_NC_ECC	Flash controller CM0+ cache non-correctable ECC violation. See CPUSS_FLASHC_CM0_CA_C_ECC description.
56	CPUSS_FLASHC_CM4_CA_C_ECC	Flash controller CM4 cache correctable ECC violation. See CPUSS_FLASHC_CM0_CA_C_ECC description.
57	CPUSS_FLASHC_CM4_CA_NC_ECC	Flash controller CM4 cache non-correctable ECC violation. See CPUSS_FLASHC_CM0_CA_C_ECC description.
58	CPUSS_RAMC0_C_ECC	System memory controller 0 correctable ECC violation: DATA0[31:0]: Violating address. DATA1[6:0]: Syndrome of 32-bit SRAM code word.
59	CPUSS_RAMC0_NC_ECC	System memory controller 0 non-correctable ECC violation. See CPUSS_RAMC0_C_ECC description.
60	CPUSS_RAMC1_C_ECC	System memory controller 1 correctable ECC violation. See CPUSS_RAMC0_C_ECC description.
61	CPUSS_RAMC1_NC_ECC	System memory controller 1 non-correctable ECC violation. See CPUSS_RAMC0_C_ECC description.
64	CPUSS_CRYPTO_C_ECC	Crypto memory correctable ECC violation. DATA0[31:0]: Violating address. DATA1[6:0]: Syndrome of Least Significant 32-bit SRAM. DATA1[14:8]: Syndrome of Most Significant 32-bit SRAM.
65	CPUSS_CRYPTO_NC_ECC	CRYPTO memory non-correctable ECC violation. See CPUSS_CRYPTO_C_ECC description.
70	CPUSS_DW0_C_ECC	P-DMA0 memory correctable ECC violation: DATA0[11:0]: Violating DW SRAM address (word address, assuming byte addressable). DATA1[6:0]: Syndrome of 32-bit SRAM code word.
71	CPUSS_DW0_NC_ECC	P-DMA0 memory non-correctable ECC violation. See CPUSS_DW0_C_ECC description.
72	CPUSS_DW1_C_ECC	P-DMA1 memory correctable ECC violation. See CPUSS_DW0_C_ECC description.
73	CPUSS_DW1_NC_ECC	P-DMA1 memory non-correctable ECC violation. See CPUSS_DW0_C_ECC description.
74	CPUSS_FM_SRAM_C_ECC	Flash code storage SRAM memory correctable ECC violation: DATA0[15:0]: Address location in the eCT Flash SRAM. DATA1[6:0]: Syndrome of 32-bit SRAM word.
75	CPUSS_FM_SRAM_NC_ECC	Flash code storage SRAM memory non-correctable ECC violation: See CPUSS_FM_SRAMC_C_ECC description.
80	CANFD_0_CAN_C_ECC	CAN0 message buffer correctable ECC violation: DATA0[15:0]: Violating address. DATA0[22:16]: ECC violating data[38:32] from MRAM. DATA0[27:24]: Master ID: 0-7 = CAN channel ID within mxttcanfd cluster, 8 = AHB I/F DATA1[31:0]: ECC violating data[31:0] from MRAM.

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Table 21-1 Fault Assignments *(continued)*

Fault	Source	Description
81	CANFD_0_CAN_NC_ECC	CAN0 message buffer non-correctable ECC violation: DATA0[15:0]: Violating address. DATA0[22:16]: ECC violating data[38:32] from MRAM (not for Address Error). DATA0[27:24]: Master ID: 0-7 = CAN channel ID within mxttcanfd cluster, 8 = AHB I/F DATA0[30]: Write access, only possible for Address Error DATA0[31]: Address Error: a CAN channel did an MRAM access above MRAM_SIZE DATA1[31:0]: ECC violating data[31:0] from MRAM (not for Address Error).
82	CANFD_1_CAN_C_ECC	CAN1 message buffer correctable ECC violation. See CANFD_0_CAN_C_ECC description.
83	CANFD_1_CAN_NC_ECC	CAN1 message buffer non-correctable ECC violation. See CANFD_0_CAN_NC_ECC description.
90	SRSS_FAULT_CSV	Consolidated fault output for clock supervisors. Multiple CSV can detect a violation at the same time. DATA0[15:0]: CLK_HF* root CSV violation flags. DATA0[24]: CLK_REF CSV violation flag (reference clock for CLK_HF CSVs) DATA0[25]: CLK_LF CSV violation flag DATA0[26]: CLK_HVILO CSV violation flag
91	SRSS_FAULT_SSV	Consolidated fault output for supply supervisors. Multiple CSV can detect a violation at the same time. DATA0[0]: BOD on VDDA DATA[1]: OVD on VDDA DATA[16]: LVD/HVD #1 DATA0[17]: LVD/HVD #2
92	SRSS_FAULT_MCWDT0	Fault output for MCWDT0 (all sub-counters) Multiple counters can detect a violation at the same time. DATA0[0]: MCWDT sub counter 0 LOWER_LIMIT DATA0[1]: MCWDT sub counter 0 UPPER_LIMIT DATA0[2]: MCWDT sub counter 1 LOWER_LIMIT DATA0[3]: MCWDT sub counter 1 UPPER_LIMIT
93	SRSS_FAULT_MCWDT1	Fault output for MCWDT1 (all sub-counters). See SRSS_FAULT_MCWDT0 description.

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22 Peripheral protection unit fixed structure pairs

Protection pair is a pair PPU structures, a master and a slave structure. The master structure protects the slave structure, and the slave structure protects resources such as peripheral registers, or the peripheral itself.

Table 22-1 PPU fixed structure pairs

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
0	PERI_MS_PPU_FX_PERI_MAIN	0x40000000	0x00002000	Peripheral Interconnect main
1	PERI_MS_PPU_FX_PERI_SECURE	0x40002000	0x00000004	Peripheral interconnect secure
2	PERI_MS_PPU_FX_PERI_GR0_GROUP	0x40004010	0x00000004	Peripheral Group #0 main
3	PERI_MS_PPU_FX_PERI_GR1_GROUP	0x40004030	0x00000004	Peripheral Group #1 main
4	PERI_MS_PPU_FX_PERI_GR2_GROUP	0x40004050	0x00000004	Peripheral Group #2 main
5	PERI_MS_PPU_FX_PERI_GR3_GROUP	0x40004060	0x00000020	Peripheral Group #3 main
6	PERI_MS_PPU_FX_PERI_GR5_GROUP	0x400040A0	0x00000020	Peripheral Group #5 main
7	PERI_MS_PPU_FX_PERI_GR6_GROUP	0x400040C0	0x00000020	Peripheral Group #6 main
8	PERI_MS_PPU_FX_PERI_GR9_GROUP	0x40004120	0x00000020	Peripheral Group #9 main
9	PERI_MS_PPU_FX_PERI_TR	0x40008000	0x00008000	Peripheral trigger multiplexer
10	PERI_MS_PPU_FX_CRYPTO_MAIN	0x40100000	0x00000400	Crypto main
11	PERI_MS_PPU_FX_CRYPTO_CRYPTO	0x40101000	0x00000800	Crypto MMIO (Memory Mapped I/O)
12	PERI_MS_PPU_FX_CRYPTO_BOOT	0x40102000	0x00000100	Crypto boot
13	PERI_MS_PPU_FX_CRYPTO_KEY0	0x40102100	0x00000004	Crypto Key #0
14	PERI_MS_PPU_FX_CRYPTO_KEY1	0x40102120	0x00000004	Crypto Key #1
15	PERI_MS_PPU_FX_CRYPTO_BUF	0x40108000	0x00002000	Crypto buffer
16	PERI_MS_PPU_FX_CPUSS_CM4	0x40200000	0x00000400	CM4 CPU core
17	PERI_MS_PPU_FX_CPUSS_CM0	0x40201000	0x00001000	CM0+ CPU core
18	PERI_MS_PPU_FX_CPUSS_BOOT[34]	0x40202000	0x00000200	CPUSS boot
19	PERI_MS_PPU_FX_CPUSS_CM0_INT	0x40208000	0x00000800	CPUSS CM0+ interrupts
20	PERI_MS_PPU_FX_CPUSS_CM4_INT	0x4020A000	0x00000800	CPUSS CM4 interrupts
21	PERI_MS_PPU_FX_FAULT_STRUCT0_MAIN	0x40210000	0x00000100	CPUSS Fault Structure #0 main
22	PERI_MS_PPU_FX_FAULT_STRUCT1_MAIN	0x40210100	0x00000100	CPUSS Fault Structure #1 main
23	PERI_MS_PPU_FX_FAULT_STRUCT2_MAIN	0x40210200	0x00000100	CPUSS Fault Structure #2 main
24	PERI_MS_PPU_FX_FAULT_STRUCT3_MAIN	0x40210300	0x00000100	CPUSS Fault Structure #3 main
25	PERI_MS_PPU_FX_IPC_STRUCT0_IPC	0x40220000	0x00000020	CPUSS IPC Structure #0
26	PERI_MS_PPU_FX_IPC_STRUCT1_IPC	0x40220020	0x00000020	CPUSS IPC Structure #1
27	PERI_MS_PPU_FX_IPC_STRUCT2_IPC	0x40220040	0x00000020	CPUSS IPC Structure #2
28	PERI_MS_PPU_FX_IPC_STRUCT3_IPC	0x40220060	0x00000020	CPUSS IPC Structure #3
29	PERI_MS_PPU_FX_IPC_STRUCT4_IPC	0x40220080	0x00000020	CPUSS IPC Structure #4
30	PERI_MS_PPU_FX_IPC_STRUCT5_IPC	0x402200A0	0x00000020	CPUSS IPC Structure #5
31	PERI_MS_PPU_FX_IPC_STRUCT6_IPC	0x402200C0	0x00000020	CPUSS IPC Structure #6
32	PERI_MS_PPU_FX_IPC_STRUCT7_IPC	0x402200E0	0x00000020	CPUSS IPC Structure #7
33	PERI_MS_PPU_FX_IPC_INTR_STRUCT0_INTR	0x40221000	0x00000010	CPUSS IPC Interrupt Structure #0
34	PERI_MS_PPU_FX_IPC_INTR_STRUCT1_INTR	0x40221020	0x00000010	CPUSS IPC Interrupt Structure #1
35	PERI_MS_PPU_FX_IPC_INTR_STRUCT2_INTR	0x40221040	0x00000010	CPUSS IPC Interrupt Structure #2
36	PERI_MS_PPU_FX_IPC_INTR_STRUCT3_INTR	0x40221060	0x00000010	CPUSS IPC Interrupt Structure #3
37	PERI_MS_PPU_FX_IPC_INTR_STRUCT4_INTR	0x40221080	0x00000010	CPUSS IPC Interrupt Structure #4
38	PERI_MS_PPU_FX_IPC_INTR_STRUCT5_INTR	0x402210A0	0x00000010	CPUSS IPC Interrupt Structure #5
39	PERI_MS_PPU_FX_IPC_INTR_STRUCT6_INTR	0x402210C0	0x00000010	CPUSS IPC Interrupt Structure #6

Note
34.Fixed PPU is configured inside the Boot and user is not allowed to change the attributes of this PPU.

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
40	PERI_MS_PPU_FX_IPC_INTR_STRUCT7_INTR	0x402210E0	0x00000010	CPUSS IPC Interrupt Structure #7
41	PERI_MS_PPU_FX_PROT_SMPU_MAIN	0x40230000	0x00000040	Peripheral protection SMPU main
42	PERI_MS_PPU_FX_PROT_MPU0_MAIN	0x40234000	0x00000004	Peripheral protection MPU #0 main
43	PERI_MS_PPU_FX_PROT_MPU14_MAIN	0x40237800	0x00000004	Peripheral protection MPU #14 main
44	PERI_MS_PPU_FX_PROT_MPU15_MAIN	0x40237C00	0x00000400	Peripheral protection MPU #15 main
45	PERI_MS_PPU_FX_FLASHC_MAIN	0x40240000	0x00000008	Flash controller main
46	PERI_MS_PPU_FX_FLASHC_CMD	0x40240008	0x00000004	Flash controller command
47	PERI_MS_PPU_FX_FLASHC_DFT	0x40240200	0x00000100	Flash controller tests
48	PERI_MS_PPU_FX_FLASHC_CM0	0x40240400	0x00000080	Flash controller CM0+
49	PERI_MS_PPU_FX_FLASHC_CM4	0x40240480	0x00000080	Flash controller CM4
50	PERI_MS_PPU_FX_FLASHC_CRYPTO	0x40240500	0x00000004	Flash controller Crypto
51	PERI_MS_PPU_FX_FLASHC_DW0	0x40240580	0x00000004	Flash controller P-DMA0
52	PERI_MS_PPU_FX_FLASHC_DW1	0x40240600	0x00000004	Flash controller P-DMA1
53	PERI_MS_PPU_FX_FLASHC_DMAC	0x40240680	0x00000004	Flash controller M-DMA0
54	PERI_MS_PPU_FX_FLASHC_FlashMgmt[35]	0x4024F000	0x00000080	Flash management
55	PERI_MS_PPU_FX_FLASHC_MainSafety	0x4024F400	0x00000008	Flash controller code-flash safety
56	PERI_MS_PPU_FX_FLASHC_WorkSafety	0x4024F500	0x00000004	Flash controller work-flash safety
57	PERI_MS_PPU_FX_SRSS_GENERAL	0x40260000	0x00000400	SRSS General
58	PERI_MS_PPU_FX_SRSS_MAIN	0x40261000	0x00001000	SRSS main
59	PERI_MS_PPU_FX_SRSS_SECURE	0x40262000	0x00002000	SRSS secure
60	PERI_MS_PPU_FX_MCWDT0_CONFIG	0x40268000	0x00000080	MCWDT #0 configuration
61	PERI_MS_PPU_FX_MCWDT1_CONFIG	0x40268100	0x00000080	MCWDT #1 configuration
62	PERI_MS_PPU_FX_MCWDT0_MAIN	0x40268080	0x00000040	MCWDT #0 main
63	PERI_MS_PPU_FX_MCWDT1_MAIN	0x40268180	0x00000040	MCWDT #1 main
64	PERI_MS_PPU_FX_WDT_CONFIG	0x4026C000	0x00000020	System WDT configuration
65	PERI_MS_PPU_FX_WDT_MAIN	0x4026C040	0x00000020	System WDT main
66	PERI_MS_PPU_FX_BACKUP_BACKUP	0x40270000	0x00010000	SRSS backup
67	PERI_MS_PPU_FX_DW0_DW	0x40280000	0x00000100	P-DMA0 main
68	PERI_MS_PPU_FX_DW1_DW	0x40290000	0x00000100	P-DMA1 main
69	PERI_MS_PPU_FX_DW0_DW_CRC	0x40280100	0x00000080	P-DMA0 CRC
70	PERI_MS_PPU_FX_DW1_DW_CRC	0x40290100	0x00000080	P-DMA1 CRC
71	PERI_MS_PPU_FX_DW0_CH_STRUCT0_CH	0x40288000	0x00000040	P-DMA0 Channel #0
72	PERI_MS_PPU_FX_DW0_CH_STRUCT1_CH	0x40288040	0x00000040	P-DMA0 Channel #1
73	PERI_MS_PPU_FX_DW0_CH_STRUCT2_CH	0x40288080	0x00000040	P-DMA0 Channel #2
74	PERI_MS_PPU_FX_DW0_CH_STRUCT3_CH	0x402880C0	0x00000040	P-DMA0 Channel #3
75	PERI_MS_PPU_FX_DW0_CH_STRUCT4_CH	0x40288100	0x00000040	P-DMA0 Channel #4
76	PERI_MS_PPU_FX_DW0_CH_STRUCT5_CH	0x40288140	0x00000040	P-DMA0 Channel #5
77	PERI_MS_PPU_FX_DW0_CH_STRUCT6_CH	0x40288180	0x00000040	P-DMA0 Channel #6
78	PERI_MS_PPU_FX_DW0_CH_STRUCT7_CH	0x402881C0	0x00000040	P-DMA0 Channel #7
79	PERI_MS_PPU_FX_DW0_CH_STRUCT8_CH	0x40288200	0x00000040	P-DMA0 Channel #8
80	PERI_MS_PPU_FX_DW0_CH_STRUCT9_CH	0x40288240	0x00000040	P-DMA0 Channel #9
81	PERI_MS_PPU_FX_DW0_CH_STRUCT10_CH	0x40288280	0x00000040	P-DMA0 Channel #10
82	PERI_MS_PPU_FX_DW0_CH_STRUCT11_CH	0x402882C0	0x00000040	P-DMA0 Channel #11
83	PERI_MS_PPU_FX_DW0_CH_STRUCT12_CH	0x40288300	0x00000040	P-DMA0 Channel #12

Note
35.Fixed PPU is configured inside the Boot and user is not allowed to change the attributes of this PPU.

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
84	PERI_MS_PPU_FX_DW0_CH_STRUCT13_CH	0x40288340	0x00000040	P-DMA0 Channel #13
85	PERI_MS_PPU_FX_DW0_CH_STRUCT14_CH	0x40288380	0x00000040	P-DMA0 Channel #14
86	PERI_MS_PPU_FX_DW0_CH_STRUCT15_CH	0x402883C0	0x00000040	P-DMA0 Channel #15
87	PERI_MS_PPU_FX_DW0_CH_STRUCT16_CH	0x40288400	0x00000040	P-DMA0 Channel #16
88	PERI_MS_PPU_FX_DW0_CH_STRUCT17_CH	0x40288440	0x00000040	P-DMA0 Channel #17
89	PERI_MS_PPU_FX_DW0_CH_STRUCT18_CH	0x40288480	0x00000040	P-DMA0 Channel #18
90	PERI_MS_PPU_FX_DW0_CH_STRUCT19_CH	0x402884C0	0x00000040	P-DMA0 Channel #19
91	PERI_MS_PPU_FX_DW0_CH_STRUCT20_CH	0x40288500	0x00000040	P-DMA0 Channel #20
92	PERI_MS_PPU_FX_DW0_CH_STRUCT21_CH	0x40288540	0x00000040	P-DMA0 Channel #21
93	PERI_MS_PPU_FX_DW0_CH_STRUCT22_CH	0x40288580	0x00000040	P-DMA0 Channel #22
94	PERI_MS_PPU_FX_DW0_CH_STRUCT23_CH	0x402885C0	0x00000040	P-DMA0 Channel #23
95	PERI_MS_PPU_FX_DW0_CH_STRUCT24_CH	0x40288600	0x00000040	P-DMA0 Channel #24
96	PERI_MS_PPU_FX_DW0_CH_STRUCT25_CH	0x40288640	0x00000040	P-DMA0 Channel #25
97	PERI_MS_PPU_FX_DW0_CH_STRUCT26_CH	0x40288680	0x00000040	P-DMA0 Channel #26
98	PERI_MS_PPU_FX_DW0_CH_STRUCT27_CH	0x402886C0	0x00000040	P-DMA0 Channel #27
99	PERI_MS_PPU_FX_DW0_CH_STRUCT28_CH	0x40288700	0x00000040	P-DMA0 Channel #28
100	PERI_MS_PPU_FX_DW0_CH_STRUCT29_CH	0x40288740	0x00000040	P-DMA0 Channel #29
101	PERI_MS_PPU_FX_DW0_CH_STRUCT30_CH	0x40288780	0x00000040	P-DMA0 Channel #30
102	PERI_MS_PPU_FX_DW0_CH_STRUCT31_CH	0x402887C0	0x00000040	P-DMA0 Channel #31
103	PERI_MS_PPU_FX_DW0_CH_STRUCT32_CH	0x40288800	0x00000040	P-DMA0 Channel #32
104	PERI_MS_PPU_FX_DW0_CH_STRUCT33_CH	0x40288840	0x00000040	P-DMA0 Channel #33
105	PERI_MS_PPU_FX_DW0_CH_STRUCT34_CH	0x40288880	0x00000040	P-DMA0 Channel #34
106	PERI_MS_PPU_FX_DW0_CH_STRUCT35_CH	0x402888C0	0x00000040	P-DMA0 Channel #35
107	PERI_MS_PPU_FX_DW0_CH_STRUCT36_CH	0x40288900	0x00000040	P-DMA0 Channel #36
108	PERI_MS_PPU_FX_DW0_CH_STRUCT37_CH	0x40288940	0x00000040	P-DMA0 Channel #37
109	PERI_MS_PPU_FX_DW0_CH_STRUCT38_CH	0x40288980	0x00000040	P-DMA0 Channel #38
110	PERI_MS_PPU_FX_DW0_CH_STRUCT39_CH	0x402889C0	0x00000040	P-DMA0 Channel #39
111	PERI_MS_PPU_FX_DW0_CH_STRUCT40_CH	0x40288A00	0x00000040	P-DMA0 Channel #40
112	PERI_MS_PPU_FX_DW0_CH_STRUCT41_CH	0x40288A40	0x00000040	P-DMA0 Channel #41
113	PERI_MS_PPU_FX_DW0_CH_STRUCT42_CH	0x40288A80	0x00000040	P-DMA0 Channel #42
114	PERI_MS_PPU_FX_DW0_CH_STRUCT43_CH	0x40288AC0	0x00000040	P-DMA0 Channel #43
115	PERI_MS_PPU_FX_DW0_CH_STRUCT44_CH	0x40288B00	0x00000040	P-DMA0 Channel #44
116	PERI_MS_PPU_FX_DW0_CH_STRUCT45_CH	0x40288B40	0x00000040	P-DMA0 Channel #45
117	PERI_MS_PPU_FX_DW0_CH_STRUCT46_CH	0x40288B80	0x00000040	P-DMA0 Channel #46
118	PERI_MS_PPU_FX_DW0_CH_STRUCT47_CH	0x40288BC0	0x00000040	P-DMA0 Channel #47
119	PERI_MS_PPU_FX_DW0_CH_STRUCT48_CH	0x40288C00	0x00000040	P-DMA0 Channel #48
120	PERI_MS_PPU_FX_DW0_CH_STRUCT49_CH	0x40288C40	0x00000040	P-DMA0 Channel #49
121	PERI_MS_PPU_FX_DW0_CH_STRUCT50_CH	0x40288C80	0x00000040	P-DMA0 Channel #50
122	PERI_MS_PPU_FX_DW0_CH_STRUCT51_CH	0x40288CC0	0x00000040	P-DMA0 Channel #51
123	PERI_MS_PPU_FX_DW0_CH_STRUCT52_CH	0x40288D00	0x00000040	P-DMA0 Channel #52
124	PERI_MS_PPU_FX_DW0_CH_STRUCT53_CH	0x40288D40	0x00000040	P-DMA0 Channel #53
125	PERI_MS_PPU_FX_DW0_CH_STRUCT54_CH	0x40288D80	0x00000040	P-DMA0 Channel #54
126	PERI_MS_PPU_FX_DW0_CH_STRUCT55_CH	0x40288DC0	0x00000040	P-DMA0 Channel #55
127	PERI_MS_PPU_FX_DW0_CH_STRUCT56_CH	0x40288E00	0x00000040	P-DMA0 Channel #56
128	PERI_MS_PPU_FX_DW0_CH_STRUCT57_CH	0x40288E40	0x00000040	P-DMA0 Channel #57

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
129	PERI_MS_PPU_FX_DW0_CH_STRUCT58_CH	0x40288E80	0x00000040	P-DMA0 Channel #58
130	PERI_MS_PPU_FX_DW0_CH_STRUCT59_CH	0x40288EC0	0x00000040	P-DMA0 Channel #59
131	PERI_MS_PPU_FX_DW0_CH_STRUCT60_CH	0x40288F00	0x00000040	P-DMA0 Channel #60
132	PERI_MS_PPU_FX_DW0_CH_STRUCT61_CH	0x40288F40	0x00000040	P-DMA0 Channel #61
133	PERI_MS_PPU_FX_DW0_CH_STRUCT62_CH	0x40288F80	0x00000040	P-DMA0 Channel #62
134	PERI_MS_PPU_FX_DW0_CH_STRUCT63_CH	0x40288FC0	0x00000040	P-DMA0 Channel #63
135	PERI_MS_PPU_FX_DW0_CH_STRUCT64_CH	0x40289000	0x00000040	P-DMA0 Channel #64
136	PERI_MS_PPU_FX_DW0_CH_STRUCT65_CH	0x40289040	0x00000040	P-DMA0 Channel #65
137	PERI_MS_PPU_FX_DW0_CH_STRUCT66_CH	0x40289080	0x00000040	P-DMA0 Channel #66
138	PERI_MS_PPU_FX_DW0_CH_STRUCT67_CH	0x402890C0	0x00000040	P-DMA0 Channel #67
139	PERI_MS_PPU_FX_DW0_CH_STRUCT68_CH	0x40289100	0x00000040	P-DMA0 Channel #68
140	PERI_MS_PPU_FX_DW0_CH_STRUCT69_CH	0x40289140	0x00000040	P-DMA0 Channel #69
141	PERI_MS_PPU_FX_DW0_CH_STRUCT70_CH	0x40289180	0x00000040	P-DMA0 Channel #70
142	PERI_MS_PPU_FX_DW0_CH_STRUCT71_CH	0x402891C0	0x00000040	P-DMA0 Channel #71
143	PERI_MS_PPU_FX_DW0_CH_STRUCT72_CH	0x40289200	0x00000040	P-DMA0 Channel #72
144	PERI_MS_PPU_FX_DW0_CH_STRUCT73_CH	0x40289240	0x00000040	P-DMA0 Channel #73
145	PERI_MS_PPU_FX_DW0_CH_STRUCT74_CH	0x40289280	0x00000040	P-DMA0 Channel #74
146	PERI_MS_PPU_FX_DW0_CH_STRUCT75_CH	0x402892C0	0x00000040	P-DMA0 Channel #75
147	PERI_MS_PPU_FX_DW0_CH_STRUCT76_CH	0x40289300	0x00000040	P-DMA0 Channel #76
148	PERI_MS_PPU_FX_DW0_CH_STRUCT77_CH	0x40289340	0x00000040	P-DMA0 Channel #77
149	PERI_MS_PPU_FX_DW0_CH_STRUCT78_CH	0x40289380	0x00000040	P-DMA0 Channel #78
150	PERI_MS_PPU_FX_DW0_CH_STRUCT79_CH	0x402893C0	0x00000040	P-DMA0 Channel #79
151	PERI_MS_PPU_FX_DW0_CH_STRUCT80_CH	0x40289400	0x00000040	P-DMA0 Channel #80
152	PERI_MS_PPU_FX_DW0_CH_STRUCT81_CH	0x40289440	0x00000040	P-DMA0 Channel #81
153	PERI_MS_PPU_FX_DW0_CH_STRUCT82_CH	0x40289480	0x00000040	P-DMA0 Channel #82
154	PERI_MS_PPU_FX_DW0_CH_STRUCT83_CH	0x402894C0	0x00000040	P-DMA0 Channel #83
155	PERI_MS_PPU_FX_DW0_CH_STRUCT84_CH	0x40289500	0x00000040	P-DMA0 Channel #84
156	PERI_MS_PPU_FX_DW0_CH_STRUCT85_CH	0x40289540	0x00000040	P-DMA0 Channel #85
157	PERI_MS_PPU_FX_DW0_CH_STRUCT86_CH	0x40289580	0x00000040	P-DMA0 Channel #86
158	PERI_MS_PPU_FX_DW0_CH_STRUCT87_CH	0x402895C0	0x00000040	P-DMA0 Channel #87
159	PERI_MS_PPU_FX_DW0_CH_STRUCT88_CH	0x40289600	0x00000040	P-DMA0 Channel #88
160	PERI_MS_PPU_FX_DW0_CH_STRUCT89_CH	0x40289640	0x00000040	P-DMA0 Channel #89
161	PERI_MS_PPU_FX_DW0_CH_STRUCT90_CH	0x40289680	0x00000040	P-DMA0 Channel #90
162	PERI_MS_PPU_FX_DW0_CH_STRUCT91_CH	0x402896C0	0x00000040	P-DMA0 Channel #91
163	PERI_MS_PPU_FX_DW1_CH_STRUCT0_CH	0x40298000	0x00000040	P-DMA1 Channel #0
164	PERI_MS_PPU_FX_DW1_CH_STRUCT1_CH	0x40298040	0x00000040	P-DMA1 Channel #1
165	PERI_MS_PPU_FX_DW1_CH_STRUCT2_CH	0x40298080	0x00000040	P-DMA1 Channel #2
166	PERI_MS_PPU_FX_DW1_CH_STRUCT3_CH	0x402980C0	0x00000040	P-DMA1 Channel #3
167	PERI_MS_PPU_FX_DW1_CH_STRUCT4_CH	0x40298100	0x00000040	P-DMA1 Channel #4
168	PERI_MS_PPU_FX_DW1_CH_STRUCT5_CH	0x40298140	0x00000040	P-DMA1 Channel #5
169	PERI_MS_PPU_FX_DW1_CH_STRUCT6_CH	0x40298180	0x00000040	P-DMA1 Channel #6
170	PERI_MS_PPU_FX_DW1_CH_STRUCT7_CH	0x402981C0	0x00000040	P-DMA1 Channel #7
171	PERI_MS_PPU_FX_DW1_CH_STRUCT8_CH	0x40298200	0x00000040	P-DMA1 Channel #8
172	PERI_MS_PPU_FX_DW1_CH_STRUCT9_CH	0x40298240	0x00000040	P-DMA1 Channel #9
173	PERI_MS_PPU_FX_DW1_CH_STRUCT10_CH	0x40298280	0x00000040	P-DMA1 Channel #10

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
174	PERI_MS_PPU_FX_DW1_CH_STRUCT11_CH	0x402982C0	0x00000040	P-DMA1 Channel #11
175	PERI_MS_PPU_FX_DW1_CH_STRUCT12_CH	0x40298300	0x00000040	P-DMA1 Channel #12
176	PERI_MS_PPU_FX_DW1_CH_STRUCT13_CH	0x40298340	0x00000040	P-DMA1 Channel #13
177	PERI_MS_PPU_FX_DW1_CH_STRUCT14_CH	0x40298380	0x00000040	P-DMA1 Channel #14
178	PERI_MS_PPU_FX_DW1_CH_STRUCT15_CH	0x402983C0	0x00000040	P-DMA1 Channel #15
179	PERI_MS_PPU_FX_DW1_CH_STRUCT16_CH	0x40298400	0x00000040	P-DMA1 Channel #16
180	PERI_MS_PPU_FX_DW1_CH_STRUCT17_CH	0x40298440	0x00000040	P-DMA1 Channel #17
181	PERI_MS_PPU_FX_DW1_CH_STRUCT18_CH	0x40298480	0x00000040	P-DMA1 Channel #18
182	PERI_MS_PPU_FX_DW1_CH_STRUCT19_CH	0x402984C0	0x00000040	P-DMA1 Channel #19
183	PERI_MS_PPU_FX_DW1_CH_STRUCT20_CH	0x40298500	0x00000040	P-DMA1 Channel #20
184	PERI_MS_PPU_FX_DW1_CH_STRUCT21_CH	0x40298540	0x00000040	P-DMA1 Channel #21
185	PERI_MS_PPU_FX_DW1_CH_STRUCT22_CH	0x40298580	0x00000040	P-DMA1 Channel #22
186	PERI_MS_PPU_FX_DW1_CH_STRUCT23_CH	0x402985C0	0x00000040	P-DMA1 Channel #23
187	PERI_MS_PPU_FX_DW1_CH_STRUCT24_CH	0x40298600	0x00000040	P-DMA1 Channel #24
188	PERI_MS_PPU_FX_DW1_CH_STRUCT25_CH	0x40298640	0x00000040	P-DMA1 Channel #25
189	PERI_MS_PPU_FX_DW1_CH_STRUCT26_CH	0x40298680	0x00000040	P-DMA1 Channel #26
190	PERI_MS_PPU_FX_DW1_CH_STRUCT27_CH	0x402986C0	0x00000040	P-DMA1 Channel #27
191	PERI_MS_PPU_FX_DW1_CH_STRUCT28_CH	0x40298700	0x00000040	P-DMA1 Channel #28
192	PERI_MS_PPU_FX_DW1_CH_STRUCT29_CH	0x40298740	0x00000040	P-DMA1 Channel #29
193	PERI_MS_PPU_FX_DW1_CH_STRUCT30_CH	0x40298780	0x00000040	P-DMA1 Channel #30
194	PERI_MS_PPU_FX_DW1_CH_STRUCT31_CH	0x402987C0	0x00000040	P-DMA1 Channel #31
195	PERI_MS_PPU_FX_DW1_CH_STRUCT32_CH	0x40298800	0x00000040	P-DMA1 Channel #32
196	PERI_MS_PPU_FX_DW1_CH_STRUCT33_CH	0x40298840	0x00000040	P-DMA1 Channel #33
197	PERI_MS_PPU_FX_DW1_CH_STRUCT34_CH	0x40298880	0x00000040	P-DMA1 Channel #34
198	PERI_MS_PPU_FX_DW1_CH_STRUCT35_CH	0x402988C0	0x00000040	P-DMA1 Channel #35
199	PERI_MS_PPU_FX_DW1_CH_STRUCT36_CH	0x40298900	0x00000040	P-DMA1 Channel #36
200	PERI_MS_PPU_FX_DW1_CH_STRUCT37_CH	0x40298940	0x00000040	P-DMA1 Channel #37
201	PERI_MS_PPU_FX_DW1_CH_STRUCT38_CH	0x40298980	0x00000040	P-DMA1 Channel #38
202	PERI_MS_PPU_FX_DW1_CH_STRUCT39_CH	0x402989C0	0x00000040	P-DMA1 Channel #39
203	PERI_MS_PPU_FX_DW1_CH_STRUCT40_CH	0x40298A00	0x00000040	P-DMA1 Channel #40
204	PERI_MS_PPU_FX_DW1_CH_STRUCT41_CH	0x40298A40	0x00000040	P-DMA1 Channel #41
205	PERI_MS_PPU_FX_DW1_CH_STRUCT42_CH	0x40298A80	0x00000040	P-DMA1 Channel #42
206	PERI_MS_PPU_FX_DW1_CH_STRUCT43_CH	0x40298AC0	0x00000040	P-DMA1 Channel #43
207	PERI_MS_PPU_FX_DMAC_TOP	0x402A0000	0x00000010	M-DMA0 main
208	PERI_MS_PPU_FX_DMAC_CH0_CH	0x402A1000	0x00000100	M-DMA0 Channel #0
209	PERI_MS_PPU_FX_DMAC_CH1_CH	0x402A1100	0x00000100	M-DMA0 Channel #1
210	PERI_MS_PPU_FX_DMAC_CH2_CH	0x402A1200	0x00000100	M-DMA0 Channel #2
211	PERI_MS_PPU_FX_DMAC_CH3_CH	0x402A1300	0x00000100	M-DMA0 Channel #3
212	PERI_MS_PPU_FX_EFUSE_CTL	0x402C0000	0x00000200	EFUSE control
213	PERI_MS_PPU_FX_EFUSE_DATA	0x402C0800	0x00000200	EFUSE data
214	PERI_MS_PPU_FX_BIST	0x402F0000	0x00001000	Built-in self test
215	PERI_MS_PPU_FX_HSIOM_PRT0_PRT	0x40300000	0x00000008	HSIOm Port #0
216	PERI_MS_PPU_FX_HSIOM_PRT1_PRT	0x40300010	0x00000008	HSIOm Port #1
217	PERI_MS_PPU_FX_HSIOM_PRT2_PRT	0x40300020	0x00000008	HSIOm Port #2
218	PERI_MS_PPU_FX_HSIOM_PRT3_PRT	0x40300030	0x00000008	HSIOm Port #3

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
219	PERI_MS_PPU_FX_HSIOM_PRT4_PRT	0x40300040	0x00000008	HSIOm Port #4
220	PERI_MS_PPU_FX_HSIOM_PRT5_PRT	0x40300050	0x00000008	HSIOm Port #5
221	PERI_MS_PPU_FX_HSIOM_PRT6_PRT	0x40300060	0x00000008	HSIOm Port #6
222	PERI_MS_PPU_FX_HSIOM_PRT7_PRT	0x40300070	0x00000008	HSIOm Port #7
223	PERI_MS_PPU_FX_HSIOM_PRT8_PRT	0x40300080	0x00000008	HSIOm Port #8
224	PERI_MS_PPU_FX_HSIOM_PRT9_PRT	0x40300090	0x00000008	HSIOm Port #9
225	PERI_MS_PPU_FX_HSIOM_PRT10_PRT	0x403000A0	0x00000008	HSIOm Port #10
226	PERI_MS_PPU_FX_HSIOM_PRT11_PRT	0x403000B0	0x00000008	HSIOm Port #11
227	PERI_MS_PPU_FX_HSIOM_PRT12_PRT	0x403000C0	0x00000008	HSIOm Port #12
228	PERI_MS_PPU_FX_HSIOM_PRT13_PRT	0x403000D0	0x00000008	HSIOm Port #13
229	PERI_MS_PPU_FX_HSIOM_PRT14_PRT	0x403000E0	0x00000008	HSIOm Port #14
230	PERI_MS_PPU_FX_HSIOM_PRT15_PRT	0x403000F0	0x00000008	HSIOm Port #15
231	PERI_MS_PPU_FX_HSIOM_PRT16_PRT	0x40300100	0x00000008	HSIOm Port #16
232	PERI_MS_PPU_FX_HSIOM_PRT17_PRT	0x40300110	0x00000008	HSIOm Port #17
233	PERI_MS_PPU_FX_HSIOM_PRT18_PRT	0x40300120	0x00000008	HSIOm Port #18
234	PERI_MS_PPU_FX_HSIOM_PRT19_PRT	0x40300130	0x00000008	HSIOm Port #19
235	PERI_MS_PPU_FX_HSIOM_PRT20_PRT	0x40300140	0x00000008	HSIOm Port #20
236	PERI_MS_PPU_FX_HSIOM_PRT21_PRT	0x40300150	0x00000008	HSIOm Port #21
237	PERI_MS_PPU_FX_HSIOM_PRT22_PRT	0x40300160	0x00000008	HSIOm Port #22
238	PERI_MS_PPU_FX_HSIOM_PRT23_PRT	0x40300170	0x00000008	HSIOm Port #23
239	PERI_MS_PPU_FX_HSIOM_AMUX	0x40302000	0x00000010	HSIOm Analog multiplexer
240	PERI_MS_PPU_FX_HSIOM_MON	0x40302200	0x00000010	HSIOm monitor
241	PERI_MS_PPU_FX_HSIOM_ALTJTAG	0x40302240	0x00000004	HSIOm Alternate JTAG
242	PERI_MS_PPU_FX_GPIO_PRT0_PRT	0x40310000	0x00000040	GPIO_ENH Port #0
243	PERI_MS_PPU_FX_GPIO_PRT1_PRT	0x40310080	0x00000040	GPIO_STD Port #1
244	PERI_MS_PPU_FX_GPIO_PRT2_PRT	0x40310100	0x00000040	GPIO_STD Port #2
245	PERI_MS_PPU_FX_GPIO_PRT3_PRT	0x40310180	0x00000040	GPIO_STD Port #3
246	PERI_MS_PPU_FX_GPIO_PRT4_PRT	0x40310200	0x00000040	GPIO_STD Port #4
247	PERI_MS_PPU_FX_GPIO_PRT5_PRT	0x40310280	0x00000040	GPIO_STD Port #5
248	PERI_MS_PPU_FX_GPIO_PRT6_PRT	0x40310300	0x00000040	GPIO_STD Port #6
249	PERI_MS_PPU_FX_GPIO_PRT7_PRT	0x40310380	0x00000040	GPIO_STD Port #7
250	PERI_MS_PPU_FX_GPIO_PRT8_PRT	0x40310400	0x00000040	GPIO_STD Port #8
251	PERI_MS_PPU_FX_GPIO_PRT9_PRT	0x40310480	0x00000040	GPIO_STD Port #9
252	PERI_MS_PPU_FX_GPIO_PRT10_PRT	0x40310500	0x00000040	GPIO_STD Port #10
253	PERI_MS_PPU_FX_GPIO_PRT11_PRT	0x40310580	0x00000040	GPIO_STD Port #11
254	PERI_MS_PPU_FX_GPIO_PRT12_PRT	0x40310600	0x00000040	GPIO_STD Port #12
255	PERI_MS_PPU_FX_GPIO_PRT13_PRT	0x40310680	0x00000040	GPIO_STD Port #13
256	PERI_MS_PPU_FX_GPIO_PRT14_PRT	0x40310700	0x00000040	GPIO_STD Port #14
257	PERI_MS_PPU_FX_GPIO_PRT15_PRT	0x40310780	0x00000040	GPIO_STD Port #15
258	PERI_MS_PPU_FX_GPIO_PRT16_PRT	0x40310800	0x00000040	GPIO_STD Port #16
259	PERI_MS_PPU_FX_GPIO_PRT17_PRT	0x40310880	0x00000040	GPIO_STD Port #17
260	PERI_MS_PPU_FX_GPIO_PRT18_PRT	0x40310900	0x00000040	GPIO_STD Port #18
261	PERI_MS_PPU_FX_GPIO_PRT19_PRT	0x40310980	0x00000040	GPIO_STD Port #19
262	PERI_MS_PPU_FX_GPIO_PRT20_PRT	0x40310A00	0x00000040	GPIO_STD Port #20
263	PERI_MS_PPU_FX_GPIO_PRT21_PRT	0x40310A80	0x00000040	GPIO_STD Port #21

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
264	PERI_MS_PPU_FX_GPIO_PRT22_PRT	0x40310B00	0x00000040	GPIO_STD Port #22
265	PERI_MS_PPU_FX_GPIO_PRT23_PRT	0x40310B80	0x00000040	GPIO_STD Port #23
266	PERI_MS_PPU_FX_GPIO_PRT0_CFG	0x40310040	0x00000020	GPIO_ENH Port #0 configuration
267	PERI_MS_PPU_FX_GPIO_PRT1_CFG	0x403100C0	0x00000020	GPIO_STD Port #1 configuration
268	PERI_MS_PPU_FX_GPIO_PRT2_CFG	0x40310140	0x00000020	GPIO_STD Port #2 configuration
269	PERI_MS_PPU_FX_GPIO_PRT3_CFG	0x403101C0	0x00000020	GPIO_STD Port #3 configuration
270	PERI_MS_PPU_FX_GPIO_PRT4_CFG	0x40310240	0x00000020	GPIO_STD Port #4 configuration
271	PERI_MS_PPU_FX_GPIO_PRT5_CFG	0x403102C0	0x00000020	GPIO_STD Port #5 configuration
272	PERI_MS_PPU_FX_GPIO_PRT6_CFG	0x40310340	0x00000020	GPIO_STD Port #6 configuration
273	PERI_MS_PPU_FX_GPIO_PRT7_CFG	0x403103C0	0x00000020	GPIO_STD Port #7 configuration
274	PERI_MS_PPU_FX_GPIO_PRT8_CFG	0x40310440	0x00000020	GPIO_STD Port #8 configuration
275	PERI_MS_PPU_FX_GPIO_PRT9_CFG	0x403104C0	0x00000020	GPIO_STD Port #9 configuration
276	PERI_MS_PPU_FX_GPIO_PRT10_CFG	0x40310540	0x00000020	GPIO_STD Port #10 configuration
277	PERI_MS_PPU_FX_GPIO_PRT11_CFG	0x403105C0	0x00000020	GPIO_STD Port #11 configuration
278	PERI_MS_PPU_FX_GPIO_PRT12_CFG	0x40310640	0x00000020	GPIO_STD Port #12 configuration
279	PERI_MS_PPU_FX_GPIO_PRT13_CFG	0x403106C0	0x00000020	GPIO_STD Port #13 configuration
280	PERI_MS_PPU_FX_GPIO_PRT14_CFG	0x40310740	0x00000020	GPIO_STD Port #14 configuration
281	PERI_MS_PPU_FX_GPIO_PRT15_CFG	0x403107C0	0x00000020	GPIO_STD Port #15 configuration
282	PERI_MS_PPU_FX_GPIO_PRT16_CFG	0x40310840	0x00000020	GPIO_STD Port #16 configuration
283	PERI_MS_PPU_FX_GPIO_PRT17_CFG	0x403108C0	0x00000020	GPIO_STD Port #17 configuration
284	PERI_MS_PPU_FX_GPIO_PRT18_CFG	0x40310940	0x00000020	GPIO_STD Port #18 configuration
285	PERI_MS_PPU_FX_GPIO_PRT19_CFG	0x403109C0	0x00000020	GPIO_STD Port #19 configuration
286	PERI_MS_PPU_FX_GPIO_PRT20_CFG	0x40310A40	0x00000020	GPIO_STD Port #20 configuration
287	PERI_MS_PPU_FX_GPIO_PRT21_CFG	0x40310AC0	0x00000020	GPIO_STD Port #21 configuration
288	PERI_MS_PPU_FX_GPIO_PRT22_CFG	0x40310B40	0x00000020	GPIO_STD Port #22 configuration
289	PERI_MS_PPU_FX_GPIO_PRT23_CFG	0x40310BC0	0x00000020	GPIO_STD Port #23 configuration
290	PERI_MS_PPU_FX_GPIO_GPIO	0x40314000	0x00000040	GPIO main
291	PERI_MS_PPU_FX_GPIO_TEST	0x40315000	0x00000008	GPIO test
292	PERI_MS_PPU_FX_SMARTIO_PRT12_PRT	0x40320C00	0x00000100	SMART I/O #12
293	PERI_MS_PPU_FX_SMARTIO_PRT13_PRT	0x40320D00	0x00000100	SMART I/O #13
294	PERI_MS_PPU_FX_SMARTIO_PRT14_PRT	0x40320E00	0x00000100	SMART I/O #14
295	PERI_MS_PPU_FX_SMARTIO_PRT15_PRT	0x40320F00	0x00000100	SMART I/O #15
296	PERI_MS_PPU_FX_SMARTIO_PRT17_PRT	0x40321100	0x00000100	SMART I/O #17
297	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT0_CNT	0x40380000	0x00000080	TCPWM0 Group #0, Counter #0
298	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT1_CNT	0x40380080	0x00000080	TCPWM0 Group #0, Counter #1
299	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT2_CNT	0x40380100	0x00000080	TCPWM0 Group #0, Counter #2
300	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT3_CNT	0x40380180	0x00000080	TCPWM0 Group #0, Counter #3
301	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT4_CNT	0x40380200	0x00000080	TCPWM0 Group #0, Counter #4
302	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT5_CNT	0x40380280	0x00000080	TCPWM0 Group #0, Counter #5
303	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT6_CNT	0x40380300	0x00000080	TCPWM0 Group #0, Counter #6
304	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT7_CNT	0x40380380	0x00000080	TCPWM0 Group #0, Counter #7
305	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT8_CNT	0x40380400	0x00000080	TCPWM0 Group #0, Counter #8
306	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT9_CNT	0x40380480	0x00000080	TCPWM0 Group #0, Counter #9
307	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT10_CNT	0x40380500	0x00000080	TCPWM0 Group #0, Counter #10
308	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT11_CNT	0x40380580	0x00000080	TCPWM0 Group #0, Counter #11

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
309	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT12_CNT	0x40380600	0x00000080	TCPWM0 Group #0, Counter #12
310	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT13_CNT	0x40380680	0x00000080	TCPWM0 Group #0, Counter #13
311	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT14_CNT	0x40380700	0x00000080	TCPWM0 Group #0, Counter #14
312	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT15_CNT	0x40380780	0x00000080	TCPWM0 Group #0, Counter #15
313	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT16_CNT	0x40380800	0x00000080	TCPWM0 Group #0, Counter #16
314	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT17_CNT	0x40380880	0x00000080	TCPWM0 Group #0, Counter #17
315	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT18_CNT	0x40380900	0x00000080	TCPWM0 Group #0, Counter #18
316	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT19_CNT	0x40380980	0x00000080	TCPWM0 Group #0, Counter #19
317	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT20_CNT	0x40380A00	0x00000080	TCPWM0 Group #0, Counter #20
318	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT21_CNT	0x40380A80	0x00000080	TCPWM0 Group #0, Counter #21
319	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT22_CNT	0x40380B00	0x00000080	TCPWM0 Group #0, Counter #22
320	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT23_CNT	0x40380B80	0x00000080	TCPWM0 Group #0, Counter #23
321	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT24_CNT	0x40380C00	0x00000080	TCPWM0 Group #0, Counter #24
322	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT25_CNT	0x40380C80	0x00000080	TCPWM0 Group #0, Counter #25
323	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT26_CNT	0x40380D00	0x00000080	TCPWM0 Group #0, Counter #26
324	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT27_CNT	0x40380D80	0x00000080	TCPWM0 Group #0, Counter #27
325	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT28_CNT	0x40380E00	0x00000080	TCPWM0 Group #0, Counter #28
326	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT29_CNT	0x40380E80	0x00000080	TCPWM0 Group #0, Counter #29
327	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT30_CNT	0x40380F00	0x00000080	TCPWM0 Group #0, Counter #30
328	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT31_CNT	0x40380F80	0x00000080	TCPWM0 Group #0, Counter #31
329	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT32_CNT	0x40381000	0x00000080	TCPWM0 Group #0, Counter #32
330	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT33_CNT	0x40381080	0x00000080	TCPWM0 Group #0, Counter #33
331	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT34_CNT	0x40381100	0x00000080	TCPWM0 Group #0, Counter #34
332	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT35_CNT	0x40381180	0x00000080	TCPWM0 Group #0, Counter #35
333	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT36_CNT	0x40381200	0x00000080	TCPWM0 Group #0, Counter #36
334	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT37_CNT	0x40381280	0x00000080	TCPWM0 Group #0, Counter #37
335	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT38_CNT	0x40381300	0x00000080	TCPWM0 Group #0, Counter #38
336	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT39_CNT	0x40381380	0x00000080	TCPWM0 Group #0, Counter #39
337	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT40_CNT	0x40381400	0x00000080	TCPWM0 Group #0, Counter #40
338	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT41_CNT	0x40381480	0x00000080	TCPWM0 Group #0, Counter #41
339	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT42_CNT	0x40381500	0x00000080	TCPWM0 Group #0, Counter #42
340	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT43_CNT	0x40381580	0x00000080	TCPWM0 Group #0, Counter #43
341	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT44_CNT	0x40381600	0x00000080	TCPWM0 Group #0, Counter #44
342	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT45_CNT	0x40381680	0x00000080	TCPWM0 Group #0, Counter #45
343	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT46_CNT	0x40381700	0x00000080	TCPWM0 Group #0, Counter #46
344	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT47_CNT	0x40381780	0x00000080	TCPWM0 Group #0, Counter #47
345	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT48_CNT	0x40381800	0x00000080	TCPWM0 Group #0, Counter #48
346	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT49_CNT	0x40381880	0x00000080	TCPWM0 Group #0, Counter #49
347	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT50_CNT	0x40381900	0x00000080	TCPWM0 Group #0, Counter #50
348	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT51_CNT	0x40381980	0x00000080	TCPWM0 Group #0, Counter #51
349	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT52_CNT	0x40381A00	0x00000080	TCPWM0 Group #0, Counter #52
350	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT53_CNT	0x40381A80	0x00000080	TCPWM0 Group #0, Counter #53
351	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT54_CNT	0x40381B00	0x00000080	TCPWM0 Group #0, Counter #54
352	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT55_CNT	0x40381B80	0x00000080	TCPWM0 Group #0, Counter #55
353	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT56_CNT	0x40381C00	0x00000080	TCPWM0 Group #0, Counter #56

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
354	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT57_CNT	0x40381C80	0x00000080	TCPWM0 Group #0, Counter #57
355	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT58_CNT	0x40381D00	0x00000080	TCPWM0 Group #0, Counter #58
356	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT59_CNT	0x40381D80	0x00000080	TCPWM0 Group #0, Counter #59
357	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT60_CNT	0x40381E00	0x00000080	TCPWM0 Group #0, Counter #60
358	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT61_CNT	0x40381E80	0x00000080	TCPWM0 Group #0, Counter #61
359	PERI_MS_PPU_FX_TCPWM0_GRP0_CNT62_CNT	0x40381F00	0x00000080	TCPWM0 Group #0, Counter #62
360	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT0_CNT	0x40388000	0x00000080	TCPWM0 Group #1, Counter #0
361	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT1_CNT	0x40388080	0x00000080	TCPWM0 Group #1, Counter #1
362	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT2_CNT	0x40388100	0x00000080	TCPWM0 Group #1, Counter #2
363	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT3_CNT	0x40388180	0x00000080	TCPWM0 Group #1, Counter #3
364	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT4_CNT	0x40388200	0x00000080	TCPWM0 Group #1, Counter #4
365	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT5_CNT	0x40388280	0x00000080	TCPWM0 Group #1, Counter #5
366	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT6_CNT	0x40388300	0x00000080	TCPWM0 Group #1, Counter #6
367	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT7_CNT	0x40388380	0x00000080	TCPWM0 Group #1, Counter #7
368	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT8_CNT	0x40388400	0x00000080	TCPWM0 Group #1, Counter #8
369	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT9_CNT	0x40388480	0x00000080	TCPWM0 Group #1, Counter #9
370	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT10_CNT	0x40388500	0x00000080	TCPWM0 Group #1, Counter #10
371	PERI_MS_PPU_FX_TCPWM0_GRP1_CNT11_CNT	0x40388580	0x00000080	TCPWM0 Group #1, Counter #11
372	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT0_CNT	0x40390000	0x00000080	TCPWM0 Group #2, Counter #0
373	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT1_CNT	0x40390080	0x00000080	TCPWM0 Group #2, Counter #1
374	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT2_CNT	0x40390100	0x00000080	TCPWM0 Group #2, Counter #2
375	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT3_CNT	0x40390180	0x00000080	TCPWM0 Group #2, Counter #3
376	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT4_CNT	0x40390200	0x00000080	TCPWM0 Group #2, Counter #4
377	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT5_CNT	0x40390280	0x00000080	TCPWM0 Group #2, Counter #5
378	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT6_CNT	0x40390300	0x00000080	TCPWM0 Group #2, Counter #6
379	PERI_MS_PPU_FX_TCPWM0_GRP2_CNT7_CNT	0x40390380	0x00000080	TCPWM0 Group #2, Counter #7
380	PERI_MS_PPU_FX_EVTGEN0	0x403F0000	0x00001000	Event generator #0
381	PERI_MS_PPU_FX_LIN0_MAIN	0x40500000	0x00000008	LIN0, main
382	PERI_MS_PPU_FX_LIN0_CH0_CH	0x40508000	0x00000100	LIN0, Channel #0
383	PERI_MS_PPU_FX_LIN0_CH1_CH	0x40508100	0x00000100	LIN0, Channel #1
384	PERI_MS_PPU_FX_LIN0_CH2_CH	0x40508200	0x00000100	LIN0, Channel #2
385	PERI_MS_PPU_FX_LIN0_CH3_CH	0x40508300	0x00000100	LIN0, Channel #3
386	PERI_MS_PPU_FX_LIN0_CH4_CH	0x40508400	0x00000100	LIN0, Channel #4
387	PERI_MS_PPU_FX_LIN0_CH5_CH	0x40508500	0x00000100	LIN0, Channel #5
388	PERI_MS_PPU_FX_LIN0_CH6_CH	0x40508600	0x00000100	LIN0, Channel #6
389	PERI_MS_PPU_FX_LIN0_CH7_CH	0x40508700	0x00000100	LIN0, Channel #7
390	PERI_MS_PPU_FX_LIN0_CH8_CH	0x40508800	0x00000100	LIN0, Channel #8
391	PERI_MS_PPU_FX_LIN0_CH9_CH	0x40508900	0x00000100	LIN0, Channel #9
392	PERI_MS_PPU_FX_LIN0_CH10_CH	0x40508A00	0x00000100	LIN0, Channel #10
393	PERI_MS_PPU_FX_LIN0_CH11_CH	0x40508B00	0x00000100	LIN0, Channel #11
394	PERI_MS_PPU_FX_CXPI0_MAIN	0x40510000	0x00000008	CXPI0, main
395	PERI_MS_PPU_FX_CXPI0_CH0_CH	0x40518000	0x00000100	CXPI0, Channel #0
396	PERI_MS_PPU_FX_CXPI0_CH1_CH	0x40518100	0x00000100	CXPI0, Channel #1
397	PERI_MS_PPU_FX_CXPI0_CH2_CH	0x40518200	0x00000100	CXPI0, Channel #2
398	PERI_MS_PPU_FX_CXPI0_CH3_CH	0x40518300	0x00000100	CXPI0, Channel #3

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
399	PERI_MS_PPU_FX_CANFD0_CH0_CH	0x40520000	0x00000200	CANFD0, Channel #0
400	PERI_MS_PPU_FX_CANFD0_CH1_CH	0x40520200	0x00000200	CANFD0, Channel #1
401	PERI_MS_PPU_FX_CANFD0_CH2_CH	0x40520400	0x00000200	CANFD0, Channel #2
402	PERI_MS_PPU_FX_CANFD0_CH3_CH	0x40520600	0x00000200	CANFD0, Channel #3
403	PERI_MS_PPU_FX_CANFD1_CH0_CH	0x40540000	0x00000200	CANFD1, Channel #0
404	PERI_MS_PPU_FX_CANFD1_CH1_CH	0x40540200	0x00000200	CANFD1, Channel #1
405	PERI_MS_PPU_FX_CANFD1_CH2_CH	0x40540400	0x00000200	CANFD1, Channel #2
406	PERI_MS_PPU_FX_CANFD1_CH3_CH	0x40540600	0x00000200	CANFD1, Channel #3
407	PERI_MS_PPU_FX_CANFD0_MAIN	0x40521000	0x00000100	CANFD0, main
408	PERI_MS_PPU_FX_CANFD1_MAIN	0x40541000	0x00000100	CANFD1, main
409	PERI_MS_PPU_FX_CANFD0_BUF	0x40530000	0x00010000	CANFD0, buffer
410	PERI_MS_PPU_FX_CANFD1_BUF	0x40550000	0x00010000	CANFD1, buffer
411	PERI_MS_PPU_FX_SCB0	0x40600000	0x00010000	SCB0
412	PERI_MS_PPU_FX_SCB1	0x40610000	0x00010000	SCB1
413	PERI_MS_PPU_FX_SCB2	0x40620000	0x00010000	SCB2
414	PERI_MS_PPU_FX_SCB3	0x40630000	0x00010000	SCB3
415	PERI_MS_PPU_FX_SCB4	0x40640000	0x00010000	SCB4
416	PERI_MS_PPU_FX_SCB5	0x40650000	0x00010000	SCB5
417	PERI_MS_PPU_FX_SCB6	0x40660000	0x00010000	SCB6
418	PERI_MS_PPU_FX_SCB7	0x40670000	0x00010000	SCB7
419	PERI_MS_PPU_FX_PASS0_SAR0_SAR	0x40900000	0x00000400	PASS0, SAR Channel #0
420	PERI_MS_PPU_FX_PASS0_SAR1_SAR	0x40901000	0x00000400	PASS0, SAR Channel #1
421	PERI_MS_PPU_FX_PASS0_SAR2_SAR	0x40902000	0x00000400	PASS0, SAR Channel #2
422	PERI_MS_PPU_FX_PASS0_SAR0_CH0_CH	0x40900800	0x00000040	SAR0, Channel #0
423	PERI_MS_PPU_FX_PASS0_SAR0_CH1_CH	0x40900840	0x00000040	SAR0, Channel #1
424	PERI_MS_PPU_FX_PASS0_SAR0_CH2_CH	0x40900880	0x00000040	SAR0, Channel #2
425	PERI_MS_PPU_FX_PASS0_SAR0_CH3_CH	0x409008C0	0x00000040	SAR0, Channel #3
426	PERI_MS_PPU_FX_PASS0_SAR0_CH4_CH	0x40900900	0x00000040	SAR0, Channel #4
427	PERI_MS_PPU_FX_PASS0_SAR0_CH5_CH	0x40900940	0x00000040	SAR0, Channel #5
428	PERI_MS_PPU_FX_PASS0_SAR0_CH6_CH	0x40900980	0x00000040	SAR0, Channel #6
429	PERI_MS_PPU_FX_PASS0_SAR0_CH7_CH	0x409009C0	0x00000040	SAR0, Channel #7
430	PERI_MS_PPU_FX_PASS0_SAR0_CH8_CH	0x40900A00	0x00000040	SAR0, Channel #8
431	PERI_MS_PPU_FX_PASS0_SAR0_CH9_CH	0x40900A40	0x00000040	SAR0, Channel #9
432	PERI_MS_PPU_FX_PASS0_SAR0_CH10_CH	0x40900A80	0x00000040	SAR0, Channel #10
433	PERI_MS_PPU_FX_PASS0_SAR0_CH11_CH	0x40900AC0	0x00000040	SAR0, Channel #11
434	PERI_MS_PPU_FX_PASS0_SAR0_CH12_CH	0x40900B00	0x00000040	SAR0, Channel #12
435	PERI_MS_PPU_FX_PASS0_SAR0_CH13_CH	0x40900B40	0x00000040	SAR0, Channel #13
436	PERI_MS_PPU_FX_PASS0_SAR0_CH14_CH	0x40900B80	0x00000040	SAR0, Channel #14
437	PERI_MS_PPU_FX_PASS0_SAR0_CH15_CH	0x40900BC0	0x00000040	SAR0, Channel #15
438	PERI_MS_PPU_FX_PASS0_SAR0_CH16_CH	0x40900C00	0x00000040	SAR0, Channel #16
439	PERI_MS_PPU_FX_PASS0_SAR0_CH17_CH	0x40900C40	0x00000040	SAR0, Channel #17
440	PERI_MS_PPU_FX_PASS0_SAR0_CH18_CH	0x40900C80	0x00000040	SAR0, Channel #18
441	PERI_MS_PPU_FX_PASS0_SAR0_CH19_CH	0x40900CC0	0x00000040	SAR0, Channel #19
442	PERI_MS_PPU_FX_PASS0_SAR0_CH20_CH	0x40900D00	0x00000040	SAR0, Channel #20
443	PERI_MS_PPU_FX_PASS0_SAR0_CH21_CH	0x40900D40	0x00000040	SAR0, Channel #21

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Table 22-1 PPU fixed structure pairs *(continued)*

Pair No.	PPU Fixed Structure Pair	Address	Size	Description
444	PERI_MS_PPU_FX_PASS0_SAR0_CH22_CH	0x40900D80	0x00000040	SAR0, Channel #22
445	PERI_MS_PPU_FX_PASS0_SAR0_CH23_CH	0x40900DC0	0x00000040	SAR0, Channel #23
446	PERI_MS_PPU_FX_PASS0_SAR1_CH0_CH	0x40901800	0x00000040	SAR1, Channel #0
447	PERI_MS_PPU_FX_PASS0_SAR1_CH1_CH	0x40901840	0x00000040	SAR1, Channel #1
448	PERI_MS_PPU_FX_PASS0_SAR1_CH2_CH	0x40901880	0x00000040	SAR1, Channel #2
449	PERI_MS_PPU_FX_PASS0_SAR1_CH3_CH	0x409018C0	0x00000040	SAR1, Channel #3
450	PERI_MS_PPU_FX_PASS0_SAR1_CH4_CH	0x40901900	0x00000040	SAR1, Channel #4
451	PERI_MS_PPU_FX_PASS0_SAR1_CH5_CH	0x40901940	0x00000040	SAR1, Channel #5
452	PERI_MS_PPU_FX_PASS0_SAR1_CH6_CH	0x40901980	0x00000040	SAR1, Channel #6
453	PERI_MS_PPU_FX_PASS0_SAR1_CH7_CH	0x409019C0	0x00000040	SAR1, Channel #7
454	PERI_MS_PPU_FX_PASS0_SAR1_CH8_CH	0x40901A00	0x00000040	SAR1, Channel #8
455	PERI_MS_PPU_FX_PASS0_SAR1_CH9_CH	0x40901A40	0x00000040	SAR1, Channel #9
456	PERI_MS_PPU_FX_PASS0_SAR1_CH10_CH	0x40901A80	0x00000040	SAR1, Channel #10
457	PERI_MS_PPU_FX_PASS0_SAR1_CH11_CH	0x40901AC0	0x00000040	SAR1, Channel #11
458	PERI_MS_PPU_FX_PASS0_SAR1_CH12_CH	0x40901B00	0x00000040	SAR1, Channel #12
459	PERI_MS_PPU_FX_PASS0_SAR1_CH13_CH	0x40901B40	0x00000040	SAR1, Channel #13
460	PERI_MS_PPU_FX_PASS0_SAR1_CH14_CH	0x40901B80	0x00000040	SAR1, Channel #14
461	PERI_MS_PPU_FX_PASS0_SAR1_CH15_CH	0x40901BC0	0x00000040	SAR1, Channel #15
462	PERI_MS_PPU_FX_PASS0_SAR1_CH16_CH	0x40901C00	0x00000040	SAR1, Channel #16
463	PERI_MS_PPU_FX_PASS0_SAR1_CH17_CH	0x40901C40	0x00000040	SAR1, Channel #17
464	PERI_MS_PPU_FX_PASS0_SAR1_CH18_CH	0x40901C80	0x00000040	SAR1, Channel #18
465	PERI_MS_PPU_FX_PASS0_SAR1_CH19_CH	0x40901CC0	0x00000040	SAR1, Channel #19
466	PERI_MS_PPU_FX_PASS0_SAR1_CH20_CH	0x40901D00	0x00000040	SAR1, Channel #20
467	PERI_MS_PPU_FX_PASS0_SAR1_CH21_CH	0x40901D40	0x00000040	SAR1, Channel #21
468	PERI_MS_PPU_FX_PASS0_SAR1_CH22_CH	0x40901D80	0x00000040	SAR1, Channel #22
469	PERI_MS_PPU_FX_PASS0_SAR1_CH23_CH	0x40901DC0	0x00000040	SAR1, Channel #23
470	PERI_MS_PPU_FX_PASS0_SAR1_CH24_CH	0x40901E00	0x00000040	SAR1, Channel #24
471	PERI_MS_PPU_FX_PASS0_SAR1_CH25_CH	0x40901E40	0x00000040	SAR1, Channel #25
472	PERI_MS_PPU_FX_PASS0_SAR1_CH26_CH	0x40901E80	0x00000040	SAR1, Channel #26
473	PERI_MS_PPU_FX_PASS0_SAR1_CH27_CH	0x40901EC0	0x00000040	SAR1, Channel #27
474	PERI_MS_PPU_FX_PASS0_SAR1_CH28_CH	0x40901F00	0x00000040	SAR1, Channel #28
475	PERI_MS_PPU_FX_PASS0_SAR1_CH29_CH	0x40901F40	0x00000040	SAR1, Channel #29
476	PERI_MS_PPU_FX_PASS0_SAR1_CH30_CH	0x40901F80	0x00000040	SAR1, Channel #30
477	PERI_MS_PPU_FX_PASS0_SAR1_CH31_CH	0x40901FC0	0x00000040	SAR1, Channel #31
478	PERI_MS_PPU_FX_PASS0_SAR2_CH0_CH	0x40902800	0x00000040	SAR2, Channel #0
479	PERI_MS_PPU_FX_PASS0_SAR2_CH1_CH	0x40902840	0x00000040	SAR2, Channel #1
480	PERI_MS_PPU_FX_PASS0_SAR2_CH2_CH	0x40902880	0x00000040	SAR2, Channel #2
481	PERI_MS_PPU_FX_PASS0_SAR2_CH3_CH	0x409028C0	0x00000040	SAR2, Channel #3
482	PERI_MS_PPU_FX_PASS0_SAR2_CH4_CH	0x40902900	0x00000040	SAR2, Channel #4
483	PERI_MS_PPU_FX_PASS0_SAR2_CH5_CH	0x40902940	0x00000040	SAR2, Channel #5
484	PERI_MS_PPU_FX_PASS0_SAR2_CH6_CH	0x40902980	0x00000040	SAR2, Channel #6
485	PERI_MS_PPU_FX_PASS0_SAR2_CH7_CH	0x409029C0	0x00000040	SAR2, Channel #7
486	PERI_MS_PPU_FX_PASS0_TOP	0x409F0000	0x00001000	PASS0, top

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23 Bus masters

The Arbiter (part of flash controller) performs priority-based arbitration based on the master identifier. Each bus master has a dedicated 4-bit master identifier. This master identifier is used for bus arbitration and IPC functionality.

Table 23-1 Bus masters for access and protection control

ID No.	Master ID	Description
0	CPUSS_MS_ID_CM0	Master ID for Cortex-M0+ CPU
1	CPUSS_MS_ID_CRYPTO	Master ID for Crypto
2	CPUSS_MS_ID_DW0	Master ID for P-DMA 0
3	CPUSS_MS_ID_DW1	Master ID for P-DMA 1
4	CPUSS_MS_ID_DMAC	Master ID for M-DMA0
14	CPUSS_MS_ID_CM4	Master ID for Cortex-M4 CPU
15	CPUSS_MS_ID_TC	Master ID for DAP Tap Controller

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24 Miscellaneous configuration

Table 24-1 Miscellaneous configuration for CYT2B9 devices

Sl. No.	Configuration	Number/ Instances	Description
0	SRSS_NUM_CLKPATH	4	Number of clock paths. One for each of FLL, PLL, Direct and CSV
1	SRSS_NUM_HFROOT	3	Number of CLK_HFs roots present
2	PERI_PC_NR	8	Number of protection contexts
3	PERI_CLOCK_NR	124	Number of programmable clocks (outputs)
4	PERI_DIV_8_NR	32	Number of divide-by-8 clock dividers
5	PERI_DIV_16_NR	16	Number of divide-by-16 clock dividers
6	PERI_DIV_24_5_NR	8	Number of divide-by-24.5 clock dividers
7	CPUSS_CM0P_MPU_NR	8	Number of MPU regions in CM0+
8	CPUSS_CM4_MPU_NR	8	Number of MPU regions in CM4
9	CPUSS_CRYPTO_BUFF_SIZE	2048	Number of 32-bit words in the IP internal memory buffer (to allow for a 256-B, 512-B, 1-KB, 2-KB, 4-KB, 8-KB, 16-KB, and 32-KB memory buffer)
10	CPUSS_FAULT_FAULT_NR	4	Number of fault structures
11	CPUSS_IPC_IPC_NR	8	Number of IPC structures 0 - Reserved for CM0+ access 1 - Reserved for CM4 access 2 - Reserved for DAP access Remaining for user purposes
12	SCB0_EZ_DATA_NR	256	Number of EZ memory bytes. This memory is used in EZ mode, CMD_RESP mode and FIFO mode. Note: Only SCB0 supports EZ mode
13	CPUSS_PROT_SMPU_STRUCT_NR	16	Number of SMPU protection structures
14	TCPWM_TR_ONE_CNT_NR	3	Number of input triggers per counter, routed to one counter
15	TCPWM_TR_ALL_CNT_NR	27	Number of input triggers routed to all counters, based on the pin package
16	TCPWM_GRP_NR	3	Number of TCPWM0 counter groups
17	TCPWM_GRP_NR0_GRP_GRP_CNT_NR	63	Number of counters per TCPWM0 Group #0
18	TCPWM_GRP_NR0_CNT_GRP_CNT_WIDTH	16	Counter width in number of bits per TCPWM0 Group #0
19	TCPWM_GRP_NR1_GRP_GRP_CNT_NR	12	Number of counters per TCPWM0 Group #1
20	TCPWM_GRP_NR1_CNT_GRP_CNT_WIDTH	16	Counter width in number of bits per TCPWM0 Group #1
21	TCPWM_GRP_NR2_GRP_GRP_CNT_NR	8	Number of counters per TCPWM0 Group #2
22	TCPWM_GRP_NR2_CNT_GRP_CNT_WIDTH	32	Counter width in number of bits per TCPWM0 Group #2
23	CANFD0_MRAM_SIZE / CANFD1_MRAM_SIZE	32	Message RAM size in KB shared by all the channels
24	EVTGEN_COMP_STRUCT_NR	11	Number of Event Generator comparator structures

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25 Development support

CYT2B9 has a rich set of documentation, programming tools, and online resources to assist during the development process. Visit **www.infineon.com** to find out more.

25.1 Documentation

A suite of documentation supports CYT2B9 to ensure that you can find answers to your questions quickly. This section contains a list of some of the key documents.

25.1.1 Software user guide

A step-by-step guide for using the sample driver library along with third-party IDEs such as IAR EWARM and GHS Multi.

25.1.2 Technical Reference Manual

The Technical Reference Manual (TRM) contains all the technical detail needed to use a CYT2B9 device, including a complete description of all registers. The TRM is available in the documentation section at **www.infineon.com**.

25.2 Tools

CYT2B9 is supported on third-party development tool ecosystems such as IAR and GHS. CYT2B9 is also supported by Cypress programming utilities for programming, erasing, or reading using Cypress' MiniProg4 or Segger J-link. More details are available in the documentation section at **www.infineon.com**.

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26 Electrical specifications

26.1 Absolute maximum ratings

Use of this device under conditions outside the Min and Max limits listed in **Table 26-1** may cause permanent damage to the device. Exposure to conditions within the limits of **Table 26-1** but beyond those of normal operation for extended periods of time may affect device reliability. The maximum storage temperature is 150 °C in compliance with JEDEC Standard JESD22-A103, High Temperature Storage Life. When operated under conditions within the limits of **Table 26-1** but beyond those of normal operation, the device may not operate to specification.

Power considerations

The average chip-junction temperature, T_J, in °C, may be calculated using Equation 1:

$$T_J = T_A + (P_D \times \theta_{JA})$$

Equation. 1

Where:

T_A is the ambient temperature in °C.

θ_{JA} is the package junction-to-ambient thermal resistance, in °C/W.

P_D is the sum of P_{INT} and P_{IO} ($P_D = P_{INT} + P_{IO}$).

P_{INT} is the chip internal power. ($P_{INT} = V_{DDD} \times I_{DD} + V_{DDA} \times I_A$)

P_{IO} represents the power dissipation on input and output pins; user determined.

For most applications, $P_{IO} < P_{INT}$ and may be neglected.

On the other hand, P_{IO} may be significant if the device is configured to continuously drive external modules and/or memories.

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Table 26-1 Absolute maximum ratings

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID10	V_{DDD_ABS}	V_{DDD} power supply voltage[36]	V_{SSD} – 0.3	–	V_{SSD} + 6.0	V	For ports 0, 1, 2, 3, 4, 5, 16, 17, 18, 19, 20, 21, 22, 23
SID10B	$V_{DDIO_1_ABS}$	V_{DDIO_1} power supply voltage[36]	V_{SSD} – 0.3	–	V_{SSD} + 6.0	V	$V_{DDIO_1} \geq V_{DDD}$ For ports 6, 7, 8, 9[37]
SID10C1	$V_{DDIO_2_ABS}$	V_{DDIO_2} power supply voltage[36]	V_{SSD} – 0.3	–	V_{SSD} + 6.0	V	For ports 10, 11, 12, 13, 14, 15
SID11	V_{DDA_ABS}	V_{DDA} analog power supply voltage[36]	V_{SSA} – 0.3	–	V_{SSA} + 6.0	V	$V_{DDIO_2} = V_{DDA}$
SID12	V_{REFH_ABS}	Analog reference voltage, HIGH[36]	V_{SSA} – 0.3	–	V_{SSA} + 6.0	V	$V_{REFH} \leq V_{DDA}$ + 0.3 V
SID12A	V_{REFL_ABS}	Analog reference voltage, LOW[36]	V_{SSA} – 0.3	–	V_{SSA} + 0.3	V	
SID15A	V_{I0_ABS0}	Input voltage[36]	V_{SSD} – 0.5	–	V_{DDD} + 0.5	V	For ports 0, 1, 2, 3, 4, 5, 16, 17, 18, 19, 20, 21, 22, 23
SID15B	V_{I1_ABS1}	Input voltage[36]	V_{SSD} – 0.5	–	V_{DDIO_1} + 0.5	V	For ports 6, 7, 8, 9[37]
SID15C	V_{I2_ABS2}	Input voltage[36]	V_{SSD} – 0.5	–	V_{DDIO_2} + 0.5	V	For ports 10, 11, 12, 13, 14, 15
SID16	V_{IA_ABS}	Analog input voltage[36]	V_{SSA} – 0.3	–	V_{DDA} + 0.3	V	
SID17A	V_{O0_ABS0}	Output voltage[36]	V_{SSD} – 0.3	–	V_{DDD} + 0.3		For ports 0, 1, 2, 3, 4, 5, 16, 17, 18, 19, 20, 21, 22, 23
SID17B	V_{O1_ABS1}	Output voltage[36]	V_{SSD} – 0.3	–	V_{DDIO_1} + 0.3	V	For ports 6, 7, 8, 9[37]
SID17C	V_{O2_ABS2}	Output voltage[37]	V_{SSD} – 0.3	–	V_{DDIO_2} + 0.3	V	For ports 10, 11, 12, 13, 14, 15
SID18	I_{CLAMP_ABS}	Maximum clamp current [38, 39, 40]	–5	–	5	mA	
SID18A	$I_{CLAMP_SUPPLY_POS_ABS}$	Maximum positive clamp current per I/O supply pin. Limit applies to I/O supply pin closest to the B+ injected current[41]	–	–	10	mA	+B injected DC currents are not allowed for Ports 11 and 21.
SID18B	$I_{CLAMP_SUPPLY_NEG_ABS}$	Maximum negative clamp current per I/O ground pin. Limit applies to I/O supply pin closest to the B+ injected current[41]	–	–	10	mA	+B injected DC currents are not allowed for Ports 11 and 21.
SID18C	$I_{CLAMP_TOTAL_POS_ABS}$	Maximum positive clamp current per I/O supply, if not limited by the per supply pin (based on SID18A).	–	–	50	mA	
SID18D	$I_{CLAMP_TOTAL_NEG_ABS}$	Maximum negative clamp current per I/O ground, if not limited by the per supply pin (based on SID18B).	–	–	50	mA	
SID20A	I_{OL1A_ABS}	LOW-level maximum output current [42]	–	–	6	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b0X
SID20B	I_{OL1B_ABS}	LOW-level maximum output current [42]	–	–	2	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b10
SID20C	I_{OL1C_ABS}	LOW-level maximum output current [42]	–	–	1	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b11
SID21A	I_{OL2A_ABS}	LOW-level maximum output current [42]	–	–	6	mA	For GPIO_ENH, configured for drive_sel<1:0>= 0b0X
SID21B	I_{OL2B_ABS}	LOW-level maximum output current [42]	–	–	2	mA	For GPIO_ENH, configured for drive_sel<1:0>= 0b10
SID21C	I_{OL2C_ABS}	LOW-level maximum output current [42]	–	–	1	mA	For GPIO_ENH, configured for drive_sel<1:0>= 0b11
SID26A	$\Sigma I_{OL_ABS_GPIO}$	LOW-level total output current [43]	–	–	50	mA	
SID27A	I_{OH1A_ABS}	HIGH-level maximum output current [42]	–	–	–5	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b0X
SID27B	I_{OH1B_ABS}	HIGH-level maximum output current [42]	–	–	–2	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b10

Notes
36. These parameters are based on the condition that $V_{SSD} = V_{SSA} = 0.0$ V.
37. The I/Os in VDDIO_1 domain refer to the VDDD domain in 64-LQFP package.
38. A current-limiting resistor must be provided such that the current at the I/O pin does not exceed rated values at any time, including during power transients. See **Figure 26-1** for more information on the recommended circuit.
39. V_{DDD} and V_{DDIO} must be sufficiently loaded or protected to prevent them from being pulled out of the recommended operating range by the clamp current.
40. When the conditions of [38], [39] and SID18A/B/C/D are met, $|I_{CLAMP_ABS}|$ supersedes V_{IA_ABS} and V_{I_ABS}.
41. The definition of "closer" depends on the package. In LQFP packaging, "closest" is determined by counting pins. For example, in a 176-LQFP package, P17.4 (pin 120) is closer to the V_{DDD} on pin 110 than on pin 132. Ports 11 and 21 should not be used for injection currents. The impact of injection currents is only defined for GPIO_STD/GPIO_ENH type I/Os.

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Table 26-1 Absolute maximum ratings *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID27C	I_{OH1C_ABS}	HIGH-level maximum output current [42]	–	–	–1	mA	For GPIO_STD, configured for drive_sel<1:0>= 0b11
SID28A	I_{OH2A_ABS}	HIGH-level maximum output current [42]	–	–	–5	mA	For GPIO_ENH, configured for drive_sel<1:0>= 0b0X
SID28B	I_{OH2B_ABS}	HIGH-level maximum output current [42]	–	–	–2	mA	For GPIO_ENH, configured for drive_sel<1:0>= 0b10
SID28C	I_{OH2C_ABS}	HIGH-level maximum output current [42]	–	–	–1	mA	For GPIO_ENH, configured for drive_sel<1:0> = 0b11
SID33A	$\Sigma I_{OH_ABS_GPIO}$	HIGH-level total output current[43]	–	–	–50	mA	
SID34	P_D	Power dissipation	–	–	1000	mW	T_J should not exceed 150 °C
SID35	T_A	Ambient temperature	–40	–	105	°C	For S-grade devices
SID36	T_A	Ambient temperature	–40	–	125	°C	For E-grade devices
SID37	T_{STG}	Storage temperature	–55	–	150	°C	
SID38	T_J	Operating junction temperature	–40	–	150	°C	
SID39A	V_{ESD_HBM}	Electrostatic discharge human body model	2000	–	–	V	
SID39B1	V_{ESD_CDM1}	Electrostatic discharge charged device model for corner pins	750	–	–	V	
SID39B2	V_{ESD_CDM2}	Electrostatic discharge charged device model for all other pins	500	–	–	V	
SID39C	I_{LU}	The maximum pin current the device can tolerate before triggering a latch-up	–100	–	100	mA	

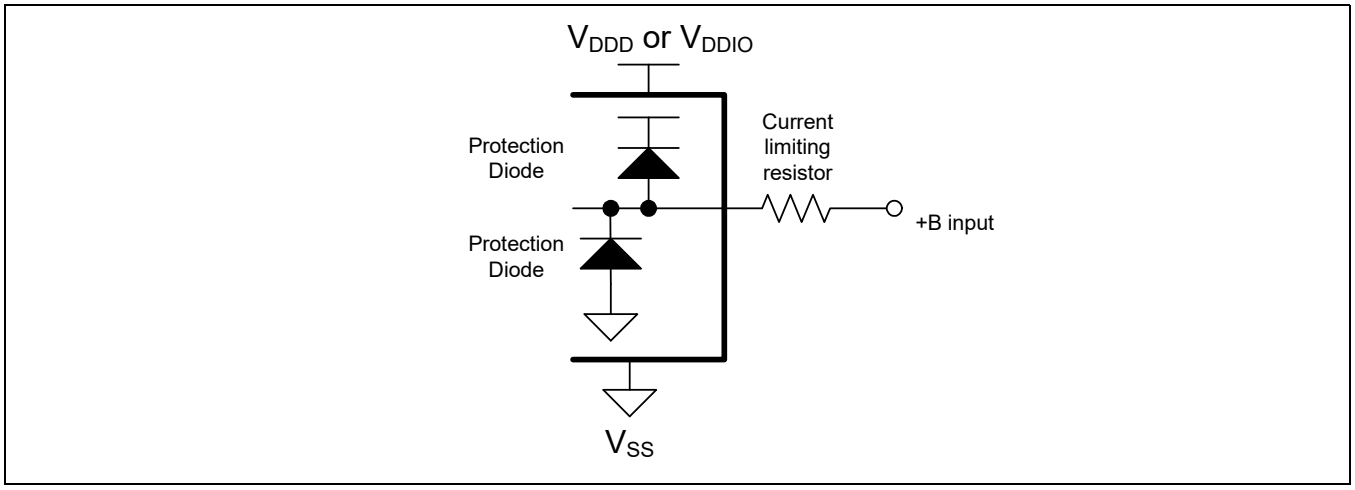


Figure 26-1 Example of a recommended circuit[44]

WARNING:
Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current, or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.

Notes
42.The maximum output current is the peak current flowing through any one GPIO.
43.The total output current is the maximum current flowing through all I/Os (GPIO_STD, and GPIO_ENH).

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26.2 Device-level specifications

Table 26-2 Recommended operating conditions

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID40	V_{DDD}, V_{DDA}, V_{DDIO_1}, V_{DDIO_2},	Power supply voltage[45]	2.7[46]	–	5.5[47]	V	
SID40A	$V_{DDIO_1_EFP}$	Power supply voltage for eFuse programming[48]	3	–	5.5	V	
SID41	C_{S1}	Smoothing capacitor[49, 50]	3.76	–	11	µF	

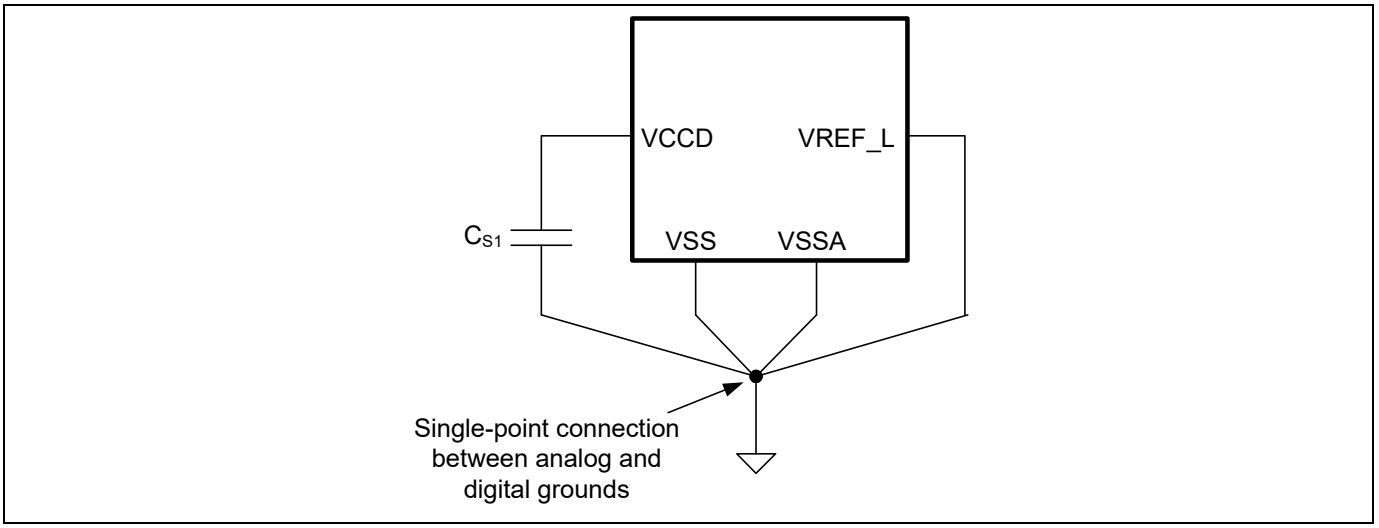


Figure 26-2 Smoothing capacitor

Smoothing capacitor should be placed as close as possible to the V_{CCD} pin.

Notes

44. +B is the positive battery voltage around 45 V.
45. V_{DDD}, V_{DDIO_1}, V_{DDIO_2}, and V_{DDA} do not have any sequencing limitation and can establish in any order. These supplies (except for V_{DDA} and V_{DDIO_2}) are independent in voltage level. See 12-Bit SAR ADC DC Specifications when using ADC units.
46. 3.0 V ±10% is supported with a lower BOD setting option for V_{DDD} and V_{DDA}. This setting provides robust protection for internal timing but BOD reset occurs at a voltage below the specified operating conditions. A higher BOD setting option is available (consistent with down to 3.0 V) and guarantees that all operating conditions are met.
47. 5.0 V ±10% is supported with a higher OVD setting option for V_{DDD} and V_{DDA}. This setting provides robust protection for internal and interface timing, but OVD reset occurs at a voltage above the specified operating conditions. A lower OVD setting option is available (consistent with up to 5.0 V) and guarantees that all operating conditions are met.
48. eFuse programming must be executed with the part in a “quiet” state, with minimal activity (preferably only JTAG or a single LIN/CAN channel on V_{DDD} domain, no activity on V_{DDIO_1}).
49. Smoothing capacitor, C_{S1} is required per chip (not per V_{CCD} pin). The V_{CCD} pins must be connected together to ensure a low-impedance connection (see the requirement in **Figure 26-2**).
50. Capacitors used for power supply decoupling or filtering are operated under a continuous DC-bias. Many capacitors used with DC power across them provide less than their target capacitance, and their capacitance is not constant across their working voltage range. When selecting capacitors for use with this device, ensure that the selected components provide the required capacitance under the specific operating conditions of temperature and voltage used in your design. While the temperature coefficient is normally found within a parts catalog (such as, X7R, C0G, Y5V), the matching voltage coefficient may only be available on the component datasheet or direct from the manufacturer. Use of components that do not provide the required capacitance under the actual operating conditions may cause the device to operate to less than datasheet specifications.

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26.3 DC specifications

Table 26-3 DC specifications, CPU current and transition time specifications

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID49C1	$I_{DD1_CM04_8_1}$	LP Active mode (CM4 and CM0+ at 8 MHz, all peripherals are disabled)	–	5	10	mA	CM0+ and CM4 clocked at 8 MHz with IMO. All peripherals are disabled. No IO toggling. TYP: T_A = 25 °C, V_{DDD} = 5.0 V, process typ (TT), CM0+ and CM4 executing Dhrystone from flash with cache enabled MAX: T_A = 25 °C, V_{DDD} = 5.5 V, process worst (FF), CM0+ and CM4 executing Dhrystone from flash with cache enabled.
SID49C	$I_{DD1_CM04_8}$	LP Active mode (CM4 and CM0+ at 8 MHz, all peripherals are enabled)	–	6	60	mA	CM0+ and CM4 clocked at 8 MHz with IMO. All peripherals are enabled. No IO toggling. M-DMA transferring data from code + work flash, P-DMA chains with maximum trigger activity. TYP: T_A = 25 °C, V_{DDD} = 5.0 V, process typ (TT), CM0+ and CM4 executing Dhrystone from flash with cache enabled MAX: T_A = 125 °C, V_{DDD} = 5.5 V, process worst (FF), CM0+ and CM4 executing max_power.c from flash with cache enabled.
SID49E	$I_{DD1_F160_2M}$	Active mode (CM4 at 160 MHz, CM0+ at 80 MHz, all peripherals are enabled)	–	43	110	mA	PLL enabled at 160 MHz with ECO reference. All peripherals are enabled. No I/O toggling. M-DMA transferring data from code + work flash, P-DMA chains with maximum trigger activity. TYP: T_A = 25 °C, V_{DDD} = 5.0 V, process typ (TT), CM4 and CM0+ executing Dhrystone from flash with cache enabled. MAX: T_A = 125 °C, V_{DDD} = 5.5 V, process worst (FF), CM4 and CM0+ executing max_power.c from flash with cache enabled
SID53A	I_{DD2_8}	All CPUs in Sleep mode	–	4	56	mA	PLL disabled, CM4 and CM0+ are sleeping at 8 MHz with IMO. All peripherals, peripheral clocks, interrupts, CSV, DMA, FLL, ECO are disabled. No I/O toggling. Typ: T_A = 25 °C, V_{DDD} = 5.0 V, process typ (TT) Max: T_A = 125 °C, V_{DDD} = 5.5 V, process worst (FF)

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Table 26-3 DC specifications, CPU current and transition time specifications *(continued)*

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID56A	I_{DD_CWU2}	Average current for cyclic wake-up operation This is the average current for the specified LP Active mode and DeepSleep mode (RTC, WDT, and Event generator operating).	–	46	136	µA	V_{DDD} = 5.5 V, T_A = 25 °C, 64-KB SRAM, ILO0 operation in DeepSleep, Smart IO operations with ILO0, CM0+, CM4: Retained TYP: process typ (TT) MAX: process worst (FF) This average current is achieved under the following conditions. 1. MCU repetitively goes from DeepSleep to LP Active with a period of 32 ms. 2. One of the I/Os is toggled using Smart I/O to activate an external sensor connected to an analog input of A/D in DeepSleep 3. After 200 µs delay, the CM4 wakes up by event generator trigger to LP Active mode with IMO and A/D conversion is triggered by software. 4. Group A/D conversion is performed on 5 channels with the sampling time of 1 µs each. 5. Once the group A/D conversion is finished, and the results fit in the window of the range comparator, the I/O is toggled back by software to de-activate the sensor and the CM4 goes back to DeepSleep.
SID59A	I_{DD_DS64B}	64-KB SRAM retention, ILO0 operation in DeepSleep mode	–	35	130	µA	DeepSleep Mode (RTC, WDT, and event generator operating, all other peripherals are off except for retention registers), T_A = 25 °C, CM0+, CM4: Retained Typ: V_{DDD} = 5.0 V, process typ (TT) Max: V_{DDD} = 5.5 V, process worst (FF)
SID61A	I_{DD_DS64D}	64-KB SRAM retention, ILO0 operation in DeepSleep mode	–	0.9	3.5	mA	DeepSleep Mode steady state at T_A = 125 °C (RTC, WDT, and event generator operating, all other peripherals are off except for retention registers), CM0+, CM4: Retained Typ: V_{DDD} = 5.0 V, process typ (TT) Max: V_{DDD} = 5.5 V, process worst (FF)
Hibernate Mode							
SID62	I_{DD_HIB1}	Hibernate Mode	–	5	–	µA	ILO0/WDT operating. All other peripherals, and all CPUs are off. T_A = 25 °C, V_{DDD} = 5.5 V, process typ (TT)
SID62A	I_{DD_HIB2}	Hibernate Mode	–	–	130	µA	ILO0/WDT operating. All other peripherals, and all CPUs are off. T_A = 125 °C, V_{DDD} = 5.5 V, process worst (FF)

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Table 26-3 DC specifications, CPU current and transition time specifications *(continued)*

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
Power Mode Transition Times							
SID65	t_{ACT_DS}	Power down time from Active to DeepSleep	–	–	2.5	µs	When the IMO is already running and all HFCLK roots are at least 8 MHz. HFCLK roots that are slower than this will require additional time to turn off.
SID63	t_{DS_ACT}	DeepSleep to Active transition time (IMO clock, SRAM execution)	–	–	10[51]	µs	When using the 8-MHz IMO. Measured from wakeup interrupt during DeepSleep until wakeup.
SID63C	t_{DS_ACT}	DeepSleep to Active transition time (IMO clock, flash execution)	–	–	20[51]	µs	When using the 8-MHz IMO. Measured from wakeup interrupt during DeepSleep until flash execution.
SID63A	$t_{DS_ACT_FLL}$	DeepSleep to Active transition time (FLL clock, SRAM execution)	–	–	15[51]	µs	When using the FLL to generate 96 MHz from the 8-MHz IMO. Measured from wakeup interrupt during DeepSleep until the FLL locks.
SID63D	$t_{DS_ACT_FLL1}$	DeepSleep to Active transition time (FLL clock, flash execution)	–	–	21.5[51]	µs	When using the FLL to generate 96 MHz from the 8-MHz IMO. Measured from wakeup interrupt during DeepSleep until flash execution.
SID63B	$t_{DS_ACT_PLL}$	DeepSleep to Active transition time (PLL clock, SRAM or flash execution)	–	–	60[51]	µs	When using the PLL to generate 96 MHz from the 8-MHz IMO. Measured from wakeup interrupt during DeepSleep until the PLL locks.
SID68	t_{HVR_ACT}	Release time from HV reset (POR, BOD, OVD, OCD, WDT, Hibernate wakeup, or XRES_L) release until CM0+ begins executing ROM boot	–	–	265	µs	Without boot runtime. Guaranteed by design
SID68A	t_{LVR_ACT}	Release time from LV reset (Fault, Internal system reset, MCWDT, or CSV) during Active/Sleep until CM0+ begins executing ROM boot	–	–	10	µs	Without boot runtime. Guaranteed by design
SID68B	t_{LVR_DS}	Release time from LV reset (Fault, or MCWDT) during DeepSleep until CM0+ begins executing ROM boot	–	–	15	µs	Without boot runtime. Guaranteed by design
SID80A	t_{RB_N}	ROM boot startup time or wakeup time from hibernate in NORMAL protection state	–	–	1800	µs	Guaranteed by Design, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later)

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Table 26-3 DC specifications, CPU current and transition time specifications *(continued)*

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID80B	t_{RB_S}	ROM boot startup time or wakeup time from hibernate in SECURE protection state	–	–	2740	µs	Guaranteed by Design, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later)
SID81A	t_{FB}	Flash boot startup time or wakeup time from hibernate in NORMAL/SECURE protection state	–	–	80	µs	Guaranteed by Design, TOC2_FLAGS=0x2CF, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later), Listen window = 0 ms
SID81B	t_{FB_A}	Flash boot with app authentication time in NORMAL/SECURE protection state	–	–	5000	µs	Guaranteed by Design, TOC2_FLAGS=0x24F, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later), Listen window = 0 ms, Public key exponent e = 0x010001, App size is 64 KB with the last 256 bytes being a digital signature in RSASSA-PKCS1-v1.5 Valid for RSA2K.
SID80A_2	$t_{RB_N_2}$	ROM boot startup time or wakeup time from hibernate in NORMAL protection state	–	–	2930	µs	Guaranteed by Design, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556)
SID80B_2	$t_{RB_S_2}$	ROM boot startup time or wakeup time from hibernate in SECURE protection state	–	–	4680	µs	Guaranteed by Design, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556)
SID81A_2	t_{FB_2}	Flash boot startup time or wakeup time from hibernate in NORMAL/SECURE protection state	–	–	200	µs	Guaranteed by Design, TOC2_FLAGS=0x2CF, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556), Listen window = 0 ms
SID81B_2	$t_{FB_A_2}$	Flash boot with app authentication time in NORMAL/SECURE protection state	–	–	10000	µs	Guaranteed by Design, TOC2_FLAGS=0x24F, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556), Listen window = 0 ms, Public key exponent e = 0x010001, App size is 64 KB with the last 256 bytes being a digital signature in RSASSA-PKCS1-v1.5 Valid for RSA2K.
Regulator specification							
SID600	V_{CCD}	Core supply voltage	1.05	1.1	1.15	V	
SID601	I_{DD_ACT}	Regulator operating current in Active/Sleep mode	–	80	150	µA	Guaranteed by design
SID602	I_{DD_DPSLP}	Regulator operating current in DeepSleep mode	–	1.5	20	µA	Guaranteed by design

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Table 26-3 DC specifications, CPU current and transition time specifications *(continued)*

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID604	I_{OUT}	Available regulator output current for operation	–	–	150	mA	Without triggering OVD
SID603	I_{RUSH}	In-rush current	–	–	375	mA	Average V_{DDD} current until C_{s1} (connected to V_{CCD} pin) is charged after Active regulator is turned on

26.4 Reset specifications

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Table 26-4 XRES_L reset

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
XRES_L DC specifications							
SID73	I_{DD_XRES}	I_{DD} when XRES_L asserted	–	–	0.9	mA	T_A = 125 °C, V_{DDD} = 5.5 V, process worst (FF)
SID74	V_{IH}	Input voltage HIGH threshold	0.7 × V_{DDD}	–	–	V	CMOS input
SID75	V_{IL}	Input voltage LOW threshold	–	–	0.3 × V_{DDD}	V	CMOS input
SID76	R_{PULLUP}	Pull-up resistor	7	–	20	kΩ	
SID77	C_{IN}	Input capacitance	–	–	5	pF	
SID78	$V_{HYSXRES}$	Input voltage hysteresis	0.05 × V_{DDD}	–	–	V	
XRES_L AC specifications							
SID70	t_{XRES_ACT}	XRES_L release to Active transition time	–	–	265	µs	Without boot runtime. Guaranteed by design
SID71	t_{XRES_PW}	XRES_L pulse width	5	–	–	µs	
SID72	t_{XRES_FT}	Pulse suppression width	100	–	–	ns	

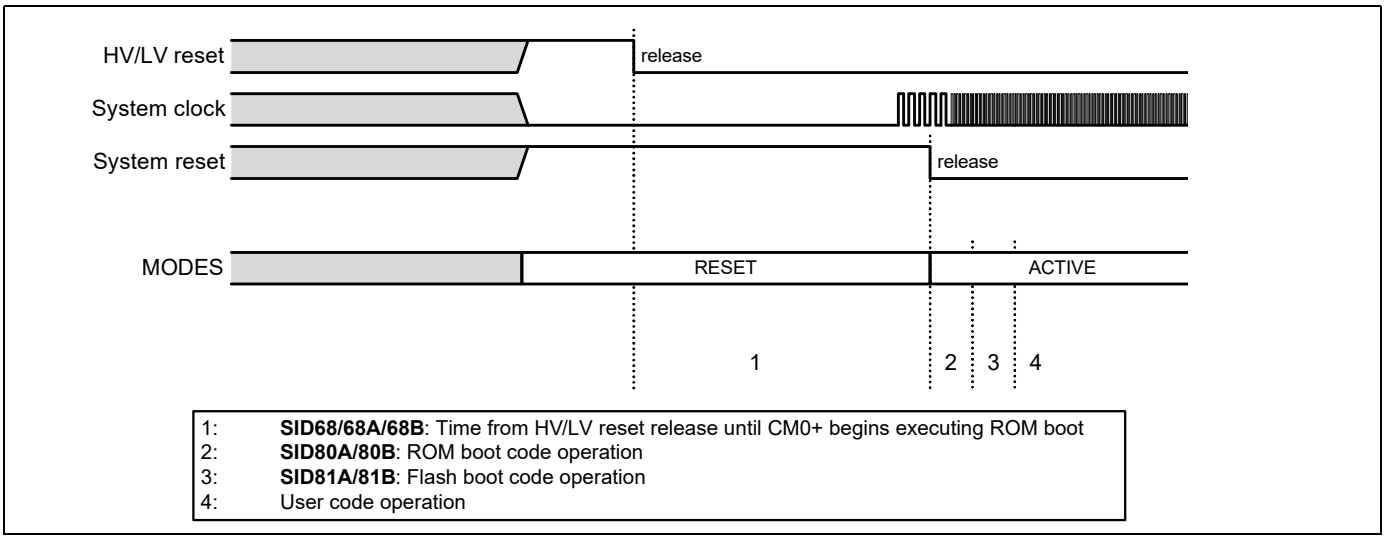


Figure 26-3 Reset sequence

Note
51. At cold temperature –5 °C to –40 °C, the DeepSleep to Active transition time can be higher than the max time indicated by as much as 20 µs.

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26.5 I/O

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Table 26-5 I/O Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
GPIO_STD Specifications for ports P1 through P23							
SID650	$V_{OL1_GPIO_STD}$	Output voltage LOW level	–	–	0.6	V	I_{OL} = 6 mA drive_sel<1:0> = 0b0X, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID650C	$V_{OL1C_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 5 mA drive_sel<1:0> = 0b0X, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID651	$V_{OL2_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 2 mA drive_sel<1:0> = 0b0X, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID652	$V_{OL3_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 1 mA drive_sel<1:0> = 0b10, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID652C	$V_{OL3C_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 2 mA drive_sel<1:0> = 0b10, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID653	$V_{OL4_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 0.5 mA drive_sel<1:0> = 0b11, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID653C	$V_{OL4C_GPIO_STD}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 1 mA drive_sel<1:0> = 0b11, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID654	$V_{OH1_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –2 mA drive_sel<1:0> = 0b0X, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID655	$V_{OH2_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –5 mA drive_sel<1:0> = 0b0X, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID656	$V_{OH3_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –1 mA drive_sel<1:0> = 0b10, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID656C	$V_{OH3C_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –2 mA drive_sel<1:0> = 0b10, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID657	$V_{OH4_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –0.5 mA drive_sel<1:0> = 0b11, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID657C	$V_{OH4C_GPIO_STD}$	Output voltage HIGH level	(V_{DDD} or V_{DDIO_1} or V_{DDIO_2}) – 0.5	–	–	V	I_{OH} = –1 mA drive_sel<1:0> = 0b11, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID658	$R_{PD_GPIO_STD}$	Pull-down resistance	25	50	100	kΩ	
SID659	$R_{PU_GPIO_STD}$	Pull-up resistance	25	50	100	kΩ	
SID660	$V_{IH_CMOS_GPIO_STD}$	Input voltage HIGH threshold in CMOS mode	0.7 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	–	–	V	
SID661	$V_{IH_TTL_GPIO_STD}$	Input voltage HIGH threshold in TTL mode	2.0	–	–	V	
SID662	$V_{IH_AUTO_GPIO_STD}$	Input voltage HIGH threshold in AUTO mode	0.8 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	–	–	V	
SID663	$V_{IL_CMOS_GPIO_STD}$	Input voltage LOW threshold in CMOS mode	–	–	0.3 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	V	
SID664	$V_{IL_TTL_GPIO_STD}$	Input voltage LOW threshold in TTL mode	–	–	0.8	V	
SID665	$V_{IL_AUTO_GPIO_STD}$	Input voltage LOW threshold in AUTO mode	–	–	0.5 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	V	
SID666	$V_{HYST_CMOS_GPIO_STD}$	Hysteresis in CMOS mode	0.05 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	–	–	V	
SID668	$V_{HYST_AUTO_GPIO_STD}$	Hysteresis in AUTO mode	0.05 × (V_{DDD} or V_{DDIO_1} or V_{DDIO_2})	–	–	V	
SID669	$C_{in_GPIO_STD}$	Input pin capacitance	–	–	5	pF	For 10 MHz and 100 MHz
SID670	$I_{IL_GPIO_STD}$	Input leakage current	–250	0.02	250	nA	For GPIO_STD except P21.0, P21.1, P21.2, P21.3, P21.4, P23.3, P23.4. $V_{DDIO_1} = V_{DDIO_2} = V_{DDD} = V_{DDA}$ = 5.5 V, $V_{SSD} < V_I < V_{DDD}$, V_{DDIO_1}, V_{DDIO_2} –40 °C ≤ TA ≤ 125 °C TYP: T_A = 25 °C, $V_{DDIO_1} = V_{DDIO_2} = V_{DDD} = V_{DDA}$ = 5.0 V

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID670C	$I_{IL_GPIO_STD_B}$	Input leakage current	–700	0.02	700	nA	Only for P21.0, P21.1, P21.2, P21.3, P21.4, P23.3, P23.4. $V_{DDIO_1} = V_{DDIO_2} = V_{DDD} = V_{DDA} = 5.5$ V, $V_{SSD} < V_I < V_{DDD}$, V_{DDIO_1}, V_{DDIO_2} –40 °C ≤ TA ≤ 125 °C TYP: T_A = 25 °C, $V_{DDIO_1} = V_{DDIO_2} = V_{DDD} = V_{DDA} = 5.0$ V
SID671	t_R or t_F (fast)$_{20_0_GPIO_STD}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	10	ns	20-pF load, drive_sel<1:0> = 0b00
SID672	t_R or t_F (fast)$_{50_0_GPIO_STD}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	50-pF load, drive_sel<1:0> = 0b00
SID673	t_R or t_F (fast)$_{20_1_GPIO_STD}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	20-pF load, drive_sel<1:0> = 0b01, guaranteed by design
SID674	t_R or t_F (fast)$_{10_2_GPIO_STD}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	10-pF load, drive_sel<1:0> = 0b10, guaranteed by design
SID675	t_R or t_F (fast)$_{6_3_GPIO_STD}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	6-pF load, drive_sel<1:0> = 0b11, guaranteed by design
SID676	t_F (fast)$_{100_GPIO_STD}$	Fall time (30% to 70% of V_{DDIO})	0.35	–	250	ns	10-pF to 400-pF load, RPU = 767 Ω, drive_sel<1:0>= 0b00, Freq = 100 kHz
SID677	t_F (fast)$_{400_GPIO_STD}$	Fall time (30% to 70% of V_{DDIO})	0.35	–	250	ns	10-pF to 400-pF load, RPU = 350 Ω, drive_sel<1:0>= 0b00, Freq = 400 kHz
SID678	$f_{IN_GPIO_STD}$	Input frequency	–	–	100	MHz	
SID679	$f_{OUT_GPIO_STD0H}$	Output frequency	–	–	50	MHz	20 pF load, drive_sel<1:0>= 00, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID680	$f_{OUT_GPIO_STD0L}$	Output frequency	–	–	32	MHz	20 pF load, drive_sel<1:0>= 00, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID681	$f_{OUT_GPIO_STD1H}$	Output frequency	–	–	25	MHz	20 pF load, drive_sel<1:0>= 01, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID682	$f_{OUT_GPIO_STD1L}$	Output frequency	–	–	15	MHz	20 pF load, drive_sel<1:0>= 01, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID683	$f_{OUT_GPIO_STD2H}$	Output frequency	–	–	25	MHz	10 pF load, drive_sel<1:0>= 10, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID684	$f_{OUT_GPIO_STD2L}$	Output frequency	–	–	15	MHz	10 pF load, drive_sel<1:0>= 10, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
SID685	$f_{OUT_GPIO_STD3H}$	Output frequency	–	–	15	MHz	6 pF load, drive_sel<1:0>= 11, 4.5 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} ≤ 5.5 V
SID686	$f_{OUT_GPIO_STD3L}$	Output frequency	–	–	10	MHz	6 pF load, drive_sel<1:0>= 11, 2.7 V ≤ V_{DDD} or V_{DDIO_1} or V_{DDIO_2} < 4.5 V
GPIO_ENH Specifications only for P0							
SID650A	$V_{OL1_GPIO_ENH}$	Output voltage LOW level	–	–	0.6	V	I_{OL} = 6 mA drive_sel<1:0> = 0b00/01, 2.7 V ≤ V_{DDD} ≤ 5.5 V
SID650D	$V_{OL1D_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 5 mA drive_sel<1:0> = 0b00/01, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID651A	$V_{OL2_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 2 mA drive_sel<1:0> = 0b00/01, 2.7 V ≤ V_{DDD} < 4.5 V
SID652A	$V_{OL3_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 1 mA drive_sel<1:0> = 0b10, 2.7 V ≤ V_{DDD} < 4.5 V
SID652D	$V_{OL3D_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 2 mA drive_sel<1:0> = 0b10, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID653A	$V_{OL4_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 0.5 mA drive_sel<1:0> = 0b11, 2.7 V ≤ V_{DDD} < 4.5 V
SID653D	$V_{OL4D_GPIO_ENH}$	Output voltage LOW level	–	–	0.4	V	I_{OL} = 1 mA drive_sel<1:0> = 0b11, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID654A	$V_{OH1_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –2 mA drive_sel<1:0> = 0b00/01, 2.7 V ≤ V_{DDD} < 4.5 V
SID655A	$V_{OH2_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –5 mA drive_sel<1:0> = 0b00/01, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID656A	$V_{OH3_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –1 mA drive_sel<1:0> = 0b10, 2.7 V ≤ V_{DDD} < 4.5 V
SID656D	$V_{OH3D_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –2 mA drive_sel<1:0> = 0b10, 4.5 V ≤ V_{DDD} ≤ 5.5 V

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID657A	$V_{OH4_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –0.5 mA drive_sel<1:0> = 0b11, 2.7 V ≤ V_{DDD} < 4.5 V
SID657D	$V_{OH4D_GPIO_ENH}$	Output voltage HIGH level	V_{DDD} – 0.5	–	–	V	I_{OL} = –1 mA drive_sel<1:0> = 0b11, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID658A	$R_{PD_GPIO_ENH}$	Pull-down resistance	25	50	100	kΩ	
SID659A	$R_{PU_GPIO_ENH}$	Pull-up resistance	25	50	100	kΩ	
SID660A	$V_{IH_CMOS_GPIO_ENH}$	Input voltage HIGH threshold in CMOS mode	0.70 × V_{DDD}	–	–	V	
SID661A	$V_{IH_TTL_GPIO_ENH}$	Input voltage HIGH threshold in TTL mode	[2]	–	–	V	
SID662A	$V_{IH_AUTO_GPIO_ENH}$	Input voltage HIGH threshold in AUTO mode	0.8 × V_{DDD}	–	–	V	
SID663A	$V_{IL_CMOS_GPIO_ENH}$	Input voltage LOW threshold in CMOS mode	–	–	0.3 × V_{DDD}	V	
SID664A	$V_{IL_TTL_GPIO_ENH}$	Input voltage LOW threshold in TTL mode	–	–	0.8	V	
SID665A	$V_{IL_AUTO_GPIO_ENH}$	Input voltage LOW threshold in AUTO mode	–	–	0.5 × V_{DDD}	V	
SID666A	$V_{HYST_CMOS_GPIO_ENH}$	Hysteresis in CMOS mode	0.05 × V_{DDD}	–	–	V	
SID668A	$V_{HYST_AUTO_GPIO_ENH}$	Hysteresis in AUTO mode	0.05 × V_{DDD}	–	–	V	
SID669A	$C_{in_GPIO_ENH}$	Input pin capacitance	–	–	5	pF	For 10 MHz and 100 MHz
SID670A	$I_{IL_GPIO_ENH}$	Input leakage current	–350	0.055	350	nA	V_{DDD} = V_{DDA} = 5.5 V, V_{SSD} < V_I < V_{DDD}, –40 °C ≤ T_A ≤ 125 °C TYP: T_A = 25 °C, V_{DDD} = V_{DDA} = 5.0 V
SID671A	t_R or t_F (fast)$_{_20_0_GPIO_ENH}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	10	ns	20-pF load, drive_sel<1:0> = 0b00, slow = 0
SID672A	t_R or t_F (fast)$_{_50_0_GPIO_ENH}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	50-pF load, drive_sel<1:0> = 0b00, slow = 0
SID673A	t_R or t_F (fast)$_{_20_1_GPIO_ENH}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	20-pF load, drive_sel<1:0> = 0b01, slow = 0, guaranteed by design
SID674A	t_R or t_F (fast)$_{_10_2_GPIO_ENH}$	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	10-pF load, drive_sel<1:0> = 0b10, slow = 0, guaranteed by design

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID675A	t_R or t_F (fast)_6_3_GPIO_ENH	Rise time or fall time (10% to 90% of V_{DDIO})	1	–	20	ns	6-pF load, drive_sel<1:0> = 0b11, slow = 0, guaranteed by design
SID676A	t_{F_I2C} (slow)_GPIO_ENH	Fall time (30% to 70% of V_{DDIO})	20 × (V_{DDD} / 5.5)	–	250	ns	10-pF to 400-pF load, drive_sel<1:0> = 0b00, slow = 1, minimum R_{PU} = 400 Ω
SID677A	t_R or t_F (slow)_20_GPIO_ENH	Rise time or fall time (10% to 90% of V_{DDIO})	20 × (V_{DDD} / 5.5)	–	160	ns	20-pF load, drive_sel<1:0> = 0b00, slow = 1, output frequency = 1 MHz
SID678A	t_R or t_F (slow)_400_GPIO_ENH	Rise time or fall time (10% to 90% of V_{DDIO})	20 × (V_{DDD} / 5.5)	–	250	ns	400-pF load, drive_sel<1:0> = 0b00, slow = 1, output frequency = 400 kHz
SID679A	$f_{IN_GPIO_ENH}$	Input frequency	–	–	100	MHz	
SID680A	$f_{OUT_GPIO_ENH0H}$	Output frequency	–	–	50	MHz	20-pF load, drive_sel<1:0>= 0b00, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID681A	$f_{OUT_GPIO_ENH0L}$	Output frequency	–	–	32	MHz	20-pF load, drive_sel<1:0>= 0b00, 2.7 V ≤ V_{DDD} < 4.5 V
SID682A	$f_{OUT_GPIO_ENH1H}$	Output frequency	–	–	25	MHz	20-pF load, drive_sel<1:0>= 0b01, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID683A	$f_{OUT_GPIO_ENH1L}$	Output frequency	–	–	15	MHz	20-pF load, drive_sel<1:0>= 0b01, 2.7 V ≤ V_{DDD} < 4.5 V
SID684A	$f_{OUT_GPIO_ENH2H}$	Output frequency	–	–	25	MHz	10-pF load, drive_sel<1:0>= 0b10, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID685A	$f_{OUT_GPIO_ENH2L}$	Output frequency	–	–	15	MHz	10-pF load, drive_sel<1:0>= 0b10, 2.7 V ≤ V_{DDD} < 4.5 V
SID686A	$f_{OUT_GPIO_ENH3H}$	Output frequency	–	–	15	MHz	6-pF load, drive_sel<1:0>= 0b11, 4.5 V ≤ V_{DDD} ≤ 5.5 V
SID687A	$f_{OUT_GPIO_ENH3L}$	Output frequency	–	–	10	MHz	6-pF load, drive_sel<1:0>= 0b11, 2.7 V ≤ V_{DDD} < 4.5 V
GPIO Input Specifications							
SID98	t_{FT}	Analog glitch filter (pulse suppression width)	–	–	50[52]	ns	One filter per port group

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Table 26-5 I/O Specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID99	t_{INT}	Minimum pulse width for GPIO interrupt	160	–	–	ns	

26.6 Analog peripherals

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

26.6.1 SAR ADC

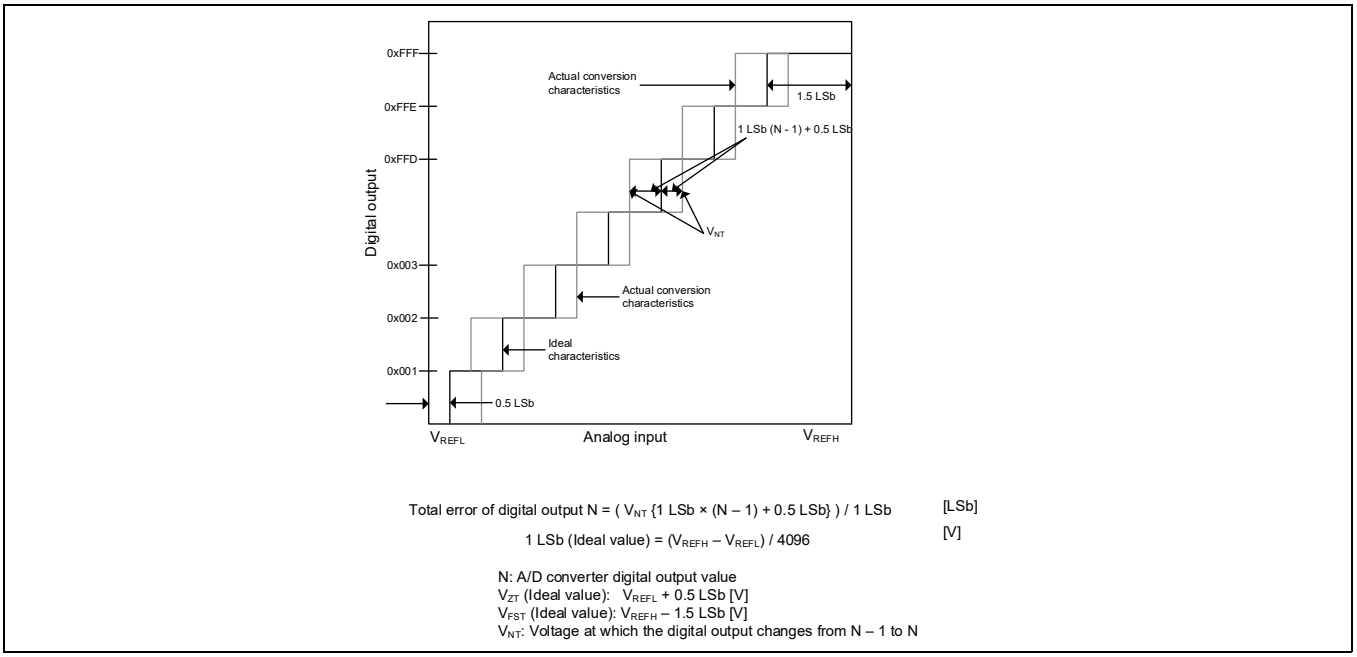


Figure 26-4 ADC characteristics and error definitions

Table 26-6 12-Bit SAR ADC DC specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID100	A_RES	SAR ADC resolution	–	–	12	bits	
SID101	A_V_{INS}	Input voltage range	V_{REFL}	–	V_{REFH}	V	
SID102	A_V_{REFH}	V_{REFH} voltage range	2.7	–	V_{DDA}	V	ADC performance degrades when high reference is higher than supply
SID102A	A_V_{DDA}[53]	V_{DDA} voltage range	2.7	–	5.5	V	
SID103	A_V_{REFL}	V_{REFL} voltage range	V_{SSA}	–	V_{SSA}	V	ADC performance degrades when low reference is lower than ground

Note
52.If longer pulse suppression width is required, use Smart I/O.

Note
53.V_{DDD} must be greater than 0.8 × V_{DDA} when ADC[2] is enabled. V_{DDIO_1} must be greater than 0.8 × V_{DDA} when ADC[0] is enabled.

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Table 26-6 12-Bit SAR ADC DC specifications

SID103A	V_{band_gap}	Internal band gap reference voltage	0.882	0.9	0.918	V	
SID19A	CLAMP_COUPLING_RATIO_POS	Ratio of current collected on a pin to the positive current injected into a neighboring pin	–	–	0.25	%	
SID19B	CLAMP_COUPLING_RATIO_NEG	Ratio of current collected on a pin to the negative current injected into a neighboring pin	–	–	1.2	%	
SID19C	$R_{CLAMP_INTERNAL}$	Internal pin resistance to current collection point	–	–	50	Ω	

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26.6.2 Calculating the impact of neighboring pins

The three ADC specifications based on SID19A, SID19B, and SID19C, can be used to calculate the pin leakage and resulting ADC offset caused by injection current using the below formula:

$$I_{LEAK} = I_{INJECTED} \times CLAMP_COUPLING_RATIO$$
$$V_{ERROR} = I_{LEAK} \times (R_{CLAMP_INTERNAL} + R_{SOURCE})$$
$$Code\ Error = V_{ERROR} \times 2^{12} / V_{REF}$$

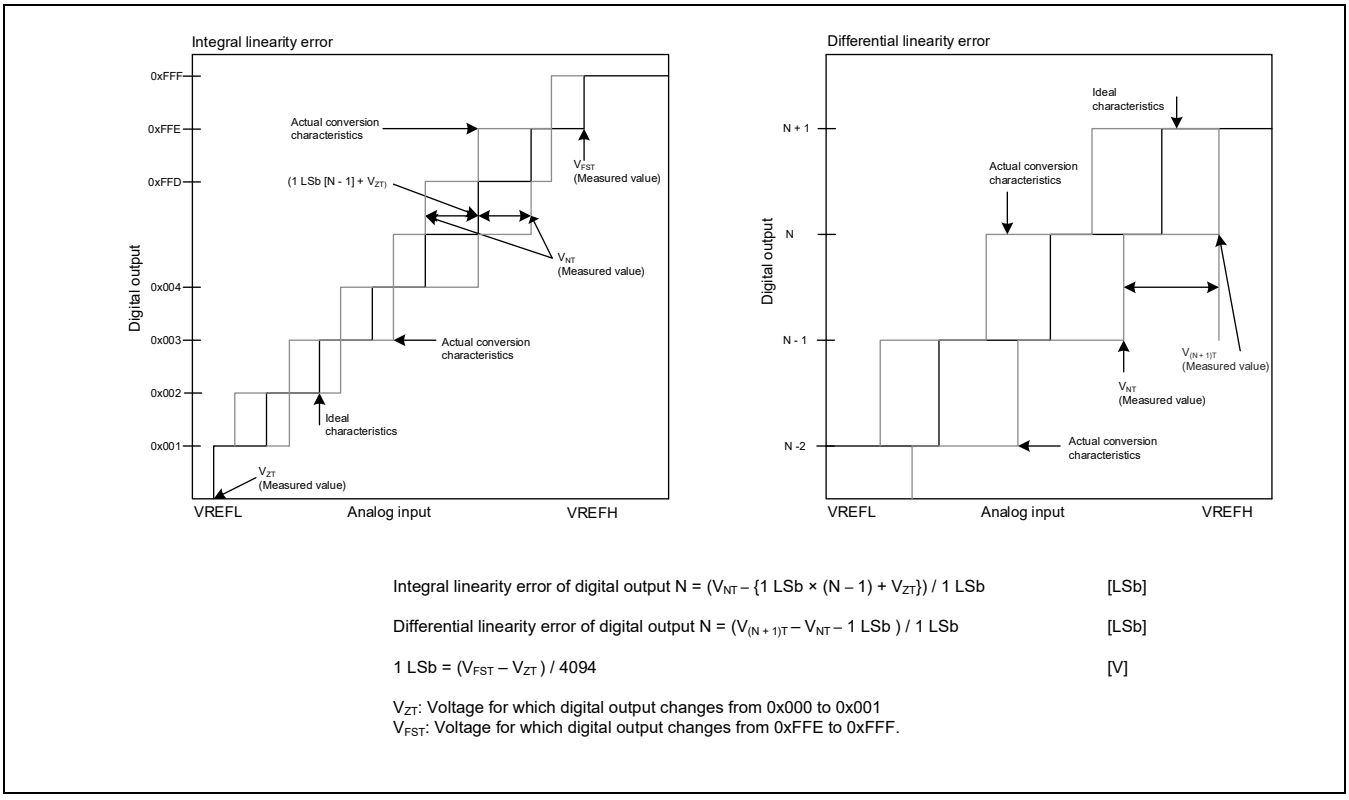
Where:

$I_{INJECTED}$ is the injected current in mA.

I_{LEAK} is the calculated leakage current in mA.

V_{ERROR} is the voltage error calculated due to leakage currents in V.

V_{REF} is the ADC reference voltage in V.



Integral linearity error of digital output N = $(V_{NT} - \{1\ LSb \times (N - 1) + V_{ZT}\}) / 1\ LSb$ [LSb]

Differential linearity error of digital output N = $(V_{(N+1)T} - V_{NT} - 1\ LSb\ ) / 1\ LSb$ [LSb]

$1\ LSb = (V_{FST} - V_{ZT}\ ) / 4094$ [V]

V_{ZT}: Voltage for which digital output changes from 0x000 to 0x001
V_{FST}: Voltage for which digital output changes from 0xFFE to 0xFFF.

Figure 26-5 Integral and differential linearity errors

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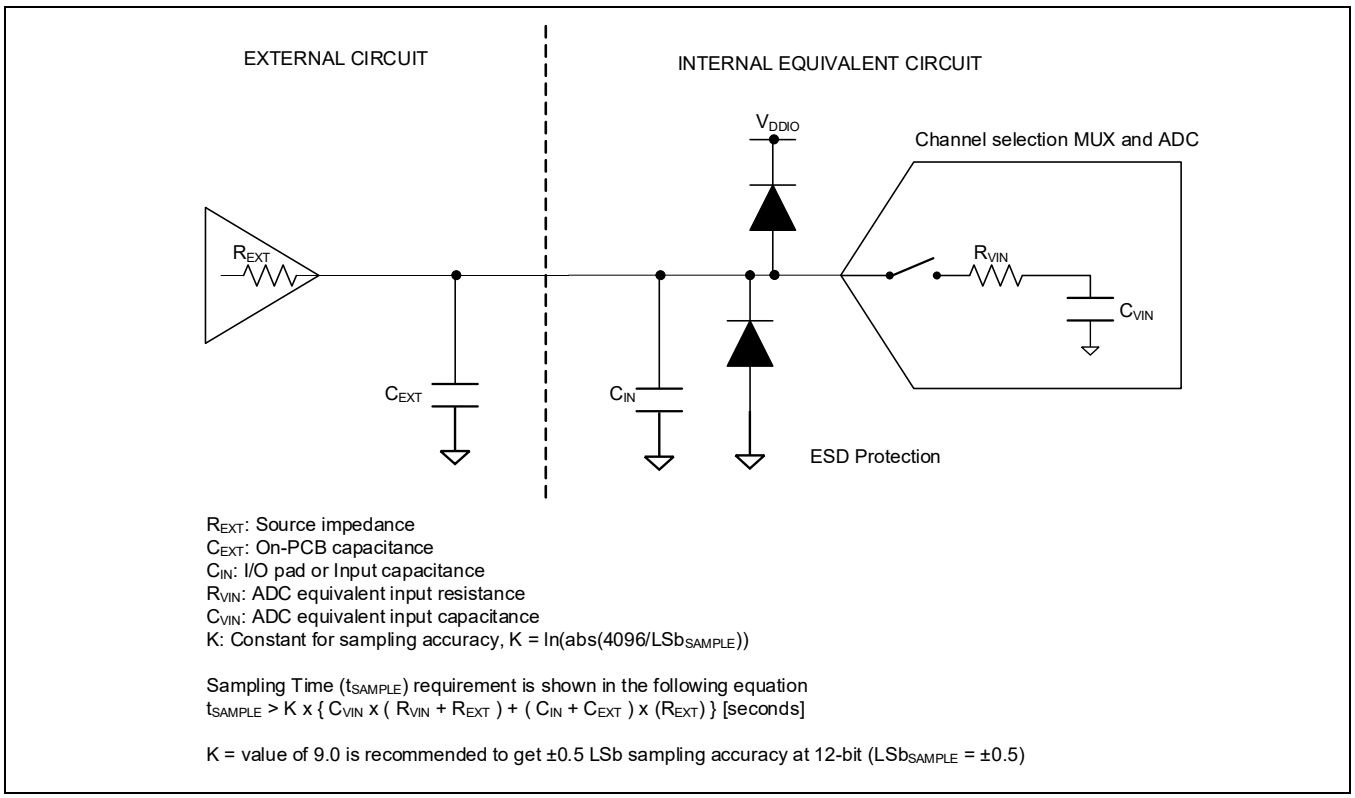


Figure 26-6 ADC equivalent circuit for analog input

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Table 26-7 SAR ADC AC specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID104	V_{ZT}	Zero transition voltage	–20	–	20	mV	V_{DDA} = 2.7 V to 5.5 V, –40 °C ≤ T_A ≤ 125 °C before offset adjustment
SID105	V_{FST}	Full-scale transition voltage	–20	–	20	mV	V_{DDA} = 2.7 V to 5.5 V, –40 °C ≤ T_A ≤ 125 °C before offset adjustment
SID114	f_{ADC_4P5}	ADC operating frequency	2	–	26.67	MHz	4.5 V ≤ V_{DDA} ≤ 5.5 V
SID114A	f_{ADC_2P7}	ADC operating frequency	2	–	13.34	MHz	2.7 V ≤ V_{DDA} < 4.5 V
SID113	t_{S_4P5}	Analog input sample time	412	–	–	ns	4.5 V ≤ V_{DDA} ≤ 5.5 V Guaranteed by design
SID113A	t_{S_2P7}	Analog input sample time	600	–	–	ns	2.7 V ≤ V_{DDA} < 4.5 V Guaranteed by design
SID113B	$t_{S_DR_4P5}$	Analog input sample time when input is from diagnostic reference	2	–	–	µs	4.5 V ≤ V_{DDA} ≤ 5.5 V Guaranteed by design
SID113C	$t_{S_DR_2P7}$	Analog input sample time when input is from diagnostic reference	2.5	–	–	µs	2.7 V ≤ V_{DDA} < 4.5 V Guaranteed by design
SID113D	t_{S_TS}	Analog input sample time for temperature sensor	3	–	–	µs	2.7 V ≤ V_{DDA} ≤ 5.5 V Guaranteed by design
SID106	t_{ST_4P5}	Max throughput (Sample per second)	–	–	1	Msps	4.5 V ≤ V_{DDA} ≤ 5.5 V, 80 MHz / 3 = 26.67 MHz, 11 sampling cycles, 15 conversion cycles
SID106A	t_{ST_2P7}	Max throughput (Sample per second)	–	–	0.5	Msps	2.7 V ≤ V_{DDA} < 4.5 V 80 MHz / 6 = 13.3 MHz, 11 sampling cycles, 15 conversion cycles
SID107	C_{VIN}	ADC input sampling capacitance	–	–	4.8	pF	Guaranteed by design
SID108	R_{VIN1}	Input path ON resistance (4.5 V to 5.5 V)	–	–	9.4	kΩ	Guaranteed by design
SID108A	R_{VIN2}	Input path ON resistance (2.7 V to 4.5 V)	–	–	13.9	kΩ	Guaranteed by design
SID108B	R_{DREF1}	Diagnostic path ON resistance (4.5 V to 5.5 V)	–	–	40	kΩ	Guaranteed by design
SID108C	R_{DREF2}	Diagnostic path ON resistance (2.7 V to 4.5 V)	–	–	50	kΩ	Guaranteed by design
SID119	ACC_RLAD	Diagnostic reference resistor ladder accuracy	–4	–	4	%	
SID109	A_TE	Total error	–5	–	5	LSb	V_{DDA} = V_{REFH} = 2.7 V to 5.5 V, V_{REFL} = V_{SSA} –40 °C ≤ T_A ≤ 125 °C Total error after offset and gain adjustment at 12 bit resolution mode

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Table 26-7 SAR ADC AC specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID109A	A_TEB	Total error	–12	–	12	LSb	$V_{DDA} = V_{REFH} = 2.7$ V to 5.5 V, $V_{REFL} = V_{SSA}$ –40 °C ≤ T_A ≤ 125 °C Total error before offset and gain adjustment at 12 bit resolution mode
SID110	A_INL	Integral nonlinearity	–2.5	–	2.5	LSb	V_{DDA} = 2.7 V to 5.5 V, –40 °C ≤ T_A ≤ 125 °C
SID111	A_DNL	Differential nonlinearity	–0.99	–	1.9	LSb	V_{DDA} = 2.7 V to 5.5 V, –40 °C ≤ T_A ≤ 125 °C
SID112	A_CE	Channel-to-channel variation (for channels connected to same ADC)	–1	–	1	LSb	V_{DDA} = 2.7 V to 5.5 V, –40 °C ≤ T_A ≤ 125 °C
SID115	I_{AIC}	Analog input leakage current	–350	70	350	nA	When input pad is selected for conversion
SID116	$I_{DIAGREF}$	Diagnostic reference current	–	–	70	µA	
SID117	I_{VDDA}	Analog power supply current while ADC is operating	–	360	550	µA	Per enabled ADC
SID117A	I_{VDDA_DS}	Analog power supply current while ADC is not operating	–	–	21	µA	Per enabled ADC
SID118	I_{VREF}	Analog reference voltage current while ADC is operating	–	360	550	µA	Per enabled ADC
SID118A	I_{VREF_LEAK}	Analog reference voltage current while ADC is not operating	–	1.8	5	µA	Per enabled ADC

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26.6.3 Temperature sensor

Table 26-8 Temperature sensor specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID200	$T_{SENSACC1}$	Temperature sensor accuracy 1	–2	–	2	°C	T_J = 150 °C This spec is valid when using ADC[0] (V_{DDIO_1}), ADC[1] (V_{DDIO_2}) or ADC[2] (V_{DDD}) with the following conditions: a. 3.0 V ≤ V_{DDD}, V_{DDIO_1} or V_{DDIO_2} = V_{DDA} = V_{REFH} ≤ 3.6 V or b. 4.5 V ≤ V_{DDD}, V_{DDIO_1} or V_{DDIO_2} = V_{DDA} = V_{REFH} ≤ 5.5 V
SID201	$T_{SENSACC2}$	Temperature sensor accuracy 2	–5	–	5	°C	–40 °C ≤ T_J < 150 °C This spec is valid when using ADC[0] (V_{DDIO_1}), ADC[1] (V_{DDIO_2}) or ADC[2] (V_{DDD}) with the following conditions: a. 3.0 V ≤ V_{DDD}, V_{DDIO_1} or V_{DDIO_2} = V_{DDA} = V_{REFH} ≤ 3.6 V or b. 4.5 V ≤ V_{DDD}, V_{DDIO_1} or V_{DDIO_2} = V_{DDA} = V_{REFH} ≤ 5.5 V
SID201A	$T_{SENSACC3}$	Temperature sensor accuracy 3	–10	–	10	°C	–40 °C ≤ T_J ≤ 150 °C This spec is valid when using ADC[0] (V_{DDIO_1}) or ADC[2] (V_{DDD}) with the following condition: 2.7 V ≤ V_{DDD} or V_{DDIO_1} ≤ 5.5 V and 2.7 V ≤ V_{DDA} = V_{REFH} ≤ 5.5 V and 0.8 × V_{DDA} < V_{DDD} or V_{DDIO_1}

26.6.4 Voltage divider accuracy

Table 26-9 Voltage divider accuracy

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID202	V_{MONDIV}	Uncorrected monitor voltage divider accuracy (measured by ADC), compared to ideal supply/2	–20	2	20	%	Any HV supply pad within 2.7 V - 5.5 V operating range

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26.7 AC specifications

Unless otherwise noted, the timings are defined with the guidelines mentioned in the **Figure 26-7**.

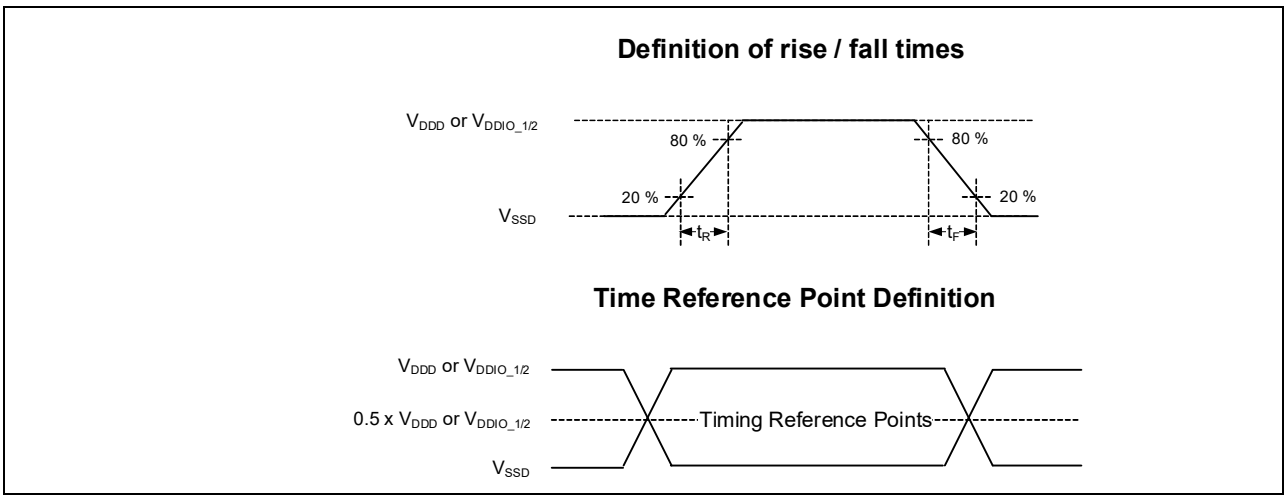


Figure 26-7 AC timings specifications

26.8 Digital peripherals

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Table 26-10 Timer/counter/PWM (TCPWM) specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID120	f_C	TCPWM operating frequency	–	–	100	MHz	f_C = peripheral clock
SID121	$t_{PWMENEXT}$	Input trigger pulse width for all trigger events	2 / f_C	–	–	ns	Trigger Events can be Stop, Start, Reload, Count, Capture, or Kill depending on which mode of operation is selected.
SID122	t_{PWMEXT}	Output trigger pulse widths	2 / f_C	–	–	ns	Minimum possible width of Overflow, Underflow, and Counter = Compare (CC) value trigger outputs
SID123	t_{CRES}	Resolution of counter	1 / f_C	–	–	ns	Minimum time between successive counts
SID124	t_{PWMRES}	PWM resolution	1 / f_C	–	–	ns	Minimum pulse width of PWM output
SID125	t_{QRES}	Quadrature inputs resolution	2 / f_C	–	–	ns	Minimum pulse width between Quadrature phase inputs.

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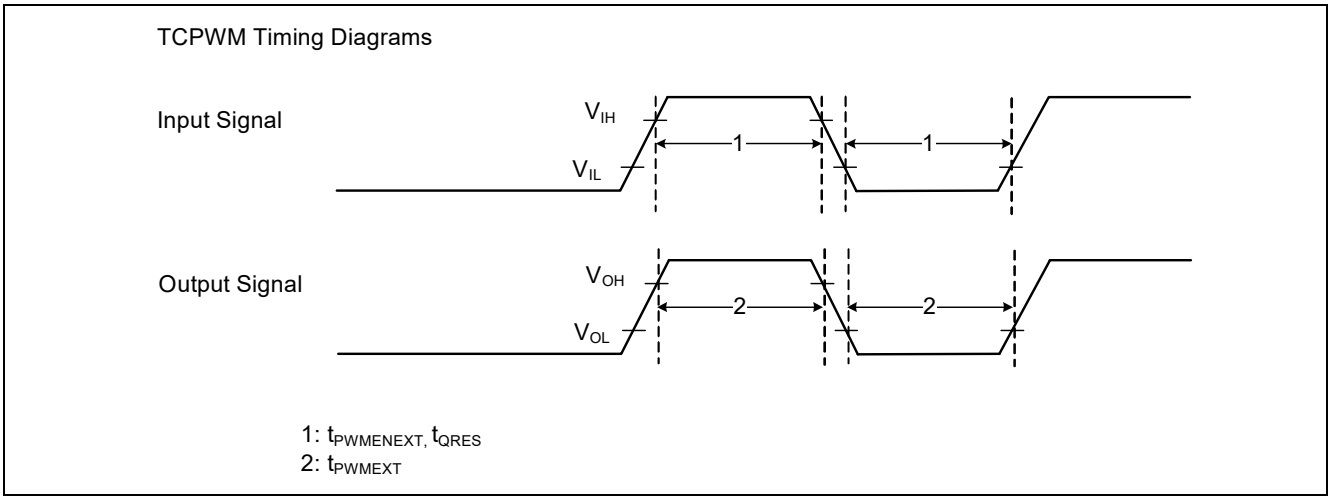


Figure 26-8 TCPWM timing diagrams

Table 26-11 Serial communication block (SCB) specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID129	f_{SCB}	SCB operating frequency	–	–	100	MHz	
I²C Interface-Standard-mode							
SID130	f_{SCL}	SCL clock frequency	–	–	100	kHz	
SID131	$t_{HD;STA}$	Hold time, START condition	4000	–	–	ns	
SID132	t_{LOW}	Low period of SCL	4700	–	–	ns	
SID133	t_{HIGH}	High period of SCL	4000	–	–	ns	
SID134	$t_{SU;STA}$	Setup time for a repeated START	4700	–	–	ns	
SID135	$t_{HD;DAT}$	Data hold time, for receiver	0	–	–	ns	
SID136	$t_{SU;DAT}$	Data setup time	250	–	–	ns	
SID138	t_F	Fall time of SCL and SDA	–	–	300	ns	Input and output
SID139	$t_{SU;STO}$	Setup time for STOP	4000	–	–	ns	
SID140	t_{BUF}	Bus-free time between START and STOP	4700	–	–	ns	
SID141	C_B	Capacitive load for each bus line	–	–	400	pF	
SID142	$t_{VD;DAT}$	Time for data signal from SCL LOW to SDA output	–	–	3450	ns	
SID143	$t_{VD;ACK}$	Data valid acknowledge time	–	–	3450	ns	
SID144	V_{OL}	LOW level output voltage	0	–	0.4	V	Open-drain at 3 mA sink current
SID145	I_{OL}	LOW level output current	3	–	–	mA	V_{OL} = 0.4 V
I²C Interface-Fast-mode							
SID150	f_{SCL_F}	SCL clock frequency	–	–	400	kHz	
SID151	$t_{HD;STA_F}$	Hold time, START condition	600	–	–	ns	

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Table 26-11 Serial communication block (SCB) specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID152	t_{LOW_F}	Low period of SCL	1300	–	–	ns	
SID153	t_{HIGH_F}	High period of SCL	600	–	–	ns	
SID154	$t_{SU;STA_F}$	Setup time for a repeated START	600	–	–	ns	
SID155	$t_{HD;DAT_F}$	Data hold time, for receiver	0	–	–	ns	
SID156	$t_{SU;DAT_F}$	Data setup time	100	–	–	ns	
SID158	t_{F_F}	Fall time of SCL and SDA	20 × (V_{DDD} / 5.5)	–	300	ns	Input and output, GPIO_ENH: slow mode, 400 pF load
SID158A	t_{FA_F}	Fall time of SCL and SDA	0.35	–	300	ns	Input and output GPIO_STD: drive_sel<1:0>= 0b00 MIN: 10 pF load, RPU = 35.41 kΩ MAX: 400 pF load, RPU = 350 Ω
SID159	$t_{SU;STO_F}$	Setup time for STOP	600	–	–	ns	Input and output
SID160	t_{BUF_F}	Bus free time between START and STOP	1300	–	–	ns	
SID161	C_{B_F}	Capacitive load for each bus line	–	–	400	pF	
SID162	$t_{VD;DAT_F}$	Time for data signal from SCL LOW to SDA output	–	–	900	ns	
SID163	$t_{VD;ACK_F}$	Data valid acknowledge time	–	–	900	ns	
SID164	t_{SP_F}	Pulse width of spikes that must be suppressed by the input filter	–	–	50	ns	
SID165	V_{OL_F}	LOW level output voltage	0	–	0.4	V	Open-drain at 3 mA sink current
SID165	I_{OL_F}	LOW level output current	3	–	–	mA	V_{OL} = 0.4 V
SID167	I_{OL2_F}	LOW level output current	6	–	–	mA	V_{OL} = 0.6 V[54]
I^2C Interface-Fast-Plus mode							
SID170	f_{SCL_FP}	SCL clock frequency	–	–	1	MHz	
SID171	$t_{HD;STA_FP}$	Hold time, START condition	260	–	–	ns	
SID172	t_{LOW_FP}	Low period of SCL	500	–	–	ns	
SID173	t_{HIGH_FP}	High period of SCL	260	–	–	ns	
SID174	$t_{SU;STA_FP}$	Setup time for a repeated START	260	–	–	ns	
SID175	$t_{HD;DAT_FP}$	Data hold time, for receiver	0	–	–	ns	
SID176	$t_{SU;DAT_FP}$	Data setup time	50	–	–	ns	

Notes
54.To drive full bus load at 400 kHz, 6 mA I_{OL} is required at 0.6 V V_{OL}.
55.To drive full bus load at 1 MHz, 20 mA I_{OL} is required at 0.4 V V_{OL}. However, this device does not support it.

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Table 26-11 Serial communication block (SCB) specifications *(continued)*

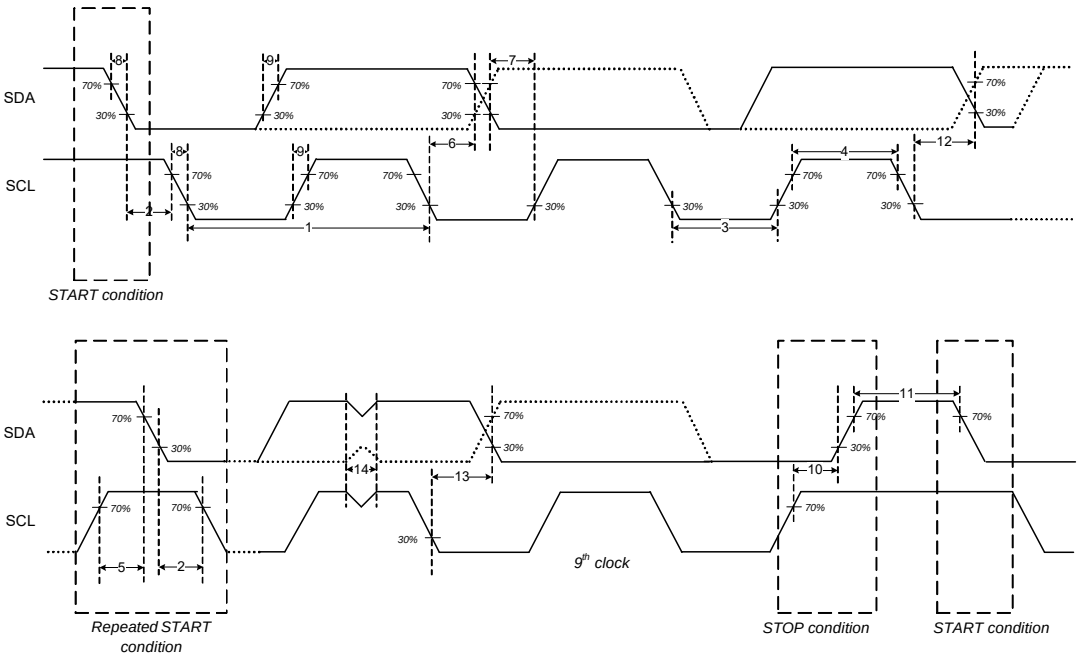
Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID178	t_{F_FP}	Fall time of SCL and SDA	20 × (V_{DDD} /5.5)	–	160	ns	Input and output 20-pF load GPIO_ENH: slow mode
SID179	$t_{SU;STO_FP}$	Setup time for STOP	260	–	–	ns	Input and output
SID180	t_{BUF_FP}	Bus free time between START and STOP	500	–	–	ns	
SID181	C_{B_FP}	Capacitive load for each bus line	–	–	20	pF	
SID182	$t_{VD;DAT_FP}$	Time for data signal from SCL LOW to SDA output	–	–	450	ns	
SID183	$t_{VD;ACK_FP}$	Data valid acknowledge time	–	–	450	ns	
SID184	t_{SP_FP}	Pulse width of spikes that must be suppressed by the input filter	–	–	50	ns	
SID186	V_{OL_FP}	LOW level output voltage	0	–	0.4	V	Open-drain at 3 mA sink current
SID187	I_{OL_FP}	LOW level output current	3	–	–	mA	V_{OL} = 0.4 V[55]
SPI Interface Master (Full-clock mode: LATE_MISO_SAMPLE = 1) [Conditions: drive_sel<1:0>= 0x]							
SID190	f_{SPI}	SPI operating frequency	–	–	12.5	MHz	Do not use half-clock mode: LATE_MISO_SAMPLE = 0
SID191	t_{DMO}	SPI Master: MOSI valid after SCLK driving edge	–	–	15	ns	
SID192	t_{DSI}	SPI Master: MISO valid before SCLK capturing edge	40	–	–	ns	
SID193	t_{HMO}	SPI Master: Previous MOSI data hold time	0	–	–	ns	
SID194	$t_{W_SCLK_H_L}$	SPI SCLK pulse width HIGH or LOW	–	0.4 × (1 / f_{SPI})	–	ns	
SID196	t_{DHI}	SPI Master: MISO hold time after SCLK capturing edge	0	–	–	ns	
SID198	t_{EN_SETUP}	SSEL valid, before the first SCK capturing edge	0.5 × (1/f_{SPI})	–	–	ns	Min is half clock period
SID199	t_{EN_SHOLD}	SSEL hold, after the last SCK capturing edge	0.5 × (1/f_{SPI})	–	–	ns	Min is half clock period
SID195	C_{SPIM_MS}	SPI capacitive load	–	–	10	pF	
SPI Interface Slave (internally clocked) [Conditions: drive_sel<1:0>= 0x]							
SID205	f_{SPI_INT}	SPI operating frequency	–	–	10	MHz	
SID206	t_{DMI_INT}	SPI Slave: MOSI Valid before Sclock capturing edge	5	–	–	ns	
SID207	t_{DSO_INT}	SPI Slave: MISO Valid after Sclock driving edge, in the internal-clocked mode	–	–	62	ns	

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Table 26-11 Serial communication block (SCB) specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID208	t_{HSP}	SPI Slave: Previous MISO data hold time	3	–	–	ns	
SID209	$t_{EN_SETUP_INT}$	SPI Slave: SSEL valid to first SCK valid edge	33	–	–	ns	
SID210	$t_{EN_HOLD_INT}$	SPI Slave Select active (LOW) from last SCLK hold	33	–	–	ns	
SID211	$t_{EN_SETUP_PRE}$	SPI Slave: from SSEL valid, to SCK falling edge before the first data bit	20	–	–	ns	
SID212	$t_{EN_HOLD_PRE}$	SPI Slave: from SCK falling edge before the first data bit, to SSEL invalid	20	–	–	ns	
SID213	$t_{EN_SETUP_CO}$	SPI Slave: from SSEL valid, to SCK falling edge in the first data bit	20	–	–	ns	
SID214	$t_{EN_HOLD_CO}$	SPI Slave: from SCK falling edge in the first data bit, to SSEL invalid	20	–	–	ns	
SID215	$t_{W_DIS_INT}$	SPI Slave Select inactive time	40	–	–	ns	
SID216	$t_{W_SCLKH_INT}$	SPI SCLK pulse width HIGH	20	–	–	ns	
SID217	$t_{W_SCLKL_INT}$	SPI SCLK pulse width LOW	20	–	–	ns	
SID218	t_{SIH_INT}	SPI MOSI hold from SCLK	12	–	–	ns	
SID219	C_{SPIS_INT}	SPI Capacitive Load	–	–	10	pF	
SPI Interface Slave (externally clocked) [Conditions: drive_sel<1:0>= 0x]							
SID220	f_{SPI_EXT}	SPI operating frequency	–	–	12.5	MHz	
SID221	t_{DMI_EXT}	SPI Slave: MOSI Valid before Sclock capturing edge	5	–	–	ns	
SID222	t_{DSO_EXT}	SPI Slave: MISO Valid after Sclock driving edge, in the external-clocked mode	–	–	32	ns	
SID223	t_{HSO_EXT}	SPI Slave: Previous MISO data hold time	3	–	–	ns	
SID224	$t_{EN_SETUP_EXT}$	SPI Slave: SSEL valid to first SCK valid edge	40	–	–	ns	
SID225	$t_{EN_HOLD_EXT}$	SPI Slave Select active (LOW) from last SCLK hold	40	–	–	ns	
SID226	$t_{W_DIS_EXT}$	SPI Slave Select inactive time	80	–	–	ns	
SID227	$t_{W_SCLKH_EXT}$	SPI SCLK pulse width HIGH	34	–	–	ns	
SID228	$t_{W_SCLKL_EXT}$	SPI SCLK pulse width LOW	34	–	–	ns	
SID229	t_{SIH_EXT}	SPI MOSI hold from SCLK	20	–	–	ns	
SID230	C_{SPIS_EXT}	SPI Capacitive Load	–	–	10	pF	
SID231	t_{VSS_EXT}	SPI Slave: MISO valid after SSEL falling edge (CPHA = 0)	–	–	33	ns	
UART Interface							
SID240	f_{BPS}	Data rate	–	–	10	Mbps	

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1: SCL clock period = $1/f_{SCL}$
2: Hold time, START condition = $t_{HD;STA}$
3: LOW period of SCL = t_{LOW}
4: HIGH period of SCL = t_{HIGH}
5: Setup time for a repeated START = $t_{SU;STA}$
6: Data hold time, for receiver = $t_{HD;DAT}$
7: Data setup time = $t_{SU;DAT}$
8: Fall time of SCL and SDA = t_F
9: Rise time of SCL and SDA = t_R
10: Setup time for STOP = $t_{SU;STO}$
11: Bus-free time between START and STOP = t_{BUF}
12: Time for data signal from SCL LOW to SDA output = $t_{VD;DAT}$
13: Data valid acknowledge time = $t_{VD;ACK}$
14: Pulse width of spikes that must be suppressed by the input filter = t_{SP}

Figure 26-9 I^2C timing diagrams

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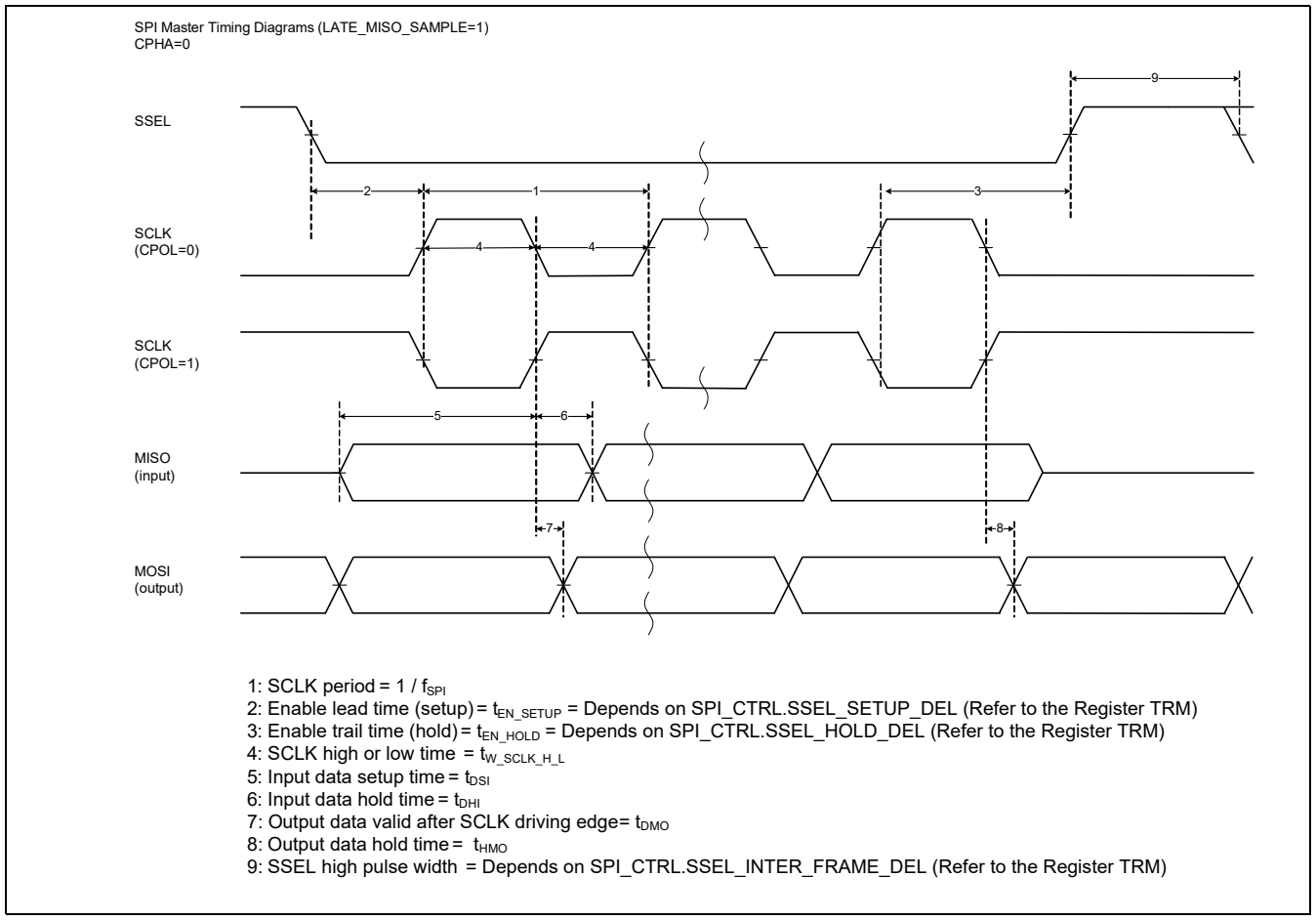


Figure 26-10 SPI master timing diagrams with LOW clock phase

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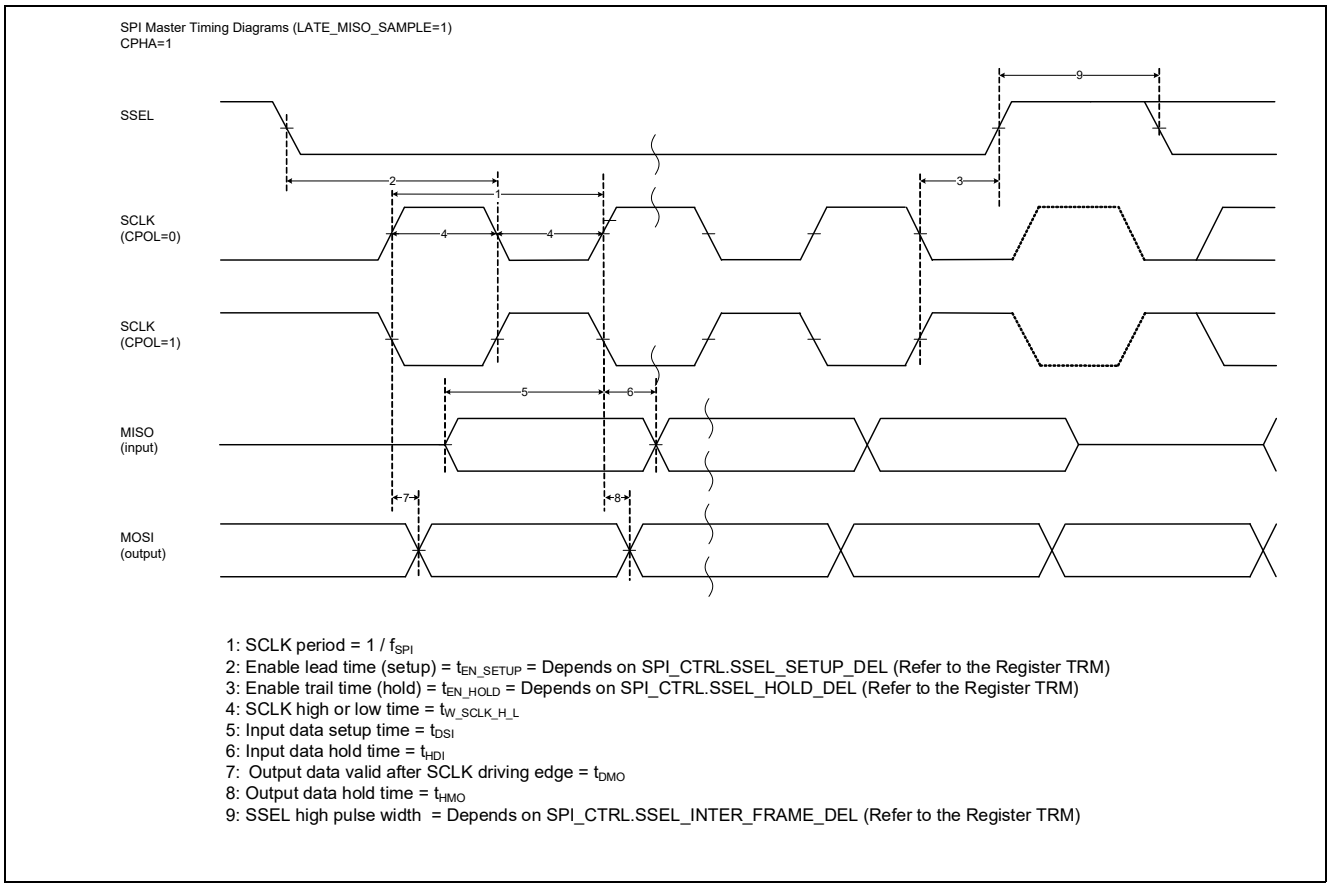


Figure 26-11 SPI master timing diagrams with HIGH clock phase

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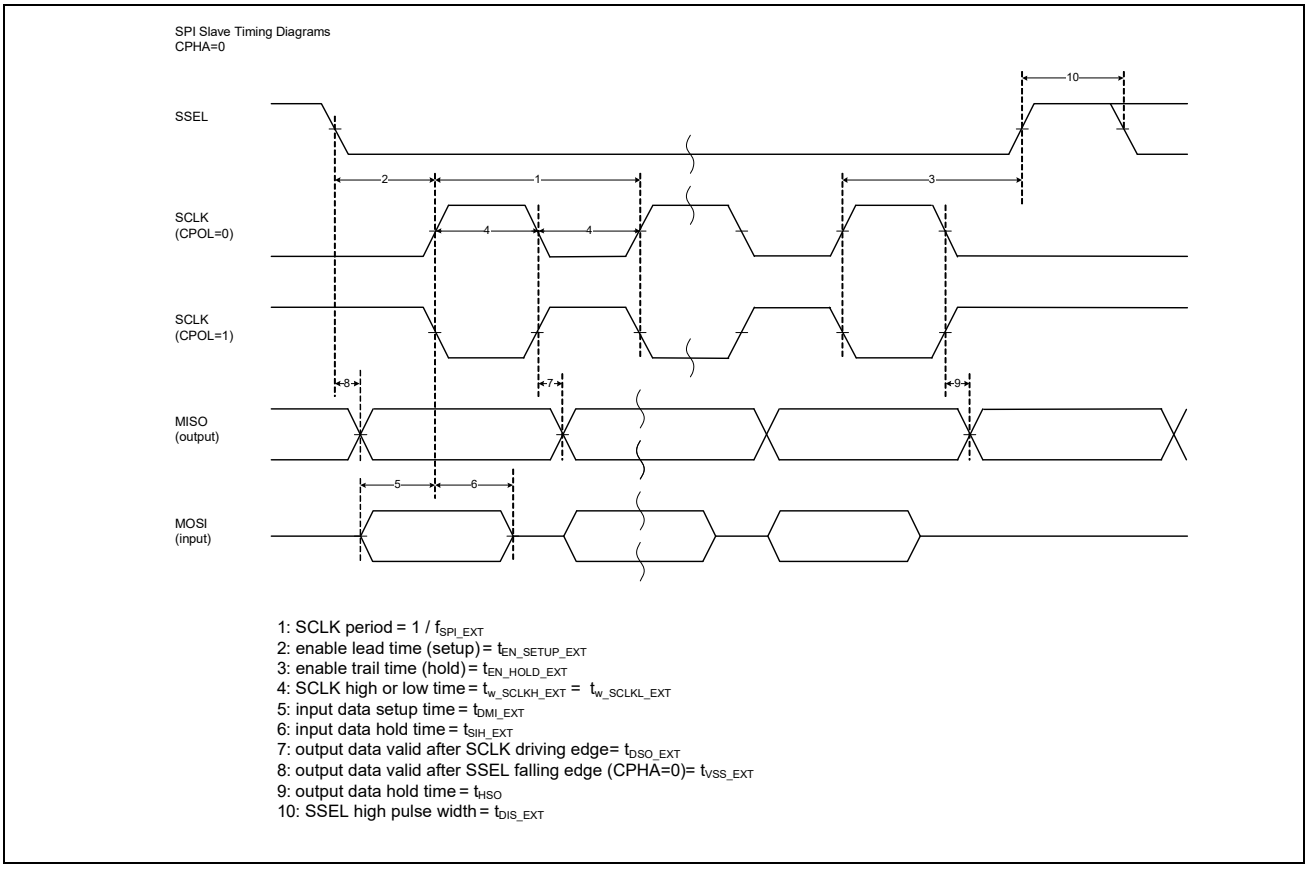


Figure 26-12 SPI slave timing diagrams with LOW clock phase

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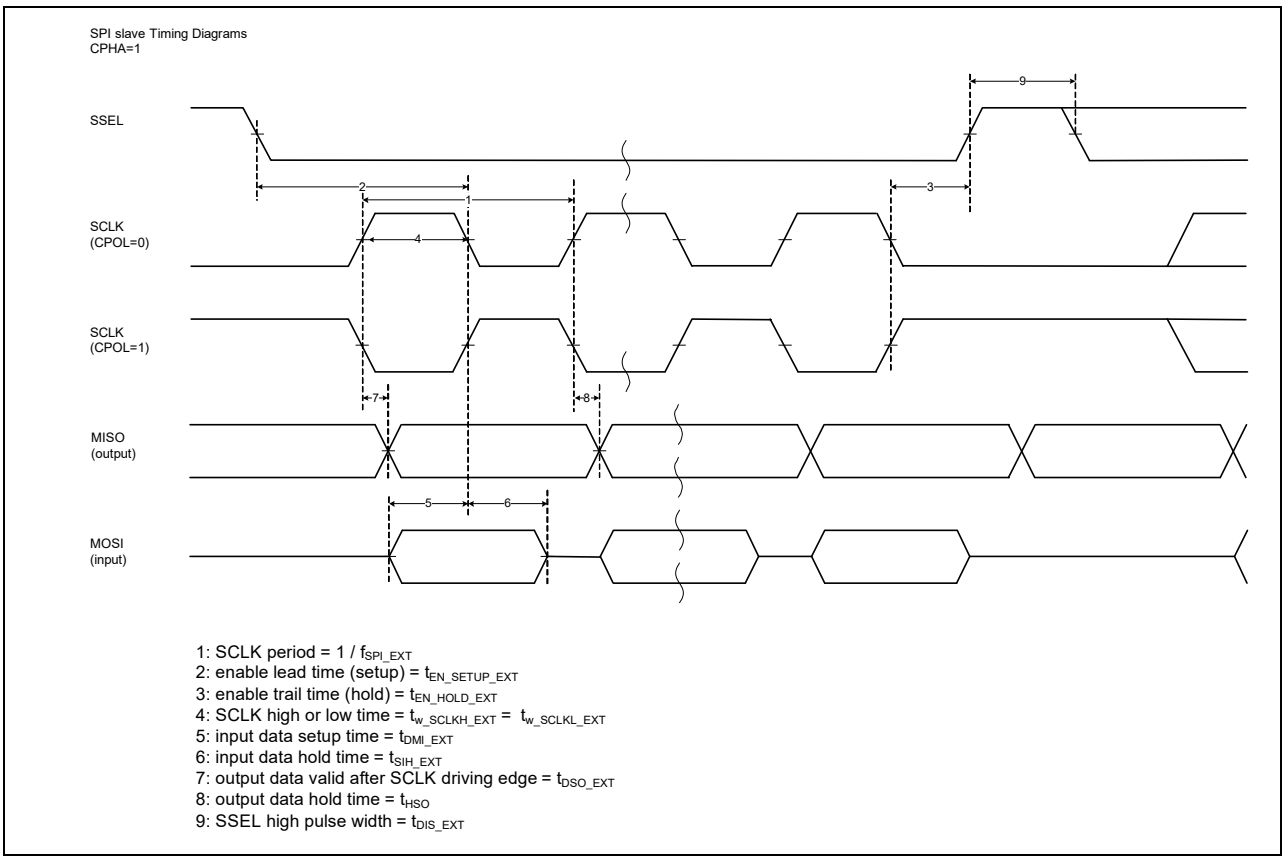


Figure 26-13 SPI slave timing diagrams with HIGH clock phase

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26.8.1 LIN specifications

Table 26-12 LIN specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID249	f_{LIN}	Internal clock frequency to the LIN block	–	–	100	MHz	
SID250	BR_NOM	Bit rate on the LIN bus	1	–	20	kbps	Guaranteed by design
SID250A	BR_REF	Bit rate on the LIN bus (not in standard LIN specification) for re-flashing in LIN slave mode	1	–	115.2	kbps	Guaranteed by design

26.8.2 CAN FD specifications

Table 26-13 CAN FD specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID630	f_{HCLK}	System clock frequency	–	–	100	MHz	$f_{cclk} \leq f_{hclk}$, Guaranteed by design
SID631	f_{CCLK}	CAN clock frequency	–	–	100	MHz	$f_{cclk} \leq f_{hclk}$, Guaranteed by design

26.8.3 CXPI specifications

Table 26-14 CXPI Specifications for PWM mode

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID400	f_{CXPI}	CXPI operating frequency	–	–	100	MHz	Guaranteed by design
SID401	f_{BRC}	Bit rate of CXPI bus	–	–	20	kbps	$t_{BIT} = 1 / f_{BRC}$, Guaranteed by design
SID402	dt_{BIT_CONT}	Difference between the signal output on TXD and the bit width (t_{BIT_REF}) of the reference communication speed	–0.5	–	0.5	%	Guaranteed by design
SID403	$t_{TX_0_HI_CONT}$	Time to detect the signal input on RXD as HIGH	0.02	–	–	t_{BIT}	$t_{BIT} = 1 / f_{BRC}$, Guaranteed by design
SID404	$t_{TX_DIF_CONT}$	Difference between the LOW width of a certain threshold value to be correctly discriminated as the logic value 1 and the logic value 0 for the signal input on RXD $t_{TX_DIF_CONT} = (t_{TX_0_LO} - t_{TX_1_LO})$	0.05	–	–	t_{BIT}	$t_{BIT} = 1 / f_{BRC}$, Guaranteed by design
SID406	$t_{TX_0_PD_CONT}$	Time from the falling edge input of RXD to the falling edge output of TXD when the logic value 0 outputs at the slave node	–	–	0.01	t_{BIT}	$t_{BIT} = 1 / f_{BRC}$, CTL0.FILTER_EN bit = '0', Guaranteed by design
SID406A	$t_{TX_0_PD_CONT}$	Time from the falling edge input of RXD to the falling edge output of TXD when the logic value 0 outputs at the slave node	–	–	0.0125	t_{BIT}	$t_{BIT} = 1 / f_{BRC}$, CTL0.FILTER_EN bit = '1', Guaranteed by design

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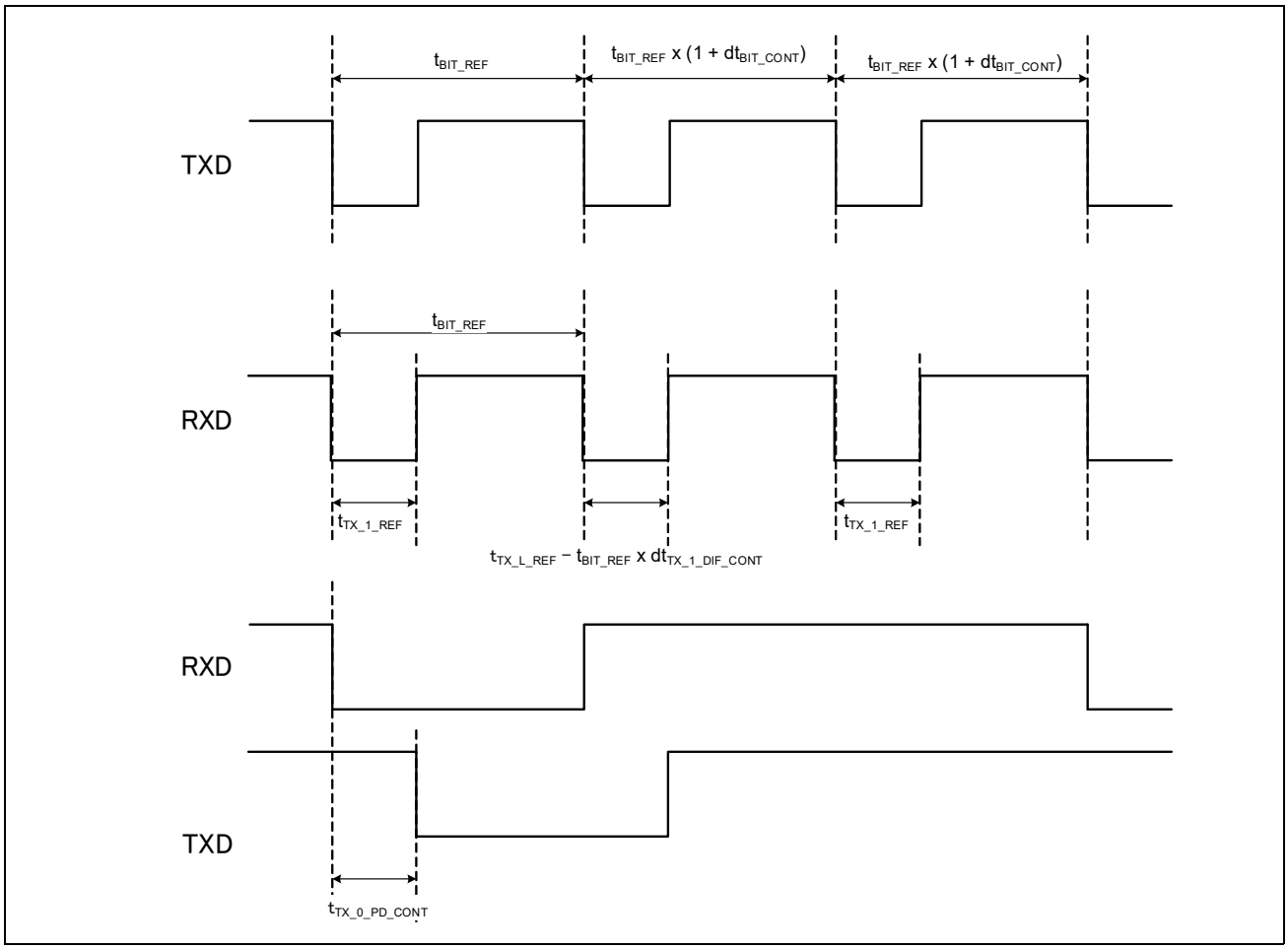


Figure 26-14 CXPI Specifications

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26.9 Memory

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Table 26-15 Flash DC specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID260	V_{PE}	Erase and program voltage	2.7	–	5.5	V	

Table 26-16 Flash AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID257	f_{FO}	Maximum flash memory operation frequency	–	–	100	MHz	Zero wait access to code-flash memory up to 100 MHz Zero wait access with cache hit up to 160 MHz
SID254	t_{ERS_SUS}	Maximum time from erase suspend command till erase is indeed suspend	–	–	37.5	µs	
SID255	$t_{ERS_RES_SUS}$	Minimum time allowed from erase resume to erase suspend	250	–	–	µs	Guaranteed by design
SID258	t_{BC_WF}	Blank check time for N-bytes of work-flash	–	–	10+0.3 × N	µs	At 100 MHz, N ≥ 4 and multiple of 4, excludes system overhead time
SID259	$t_{SECTORERASE1}$	Sector erase time (Code-flash: 32 KB)	–	45	90	ms	Includes internal preprogramming time
SID259A	$t_{SECTORERASE2}$	Sector erase time (Code-flash: 8 KB)	–	15	30	ms	Includes internal preprogramming time
SID261	$t_{SECTORERASE3}$	Sector erase time (Work-flash, 2 KB)	–	80	160	ms	Includes internal preprogramming time
SID262	$t_{SECTORERASE4}$	Sector erase time (Work-flash, 128 bytes)	–	5	15	ms	Includes internal preprogramming time
SID263	t_{WRITE1}	64-bit write time (Code-flash)	–	30	60	µs	Excludes system overhead time
SID264	t_{WRITE2}	256-bit write time (Code-flash)	–	40	70	µs	Excludes system overhead time
SID265	t_{WRITE3}	4096-bit write time (Code-flash)[56]	–	320	1200	µs	Excludes system overhead time
SID266	t_{WRITE4}	32-bit write time (Work-flash)	–	30	60	µs	Excludes system overhead time
SID267	t_{FRET1}	Code-flash retention. 1000 program/erase cycles	20	–	–	years	T_A (power on and off) ≤ 85 °C average
SID268	t_{FRET3}	Work-flash retention. 125,000 program/erase cycles	20	–	–	years	T_A (power on and off) ≤ 85 °C average
SID269	t_{FRET4}	Work-flash retention. 250,000 program/erase cycles	10	–	–	years	T_A (power on and off) ≤ 85 °C average
SID612A	I_{CC_ACT2}	Program operating current (Code or Work-flash)	–	15	48	mA	V_{DDD} = 5 V Guaranteed by design
SID613A	I_{CC_ACT3}	Erase operating current (Code or Work-flash)	–	15	48	mA	V_{DDD} = 5 V Guaranteed by design

Note
56. The code-flash includes a 'Write Buffer' of 4096-bit. If the application software writes this buffer multiple times, to get the overall write time multiply one sector write time with the corresponding factor (say for factor 64, example, 64 x 512 B = 32 KB [one sector]).

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26.10 System resources

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

Table 26-17 System resources

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
Power-on-reset specifications							
SID270	V_{POR_R}	V_{DDD} rising voltage to deassert POR	1.5	–	2.35	V	Guaranteed by design
SID276	V_{POR_F}	V_{DDD} falling voltage to assert POR	1.45	–	2.1	V	
SID271	V_{POR_H}	Level detection hysteresis	20	–	300	mV	Guaranteed by design
SID272	t_{DLY_POR}	Delay between V_{DDD} rising through 2.3 V and an internal deassertion of POR	–	–	3	µs	Guaranteed by design
SID273	t_{POFF}	V_{DDD} Power off time	100	–	–	µs	V_{DDD} < 1.45 V
SID274	POR_RR1	V_{DDD} power ramp rate with robust BOD (BOD operation is guaranteed)	–	–	100	mV/µs	This ramp supports robust BOD
SID275	POR_RR2	V_{DDD} power ramp rate without robust BOD	–	–	1000	mV/µs	This ramp does not support robust BOD t_{POFF} must be satisfied
High-voltage BOD (HV BOD) specifications							
SID500	$V_{TR_2P7_R}$	HV BOD 2.7 V rising detection point for V_{DDD} and V_{DDA} (default)	2.474	2.55	2.627	V	
SID501	$V_{TR_2P7_F}$	HV BOD 2.7 V falling detection point for V_{DDD} and V_{DDA} (default)	2.449	2.525	2.601	V	
SID502	$V_{TR_3P0_R}$	HV BOD 3.0 V rising detection point for V_{DDD} and V_{DDA}	2.765	2.85	2.936	V	
SID503	$V_{TR_3P0_F}$	HV BOD 3.0 V falling detection point for V_{DDD} and V_{DDA}	2.74	2.825	2.91	V	
SID505	HVBOD_RR_A	Power ramp rate: V_{DDD} and V_{DDA} (Active)	–	–	100	mV/µs	
SID506	HVBOD_RR_DS	Power ramp rate: V_{DDD} and V_{DDA} (DeepSleep)	–	–	10	mV/µs	
SID507	$t_{DLY_ACT_HVBOD}$	Active mode delay between V_{DDD} falling/rising through $V_{TR_2P7_F/R}$ or $V_{TR_3P0_F/R}$ and an internal HV BOD signal transitioning	–	–	0.5	µs	Guaranteed by design
SID507A	$t_{DLY_ACT_HVBOD}$	Active mode delay between V_{DDA} falling/rising through $V_{TR_2P7_F/R}$ or $V_{TR_3P0_F/R}$ and internal HV BOD signal transitioning	–	–	1	µs	Guaranteed by design
SID507B	$t_{DLY_DS_HVBOD}$	DeepSleep mode delay between V_{DDD}/V_{DDA} falling/rising through $V_{TR_2P7_F/R}$ or $V_{TR_3P0_F/R}$ and an internal HV BOD signal transitioning	–	–	4	µs	Guaranteed by design
SID508	t_{RES_HVBOD}	Response time of HV BOD, V_{DDD}/V_{DDA} supply. (For falling-then-rising supply at max ramp rate; threshold is $V_{TR_2P7_F}$ or $V_{TR_3P0_F}$.)	100	–	–	ns	Guaranteed by design

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Table 26-17 System resources *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
Low-voltage BOD (LV BOD) specifications							
SID510	$V_{TR_R_LVBOD}$	LV BOD rising detection point for V_{CCD}	0.917	0.945	0.973	V	
SID511	$V_{TR_F_LVBOD}$	LV BOD falling detection point for V_{CCD}	0.892	0.92	0.948	V	
SID515	$t_{DLY_ACT_LVBOD}$	Active delay between V_{CCD} falling/rising through V_{TR_R/F_LVBOD} and an internal LV BOD signal transitioning	–	–	1	µs	Guaranteed by design
SID515A	$t_{DLY_DS_LVBOD}$	DeepSleep mode delay between V_{CCD} falling/rising through V_{TR_R/F_LVBOD} and an internal LV BOD signal transitioning	–	–	12	µs	Guaranteed by design
SID516	t_{RES_LVBOD}	Response time of LV BOD. (For falling-then-rising supply at max ramp rate; threshold is $V_{TR_F_LVBOD}$.)	100	–	–	ns	Guaranteed by design
Low-voltage detector (LVD) DC specifications							
SID520	$V_{TR_2P8_F}$	LVD 2.8 V falling detection point for V_{DDD}	Typ – 4%	2800	Typ + 4%	mV	
SID521	$V_{TR_2P9_F}$	LVD 2.9 V falling detection point for V_{DDD}	Typ – 4%	2900	Typ + 4%	mV	
SID522	$V_{TR_3P0_F}$	LVD 3.0 V falling detection point for V_{DDD}	Typ – 4%	3000	Typ + 4%	mV	
SID523	$V_{TR_3P1_F}$	LVD 3.1 V falling detection point for V_{DDD}	Typ – 4%	3100	Typ + 4%	mV	
SID524	$V_{TR_3P2_F}$	LVD 3.2 V falling detection point for V_{DDD}	Typ – 4%	3200	Typ + 4%	mV	
SID525	$V_{TR_3P3_F}$	LVD 3.3 V falling detection point for V_{DDD}	Typ – 4%	3300	Typ + 4%	mV	
SID526	$V_{TR_3P4_F}$	LVD 3.4 V falling detection point for V_{DDD}	Typ – 4%	3400	Typ + 4%	mV	
SID527	$V_{TR_3P5_F}$	LVD 3.5 V falling detection point for V_{DDD}	Typ – 4%	3500	Typ + 4%	mV	
SID528	$V_{TR_3P6_F}$	LVD 3.6 V falling detection point for V_{DDD}	Typ – 4%	3600	Typ + 4%	mV	
SID529	$V_{TR_3P7_F}$	LVD 3.7 V falling detection point for V_{DDD}	Typ – 4%	3700	Typ + 4%	mV	
SID530	$V_{TR_3P8_F}$	LVD 3.8 V falling detection point for V_{DDD}	Typ – 4%	3800	Typ + 4%	mV	
SID531	$V_{TR_3P9_F}$	LVD 3.9 V falling detection point for V_{DDD}	Typ – 4%	3900	Typ + 4%	mV	
SID532	$V_{TR_4P0_F}$	LVD 4.0 V falling detection point for V_{DDD}	Typ – 4%	4000	Typ + 4%	mV	
SID533	$V_{TR_4P1_F}$	LVD 4.1 V falling detection point for V_{DDD}	Typ – 4%	4100	Typ + 4%	mV	
SID534	$V_{TR_4P2_F}$	LVD 4.2 V falling detection point for V_{DDD}	Typ – 4%	4200	Typ + 4%	mV	
SID535	$V_{TR_4P3_F}$	LVD 4.3 V falling detection point for V_{DDD}	Typ – 4%	4300	Typ + 4%	mV	

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Table 26-17 System resources *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID536	$V_{TR_4P4_F}$	LVD 4.4 V falling detection point for V_{DDD}	Typ – 4%	4400	Typ + 4%	mV	
SID537	$V_{TR_4P5_F}$	LVD 4.5 V falling detection point for V_{DDD}	Typ – 4%	4500	Typ + 4%	mV	
SID538	$V_{TR_4P6_F}$	LVD 4.6 V falling detection point for V_{DDD}	Typ – 4%	4600	Typ + 4%	mV	
SID539	$V_{TR_4P7_F}$	LVD 4.7 V falling detection point for V_{DDD}	Typ – 4%	4700	Typ + 4%	mV	
SID540	$V_{TR_4P8_F}$	LVD 4.8 V falling detection point for V_{DDD}	Typ – 4%	4800	Typ + 4%	mV	
SID541	$V_{TR_4P9_F}$	LVD 4.9 V falling detection point for V_{DDD}	Typ – 4%	4900	Typ + 4%	mV	
SID542	$V_{TR_5P0_F}$	LVD 5.0 V falling detection point for V_{DDD}	Typ – 4%	5000	Typ + 4%	mV	
SID543	$V_{TR_5P1_F}$	LVD 5.1 V falling detection point for V_{DDD}	Typ – 4%	5100	Typ + 4%	mV	
SID544	$V_{TR_5P2_F}$	LVD 5.2 V falling detection point for V_{DDD}	Typ – 4%	5200	Typ + 4%	mV	
SID545	$V_{TR_5P3_F}$	LVD 5.3 V falling detection point for V_{DDD}	Typ – 4%	5300	Typ + 4%	mV	
SID546	$V_{TR_2P8_R}$	LVD 2.8 V rising detection point for V_{DDD}	Typ – 4%	2825	Typ + 4%	mV	Same as $V_{TR_2P8_F}$ + 25 mV
SID547	$V_{TR_2P9_R}$	LVD 2.9 V rising detection point for V_{DDD}	Typ – 4%	2925	Typ + 4%	mV	Same as $V_{TR_2P9_F}$ + 25 mV
SID548	$V_{TR_3P0_R}$	LVD 3.0 V rising detection point for V_{DDD}	Typ – 4%	3025	Typ + 4%	mV	Same as $V_{TR_3P0_F}$ + 25 mV
SID549	$V_{TR_3P1_R}$	LVD 3.1 V rising detection point for V_{DDD}	Typ – 4%	3125	Typ + 4%	mV	Same as $V_{TR_3P1_F}$ + 25 mV
SID550	$V_{TR_3P2_R}$	LVD 3.2 V rising detection point for V_{DDD}	Typ – 4%	3225	Typ + 4%	mV	Same as $V_{TR_3P2_F}$ + 25 mV
SID551	$V_{TR_3P3_R}$	LVD 3.3 V rising detection point for V_{DDD}	Typ – 4%	3325	Typ + 4%	mV	Same as $V_{TR_3P3_F}$ + 25 mV
SID552	$V_{TR_3P4_R}$	LVD 3.4 V rising detection point for V_{DDD}	Typ – 4%	3425	Typ + 4%	mV	Same as $V_{TR_3P4_F}$ + 25 mV
SID553	$V_{TR_3P5_R}$	LVD 3.5 V rising detection point for V_{DDD}	Typ – 4%	3525	Typ + 4%	mV	Same as $V_{TR_3P5_F}$ + 25 mV
SID554	$V_{TR_3P6_R}$	LVD 3.6 V rising detection point for V_{DDD}	Typ – 4%	3625	Typ + 4%	mV	Same as $V_{TR_3P6_F}$ + 25 mV

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Table 26-17 System resources *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID555	$V_{TR_3P7_R}$	LVD 3.7 V rising detection point for V_{DDD}	Typ – 4%	3725	Typ + 4%	mV	Same as $V_{TR_3P7_F}$ + 25 mV
SID556	$V_{TR_3P8_R}$	LVD 3.8 V rising detection point for V_{DDD}	Typ – 4%	3825	Typ + 4%	mV	Same as $V_{TR_3P8_F}$ + 25 mV
SID557	$V_{TR_3P9_R}$	LVD 3.9 V rising detection point for V_{DDD}	Typ – 4%	3925	Typ + 4%	mV	Same as $V_{TR_3P9_F}$ + 25 mV
SID558	$V_{TR_4P0_R}$	LVD 4.0 V rising detection point for V_{DDD}	Typ – 4%	4025	Typ + 4%	mV	Same as $V_{TR_4P0_F}$ + 25 mV
SID559	$V_{TR_4P1_R}$	LVD 4.1 V rising detection point for V_{DDD}	Typ – 4%	4125	Typ + 4%	mV	Same as $V_{TR_4P1_F}$ + 25 mV
SID560	$V_{TR_4P2_R}$	LVD 4.2 V rising detection point for V_{DDD}	Typ – 4%	4225	Typ + 4%	mV	Same as $V_{TR_4P2_F}$ + 25 mV
SID561	$V_{TR_4P3_R}$	LVD 4.3 V rising detection point for V_{DDD}	Typ – 4%	4325	Typ + 4%	mV	Same as $V_{TR_4P3_F}$ + 25 mV
SID562	$V_{TR_4P4_R}$	LVD 4.4 V rising detection point for V_{DDD}	Typ – 4%	4425	Typ + 4%	mV	Same as $V_{TR_4P4_F}$ + 25 mV
SID563	$V_{TR_4P5_R}$	LVD 4.5 V rising detection point for V_{DDD}	Typ – 4%	4525	Typ + 4%	mV	Same as $V_{TR_4P5_F}$ + 25 mV
SID564	$V_{TR_4P6_R}$	LVD 4.6 V rising detection point for V_{DDD}	Typ – 4%	4625	Typ + 4%	mV	Same as $V_{TR_4P6_F}$ + 25 mV
SID565	$V_{TR_4P7_R}$	LVD 4.7 V rising detection point for V_{DDD}	Typ – 4%	4725	Typ + 4%	mV	Same as $V_{TR_4P7_F}$ + 25 mV
SID566	$V_{TR_4P8_R}$	LVD 4.8 V rising detection point for V_{DDD}	Typ – 4%	4825	Typ + 4%	mV	Same as $V_{TR_4P8_F}$ + 25 mV
SID567	$V_{TR_4P9_R}$	LVD 4.9 V rising detection point for V_{DDD}	Typ – 4%	4925	Typ + 4%	mV	Same as $V_{TR_4P9_F}$ + 25 mV
SID568	$V_{TR_5P0_R}$	LVD 5.0 V rising detection point for V_{DDD}	Typ – 4%	5025	Typ + 4%	mV	Same as $V_{TR_5P0_F}$ + 25 mV
SID569	$V_{TR_5P1_R}$	LVD 5.1 V rising detection point for V_{DDD}	Typ – 4%	5125	Typ + 4%	mV	Same as $V_{TR_5P1_F}$ + 25 mV
SID570	$V_{TR_5P2_R}$	LVD 5.2 V rising detection point for V_{DDD}	Typ – 4%	5225	Typ + 4%	mV	Same as $V_{TR_5P2_F}$ + 25 mV
SID571	$V_{TR_5P3_R}$	LVD 5.3 V rising detection point for V_{DDD}	Typ – 4%	5325	Typ + 4%	mV	Same as $V_{TR_5P3_F}$ + 25 mV

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Table 26-17 System resources *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID573	LVD_RR_A	Power ramp rate: V_{DDD} (Active)	–	–	100	mV/µs	
SID574	LVD_RR_DS	Power ramp rate: V_{DDD} (DeepSleep)	–	–	10	mV/µs	
SID575	$t_{DLY_ACT_LVD}$	Active mode delay between V_{DDD} falling/rising through LVD rising/falling point and an internal LVD signal transitioning	–	–	1	µs	Guaranteed by design
SID575A	$t_{DLY_DS_LVD}$	DeepSleep mode delay between V_{DDD} falling/rising through LVD rising/falling point and an internal LVD signal rising	–	–	4	µs	Guaranteed by design
SID576	t_{RES_LVD}	Response time of LVD, V_{DDD} supply. LVD guaranteed to generate pulse for V_{DDD} pulse width greater than this. (For falling-then-rising supply at max ramp rate; pulse width is time below LVD falling point)	100	–	–	ns	Guaranteed by design
High-voltage OVD (HV OVD) Specifications							
SID580	$V_{TR_5P0_R}$	HV OVD 5.0-V rising detection point for V_{DDD} and V_{DDA}	5.049	5.205	5.361	V	
SID581	$V_{TR_5P0_F}$	HV OVD 5.0-V falling detection point for V_{DDD} and V_{DDA}	5.025	5.18	5.335	V	
SID582	$V_{TR_5P5_R}$	HV OVD 5.5-V rising detection point for V_{DDD} and V_{DDA} (default)	5.548	5.72	5.892	V	
SID583	$V_{TR_5P5_F}$	HV OVD 5.5-V falling detection point for V_{DDD} and V_{DDA} (default)	5.524	5.695	5.866	V	
SID585	HVOVD_RR_A	Power ramp rate: V_{DDD} and V_{DDA} (Active)	–	–	100	mV/µs	
SID586	HVOVD_RR_DS	Power ramp rate: V_{DDD} and V_{DDA} (DeepSleep)	–	–	10	mV/µs	
SID587	$t_{DLY_ACT_HVOVD}$	Active mode delay between V_{DDD} falling/rising through $V_{TR_5P0_F/R}$ or $V_{TR_5P5_F/R}$ and an internal HV OVD signal transitioning	–	–	1	µs	Guaranteed by design
SID587A	$t_{DLY_ACT_HVOVD_A}$	Active mode delay between V_{DDA} falling/rising through $V_{TR_5P0_F/R}$ or $V_{TR_5P5_F/R}$ and an internal HV OVD signal transitioning	–	–	1.5	µs	Guaranteed by design
SID587B	$t_{DLY_DS_HVOVD}$	DeepSleep mode delay between V_{DDD}/V_{DDA} falling/rising through $V_{TR_5P0_F/R}$ or $V_{TR_5P5_F/R}$ and an internal HV OVD signal transitioning	–	–	4	µs	Guaranteed by design
SID588	t_{RES_HVOVD}	Response time of HV OVD. (For rising-then-falling supply at max ramp rate; threshold is $V_{TR_5P0_R}$ or $V_{TR_5P5_R}$.)	100	–	–	ns	Guaranteed by design
Low-voltage OVD (LV OVD) specifications							
SID590	$V_{TR_R_LVOVD}$	LV OVD rising detection point for V_{CCD}	1.261	1.3	1.339	V	
SID591	$V_{TR_F_LVOVD}$	LV OVD falling detection point for V_{CCD}	1.237	1.275	1.313	V	

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Table 26-17 System resources *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID595	$t_{DLY_ACT_LVOVD}$	Active mode delay between V_{CCD} falling/rising through V_{TR_F/R_LVOVD} and an internal LV OVD signal transitioning	–	–	1	µs	Guaranteed by design
SID595A	$t_{DLY_DS_LVOVD}$	DeepSleep mode delay between V_{CCD} falling/rising through V_{TR_F/R_LVOVD} and an internal LV OVD signal transitioning	–	–	12	µs	Guaranteed by design
SID596	t_{RES_LVOVD}	Response time of LV OVD. (For rising-then-falling supply at max ramp rate; threshold is $V_{TR_R_LVOVD}$.)	100	–	–	ns	Guaranteed by design
Over current detection (OCD) specifications							
SID598	I_{OCD}	OCD detection range for V_{CCD}	156	–	315	mA	Guaranteed by design
SID599	I_{OCD_DPSLP}	Over current detection range in DeepSleep mode	18	–	72	mA	Guaranteed by design

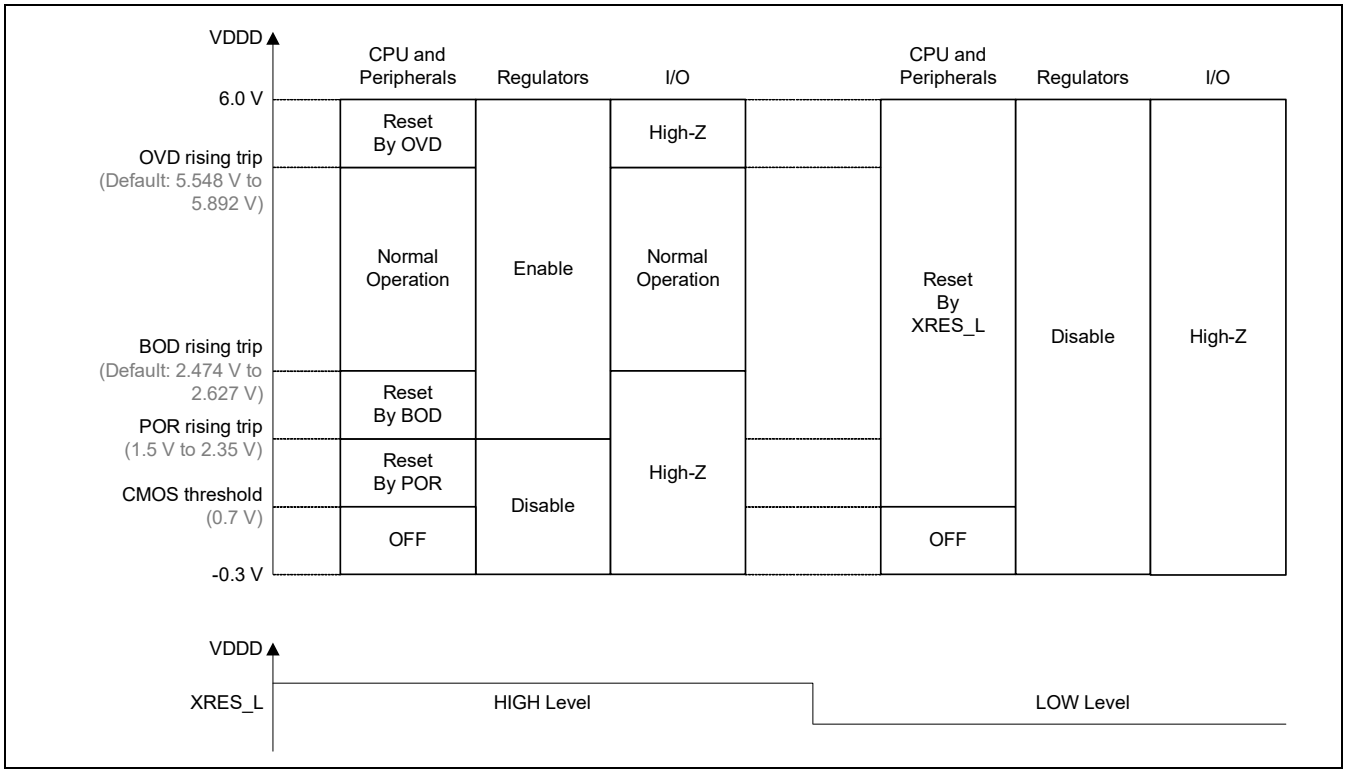


Figure 26-15 Device operations supply range

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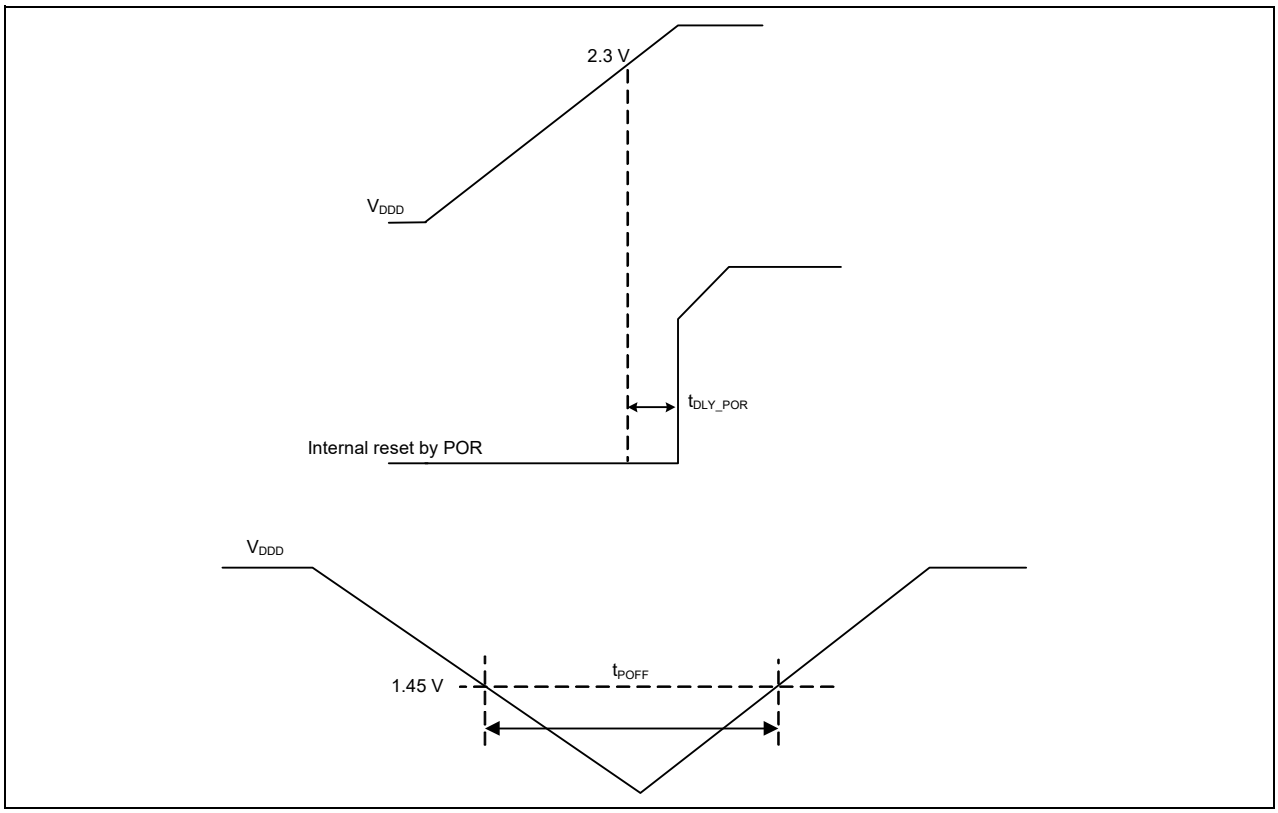


Figure 26-16 POR specifications

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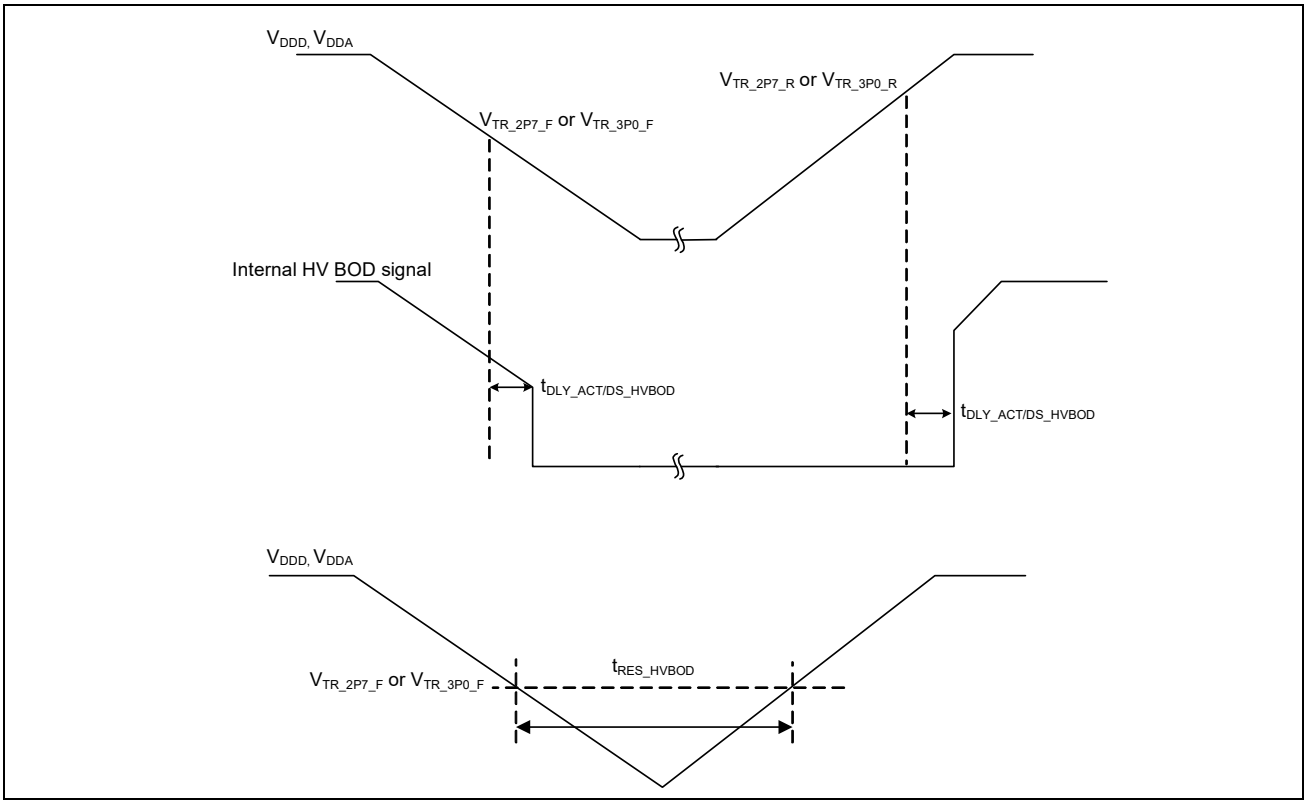


Figure 26-17 High-voltage BOD specifications

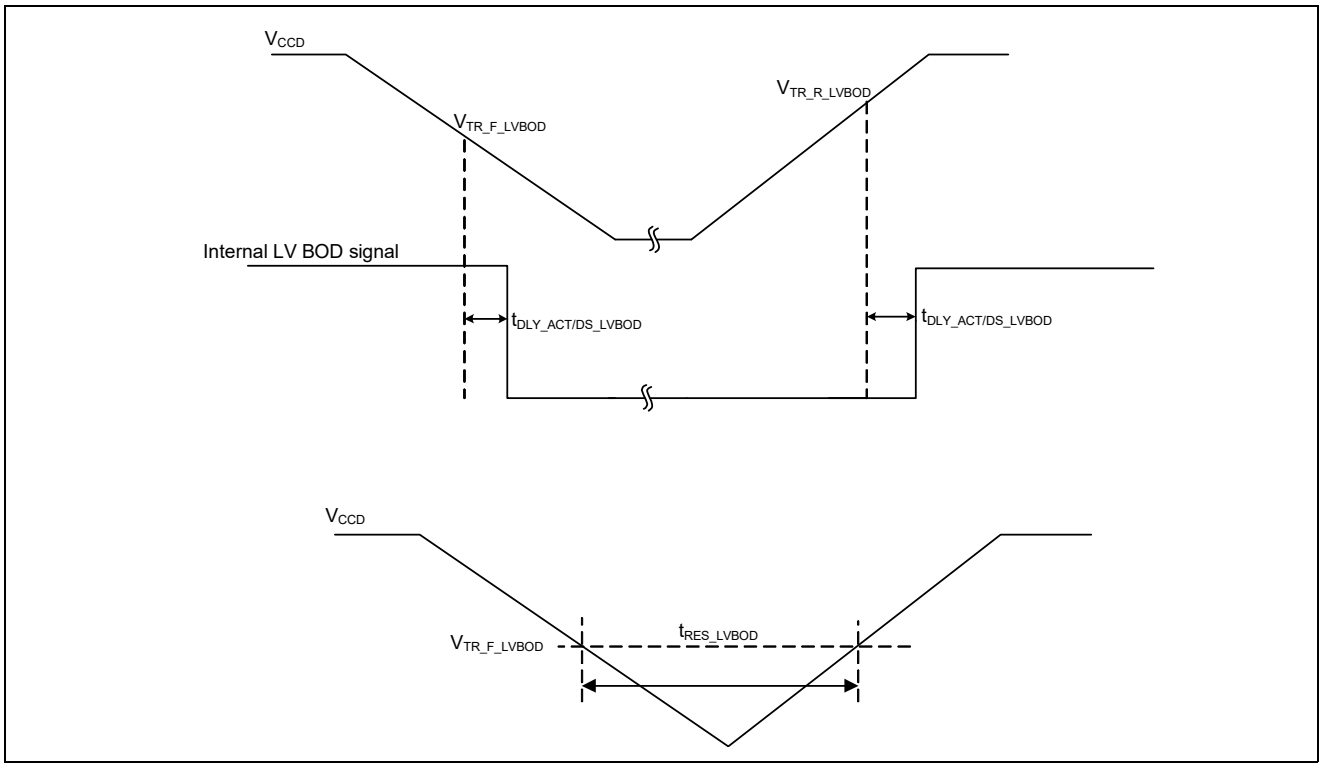


Figure 26-18 Low-Voltage BOD specifications

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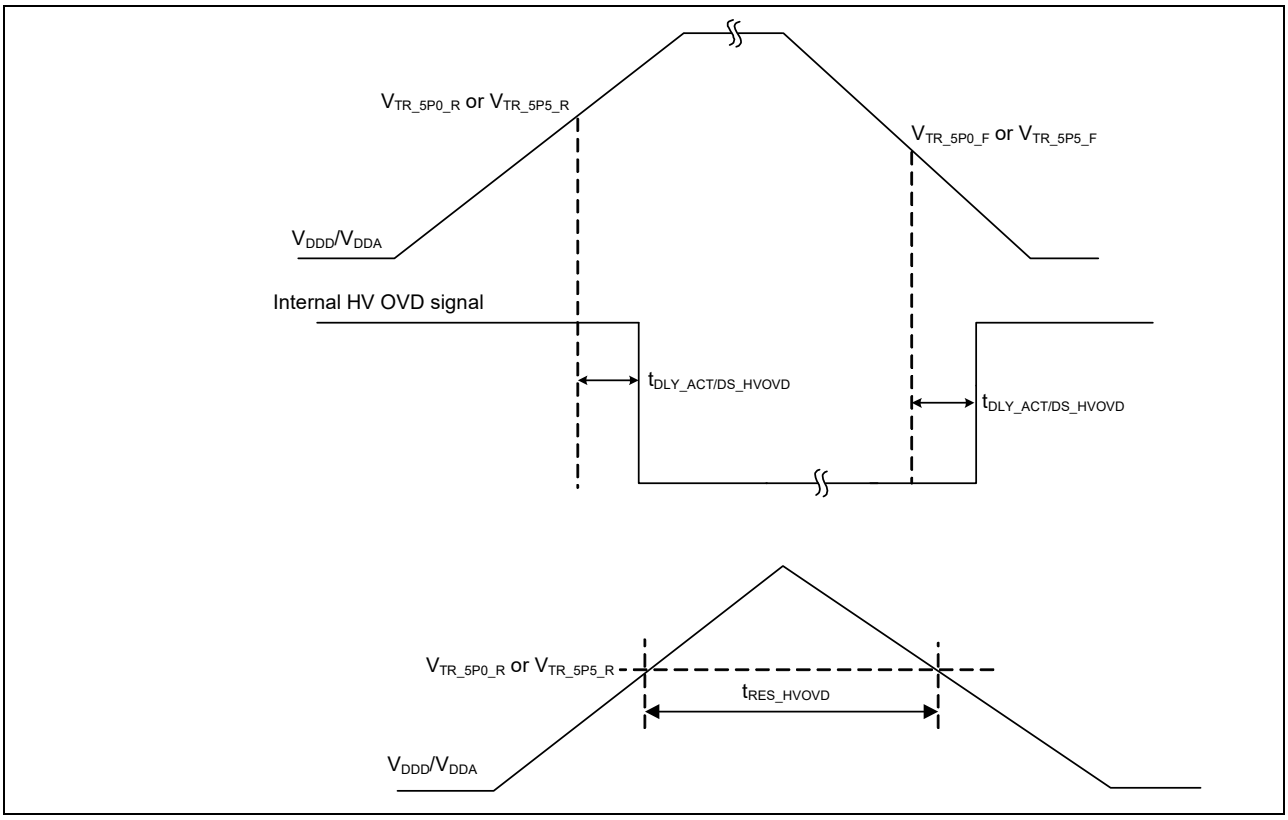


Figure 26-19 High-voltage OVD specifications

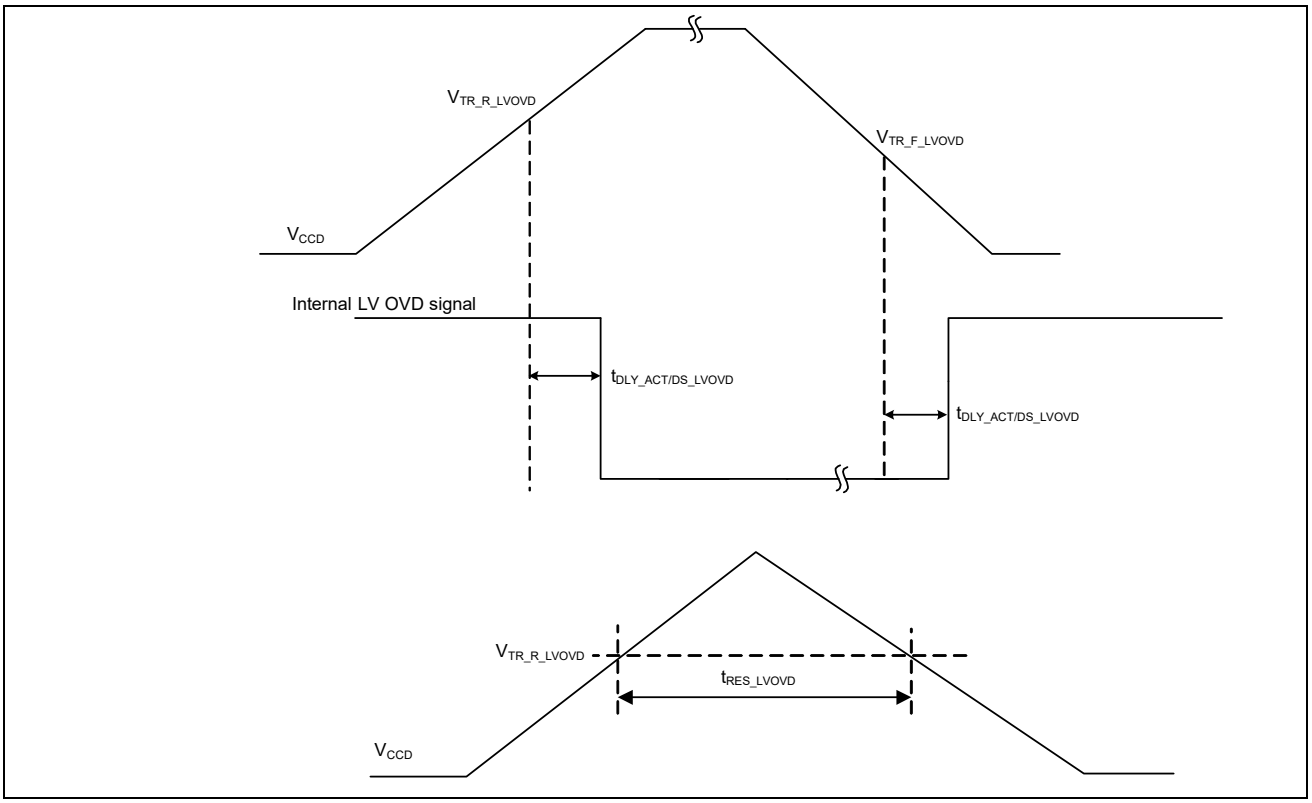


Figure 26-20 Low-voltage OVD specifications

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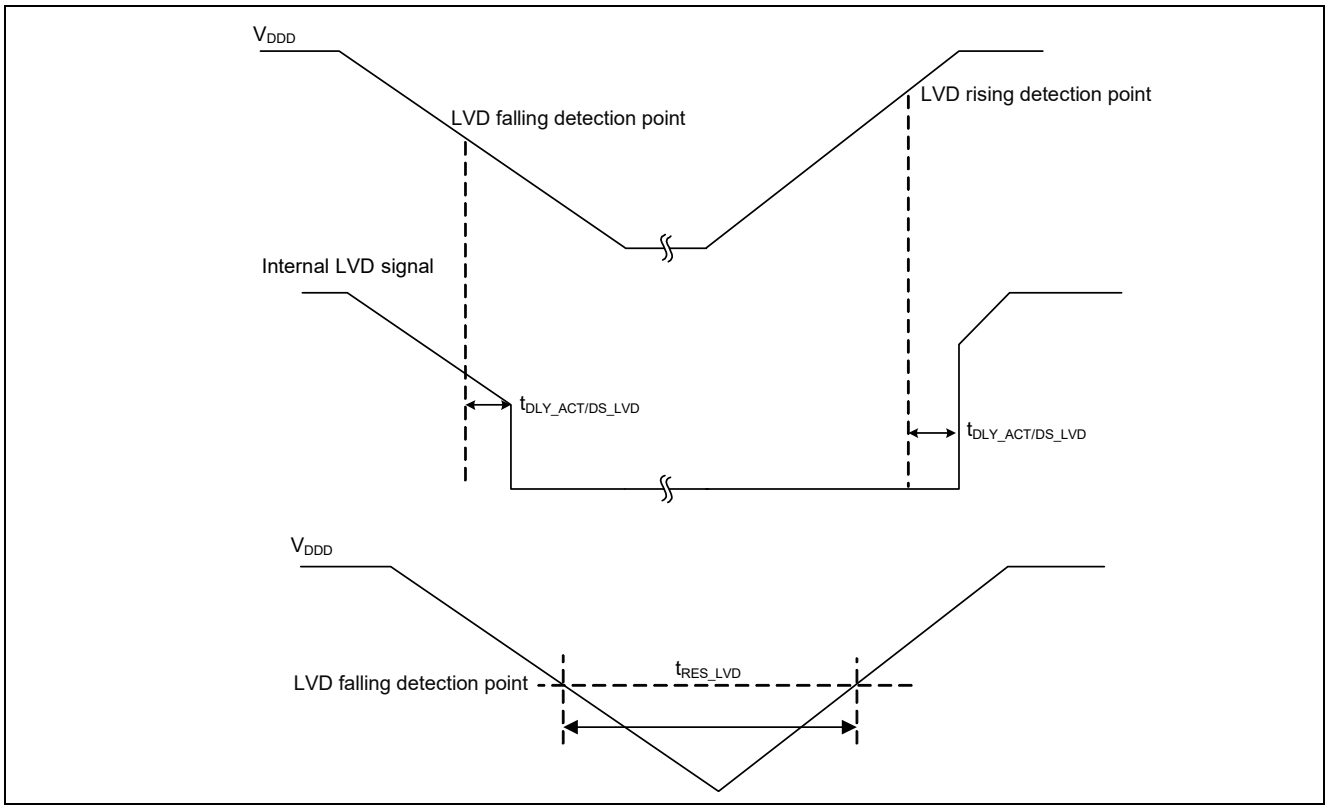


Figure 26-21 LVD specifications

26.10.1 SWD interface specifications

Table 26-18 SWD interface specifications [Conditions: drive_sel<1:0>= 00]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID300	f_{SWDCLK}	SWD clock input frequency	–	–	10	MHz	2.7 V ≤ V_{DDD} ≤ 5.5 V
SID301	t_{SWDI_SETUP}	SWDI setup time	0.25 × T	–	–	ns	T = 1 / f_{SWDCLK}
SID302	t_{SWDI_HOLD}	SWDI hold time	0.25 × T	–	–	ns	T = 1 / f_{SWDCLK}
SID303	t_{SWDO_VALID}	SWDO valid time	–	–	0.5 × T	ns	T = 1 / f_{SWDCLK}
SID304	t_{SWDO_HOLD}	SWDO hold time	1	–	–	ns	T = 1 / f_{SWDCLK}

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26.10.2 JTAG specifications

Table 26-19 JTAG AC specifications [Conditions: drive_sel<1:0>= 00]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID620	t_{JCKH}	TCK HIGH time	30	–	–	ns	30-pF load
SID621	t_{JCKL}	TCK LOW time	30	–	–	ns	30-pF load
SID622	t_{JCP}	TCK clock period	66.7	–	–	ns	30-pF load
SID623	t_{JSU}	TDI/TMS setup time	12	–	–	ns	30-pF load
SID624	t_{JH}	TDI/TMS hold time	12	–	–	ns	30-pF load
SID625	t_{JZX}	TDO High-Z to active	–	–	30	ns	30-pF load
SID626	t_{JXZ}	TDO active to High-Z	–	–	30	ns	30-pF load
SID627	t_{JCO}	TDO clock to output	–	–	30	ns	30-pF load

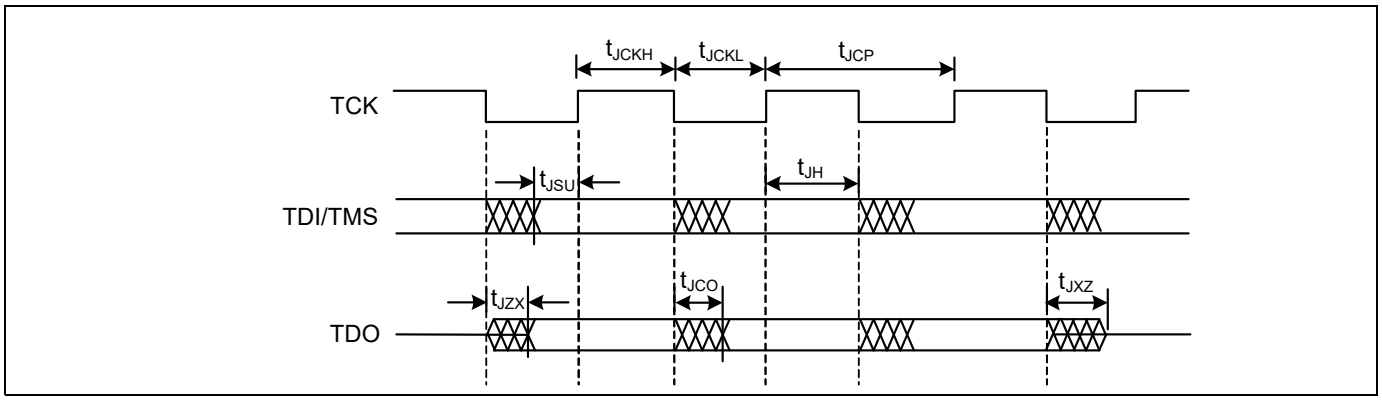


Figure 26-22 JTAG specifications

Table 26-20 Trace specifications [Conditions: drive_sel<1:0>= 00]

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID1412A	C_{TRACE}	Trace capacitive load	–	–	30	pF	
SID1412	t_{TRACE_CYC}	Trace clock period	40	–	–	ns	Trace clock cycle time for 25 MHz
SID1413	t_{TRACE_CLKL}	Trace clock LOW pulse width	2	–	–	ns	Clock low pulse width
SID1414	t_{TRACE_CLKH}	Trace clock HIGH pulse width	2	–	–	ns	Clock high pulse width
SID1415A	t_{TRACE_SETUP}	Trace data setup time	3	–	–	ns	Trace data setup time
SID1416A	t_{TRACE_HOLD}	Trace data hold time	2	–	–	ns	Trace data hold time

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26.11 Clock specifications

All specifications are valid for –40 °C ≤ T_A ≤ 125 °C and for 2.7 V to 5.5 V except where noted.

The basic requirement on the clock frequency dependency of the cores is that the Cortex-M0+ core should run at an integer divider from the Cortex-M4 core clock.

Example combinations are listed in the **Table 26-21**.

Table 26-21 Clock requirements

Core Cortex-M4 Clock (MHz)	Core Cortex-CM0+ Clock (MHz)
160	80
120	60
100	100
80	80

Table 26-22 Root and Intermediate Clocks[57]

Clock	Max Frequency (MHz)	Description
CLK_HF0	160	Root clock for CPUSS, PERI
CLK_HF1	100	Event generator (CLK_REF), Clock output on EXT_CLK pins (when used as output)
CLK_HF2	2	CSV
CLK_FAST	160	Generated by dividing CLK_HF0, intermediate clock for CM4
CLK_SLOW	100	Generated by clock gating CLK_PERI, intermediate clock for CM0+, Crypto, P-DMA, M-DMA
CLK_PERI	100	Generated by clock gating CLK_HF0, intermediate clock for LIN, SCB, PASS, CAN, TCPWM, CXPI, IOSS, CPU trace

Table 26-23 IMO AC specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID310	f_{IMOTOL}	IMO operating frequency	7.92	8	8.08	MHz	
SID311	$t_{STARTIMO}$	IMO startup time	–	–	7.5	µs	Startup time to 90% of final frequency
SID312	I_{IMO_ACT}	IMO current	–	13.5	22	µA	Guaranteed by design

Table 26-24 ILO AC specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID320	$f_{ILOTRIM}$	ILO operating frequency	31.1296	32.768	34.4064	kHz	
SID321	$t_{STARTILO}$	ILO startup time	–	8	12	µs	Startup time to 90% of final frequency
SID323	I_{ILO}	ILO current	–	500	2800	nA	Guaranteed by design

Note
57.Intermediate clocks that are not listed have the same limitations as that of their parent clock.

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Table 26-25 ECO specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID330	f_{ECO}	Crystal frequency range	3.988	–	33.34	MHz	
SID332	R_{FDBK}	Feedback resistor value. Min: RTRIM = 3; Max: RTRIM = 0 with 100 kΩ step size on RTRIM	100	–	400	kΩ	Guaranteed by design
SID333	I_{ECO3}	ECO current at T_J = 150 °C	–	–	2000	µA	Maximum operation current with a 33-MHz crystal, max 18-pF load
SID334	t_{START_4M}	4-MHz ECO startup time[58]	–	–	10	ms	Time from set CLK_ECO_-CONFIG.ECO_EN to 1 until CLK_ECO_STATUS.ECO_READY is set to 1 (See Clock Timing Diagrams)
SID335	t_{START_33M}	33-MHz ECO startup time[58]	–	–	1	ms	Time from set CLK_ECO_-CONFIG.ECO_EN to 1 until CLK_ECO_STATUS.ECO_READY is set to 1 (See Clock Timing Diagrams)

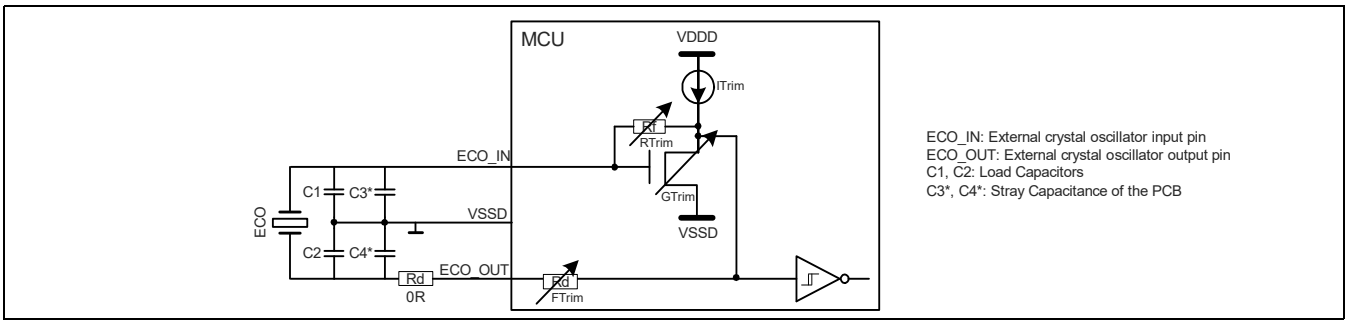


Figure 26-23 ECO connection scheme[59]

Table 26-26 PLL specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID340	PLL_LOCK	Time to achieve PLL lock	–	–	35	µs	
SID341	f_{PLL_OUT}	Output frequency from PLL block	11	–	160	MHz	
SID342	PLL_LJIT1	Long term jitter	–0.25	–	0.25	ns	For 125 ns f_{PLL_VCO}: 320 MHz f_{PLL_OUT}: 40 MHz to 160 MHz f_{PLL_PFD}: 8 MHz f_{PLL_IN}: ECO
SID343	PLL_LJIT2	Long term jitter	–0.5	–	0.5	ns	For 500 ns f_{PLL_VCO}: 320 MHz f_{PLL_OUT}: 40 MHz to 160 MHz f_{PLL_PFD}: 8 MHz f_{PLL_IN}: ECO

Notes
58. Mainly depends on the external crystal.
59. See the family-specific Architecture TRM for more information on crystal requirements (002-19314, TRAVEO™ T2G AUTOMOTIVE BODY CONTROLLER ENTRY FAMILY ARCHITECTURE TECHNICAL REFERENCE MANUAL (TRM)).

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Table 26-26 PLL specifications *(continued)*

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID344	PLL_LJIT3	Long term jitter	–0.5	–	0.5	ns	For 1000 ns f_{PLL_VCO}: 320 MHz f_{PLL_OUT}: 40 MHz to 160 MHz f_{PLL_PFD}: 8 MHz f_{PLL_IN}: ECO
SID345A	PLL_LJIT5	Long term jitter	–0.75	–	0.75	ns	For 10000 ns f_{PLL_VCO}: 320 MHz f_{PLL_OUT}: 40 MHz to 160 MHz f_{PLL_PFD}: 8 MHz f_{PLL_IN}: ECO
SID346	f_{PLL_IN}	PLL input frequency	3.988	–	33.34	MHz	
SID347	I_{PLL_160M1}	PLL operating current (f_{OUT} = 160 MHz)	–	740	1110	µA	f_{IN} = 4 MHz, f_{PFD} = 4 MHz, f_{VCO} = 320 MHz, f_{OUT} = 160 MHz
SID347A	I_{PLL_160M2}	PLL operating current (f_{OUT} = 160 MHz)	–	750	1125	µA	f_{IN} = 8 MHz, f_{PFD} = 8 MHz, f_{VCO} = 320 MHz, f_{OUT} = 160 MHz
SID347B	I_{PLL_160M3}	PLL operating current (f_{OUT} = 160 MHz)	–	750	1125	µA	f_{IN} = 16 MHz, f_{PFD} = 8 MHz, f_{VCO} = 320 MHz, f_{OUT} = 160 MHz
SID339	I_{PLL_100M1}	PLL operating current (f_{OUT} = 100 MHz)	–	520	780	µA	f_{IN} = 4 MHz, f_{PFD} = 4 MHz, f_{VCO} = 200 MHz, f_{OUT} = 100 MHz
SID339A	I_{PLL_100M2}	PLL operating current (f_{OUT} = 100 MHz)	–	530	795	µA	f_{IN} = 8 MHz, f_{PFD} = 8 MHz, f_{VCO} = 200 MHz, f_{OUT} = 100 MHz
SID339B	I_{PLL_100M3}	PLL operating current (f_{OUT} = 100 MHz)	–	530	795	µA	f_{IN} = 16 MHz, f_{PFD} = 8 MHz, f_{VCO} = 200 MHz, f_{OUT} = 100 MHz
SID348	I_{PLL_80M1}	PLL operating current (f_{OUT} = 80 MHz)	–	520	780	µA	f_{IN} = 4 MHz, f_{PFD} = 4 MHz, f_{VCO} = 240 MHz, f_{OUT} = 80 MHz
SID348A	I_{PLL_80M2}	PLL operating current (f_{OUT} = 80 MHz)	–	530	795	µA	f_{IN} = 8 MHz, f_{PFD} = 8 MHz, f_{VCO} = 240 MHz, f_{OUT} = 80 MHz
SID348B	I_{PLL_80M3}	PLL operating current (f_{OUT} = 80 MHz)	–	530	795	µA	f_{IN} = 16 MHz, f_{PFD} = 8 MHz, f_{VCO} = 240 MHz, f_{OUT} = 80 MHz
SID348C	f_{PLL_VCO}	VCO frequency	170	–	400	MHz	
SID349C	f_{PLL_PFD}	PFD frequency	3.988	–	8	MHz	

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Table 26-27 FLL specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID350	t_{FLL_WAKE}	FLL wake up time	–	–	5	µs	Wakeup with < 10 °C temperature change while in DeepSleep. f_{FLL_IN} = 8 MHz, f_{FLL_OUT} = 100 MHz, Time from stable reference clock until FLL frequency is within 5% of final value
SID351	f_{FLL_OUT}	Output frequency from FLL block	24	–	100	MHz	Output range of FLL divided-by-2 output
SID352	FLL_CJIT	FLL frequency accuracy	–1	–	1	%	This is added to the error of the source
SID353	f_{FLL_IN}	Input frequency	0.25	–	80	MHz	
SID354	I_{FLL}	FLL operating current	–	250	360	µA	Reference clock: IMO, CCO frequency: 200 MHz, FLL frequency: 100 MHz, guaranteed by design

Table 26-28 WCO specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID360	f_{WCO}	Watch Crystal frequency	–	32.768	–	kHz	Maximum drive level: 0.5 µW
SID361	WCO_DC	WCO duty cycle	10	–	90	%	
SID362	t_{START_WCO}	WCO start up time[60]	–	–	1000	ms	For Grade-S devices Time from set CTL.WCO_EN to 1 until STATUS.WCO_OK is set to 1. (See Clock Timing Diagrams)
SID362E	t_{START_WCOE}	WCO start up time[60]	–	–	1400	ms	For Grade-E devices Time from set CTL.WCO_EN to 1 until STATUS.WCO_OK is set to 1. (See Clock Timing Diagrams)
SID363	I_{WCO}	WCO current	–	1.4	–	µA	

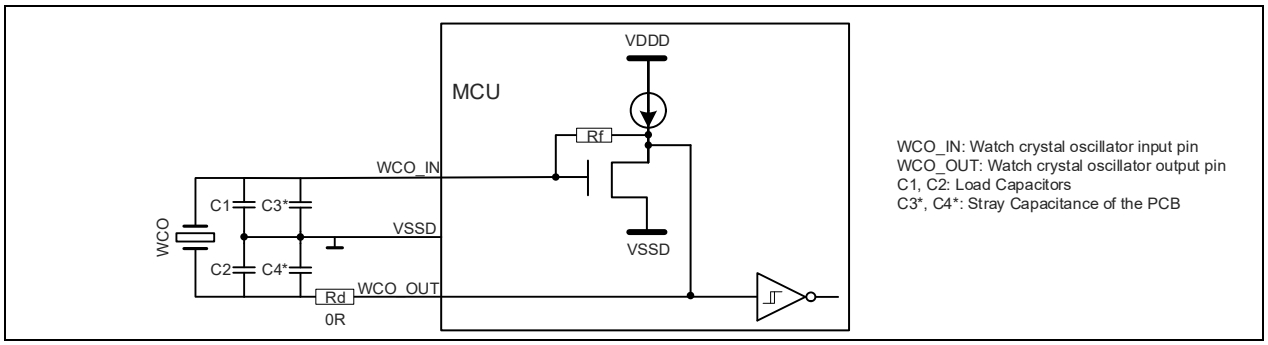


Figure 26-24 WCO connection scheme[61]

Notes
60. Mainly depends on the external crystal.
61. See the family-specific Architecture TRM for more information on crystal requirements (002-19314, TRAVEO™ T2G Automotive Body Controller Entry Family Architecture Technical Reference Manual (TRM)).

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Table 26-29 External clock input specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID366	f_{EXT}	External clock input frequency	0.25	–	80	MHz	For EXT_CLK pin (all input level settings: CMOS, TTL, Automotive)
SID367	EXT_DC	External clock duty cycle	45	–	55	%	

26.11.1 Clock timing diagrams

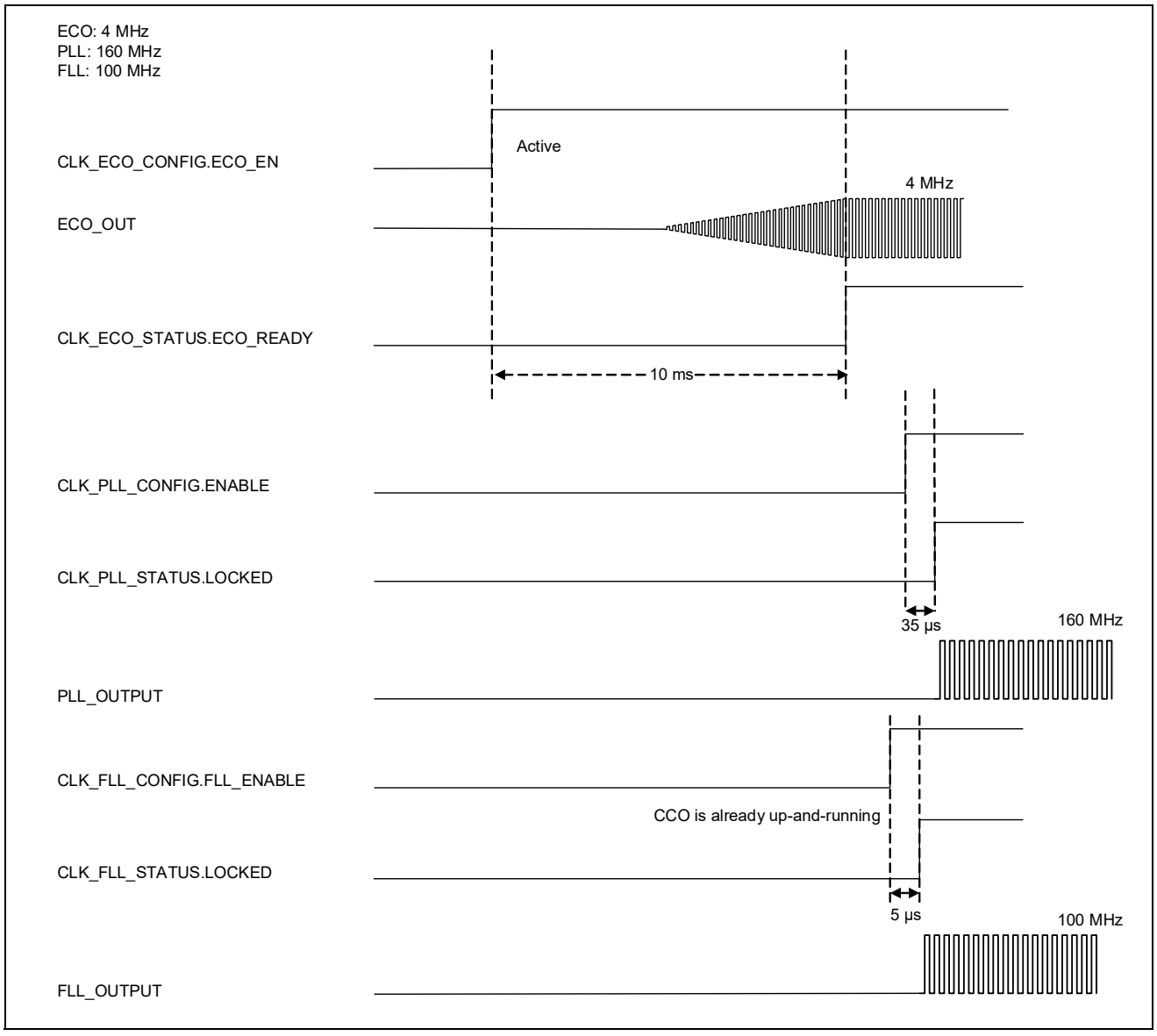


Figure 26-25 ECO to PLL or FLL diagram

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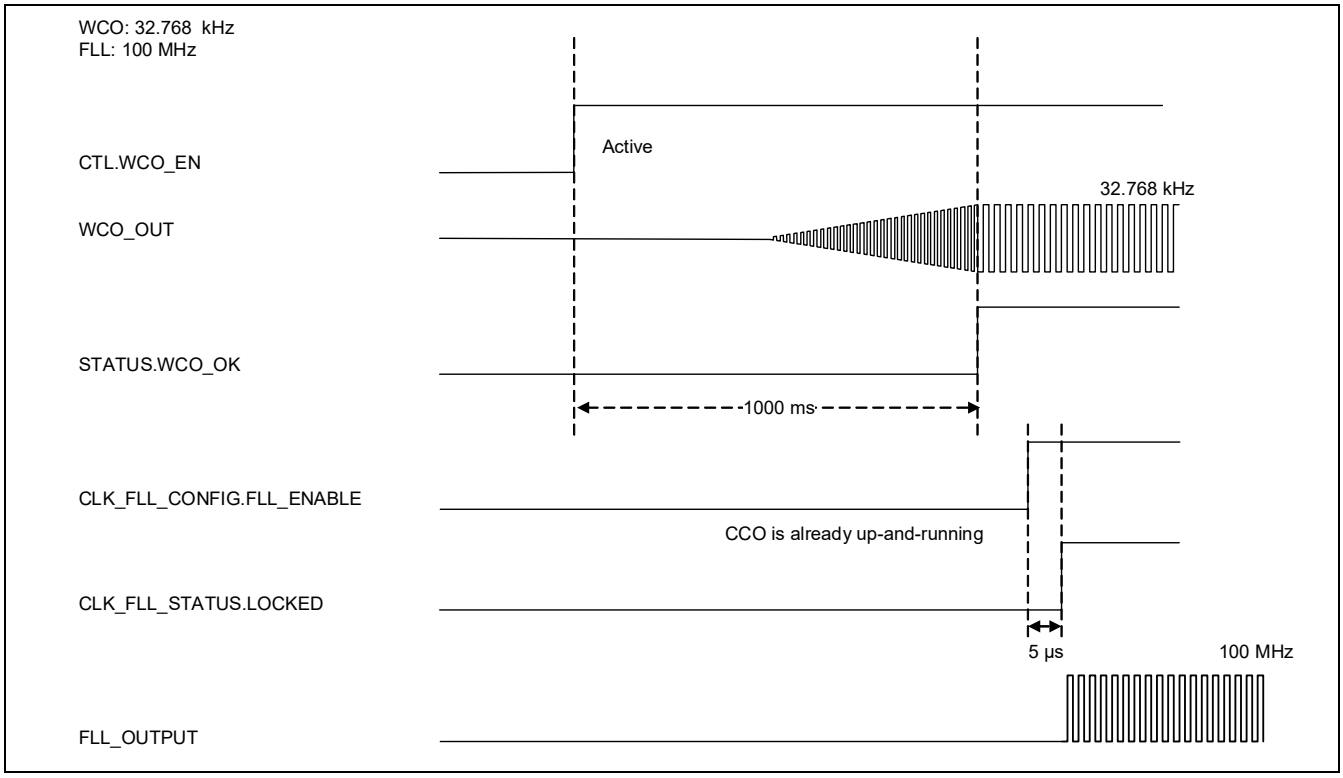


Figure 26-26 WCO to FLL diagram

Table 26-30 MCWDT timeout specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID410	t_{MCWDT1}	Minimum MCWDT timeout	58.12	–	–	µs	When using the ILO (32.768 kHz + 5%) and 16-bit MCWDT counter Guaranteed by design
SID411	t_{MCWDT2}	Maximum MCWDT timeout	–	–	2.11	s	When using the ILO (32.768 kHz – 5%) and 16-bit MCWDT counter Guaranteed by design

Table 26-31 WDT timeout specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID412	t_{WDT1}	Minimum WDT timeout	58.12	–	–	µs	When using the ILO (32.768 kHz + 5%) and 32-bit WDT counter Guaranteed by design
SID413	t_{WDT2}	Maximum WDT timeout	–	–	38.33	h	When using the ILO (32.768 kHz – 5%) and 32-bit WDT counter Guaranteed by design
SID414	t_{WDT3}	Default WDT timeout	–	1000	–	ms	When using the ILO and 32-bit WDT counter at 0x8000 (default value), guaranteed by design

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27 Ordering Information

The CYT2B9 microcontroller part numbers and features are listed in **Table 27-1**. The Arm® TAP JTAG ID is 0x6BA0 0477.

Table 27-1 CYT2B9 Ordering Information

Device Code	Ordering code[62]	Package	Code-flash (KB)	Work-flash (KB)	RAM (KB)	ADC Channels	SCB Channels	LIN Channels	CAN FD Channels	CXPI Channels	eSHE/ HSM	Temperature Grade	JTAG ID CODE
CYT2B93BAS[63]	CYT2B93BACQ0AZSGS	64-LQFP	2112[64]	128[65]	256	27	5	7	5	2	eSHE	S[66]	0x1E6C9069[68]
CYT2B93BAE[63]	CYT2B93BACQ0AZEGS	64-LQFP	2112	128	256	27	5	7	5	2	eSHE	E[67]	0x1E6C9069
CYT2B93CAS	CYT2B93CACQ0AZSGS	64-LQFP	2112	128	256	27	5	7	5	2	HSM	S	0x1E6CA069
CYT2B93CAE	CYT2B93CACQ0AZEGS	64-LQFP	2112	128	256	27	5	7	5	2	HSM	E	0x1E6CA069
CYT2B94BAS[63]	CYT2B94BACQ0AZSGS	80-LQFP	2112	128	256	34	6	9	7	3	eSHE	S	0x1E6D1069
CYT2B94BAE[63]	CYT2B94BACQ0AZEGS	80-LQFP	2112	128	256	34	6	9	7	3	eSHE	E	0x1E6D1069
CYT2B94CAS	CYT2B94CACQ0AZSGS	80-LQFP	2112	128	256	34	6	9	7	3	HSM	S	0x1E6D2069
CYT2B94CAE	CYT2B94CACQ0AZEGS	80-LQFP	2112	128	256	34	6	9	7	3	HSM	E	0x1E6D2069
CYT2B95BAS[63]	CYT2B95BACQ0AZSGS	100-LQFP	2112	128	256	39	8	9	8	4	eSHE	S	0x1E6D9069
CYT2B95BAE[63]	CYT2B95BACQ0AZEGS	100-LQFP	2112	128	256	39	8	9	8	4	eSHE	E	0x1E6D9069
CYT2B95CAS	CYT2B95CACQ0AZSGS	100-LQFP	2112	128	256	39	8	9	8	4	HSM	S	0x1E6DA069
CYT2B95CAE	CYT2B95CACQ0AZEGS	100-LQFP	2112	128	256	39	8	9	8	4	HSM	E	0x1E6DA069
CYT2B97BAS[63]	CYT2B97BACQ0AZSGS	144-LQFP	2112	128	256	54	8	12	8	4	eSHE	S	0x1E6E1069
CYT2B97BAE[63]	CYT2B97BACQ0AZEGS	144-LQFP	2112	128	256	54	8	12	8	4	eSHE	E	0x1E6E1069
CYT2B97CAS	CYT2B97CACQ0AZSGS	144-LQFP	2112	128	256	54	8	12	8	4	HSM	S	0x1E6E2069
CYT2B97CAE	CYT2B97CACQ0AZEGS	144-LQFP	2112	128	256	54	8	12	8	4	HSM	E	0x1E6E2069
CYT2B98BAS[63]	CYT2B98BACQ0AZSGS	176-LQFP	2112	128	256	64	8	12	8	4	eSHE	S	0x1E6E9069
CYT2B98BAE[63]	CYT2B98BACQ0AZEGS	176-LQFP	2112	128	256	64	8	12	8	4	eSHE	E	0x1E6E9069
CYT2B98CAS	CYT2B98CACQ0AZSGS	176-LQFP	2112	128	256	64	8	12	8	4	HSM	S	0x1E6EA069
CYT2B98CAE	CYT2B98CACQ0AZEGS	176-LQFP	2112	128	256	64	8	12	8	4	HSM	E	0x1E6EA069

Notes
62. Supported shipment types are “Tray” (default) and “Tape and Reel”. Add the character ‘T’ at the end to get the ordering code for “Tape and Reel” shipment type.
63. 3DES/SHA-1/SHA-2/SHA-3/CRC/Vector unit for asymmetric cryptography features are not supported.
64. Code-flash size 2112 KB = 32 KB × 62 (Large Sectors) + 8 KB × 16 (Small Sectors).
65. Work-flash size 128 KB = 2 KB × 48 (Large Sectors) + 128 B × 256 (Small Sectors).
66. S-grade Temperature (–40 °C to 105 °C).
67. E-grade Temperature (–40 °C to 125 °C).
68. JTAG ID CODE bits 12 through 27, represents the Silicon ID of the device.

27.1 Part number nomenclature

Table 27-2 Device code nomenclature

Field	Description	Value	Meaning
CY	Cypress Prefix	CY	
T	Category	T	TRAVEO™
2	Family	2	TRAVEO™ T2G (Core M4)
B	Application	B	Body
D	Code-flash/Work-flash/SRAM quantity	9	2112 KB / 128 KB / 256 KB
P	Packages	3	64-LQFP
		4	80-LQFP
		5	100-LQFP
		7	144-LQFP
		8	176-LQFP
H	Hardware Option	B	eSHE – on, HSM – off, RSA - 2K
		C	eSHE – on, HSM – on, RSA - 2K
I	Marketing Option	A	No options
C	Temperature Grade	S	S-grade (–40 °C to 105 °C)
		E	E-grade (–40 °C to 125 °C)

Table 27-3 Ordering code nomenclature

Field	Description	Value	Meaning
CY	Cypress Prefix	CY	
T	Category	T	TRAVEO™
2	Family Name	2	TRAVEO™ T2G (Core M4)
B	Application	B	Body
D	Code-flash/Work-flash/SRAM quantity	9	2112 KB / 128 KB / 256 KB
P	Packages	3	64-LQFP
		4	80-LQFP
		5	100-LQFP
		7	144-LQFP
		8	176-LQFP
H	Hardware Option	B	eSHE – on, HSM – off, RSA - 2K
		C	eSHE – on, HSM – on, RSA - 2K
I	Marketing Option	A	No options
R	Revision	A	First revision
		B	Second revision
		C	Third revision
F	Fab Location	Q	UMC (Fab 12i) Singapore
X	Reserved	0	Reserved
K	Package Code	AZ	LQFP
C	Temperature Grade	S	S-grade (–40 °C to 105 °C)
		E	E-grade (–40 °C to 125 °C)
Q	Quality Grade	ES	Engineering samples
		GS	Standard grade of automotive
S	Shipment Type	Blank	Tray shipment
		T	Tape and reel shipment

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28 Packaging

CYT2B9 is offered in the packages listed in the **Table 28-1**.

Table 28-1 Package information

Package	Dimensions	Contact/Lead Pitch	Coefficient of Thermal Expansion	I/O Pins
176-LQFP	24 × 24 × 1.7 mm (max)	0.5 mm	a1[69] = 8.5 ppm/°C, a2[70] = 33.8 ppm/°C	152
144-LQFP	20 × 20 × 1.7 mm (max)	0.5 mm	a1[69] = 8.5 ppm/°C, a2[70] = 33.7 ppm/°C	122
100-LQFP	14 × 14 × 1.7 mm (max)	0.5 mm	a1[69] = 8.5 ppm/°C, a2[70] = 33.6 ppm/°C	78
80-LQFP	12 × 12 × 1.7 mm (max)	0.5 mm	a1[69] = 8.5 ppm/°C, a2[70] = 33.5 ppm/°C	63
64-LQFP	10 × 10 × 1.7 mm (max)	0.5 mm	a1[69] = 8.5 ppm/°C, a2[70] = 33.2 ppm/°C	49

Table 28-2 Package characteristics

Parameter	Description	Conditions	Min	Typ	Max	Units
T_A	Operating ambient temperature	S-grade	–40	–	105	°C
T_A	Operating ambient temperature	E-grade	–40	–	125	°C
T_J	Operating junction temperature	–	–	–	150	°C
$R_{\theta JA}$	Package thermal resistance, junction to ambient θ_{JA}[71, 72]	64 LQFP	–	–	36.5	°C/Watt
		80 LQFP	–	–	31.7	°C/Watt
		100 LQFP	–	–	28.6	°C/Watt
		144 LQFP	–	–	25.0	°C/Watt
		176 LQFP	–	–	24.3	°C/Watt
$R_{\theta JB}$	Package θ_{JB}	64 LQFP	–	–	31.5	°C/Watt
		80 LQFP	–	–	26.0	°C/Watt
		100 LQFP	–	–	20.9	°C/Watt
		144 LQFP	–	–	20.0	°C/Watt
		176 LQFP	–	–	19.6	°C/Watt
$R_{\theta JC}$	Package thermal resistance, junction to case θ_{JC}	64 LQFP	–	–	7.4	°C/Watt
		80 LQFP	–	–	6.2	°C/Watt
		100 LQFP	–	–	5.3	°C/Watt
		144 LQFP	–	–	4.0	°C/Watt
		176 LQFP	–	–	3.6	°C/Watt

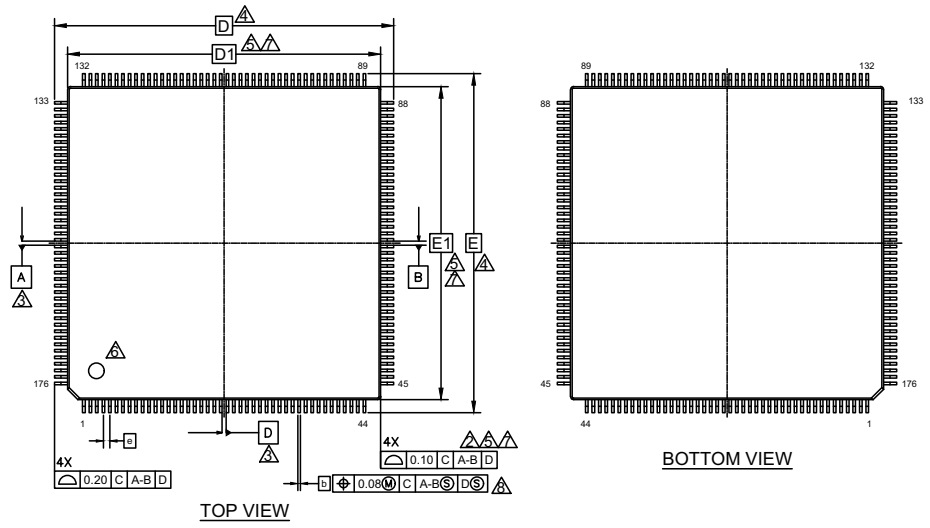
Notes
69.a1 = CTE (Coefficient of Thermal Expansion) value below T_g (ppm/°C) (T_g is glass transition temperature which is 131°C).
70.a2 = CTE value above T_g (ppm/°C).
71.Board condition complies to JESD51-7 (4 Layers).
72.Maximum value °C/Watt shown is for T_A = 125 °C.

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Table 28-3 Solder Reflow Peak Temperature, Package Moisture Sensitivity Level (MSL), IPC/JEDEC J-STD-2

Package	Maximum Peak Temperature (°C)	Maximum Time at Peak Temperature (seconds)	MSL
176-LQFP	260	30	3
144-LQFP	260	30	3
100-LQFP	260	30	3
80-LQFP	260	30	3
64-LQFP	260	30	3

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SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.17	0.22	0.27
c	0.09	—	0.20
D	26.00 BSC		
D1	24.00 BSC		
e	0.50 BSC		
E	26.00 BSC		
E1	24.00 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		
θ	0°	—	8°

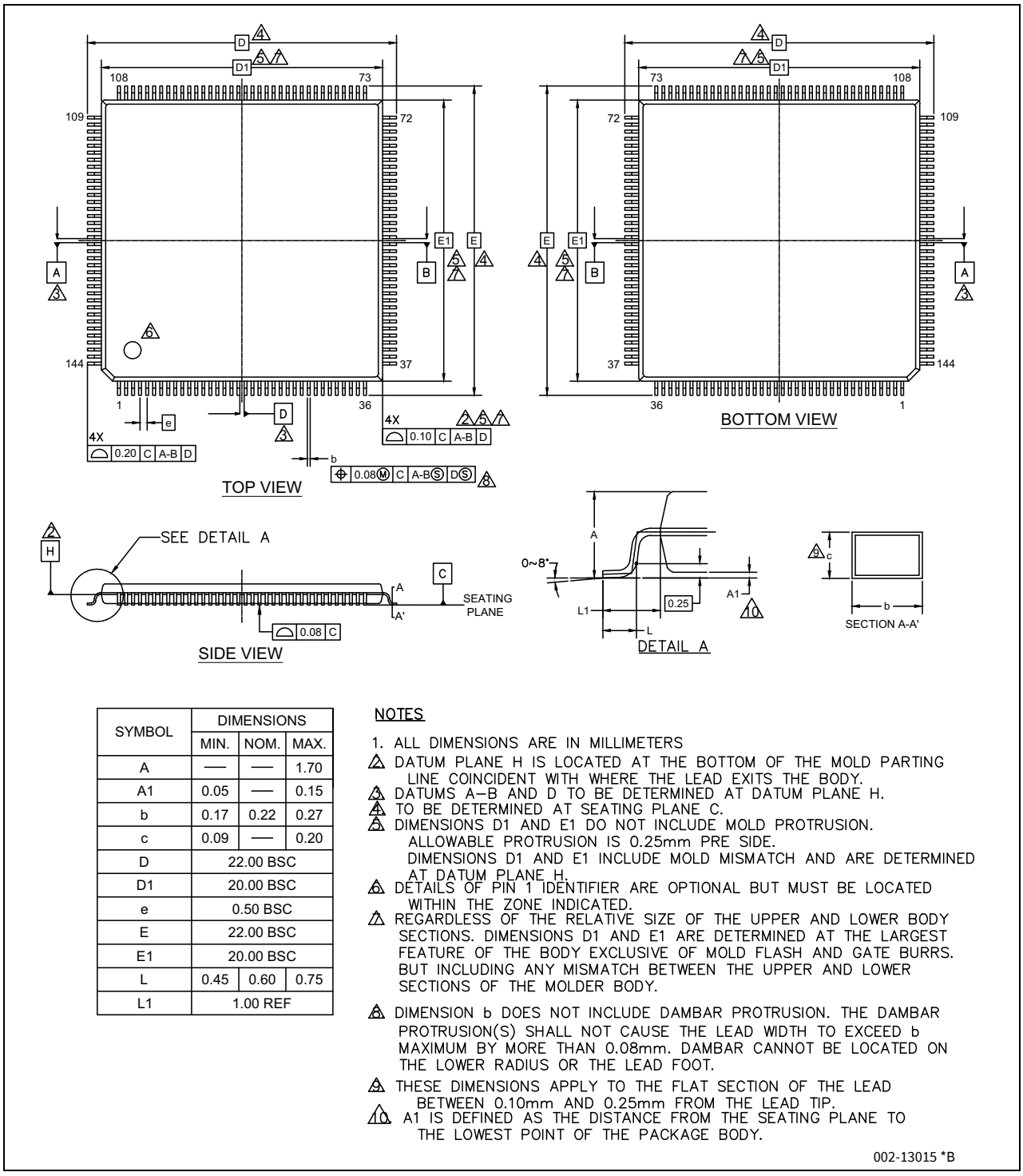
NOTES

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A–B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-15150 *A

Figure 28-1 Package Outline – 176-LQFP

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SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.17	0.22	0.27
c	0.09	—	0.20
D	22.00 BSC		
D1	20.00 BSC		
e	0.50 BSC		
E	22.00 BSC		
E1	20.00 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		

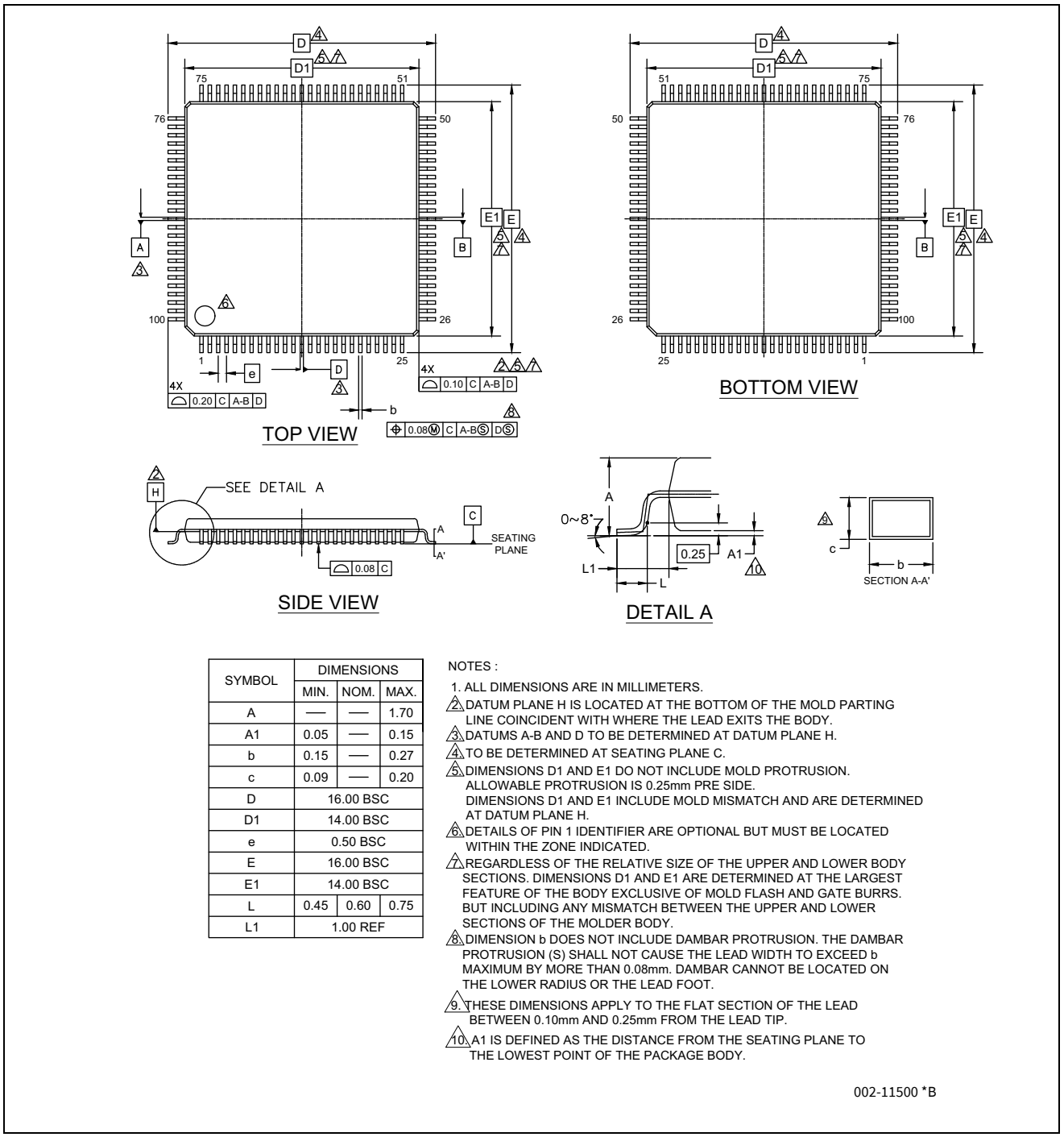
NOTES

1. ALL DIMENSIONS ARE IN MILLIMETERS
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A–B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-13015 *B

Figure 28-2 Package Outline – 144-LQFP

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SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.15	—	0.27
c	0.09	—	0.20
D	16.00 BSC		
D1	14.00 BSC		
e	0.50 BSC		
E	16.00 BSC		
E1	14.00 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		

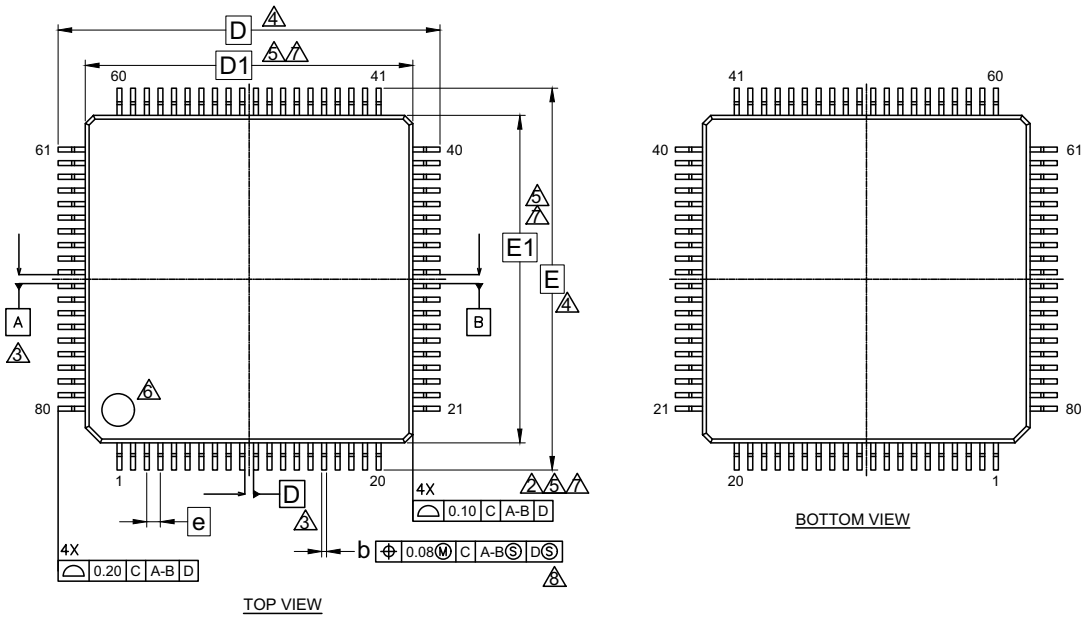
NOTES :

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-11500 *B

Figure 28-3 Package outline – 100-LQFP

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SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.15	—	0.27
c	0.09	—	0.20
D	14.00 BSC.		
D1	12.00 BSC.		
e	0.50 BSC		
E	14.00 BSC.		
E1	12.00 BSC.		
L	0.45	0.60	0.75
L1	1.00 REF		

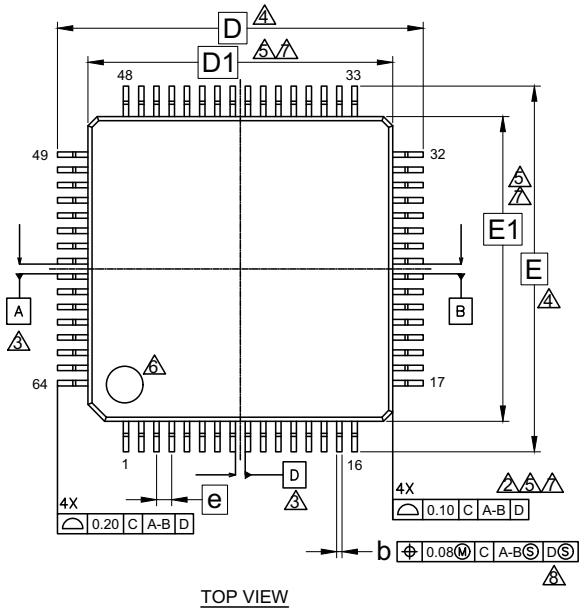
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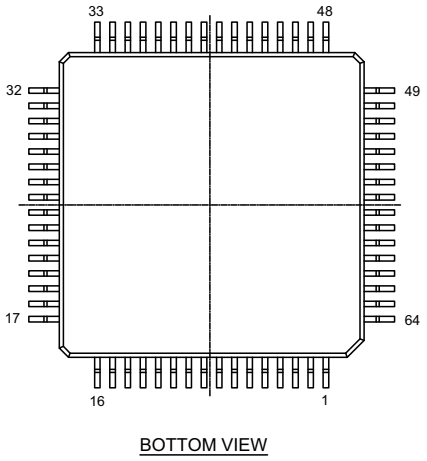
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm)
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A–B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

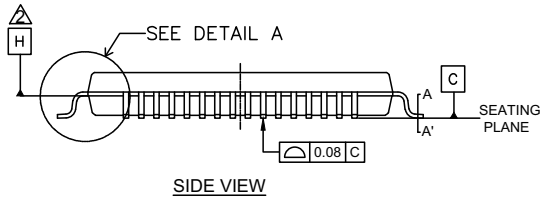
002-11501 *A

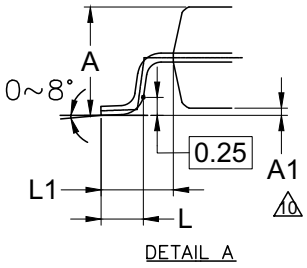
Figure 28-4 Package outline – 80-LQFP

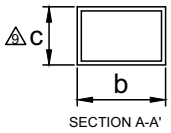
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SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.00	—	0.20
b	0.15	—	0.27
c	0.09	—	0.20
D	12.00 BSC.		
D1	10.00 BSC.		
e	0.50 BSC		
E	12.00 BSC.		
E1	10.00 BSC.		
L	0.45	0.60	0.75
L1	1.00 REF		

NOTES

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A–B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-11499 *A

Figure 28-5 Package Outline – 64-LQFP

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29 Appendix

29.1 Bootloading or end-of-line programming

- Triggered at device startup if a trigger condition is applied
- Either CAN or LIN communication may be used
- Bootloader polls for the communication on CAN or LIN at separate time frames, until the overall 300-second timeout is reached
- If a boot loader command is received on either communication interface, the polling stops and bootloader starts using this interface

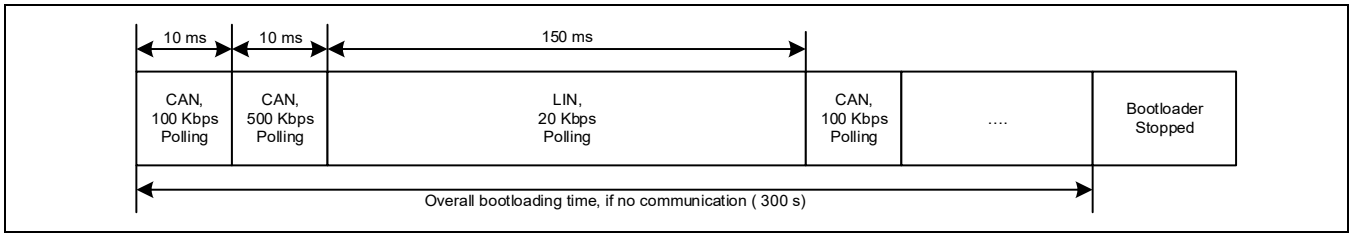


Figure 29-1 Bootloading sequence

Table 29-1 CAN interface details

Sl. No.	CAN Interface	Configuration
1	CAN Mode	Classic CAN
2	CAN Instance	CAN0, Channel#1
3	CAN TX	P0.2 / CAN0_1_TX
4	CAN RX	P0.3 / CAN0_1_RX
5	CAN Transceiver NSTB / EN (Low)	P23.3 (optional)
6	CAN Transceiver EN / EN (High)	P2.1 (optional)
7	CAN RX Message ID	0x1A1
8	CAN TX Message ID	0x1B1
9	Baud	100 or 500 kbps alternating

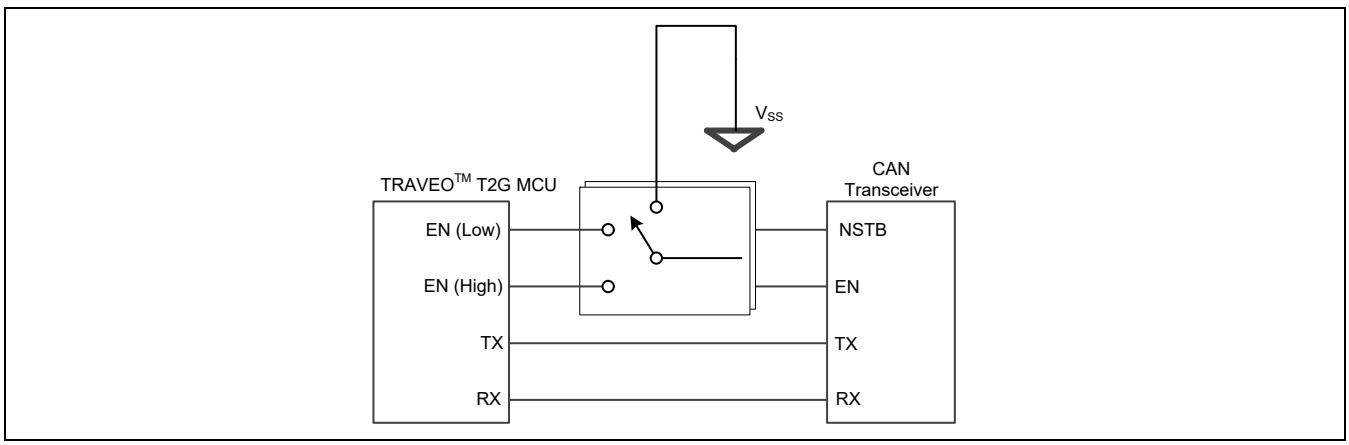


Figure 29-2 MCU to CAN transceiver connections

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Table 29-2 LIN Interface Details

Sl. No.	LIN Interface	Configuration
1	LIN Type	LIN0, Channel#1
2	LIN Mode	Slave
3	LIN Checksum Type	Classic
4	LIN TX	P0.1 / LIN1_TX
5	LIN RX	P0.0 / LIN1_RX
6	LIN EN / EN (High)	P2.1 (optional)
7	LIN EN (Low)	P23.3 (optional)
8	LIN TX PID	0x46
9	LIN RX PID	0x45
10	Baud	20 or 115.2 kbps
11	Break Field Length	11
12	Break Delimiter Length	1 bit

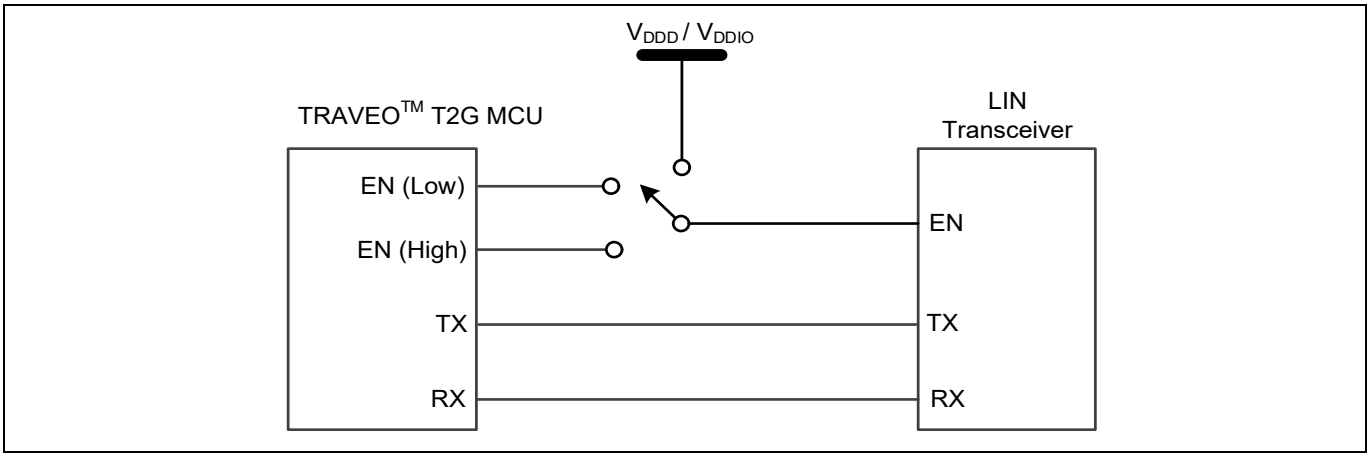


Figure 29-3 MCU to LIN transceiver connections

29.2 External IP revisions

Table 29-3 IP revisions

Module	IP	Revision	Vendor
CAN FD	mxttcanfd	M_TTCAN IP revision: Rev.3.2.3	Bosch
Arm® Cortex®-M0+	armcm0p	Cortex®-M0+-r0p1	Arm®
Arm® Cortex®-M4	armcm4	Cortex®-M4-r0p1	Arm®
Arm® Coresight	armcoresighttk	CoreSight-SoC-TM100-r3p2	Arm®

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30 Acronyms

Table 30-1 Acronyms used in the Document

Acronym	Description
A/D	Analog to Digital
ABS	Absolute
ADC	Analog to Digital converter
AES	Advanced encryption standard
AHB	AMBA (advanced microcontroller bus architecture) high-performance bus, Arm® data transfer bus
Arm®	Advanced RISC machine, a CPU architecture
ASIL	Automotive safety integrity level
BOD	Brown-out detection
CAN FD	Controller Area Network with Flexible Data rate
CMOS	Complementary metal-oxide-semiconductor
CPU	Central Processing Unit
CRC	Cyclic redundancy check, an error-checking protocol
CSV	Clock supervisor
CTI	Cross trigger interface
CXPI	Clock Extension Peripheral Interface
DES	Data encryption standard
DFT	Design-For-Test
DW	Datawire same as P-DMA
ECC	Error correcting code/Elliptical curve cryptography
ECO	External crystal oscillator
ETM	Embedded Trace Macrocell
EVTGEN	Event Generator
FLL	Frequency Locked Loop
FPU	Floating point unit
GHS	Green Hills tool chain with Multi IDE
GPIO	General purpose input/output
HSM	Hardware security module
I/O	Input/output
I^2C	Inter-Integrated Circuit, a communications protocol
ILO	Internal low-speed oscillator
IMO	Internal main oscillator

Acronym	Description
IRQ	Interrupt request
JTAG	Joint test action group
LDO	Low drop out regulators
LIN	Local Interconnect Network, a communications protocol
LVD	Low voltage detection
OTA	Over-the-air programming
OTP	One-time programmable
OVD	Overvoltage detection
P-DMA	Peripheral-Direct Memory Access same as DW
PLL	Phase Locked Loop
POR	Power-on reset
PPU	Peripheral protection unit
PRNG	Pseudorandom number generator
PWM	Pulse-width modulation
MCU	Microcontroller Unit
MCWDT	Multi-counter watchdog timer
M-DMA	Memory-Direct Memory Access
MISO	SPI Master-in slave-out
MMIO	Memory mapped I/O
MOSI	SPI Master-out slave-in
MPU	Memory protection unit
MTB	Micro trace buffer
MUL	Multiplier
MUX	Multiplexer
NVIC	Nested vectored interrupt controller
RAM	Random access memory
RISC	Reduced-instruction-set computing
ROM	Read only memory
RSA	Rivest-Shamir-Adleman Public Key Encryption Algorithm
RTC	Real-time clock
SAR	Successive approximation register

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Table 30-1 Acronyms used in the Document *(continued)*

Acronym	Description
IOSS	Input/output sub-system
IPC	Inter-processor communication
IrDA	Infrared interface
SECDED	Single error correction, double error detection
SHA	Secure hash algorithm
SHE	Secure hardware extension
SMPU	Shared memory protection unit
SPI	Serial peripheral interface, a communications protocol
SRAM	Static random access memory
SWD	Serial wire debug
SWJ	Serial wire JTAG

Acronym	Description
SCB	Serial communication block
SCL	I^2C serial clock
SDA	I^2C serial data
TCPWM	Timer/Counter Pulse-width modulator
TTL	Transistor-transistor logic
TRNG	True random number generator
UART	Universal Asynchronous Transmitter Receiver
WCO	Watch crystal oscillator
WDT	Watchdog timer reset
XRES_L	External reset I/O pin

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31 Errata

This section describes the errata for the CYT2B9 product family. Details include trigger conditions, scope of impact, available workaround, and silicon revision applicability. Contact your local Cypress Sales Representative if you have further questions.

Part Numbers Affected

Part Numbers
All CYT2B9 parts

CYT2B9 Qualification Status

Production samples

CYT2B9 Errata Summary

The following table defines the errata applicability to available CYT2B9 family devices.

Items	Errata ID	CYT2B9	Silicon Rev.	Fix Status
[1.] **ConfigureFmInterrupt API assumes a parameter with 8-byte boundary but the actual boundary is 4 bytes**	67	CYT2B93BACQ0AZSGS CYT2B93BACQ0AZEGS CYT2B93CACQ0AZSGS CYT2B93CACQ0AZEGS CYT2B94BACQ0AZSGS CYT2B94BACQ0AZEGS CYT2B94CACQ0AZSGS CYT2B94CACQ0AZEGS CYT2B95BACQ0AZSGS CYT2B95BACQ0AZEGS CYT2B95CACQ0AZSGS CYT2B95CACQ0AZEGS CYT2B97BACQ0AZSGS CYT2B97BACQ0AZEGS CYT2B97CACQ0AZSGS CYT2B97CACQ0AZEGS CYT2B98BACQ0AZSGS CYT2B98BACQ0AZEGS CYT2B98CACQ0AZSGS CYT2B98CACQ0AZEGS	C	No silicon fix planned. Use workaround.
[2] **SMPU/MPU/PPU protection region size is limited to 2 GB**	68			No silicon fix planned. Use workaround.
[3] **DirectExecute API may return error if called with arguments placed in SRAM memory**	69			No silicon fix planned. Use workaround.
[4] **CAN FD RX FIFO top pointer feature does not function as expected**	96			No silicon fix planned. Use workaround.
[5] **CAN FD debug message handling state machine is not reset to Idle state when CANFD_CH_CCCR.INIT is set**	97			No silicon fix planned. Use workaround.
[6] **TPIU Peripheral ID mismatch**	98			No silicon fix planned.
[7] **Limitation of the memory hole in SCB register space**	124			No silicon fix planned. Use workaround.
[8] **WDT service can be missed**	129			No silicon fix planned. Use workaround.
[9] **CAN FD controller message order inversion when transmitting from dedicated Tx Buffers configured with same Message ID**	147			No silicon fix planned. Use workaround.
[10] **CAN FD incomplete description of Dedicated Tx Buffers and Tx Queue related to transmission from multiple buffers configured with the same Message ID**	167			No silicon fix planned. Use workaround. TRM will be updated.

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1. ConfigureFmInterrupt API assumes a parameter with 8-byte boundary but the actual boundary is 4 bytes	
Problem Definition	STATUS_ADDR_PROTECTED will be returned if the ConfigureFmInterrupt API is called with arguments stored in SRAM with 4-byte boundary (available SRAM or protected boundary SRAM).
Parameters Affected	NA
Trigger Condition(s)	Call ConfigureFmInterrupt API with arguments stored in SRAM at 4-byte boundary of available SRAM or protected boundary of SRAM.
Scope of Impact	ConfigureFmInterrupt API will fail by returning STATUS_ADDR_PROTECTED error status when called with argument having 4-byte boundary of available SRAM or protected boundary of SRAM.
Workaround	Allow 4 bytes margin (that is, assume that API parameter size is 8 and store the arguments) for the ConfigureFmInterruptAPI.
Fix Status	No silicon fix planned. Use workaround.

2. SMPU/MPU/PPU protection region size is limited to 2 GB	
Problem Definition	If SMPU/MPU/PPU protection block size is configured for 4 GB (PROT_SMPU_SMPU_-STRUCT_ATT0.REGION.SIZE = 31), then during protection check in SROM, the value of the internal uint32 variable will overflow (4G = 0x1 0000 0000). Therefore, SROM assumes the protection size equals zero and no protection will be applied.
Parameters Affected	NA
Trigger Condition(s)	Configure SMPU/MPU/PPU to protect with region size equal to 4 GB or the region size with value 31u.
Scope of Impact	If SMPU/MPU/PPU is configured to protect region size of 4 GB, then SROM software does not apply any protection per the request.
Workaround	Use two protection blocks of region size equal to 2 GB if 4-GB region size protection is required.
Fix Status	No silicon fix planned. Use workaround.

3. DirectExecute API may return error if called with arguments placed in SRAM memory	
Problem Definition	If DirectExecute API is called in the master PC (other than PC0 or PC1) with arguments in SRAM_SCRATCH_ADDR, then the API will return STATUS_ADDR_PROTECTED status.
Parameters Affected	NA
Trigger Condition(s)	Call DirectExecute API with arguments in SRAM_SCRATCH_ADDR and master PC configured > 1.
Scope of Impact	DirectExecute API, if called with master PC configured > 1 and arguments in SRAM_SCRATCH_ADDR, will return STATUS_ADDR_PROTECTED.
Workaround	Call DirectExecute API with master PC0 or PC1 if the arguments are stored in SRAM memory.
Fix Status	No silicon fix planned. Use workaround.

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4. CAN FD RX FIFO top pointer feature does not function as expected	
Problem Definition	RX FIFO top pointer function calculates the address for received messages in Message RAM by hardware. This address should restart from the start address after reading all messages of RX FIFO n size (n: 0 or 1). However, the address does not restart from the start address when RX FIFO n size is set to 1(CANFD_CH_RXFnC.FnS = 0x01). This results in CPU/DMA reading messages from the wrong address in Message RAM.
Parameters Affected	NA
Trigger Condition(s)	The RX FIFO top pointer function is used when RX FIFO n size is set to 1 element (CANFD_CH_RXFnC.FnS = 0x01).
Scope of Impact	Received message cannot be correctly read by using the RX FIFO top pointer function, when RX FIFO n size is set to 1 element.
Workaround	Any of the following can be used as a workaround: 1) Set RX FIFO n size to 2 or more when using RX FIFO top pointer function. 2) Do not use the RX FIFO top pointer function when RX FIFO n size is set to 1 element. Instead of RX FIFO top pointer, read received messages from the Message RAM directly.
Fix Status	No silicon fix planned. Use workaround.

5. CAN FD debug message handling state machine is not reset to Idle state when CANFD_CH_CCCR.INIT is set	
Problem Definition	If either of the CANFD_CH_CCCR.INIT bits is set by the Host or when the M_TTCAN module enters BusOff state, the debug message handling state machine stays in its current state instead of being reset to Idle state. Configuring the bit CANFD_CH_CCCR.CCE does not change CANFD_CH_RXF1S.DMS.
Parameters Affected	NA
Trigger Condition(s)	Either of the CANFD_CH_CCCR.INIT bits is set by the Host or when the M_TTCAN module enters BusOff state.
Scope of Impact	The errata is limited to the use case when the debug on CAN functionality is active. Normal operation of the CAN module is not affected, in which case the debug message handling state machine always remains in Idle state. In the described use case, the debug message handling state machine is stopped and remains in the current state signaled by the CANFD_CH_RXF1S.DMS bit. In case CANFD_CH_RXF1S.DMS is set to 0b11, the DMA request remains active.
Workaround	In case the debug message handling state machine has stopped while CANFD_CH_RXF1S.DMS is 0b01 or 0b10, it can be reset to Idle state by hardware reset or by reception of debug messages after CANFD_CH_CCCR.INIT is reset to zero.
Fix Status	No silicon fix planned. Use workaround.

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6. TPIU Peripheral ID mismatch	
Problem Definition	TPIU peripheral ID indicates that it is M3-TPIU instead of M4-TPIU.
Parameters Affected	NA
Trigger Condition(s)	When debugger reads PID registers for component identification.
Scope of Impact	The only impact is that the debugger reads the TPIU as M3-TPIU.
Workaround	No specific workaround required. Debugger can use trace features.
Fix Status	No silicon fix planned.

7. Limitation of the memory hole in SCB register space	
Problem Definition	The memory hole [offset address: 0x1000 to 0xFFFF] inside the SCB register space is not aligned to the below defined spec. Since the offset address bits [15:12] are ignored and treated as 4'b0000, write/read access to the offset address [0x1000 to 0xFFFF] will actually happen to [0x0000 to 0x0FFF]. - Access to address gaps in mapped memory space: writes are ignored and any read returns a zero.
Parameters Affected	NA
Trigger Condition(s)	Access to the memory hole [offset address: 0x1000 to 0xFFFF] in SCB register space
Scope of Impact	The memory hole [offset address: 0x1000 to 0xFFFF] in the SCB register space is not aligned to other IP registers.
Workaround	Do not access to the memory hole [offset address: 0x1000 to 0xFFFF] in SCB register space.
Fix Status	No fix planned

8. WDT service can be missed	
Problem Definition	If WDT service happens within 4 ILO clock cycles before DeepSleep entry, it clears the counter but does not fully complete an internal handshake. A service after DeepSleep wakeup may then be missed if it occurs less than 2 ILO clock cycles after the processor resumes clocking. After this time, the internal handshake is complete and servicing works normally.
Parameters Affected	NA
Trigger Condition(s)	Service WDT within 4 ILO clock cycles before DeepSleep entry and within 2 ILO clock cycles of processor clock resuming.
Scope of Impact	WDT service after DeepSleep wakeup may be ignored and WDT continues counting. This can cause unintended WARN_ACTION or UPPER_ACTION, including interrupt, fault, and/or reset.
Workaround	Wait 130 µs or more after DeepSleep wakeup. (For example, to measure 130 µs, software can read WDT_CNT register at wake up and make sure that WDT_CNT was incremented of 4 units before servicing WDT). Afterwards, write '1' to WDT service (WDT_SERVICE.SERVICE) after waiting until WDT service (WDT_SERVICE.SERVICE) reads '0'.
Fix Status	No silicon fix planned. Use workaround.

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9. CAN FD controller message order inversion when transmitting from dedicated Tx Buffers configured with same Message ID	
Problem Definition	Configuration: Several Tx Buffers are configured with same Message ID. Transmission of these Tx Buffers is requested sequentially with a delay between the individual Tx requests. Expected behavior: When multiple Tx Buffers that are configured with the same Message ID have pending Tx requests, they shall be transmitted in ascending order of their Tx Buffer numbers. The Tx Buffer with lowest buffer number and pending Tx request is transmitted first. Observed behavior: It may happen, depending on the delay between the individual Tx requests, that in the case where multiple Tx Buffers are configured with the same Message ID the Tx Buffers are not transmitted in order of the Tx Buffer number (lowest number first).
Parameters Affected	NA
Trigger Condition(s)	When multiple Tx Buffers that are configured with the same Message ID have pending Tx requests.
Scope of Impact	In the case described it may happen, that Tx Buffers configured with the same Message ID and pending Tx request are not transmitted with lowest Tx Buffer number first (message order inversion).
Workaround	Any of the following: 1) First write the group of Tx message with the same Message ID to the Message RAM and then afterwards request transmission of all these messages concurrently by a single write access to CANFDx_CHy_TXBAR. Before requesting a group of Tx messages with this Message ID ensure that no message with this Message ID has a pending Tx request. 2) Use the Tx FIFO instead of dedicated Tx Buffers for the transmission of several messages with the same Message ID in a specific order. Applications not able to use workaround #1 or #2 can implement a counter within the data section of their messages sent with same ID in order to allow the recipients to determine the correct sending sequence.
Fix Status	No silicon fix planned. Use workaround.

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10. CAN FD incomplete description of Dedicated Tx Buffers and Tx Queue related to transmission from multiple buffers configured with the same Message ID	
Problem Definition	The following are the updated description in Sections "Dedicated Tx Buffers" and "Tx Queue" of the Architecture TRM related to the transmission from multiple buffers configured with the same Message ID. Dedicated Tx Buffers - TRM Statement: If multiple Tx Buffers are configured with the same Message ID, the Tx Buffer with the lowest buffer number is transmitted first. - Enhancement: These Tx buffers shall be requested in ascending order with lowest buffer number first. Alternatively all Tx buffers configured with the same Message ID can be requested simultaneously by a single write access to CANFDx_CHy_TXBAR. Tx Queue - TRM Statement: If multiple queue buffers are configured with the same Message ID, the queue buffer with the lowest buffer number is transmitted first. - Replacement: In case that multiple Tx Queue buffers are configured with the same Message ID, the transmission order depends on numbers of the buffers where the messages were stored for transmission. As these buffer numbers depend on the then current states of the PUT Index, a prediction of the transmission order is not possible. - TRM Statement: An Add Request cyclically increments the Put Index to the next free Tx Buffer. - Replacement: The PUT Index always points to that free buffer of the Tx Queue with the lowest number.
Parameters Affected	NA
Trigger Condition(s)	Using multiple dedicated Tx Buffers or Tx Queue Buffers configured with the same Message ID.
Scope of Impact	In the case the dedicated Tx Buffers with the same Message ID are not requested in ascending order or at the same time or in case of multiple Tx Queue Buffers with the same Message ID, it cannot be guaranteed, that these messages are transmitted in ascending order with lowest buffer number first.
Workaround	In case a defined order of transmission is required the Tx FIFO shall be used for transmission of messages with the same Message ID. Alternatively dedicated Tx Buffers with the same Message ID shall be requested in ascending order with lowest buffer number first or by a single write access to CANFDx_CHy_TXBAR. Alternatively a single Tx Buffer can be used to transmit those messages one after the other.
Fix Status	No silicon fix planned. Use workaround. TRM will be updated accordingly.

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Revision history

Document version	Date of release	Description of changes
*D	08/17/2019	Release to web.
*E	11/26/2019	Updated SRAM details in **CYT2B9 address map**. Updated affected part numbers in **Errata**. **Electrical specifications**: Updated ADC Calculation of impact of neighboring pins and Trace Updated sample revision in **Ordering Information**. Updated **Packaging**.
*F	12/12/2019	Updated **Figure 4-1** Updated **Fault Assignments** with detailed description. Corrected **Errata** table with correct revisions.
*G	04/23/2020	Added eSHE footnote on page 1. Updated **Block diagram**. Updated SCB/UART content in **Functional description**. Added note for VCCD in **Power pin assignments**. Added **Pin Mux Descriptions**. Updated **Fault Assignments** table with detailed descriptions. Added JTAG ID and package support footnotes in **Ordering Information**. Removed CM7 from **Part number nomenclature**. Updated **Packaging**. Updated **Errata**.
*H	06/29/2020	Updated **Features list**. Updated **Clock system**. Updated **Electrical specifications**. Updated **Ordering Information**. Updated **Appendix**. Refer to **Revision History Change Log** for the detailed list of changes for this revision.
*I	10/13/2021	Updated **Features list**. Updated **Communication peripheral instance list**. Updated **High-Speed I/O matrix connections**. Updated **Alternate function pin assignments**. Updated **Trigger multiplexer**. Updated **Faults**. Updated **Electrical specifications**. Updated **Part number nomenclature**. Updated **Appendix**. Added **Errata**. Refer to **Revision History Change Log** for the detailed list of changes for this revision.

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31.1 Revision History Change Log

Rev *I Section Updates

Section	Change description	Current spec (Rev *H)	New spec (Rev *I)	Reason for change
1. Features List	Renamed Features in Table 1-1	LIN/UART Master support	LIN0	Updated
1.1 Communication Peripheral Instance List	Renamed module in Table 1-2	LIN	LIN0	Updated
3.2.3 Clock System	Updated IMO Clock Source description	The IMO operates at a frequency of 8 MHz ±1%. The internal trim settings for the IMO can be dynamically updated to provide a tolerance < 1%.	The IMO operates at a frequency of around 8 MHz.	Updated
3.2.6 Power Modes	Updated description	Hibernate – the device and I/Os are in High-Z state, the device resets on wakeup	Hibernate – the device and I/O states are frozen, the device resets on wakeup	Correction
3.4 I/Os	Updated description	During power-on, Hibernate, and reset, the I/Os are forced to the High-Z state.	During power-on, and reset, the I/Os are forced to the High-Z state. During the Hibernate mode, I/Os are frozen.	Updated
9. Pin Assignment	Updated Figure 9-2, 9-4, 9-6, 9-8, 9-10	Identifier (n) does not present	Added identifier (n).	Added
10. High-Speed I/O Matrix Connections	Updated Table 10-1	Number: Description 1: GPIO controls 'out', DSI controls 'output enable' 2: DSI controls 'out' and 'output enable' 3: DSI controls 'out', GPIO controls 'output enable' 4: Analog multiplexer bus A 5: Analog multiplexer bus B 6: Analog multiplexer bus A, DSI control 7: Analog multiplexer bus B, DSI control	Number: Description 1: 2: 3: 4: Reserved 5: 6: 7:	Correction
13. Alternate Function Pin Assignments	Updated Table 13-1	(none)	Added note [28]: Refer to Table 13-2 for more information on pin multiplexer abbreviations used.	Added
13. Alternate Function Pin Assignments	Updated Table 13-1	Identifier (n) and note do not present	Added identifier (n). Added note [29]: For any function marked with an identifier (n), the AC timing is only guaranteed within the respective group "n".	Added
13. Alternate Function Pin Assignments	Updated Table 13-1	PWM_xx, PWM_xx_N, TC_xx_TR0, and TC_xx_TR1	PWM0_xx, PWM0_xx_N, TC0_xx_TR0, and TC0_xx_TR1	Updated
16. Trigger Multiplexer	Updated Figure 16-1	PDMA0_TR_OUT is not connected to MUX Group 6 MUX Group 10 input: P-DMA1*, M-DMA*, CXPI*, PASS*, EVTGEN*, TCPWM_TR_OUT1*	PDMA0_TR_OUT is connected to MUX Group 6 MUX Group 10 input: P-DMA1*, M-DMA*, CXPI*, PASS*, EVTGEN*, TCPWM_TR_OUT1*, HSIOM*	Updated
17. Triggers Group Inputs	Updated Table 17-1	MUX Group 10: 157:188 (none)	MUX Group 10: 157:188 / HSIOM_IO_INPUT[0:31] / I/O inputs	Updated
21. Faults	Updated Table 21-1	No.: Description 32: Peripheral Group #0 PPU violation. 33: Peripheral Group #1 PPU violation. 34: Peripheral Group #2 PPU violation. 35: Peripheral Group #3 PPU violation. 37: Peripheral Group #4 PPU violation. 38: Peripheral Group #5 PPU violation. 41: Peripheral Group #6 PPU violation. 49: Flash controller main flash cache correctable ECC violation 50: Flash controller main flash cache non-correctable ECC violation. 52: Flash controller work flash cache correctable ECC violation. 53: Flash controller work-flash cache non-correctable ECC violation.	No.: Description 32: Peripheral Group #0 violation. 33: Peripheral Group #1 violation. 34: Peripheral Group #2 violation. 35: Peripheral Group #3 violation. 37: Peripheral Group #5 violation. 38: Peripheral Group #6 violation. 41: Peripheral Group #9 violation. 49: Flash controller main flash correctable ECC violation 50: Flash controller main flash non-correctable ECC violation. 52: Flash controller work flash correctable ECC violation. 53: Flash controller work-flash non-correctable ECC violation.	Correction
26. Electrical Specifications	Removed Table 26-3. Smoothing Capacitor Connections	Table 26-3. Smoothing Capacitor Connections	(none)	This table is provided in Hardware Design Guide (002-20270).
26. Electrical Specifications	Added 26.7 AC Specifications	(none)	Added 26.7 AC Specifications	Added description
26. Electrical Specifications	Updated Figure 26-7	1: tPWMEBEXT, tQRES	1: tPWMENEXT, tQRES	Updated

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Rev *I Section Updates *(continued)*

Section	Change description	Current spec (Rev *H)	New spec (Rev *I)	Reason for change
26. Electrical Specifications	Updated Figure 26-9 to 26-12	Time reference point: VOH/VOL, VIH/VIL	Time reference point: 50 %	Updated
26. Electrical Specifications	Updated Table 26-18 title	SWD Interface Specifications	SWD Interface Specifications [Conditions: drive_sel<1:0>= 00]	Added condition
26. Electrical Specifications	Updated Table 26-19 title	JTAG AC Specifications	JTAG AC Specifications [Conditions: drive_sel<1:0>= 00]	Added condition
26. Electrical Specifications	Updated Table 1 title	Trace Specifications	Trace Specifications [Conditions: drive_sel<1:0>= 00]	Added condition
26. Electrical Specifications	Updated Table 26-21	CLK_HF1 / Description: Event generator, … CLK_HF2 / Max Frequency (MHz): 8	CLK_HF1 / Description: Event generator (CLK_REF), … CLK_HF2 / Max Frequency (MHz): 2	Correction
27.1 Part Number Nomenclature	Updated Table 27-2, 27-3	Hardware Option: Value / Meaning B / eSHE – on, HSM – off C / eSHE – on, HSM – on	Hardware Option: Value / Meaning B / eSHE – on, HSM – off, RSA - 2K C / eSHE – on, HSM – on, RSA - 2K	Updated
29. Appendix	Updated Table 29-1	CAN Instance: CANFD0_CH1 CAN TX: P0.2 CAN RX: P0.3 CAN Transceiver NSTB: P23.3 CAN Transceiver EN: P2.1	CAN Instance: CAN0, Channel#1 CAN TX: P0.2 / CAN0_1_TX CAN RX: P0.3 / CAN0_1_RX CAN Transceiver NSTB / EN (Low): P23.3 (optional) CAN Transceiver EN / EN (High): P2.1 (optional)	Updated
29. Appendix	Updated Table 29-2	LIN Type: LIN0_CH1 LIN TX: P0.1 LIN RX: P0.0 LIN EN: P2.1	LIN Type: LIN0, Channel#1 LIN TX: P0.1 / LIN1_TX LIN RX: P0.0 / LIN1_RX LIN EN / EN (High): P2.1 (optional) LIN EN (Low): P23.3 (optional)	Updated
29. Appendix	Updated Figure 29-3	EN (LOW) and VDDIO line do not present.	Added EN (LOW) and VDDIO line	Updated
31. Errata	Added errata	-	Added Errata ID 147 and 167.	Added errata

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Rev *I Electrical Specification updates

Spec ID	Description	Changed Item	Current Spec (Rev. *H)	New Spec (Rev. *I)	Reason for Change
SID40	Power Supply voltage	Note	[51] VDDD, VDDIO_1, VDDIO_2, and VDDA do not have any sequencing limitation and can establish in any order. These supplies (except VDDA and VDDIO_2) are independent in voltage level. For example, VDDIO_1 = 5.0 V, VDDD = 3.3 V, and VDDA = VDDIO_2 = 4.0 V are supported, as is any other combination of voltages between 2.7 V and 5.5 V inclusive. The presence of VDDA without VDDD can cause some leakage from VDDA. However, the device does not drive any analog or digital output.	[45] VDDD, VDDIO_1, VDDIO_2, and VDDA do not have any sequencing limitation and can establish in any order. These supplies (except VDDA and VDDIO_2) are independent in voltage level. See 12-Bit SAR ADC DC Specifications when using ADC units.	Updated description
SID49C1	LP Active mode (CM4 and CM0+ at 8 MHz, all peripherals are disabled)	Details/Conditions	MAX: TA = 125 °C, VDDD = 5.5 V, process typ (FF)	MAX: TA = 25 °C, VDDD = 5.5 V, process worst (FF)	Correction
SID49C	LP Active mode (CM4 and CM0+ at 8 MHz, all peripherals are enabled)	Details/Conditions	CM0+ and CM4 executing max_power.c from ARM with cache enabled.	CM0+ and CM4 executing max_power.c from flash with cache enabled.	Updated condition
SID56A	Average current for cyclic wake-up operation This is the average current for the specified LP Active mode and DeepSleep mode (RTC, WDT and Event generator operating).	Details/Conditions	MAX: process typ (FF)	MAX: process worst (FF)	Correction
SID62	Hibernate Mode	Details/Conditions	TA = 25 °C, VDDD = 5.5 V	ILO0/WDT operating. All other peripherals, and all CPUs are off. TA = 25 °C, VDDD = 5.5 V, process typ (TT)	Updated condition
SID62A	Hibernate Mode	Max Details/Conditions	Max: 175 uA Details/Conditions: TA = 125 °C, VDDD = 5.5 V	Max: 130 uA Details/Conditions: ILO0/WDT operating. All other peripherals, and all CPUs are off. TA = 125 °C, VDDD = 5.5 V, process worst (FF)	Updated spec
SID63 SID63A SID63B SID63C SID63D	DeepSleep to Active transition time	Note	(none)	Added Note[51]: At cold temperature -5°C to -40°C, the DeepSleep to Active transition time can be higher than the max time indicated by as much as 20 us	Added note
SID80A	ROM boot startup time or wakeup time from hibernate in NORMAL protection state	Max Details/Conditions	Max: 1200 us Details/Conditions: Guaranteed by Design, CM0+ clocked at 100 MHz	Max: 1800 us Details/Conditions: Guaranteed by Design, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later)	Updated spec
SID80B	ROM boot startup time or wakeup time from hibernate in SECURE protection state	Max Details/Conditions	Max: 2050 us Details/Conditions: Guaranteed by Design, TOC2_FLAGS=0x2CF, CM0+ clocked at 100 MHz	Max: 2740 us Details/Conditions: Guaranteed by Design, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later)	Updated spec
SID81A	Flash boot startup time or wakeup time from hibernate in NORMAL/SECURE protection state	Details/Conditions	Guaranteed by Design, TOC2_FLAGS=0x2CF, CM0+ clocked at 100 MHz, Listen window = 0 ms	Guaranteed by Design, TOC2_-FLAGS=0x2CF, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later), Listen window = 0 ms	Updated condition
SID81B	Flash boot with app authentication time in NORMAL/SECURE protection state	Max Details/Conditions	Max: 4070 us Details/Conditions: Guaranteed by Design, TOC2_FLAGS=0x2CF, CM0+ clocked at 100 MHz, Listen window = 0 ms, App size is 64 KB with the last 256 bytes being a digital signature in RSASSA-PKCS1-v1.5.	Max: 5000 us Details/Conditions: Guaranteed by Design, TOC2_-FLAGS=0x24F, CM0+ clocked at 100 MHz (Flash boot version 3.1.0.556 and later), Listen window = 0 ms, Public key exponent e = 0x010001, App size is 64 KB with the last 256 bytes being a digital signature in RSASSA-PKCS1-v1.5. Valid for RSA2K.	Updated spec
SID80A_2	ROM boot startup time or wakeup time from hibernate in NORMAL protection state	All	(none)	SID80A_2 Parameter: tRB_N_2 Max: 2930 us Details/Conditions: Guaranteed by Design, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556)	Added spec
SID80B_2	ROM boot startup time or wakeup time from hibernate in SECURE protection state	All	(none)	SID80B_2 Parameter: tRB_S_2 Max: 4680 us Details/Conditions: Guaranteed by Design, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556)	Added spec

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Rev *I Electrical Specification updates *(continued)*

Spec ID	Description	Changed Item	Current Spec (Rev. *H)	New Spec (Rev. *I)	Reason for Change
SID81A_2	Flash boot startup time or wakeup time from hibernate in NORMAL/SECURE protection state	All	(none)	SID81A_2 Parameter: tFB_2 Max: 200 us Details/Conditions: Guaranteed by Design, TOC2_-FLAGS=0x2CF, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556), Listen window = 0 ms	Added spec
SID81B_2	Flash boot with app authentication time in NORMAL/SECURE protection state	All	(none)	SID81B_2 Parameter: tFB_A_2 Max: 10000 us Details/Conditions: Guaranteed by Design, TOC2_-FLAGS=0x24F, CM0+ clocked at 50 MHz (Flash boot version earlier than 3.1.0.556), Listen window = 0 ms, Public key exponent e = 0x010001, App size is 64 KB with the last 256 bytes being a digital signature in RSASSA-PKCS1-v1.5 Valid for RSA2K.	Added spec
SID102A	VDDA voltage range	All	(none)	VDDA voltage range	Added spec
SID103A	Internal band gap reference voltage	All	(none)	Internal band gap reference voltage	Added spec
SID113D	Analog input sample time for temperature sensor	All	(none)	Analog input sample time for temperature sensor	Added spec
SID200	Temperature Sensor accuracy 1	Details/Conditions	TJ = 150 °C This spec is valid for the following conditions: a. 3.0 V ≤ VDDD=VDDA=VREFH ≤ 3.6 V or b. 4.5 V ≤ VDDD=VDDA=VREFH ≤ 5.5 V	TJ = 150 °C This spec is valid when using ADC[0] (VDDIO_1), ADC[1] (VDDIO_2) or ADC[2] (VDDD) with the following conditions: a. 3.0 V ≤ VDDD, VDDIO_1 or VDDIO_2 = VDDA = VREFH ≤ 3.6 V or b. 4.5 V ≤ VDDD, VDDIO_1 or VDDIO_2 = VDDA = VREFH ≤ 5.5 V	Updated condition
SID201	Temperature Sensor accuracy 2	Details/Conditions	- 40 °C ≤ TJ < 150 °C This spec is valid for the following conditions: a. 3.0 V ≤ VDDD=VDDA=VREFH ≤ 3.6 V or b. 4.5 V ≤ VDDD=VDDA=VREFH ≤ 5.5 V	- 40 °C ≤ TJ < 150 °C This spec is valid when using ADC[0] (VDDIO_1), ADC[1] (VDDIO_2) or ADC[2] (VDDD) with the following conditions: a. 3.0 V ≤ VDDD, VDDIO_1 or VDDIO_2 = VDDA = VREFH ≤ 3.6 V or b. 4.5 V ≤ VDDD, VDDIO_1 or VDDIO_2 = VDDA = VREFH ≤ 5.5 V	Updated condition
SID201A	Temperature Sensor accuracy 3	Details/Conditions	- 40 °C ≤ TJ ≤ 150 °C This spec is valid for the following conditions except SID201 conditions: 2.7 V ≤ VDDD ≤ 5.5 V and 2.7 V ≤ VDDA=VREFH ≤ 5.5 V	- 40 °C ≤ TJ ≤ 150 °C This spec is valid when using ADC[0] (VDDIO_1) or ADC[2] (VDDD) with the following condition: 2.7 V ≤ VDDD or VDDIO_1 ≤ 5.5 V and 2.7 V ≤ VDDA = VREFH ≤ 5.5 V and 0.8 x VDDA < VDDD or VDDIO_1	Updated condition
SID598	Over current detection range in Active/Sleep mode	Details/Conditions	(None)	Guaranteed by Design	Added codition
SID599	Over current detection range in DeepSleep mode	Details/Conditions	(None)	Guaranteed by Design	Added codition
SID332	Feedback resistor vaule for ECO	Details/Conditions	(None)	Guaranteed by Design	Added codition
SID334	4-MHz ECO start-up time	Details/Conditions	Start-up time to 90% of final frequency	Time from set CLK_ECO_CONFIG.ECO_EN to 1 until CLK_ECO_STATUS.ECO_READY is set to 1. (See Clock Timing Diagrams)	Updated condition
SID335	33-MHz ECO start-up time	Details/Conditions	Start-up time to 90% of final frequency	Time from set CLK_ECO_CONFIG.ECO_EN to 1 until CLK_ECO_STATUS.ECO_READY is set to 1. (See Clock Timing Diagrams)	Updated condition

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Rev *I Electrical Specification updates *(continued)*

Spec ID	Description	Changed Item	Current Spec (Rev. *H)	New Spec (Rev. *I)	Reason for Change
SID362	WCO start up time	Details/Conditions	For Grade-S devices	For Grade-S devices Time from set CTL.WCO_EN to 1 until STATUS.WCO_OK is set to 1. (See Clock Timing Diagrams)	Updated condition
SID362E	WCO start up time	Details/Conditions	For Grade-E devices	For Grade-E devices Time from set CTL.WCO_EN to 1 until STATUS.WCO_OK is set to 1. (See Clock Timing Diagrams)	Updated condition
SID349C	PFD frequency	Min	4 MHz	3.988 MHz	Correction
SID412	Minimum WDT timeout	Details/Conditions	When using the ILO (32.768 kHz + 5 %) and 16-bit WDT counter. Guaranteed by Design.	When using the ILO (32.768 kHz + 5 %) and 32-bit WDT counter. Guaranteed by Design.	Correction
SID413	Maximum WDT timeout	Details/Conditions	When using the ILO (32.768 kHz - 5 %) and 16-bit WDT counter. Guaranteed by Design.	When using the ILO (32.768 kHz - 5 %) and 32-bit WDT counter. Guaranteed by Design.	Correction
SID414	Default WDT timeout	Typ Details/Conditions	Typ: 125 ms Details/Conditions: When using the ILO and 32-bit WDT counter at 0x1000 (default value). Guaranteed by Design.	Typ: 1000 ms Details/Conditions: When using the ILO and 32-bit WDT counter at 0x8000 (default value). Guaranteed by Design.	Correction

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